

General Description

The SLG46811 provides a small, low power component for commonly used Mixed-Signal functions. The user creates their circuit design by programming the one time programmable (OTP) Non-Volatile Memory (NVM) to configure the interconnect logic, the IO Pins, and the macrocells of the SLG46811. This highly versatile device allows a wide variety of Mixed-Signal functions to be designed within a very small, low power single integrated circuit.

Key Features

- Multichannel Sampling Analog Comparator (MS ACMP)
 - Sampling up to Four Analog Channels
 - Selectable Voltage Reference for Each Channel
 - Different Sampling Scenarios
 - Synchronous or Asynchronous Result Appearance
- Integrated Voltage References (Vref)
- Twelve Combination Function Macrocells
 - Two 2-Bit LUT or DFF/LATCH Macrocells
 - One Selectable Programmable Pattern Generator or 2-bit LUT
 - Four 3-Bit LUT or DFF/LATCH with Set/Reset
 - Four Selectable DFF/LATCH or 3-bit LUTs or Shift Registers
 - One 4-Bit LUT or DFF/LATCH with Set/Reset Macrocell
- Six Multi-Function Macrocells
 - Five Selectable DFF/LATCH or 3-bit LUTs + 8-bit Delay/Counters
 - One Selectable DFF/LATCH or 3-bit LUTs + 8-bit Delay/Counter/FSM
- Extended Pattern Generator
 - Up to 8 Parallel Outputs
 - 92 bytes Pattern Stored in the NVM
- Serial Communications
 - I²C Protocol Interface
- Programmable Delay with Edge Detector Output
- Deglitch Filter or Edge Detector
- Two Oscillators (OSC)
 - Selectable 2.048 kHz or 10 kHz Oscillator
 - 25 MHz Oscillator
- Analog Temperature Sensor
- Power-On Reset (POR) with CRC
- Read Back Protection (Read Lock)
- Power Supply
 - $2.3\text{ V} \leq V_{DD} \leq 5.5\text{ V}$
- Operating Temperature Range: -40 °C to 85 °C
- RoHS Compliant/Halogen-Free
- Available Package
 - 12-pin STQFN: 1.6 mm x 1.6 mm x 0.55 mm, 0.4 mm pitch

Applications

- Notebook and Tablet PCs
- Smartphones and Fitness Bands
- Personal Computers and Servers
- PC Peripherals
- Consumer Electronics
- Data Communications Equipment
- Handheld and Portable Electronics

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1 Block Diagram

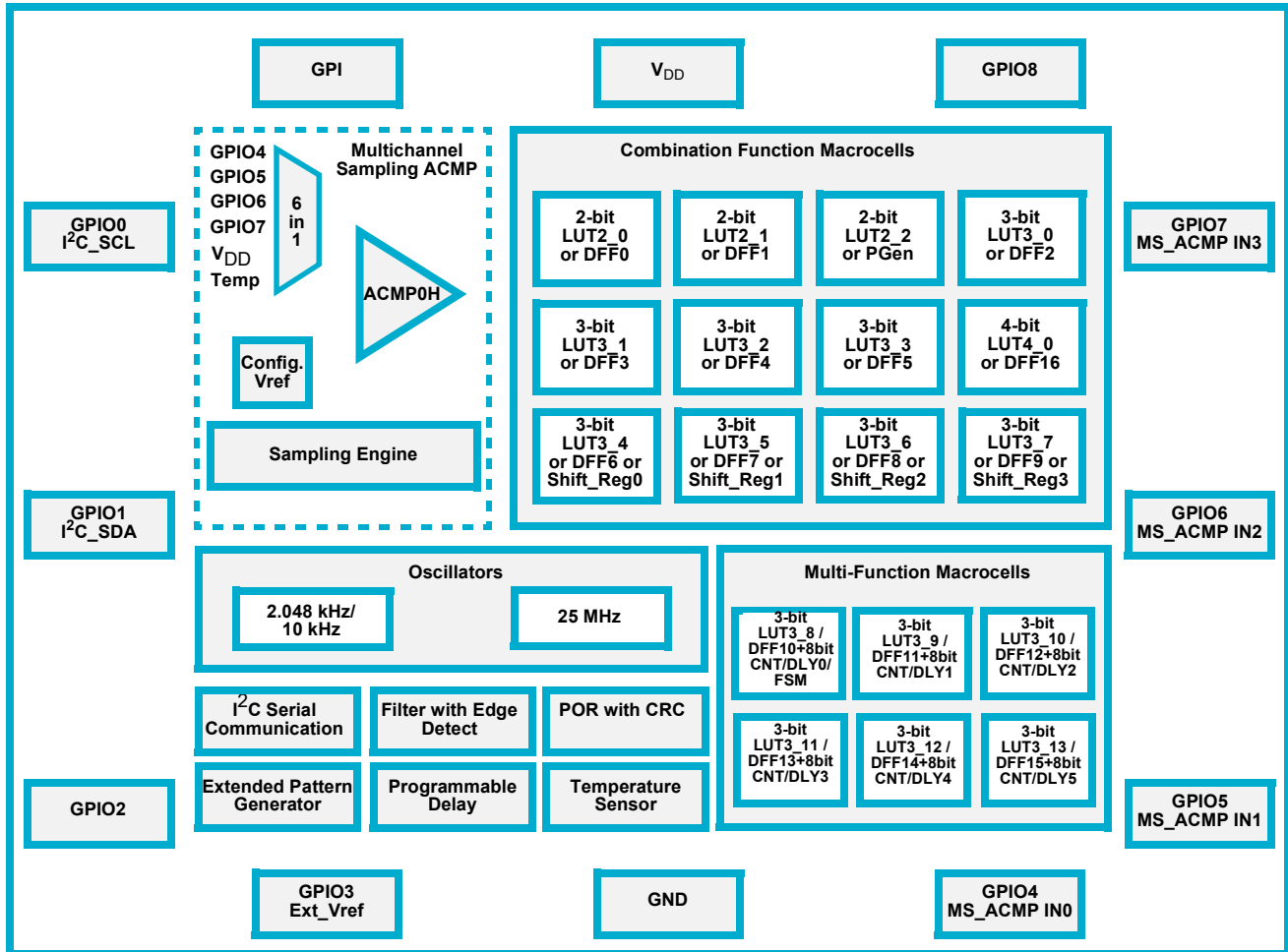


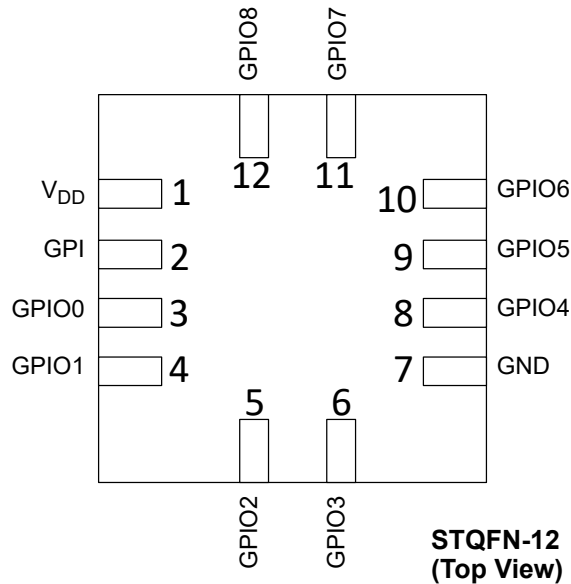
Figure 1: Block Diagram

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

2 Pinout

2.1 PIN CONFIGURATION - STQFN-12



| Pin # | Pin Name | Pin Functions |
|-------|-----------------|--|
| 1 | V _{DD} | Power Supply |
| 2 | GPI | GPI, SLA_0, EXT_CLK_OSC0 |
| 3 | GPIO0 | GPIO, I ² C SCL |
| 4 | GPIO1 | GPIO, I ² C SDA |
| 5 | GPIO2 | GPIO with OE |
| 6 | GPIO3 | GPIO with OE, SLA_1, EXT_Vref |
| 7 | GND | Ground |
| 8 | GPIO4 | GPIO, SLA_2, MS ACMP input 0 |
| 9 | GPIO5 | GPIO, MS ACMP input 1 |
| 10 | GPIO6 | GPIO, MS ACMP input 2 |
| 11 | GPIO7 | GPIO with OE, MS ACMP input 3, SLA_3, EXT_CLK_OSC1 |
| 12 | GPIO8 | GPIO with OE |

Legend:

- OE:** Output Enable
- MS ACMP input:** Multichannel Sample ACMP Positive Input
- I²C SCL:** I²C Clock Input
- I²C SDA:** I²C Data Input/Output
- EXT_CLKx:** External Clock Input
- SLA:** Slave Address

Table 1: Functional Pin Description

| STQFN 12 Pin # | Pin Name | Signal Name | Function | Input Options | Output Options |
|----------------|-----------------|---------------------------|-------------------------------------|---------------------------------------|------------------------|
| 1 | V _{DD} | V _{DD} | Power Supply | -- | -- |
| 2 | GPI | GPI | General Purpose Input | Digital Input without Schmitt Trigger | -- |
| | | | | Digital Input with Schmitt Trigger | -- |
| | | Slave Address 0 | | -- | -- |
| | | External Clock of OSC0 | External Clock Connection | -- | -- |
| 3 | GPIO0 | GPIO | General Purpose IO with OE (Note 1) | Digital Input without Schmitt Trigger | Open-Drain NMOS (3.2x) |
| | | | | Digital Input with Schmitt Trigger | |
| | | | | Low Voltage Digital Input | -- |
| | | I ² C SCL | I ² C Serial Clock | Digital Input without Schmitt Trigger | -- |
| | | | | Digital Input with Schmitt Trigger | -- |
| | | Low Voltage Digital Input | -- | | |

Table 1: Functional Pin Description (Continued)

| STQFN 12 Pin # | Pin Name | Signal Name | Function | Input Options | Output Options |
|-------------------|--------------------|--------------------------------|---|--|------------------------------|
| 4 | GPIO1 | GPIO | General Purpose IO | Digital Input without Schmitt Trigger | Open-Drain NMOS (3.2x) |
| | | | | Digital Input with Schmitt Trigger | |
| | | | | Low Voltage Digital Input | |
| | | I ² C SDA | I ² C Serial Data | Digital Input without Schmitt Trigger | -- |
| | | | | Digital Input with Schmitt Trigger | -- |
| | | | | Low Voltage Digital Input | -- |
| 5 | GPIO2 | GPIO | General Purpose IO with OE (Note 1) | Digital Input without Schmitt Trigger | Push-Pull (1x) (2x) |
| | | | | Digital Input with Schmitt Trigger | Open-Drain NMOS (1x) (2x) |
| | | | | Low Voltage Digital Input | -- |
| 6 | GPIO3 | GPIO | General Purpose IO with OE (Note 1) | Digital Input without Schmitt Trigger | Push-Pull (1x) (2x) |
| | | | | Digital Input with Schmitt Trigger | Open-Drain NMOS (1x) (2x) |
| | | | | Low Voltage Digital Input | -- |
| | | EXT_Vref | ACMP Inverting Input | Analog | -- |
| | Slave Address 1 | | -- | -- | |
| 7 | GND | GND | Power Supply | -- | -- |
| 8 | GPIO4 | GPIO | General Purpose IO | Digital Input without Schmitt Trigger | Push-Pull (1x) (2x) |
| | | | | Digital Input with Schmitt Trigger | Open-Drain NMOS (1x) (2x) |
| | | | | Low Voltage Digital Input | -- |
| | | MS_ACMP In0 | Positive Input 0 of MS ACMP | Analog | -- |
| | Slave Address 2 | | -- | -- | |
| 9 | GPIO5 | GPIO | General Purpose IO | Digital Input without Schmitt Trigger | Push-Pull (1x) (2x) |
| | | | | Digital Input with Schmitt Trigger | Open-Drain NMOS (1x) (2x) |
| | | | | Low Voltage Digital Input | -- |
| | MS ACMP In1 | Positive Input 1 of MS ACMP | Analog | -- | |
| 10 | GPIO6 | GPIO | General Purpose IO | Digital Input without Schmitt Trigger | Push-Pull (1x) (2x) |
| | | | | Digital Input with Schmitt Trigger | Open-Drain NMOS (1x) (2x) |
| | | | | Low Voltage Digital Input | -- |
| | | MS ACMP In2 | Positive Input 2 of MS ACMP | Analog | -- |

Table 1: Functional Pin Description (Continued)

| STQFN 12 Pin # | Pin Name | Signal Name | Function | Input Options | Output Options |
|-------------------|-------------|---------------------------|---|--|------------------------------|
| 11 | GPIO7 | GPIO | General Purpose IO with OE (Note 1) | Digital Input without Schmitt Trigger | Push-Pull (1x) (2x) |
| | | | | Digital Input with Schmitt Trigger | Open-Drain NMOS (1x) (2x) |
| | | | | Low Voltage Digital Input | -- |
| | | MS ACMP In 3 | Positive Input 3 of MS ACMP | Analog | -- |
| | | Slave Address 3 | | -- | -- |
| | | External Clock of OSC1 | External Clock Connection | -- | -- |
| 12 | GPIO8 | GPIO | General Purpose IO with OE (Note 1) | Digital Input without Schmitt Trigger | Push-Pull (1x) (2x) |
| | | | | Digital Input with Schmitt Trigger | Open-Drain NMOS (1x) (2x) |
| | | | | Low Voltage Digital Input | -- |

Note 1 General Purpose IO's with OE can be used to implement bidirectional signals under user control via Connection Matrix to OE signal in IO structure or as a 3-state output.

Table 2: Pin Type Definitions

| Pin Type | Description |
|-----------------|------------------------------|
| V _{DD} | Power Supply |
| GPI | General Purpose Input |
| GPIO | General Purpose Input/Output |
| GND | Ground |

3 Characteristics

3.1 ABSOLUTE MAXIMUM RATINGS

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, so functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification are not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Table 3: Absolute Maximum Ratings

| Parameter | Min | Max | Unit |
|---|--------------|------------------|------|
| Supply Voltage on V_{DD} relative to GND | -0.3 | 7 | V |
| DC Input Voltage | GND - 0.5 V | $V_{DD} + 0.5 V$ | V |
| Maximum Average or DC Current (Through V_{DD} or GND pin) | -- | 90 | mA |
| Maximum Average or DC Current (Through pin) | Push-Pull 1x | 11 | mA |
| | Push-Pull 2x | 16 | |
| | OD 1x | 11 | |
| | OD 2x | 21 | |
| Current at Input Pin | -1.0 | 1.0 | mA |
| Input Leakage Current (Absolute Value) | -- | 1000 | nA |
| Storage Temperature Range | -65 | 150 | °C |
| Junction Temperature | -- | 150 | °C |
| Moisture Sensitive Level | 1 | | |

3.2 ELECTROSTATIC DISCHARGE RATINGS

Table 4: Electrostatic Discharge Ratings

| Parameter | Min | Max | Unit |
|---------------------------------------|------|-----|------|
| ESD Protection (Human Body Model) | 2000 | -- | V |
| ESD Protection (Charged Device Model) | 1300 | -- | V |

3.3 RECOMMENDED OPERATING CONDITIONS

Table 5: Recommended Operating Conditions

| Parameter | Condition | Min | Max | Unit |
|--|--|-----|----------------|------|
| Supply Voltage (V_{DD}) | | 2.3 | 5.5 | V |
| Operating Temperature | | -40 | 85 | °C |
| Maximal Voltage Applied to any PIN in High Impedance State | | -- | $V_{DD} + 0.3$ | V |
| Capacitor Value at V_{DD} | | 0.1 | -- | μF |
| Analog Input Common Mode Range | Allowable Input Voltage at Analog Pins | 0 | V_{DD} | V |

3.4 ELECTRICAL CHARACTERISTICS
Table 6: EC at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted

| Parameter | Description | Condition | Min | Typ | Max | Unit |
|-----------------|---------------------------|--|----------------------|-----|----------------------|------|
| V _{IH} | HIGH-Level Input Voltage | Logic Input (Note 1) | 0.7x V _{DD} | -- | V _{DD} +0.3 | V |
| | | Logic Input with Schmitt Trigger (Positive Going Threshold Voltage min = 0.4xV _{DD} , max = 0.7xV _{DD}) | 0.8x V _{DD} | -- | V _{DD} +0.3 | V |
| | | Low-Level Logic Input (Note 1) | 1.25 | -- | -- | V |
| V _{IL} | LOW-Level Input Voltage | Logic Input (Note 1) | GND-0.3 | -- | 0.3x V _{DD} | V |
| | | Logic Input with Schmitt Trigger (Negative Going Threshold Voltage min = 0.3xV _{DD} , max = 0.6xV _{DD}) | GND-0.4 | -- | 0.2x V _{DD} | V |
| | | Low-Level Logic Input (Note 1) | GND-0.5 | -- | 0.5 | V |
| V _{OH} | HIGH-Level Output Voltage | Push-Pull, 1x Drive, V _{DD} = 2.5 V ± 8 %, I _{OH} = 1 mA | 2.18 | -- | -- | V |
| | | Push-Pull, 1x Drive, V _{DD} = 3.3 V ± 10 %, I _{OH} = 3 mA | 2.68 | -- | -- | V |
| | | Push-Pull, 1x Drive, V _{DD} = 5.0 V ± 10 %, I _{OH} = 5 mA | 4.16 | -- | -- | V |
| | | Push-Pull, 2x Drive, V _{DD} = 2.5 V ± 8 %, I _{OH} = 1 mA | 2.24 | -- | -- | V |
| | | Push-Pull, 2x Drive, V _{DD} = 3.3 V ± 10 %, I _{OH} = 3 mA | 2.83 | -- | -- | V |
| | | Push-Pull, 2x Drive, V _{DD} = 5.0 V ± 10 %, I _{OH} = 5 mA | 4.33 | -- | -- | V |
| V _{OL} | LOW-Level Output Voltage | Push-Pull, 1x Drive, V _{DD} = 2.5 V ± 8 %, I _{OL} = 1 mA | -- | -- | 0.092 | V |
| | | Push-Pull, 1x Drive, V _{DD} = 3.3 V ± 10 %, I _{OL} = 3 mA | -- | -- | 0.227 | V |
| | | Push-Pull, 1x Drive, V _{DD} = 5.0 V ± 10 %, I _{OL} = 5 mA | -- | -- | 0.283 | V |
| | | Push-Pull, 2x Drive, V _{DD} = 2.5 V ± 8 %, I _{OL} = 1 mA | -- | -- | 0.045 | V |
| | | Push-Pull, 2x Drive, V _{DD} = 3.3 V ± 10 %, I _{OL} = 3 mA | -- | -- | 0.111 | V |
| | | Push-Pull, 2x Drive, V _{DD} = 5.0 V ± 10 %, I _{OL} = 5 mA | -- | -- | 0.140 | V |
| | | NMOS OD, 1x Drive, V _{DD} = 2.5 V ± 8 %, I _{OL} = 1 mA | -- | -- | 0.036 | V |
| | | NMOS OD, 1x Drive, V _{DD} = 3.3 V ± 10 %, I _{OL} = 3 mA | -- | -- | 0.089 | V |

Table 6: EC at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted (Continued)

| Parameter | Description | Condition | Min | Typ | Max | Unit |
|--------------------|--|--|--------|------|-------|------|
| V _{OL} | LOW-Level Output Voltage | NMOS OD, 1x Drive, V _{DD} = 5.0 V ± 10 %, I _{OL} = 5 mA | -- | -- | 0.112 | V |
| | | NMOS OD, 2x Drive, V _{DD} = 2.5 V ± 8 %, I _{OL} = 1 mA | -- | -- | 0.018 | V |
| | | NMOS OD, 2x Drive, V _{DD} = 3.3 V ± 10 %, I _{OL} = 3 mA | -- | -- | 0.046 | V |
| | | NMOS OD, 2x Drive, V _{DD} = 5.0 V ± 10 %, I _{OL} = 5 mA | -- | -- | 0.059 | V |
| I _{OH} | HIGH-Level Output Pulse Current (Note 2) | Push-Pull, 1x Drive, V _{DD} = 2.5 V ± 8 %, V _{OH} = V _{DD} - 0.2 | 1.520 | -- | -- | mA |
| | | Push-Pull, 1x Drive, V _{DD} = 3.3 V ± 10 %, V _{OH} = 2.4 V | 5.125 | -- | -- | mA |
| | | Push-Pull, 1x Drive, V _{DD} = 5.0 V ± 10 %, V _{OH} = 2.4 V | 19.589 | -- | -- | mA |
| | | Push-Pull, 2x Drive, V _{DD} = 2.5 V ± 8 %, V _{OH} = V _{DD} - 0.2 | 3.008 | -- | -- | mA |
| | | Push-Pull, 2x Drive, V _{DD} = 3.3 V ± 10 %, V _{OH} = 2.4 V | 10.106 | -- | -- | mA |
| | | Push-Pull, 2x Drive, V _{DD} = 5.0 V ± 10 %, V _{OH} = 2.4 V | 37.960 | -- | -- | mA |
| I _{OL} | LOW-Level Output Pulse Current (Note 2) | Push-Pull, 1x Drive, V _{DD} = 2.5 V ± 8 %, V _{OL} = 0.15 V | 1.483 | -- | -- | mA |
| | | Push-Pull, 1x Drive, V _{DD} = 3.3 V ± 10 %, V _{OL} = 0.4 V | 4.622 | -- | -- | mA |
| | | Push-Pull, 1x Drive, V _{DD} = 5.0 V ± 10 %, V _{OL} = 0.4 V | 6.250 | -- | -- | mA |
| | | Push-Pull, 2x Drive, V _{DD} = 2.5 V ± 8 %, V _{OL} = 0.15 V | 2.965 | -- | -- | mA |
| | | Push-Pull, 2x Drive, V _{DD} = 3.3 V ± 10 %, V _{OL} = 0.4 V | 9.228 | -- | -- | mA |
| | | Push-Pull, 2x Drive, V _{DD} = 5.0 V ± 10 %, V _{OL} = 0.4 V | 12.443 | -- | -- | mA |
| | | NMOS OD, 1x Drive, V _{DD} = 2.5 V ± 8 %, V _{OL} = 0.15 V | 3.676 | -- | -- | mA |
| | | NMOS OD, 1x Drive, V _{DD} = 3.3 V ± 10 %, V _{OL} = 0.4 V | 11.438 | -- | -- | mA |
| | | NMOS OD, 1x Drive, V _{DD} = 5.0 V ± 10 %, V _{OL} = 0.4 V | 15.397 | -- | -- | mA |
| | | NMOS OD, 2x Drive, V _{DD} = 2.5 V ± 8 %, V _{OL} = 0.15 V | 7.285 | -- | -- | mA |
| | | NMOS OD, 2x Drive, V _{DD} = 3.3 V ± 10 %, V _{OL} = 0.4 V | 22.589 | -- | -- | mA |
| | | NMOS OD, 2x Drive, V _{DD} = 5.0 V ± 10 %, V _{OL} = 0.4 V | 30.030 | -- | -- | mA |
| T _{SU} | Startup Time | T _{RAMP} = 1 V/μs, From V _{DD} rising past PON _{THR} | -- | 1.85 | 3.42 | ms |
| PON _{THR} | Power-On Threshold | V _{DD} Level Required to Start Up the Chip | 1.55 | 1.86 | 2.17 | V |

Table 6: EC at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted (Continued)

| Parameter | Description | Condition | Min | Typ | Max | Unit |
|---------------------|---------------------------------|--|------|------|------|------|
| POFF _{THR} | Power-Off Threshold | V _{DD} Level Required to Switch Off the Chip | 1.06 | 1.34 | 1.62 | V |
| R _{PULL} | Pull-up or Pull-down Resistance | 1 M for Pull-up: V _{IN} = GND; for Pull-down: V _{IN} = V _{DD} | -- | 1 | -- | MΩ |
| | | 100 k for Pull-up: V _{IN} = GND for Pull-down: V _{IN} = V _{DD} | -- | 100 | -- | kΩ |
| | | 10 k For Pull-up: V _{IN} = GND for Pull-down: V _{IN} = V _{DD} | -- | 10 | -- | kΩ |
| C _{IN} | Input Capacitance | T = 25 °C | | 2.4 | | pF |

Note 1 No hysteresis.
Note 2 DC or average current through any pin should not exceed value given in Absolute Maximum Conditions.

3.5 I²C PINS ELECTRICAL CHARACTERISTICS

Table 7: EC of SDA and SCL Pins, DI Mode, at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted

| Parameter | Description | Condition | Fast-Mode | | Fast-Mode Plus | | Unit |
|------------------|---|--|-----------------------------|---------------------|-----------------------------|---------------------|------|
| | | | Min | Max | Min | Max | |
| V _{IL} | LOW-level Input Voltage | | -0.5 | 0.3xV _{DD} | -0.5 | 0.3xV _{DD} | V |
| V _{IH} | HIGH-level Input Voltage | | 0.7xV _{DD} | 5.5 | 0.7xV _{DD} | 5.5 | V |
| V _{HYS} | Hysteresis of Schmitt Trigger Inputs | | 0.05xV _{DD} | -- | 0.05xV _{DD} | -- | V |
| V _{OL1} | LOW-Level Output Voltage 1 | (Open-Drain or open collector) at 3 mA sink current V _{DD} > 2 V | 0 | 0.4 | 0 | 0.4 | V |
| V _{OL2} | LOW-Level Output Voltage 2 | (Open-Drain or open collector) at 2 mA sink current V _{DD} ≤ 2 V | 0 | 0.2xV _{DD} | 0 | 0.2xV _{DD} | V |
| I _{OL} | LOW-Level Output Current | V _{OL} = 0.4 V, V _{DD} = 2.3 V | 3 | -- | 20 | -- | mA |
| | | V _{OL} = 0.4 V, V _{DD} = 3.3 V | 3 | -- | 20 | -- | mA |
| | | V _{OL} = 0.4 V, V _{DD} = 4.5 V | 3 | -- | 20 | -- | mA |
| | | V _{OL} = 0.6 V, V _{DD} = 5.5 V | 6 | -- | -- | -- | mA |
| t _{of} | Output Fall Time from V _{IHmin} to V _{ILmax} (Note 1) | | 14x (V _{DD} /5.5V) | 250 | 10x (V _{DD} /5.5V) | 120 | ns |
| t _{SP} | Input Filter Spike Suppression | Digital Input (SDA) | 50 | -- | 50 | -- | ns |
| | | Digital Input (SCL) | 50 | -- | 50 | -- | ns |
| I _i | Input Current each IO Pin | 0.1xV _{DD} < V _I < 0.9xV _{DDmax} | -10 | +10 | -10 | +10 | μA |
| C _i | Capacitance for each IO Pin | | -- | 10 | -- | 10 | pF |

Note 1 Does not meet standard I²C specifications: t_{of} = 20x(V_{DD}/5.5V) (min).
Note 2 For Fast-mode Plus SDA pin must be configured as NMOS 3.2x Open-Drain, see register [613] in section 18.

Table 8: EC of SDA and SCL Pins, DILV Mode, at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted

| Parameter | Description | Condition | Fast-Mode | | Unit |
|------------------|---|--|--------------------------------|---------------------|------|
| | | | Min | Max | |
| V _{IL} | LOW-level Input Voltage (Note 1) | | -- | 0.7 | V |
| V _{IH} | HIGH-level Input Voltage (Note 1) | | 1.25 | -- | V |
| V _{HYS} | Hysteresis of Schmitt Trigger Inputs | | 0.05xV _{DD} | -- | V |
| V _{OL1} | LOW-Level Output Voltage 1 | (Open-Drain or open collector) at 3 mA sink current, V _{DD} > 2 V | 0 | 0.4 | V |
| V _{OL2} | LOW-Level Output Voltage 2 | (Open-Drain or open collector) at 2 mA sink current, V _{DD} ≤ 2 V | 0 | 0.2xV _{DD} | V |
| I _{OL} | LOW-Level Output Current | V _{OL} = 0.4 V, V _{DD} = 2.3 V | 3 | -- | mA |
| | | V _{OL} = 0.4 V, V _{DD} = 3.3 V | 3 | -- | mA |
| | | V _{OL} = 0.4 V, V _{DD} = 4.5 V | 3 | -- | mA |
| | | V _{OL} = 0.6 V, V _{DD} = 5.5 V | 6 | -- | mA |
| t _{of} | Output Fall Time from V _{IHmin} to V _{ILmax} (Note 1) | | 14x (V _{DD} /5.5V) | 250 | ns |
| t _{SP} | Input Filter Spike Suppression (SCL, SDA) | Digital Input LOW Voltage (SDA) | 50 | -- | ns |
| | | Digital Input LOW Voltage (SCL) | 50 | -- | ns |
| I _i | Input Current each IO Pin | 0.1xV _{DD} < V _I < 0.9xV _{DDmax} | -10 | +10 | μA |
| C _i | Capacitance for each IO Pin | | -- | 10 | pF |

Note 1 Does not meet standard I²C specifications: V_{IL} = 0.3xV_{DD} (max); V_{IH} = 0.7xV_{DD} (min); t_{of} = 20x(V_{DD}/5.5V) (min).

Table 9: I²C Bus Timing Characteristics, DI Mode, at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted

| Parameter | Description | Condition | Speed | | | | Unit |
|---------------------|--------------------------------------|-----------|---------|-----|-------|------|------|
| | | | 400 kHz | | 1 MHz | | |
| | | | Min | Max | Min | Max | |
| F _{SCL} | Clock Frequency, SCL | | -- | 400 | -- | 1000 | kHz |
| t _{LOW} | Clock Pulse Width Low | | 1300 | -- | 500 | -- | ns |
| t _{HIGH} | Clock Pulse Width High | | 600 | -- | 260 | -- | ns |
| t _{BUF} | Bus Free Time between Stop and Start | | 1300 | -- | 500 | -- | ns |
| t _{HD_STA} | Start Hold Time | | 600 | -- | 260 | -- | ns |
| t _{SU_STA} | Start Set-up Time | | 600 | -- | 260 | -- | ns |
| t _{HD_DAT} | Data Hold Time | | 0 | -- | 0 | -- | ns |
| t _{SU_DAT} | Data Set-up Time | | 100 | -- | 50 | -- | ns |
| t _R | Inputs Rise Time | | -- | 300 | -- | 120 | ns |
| t _F | Inputs Fall Time | | -- | 300 | -- | 120 | ns |
| t _{SU_STO} | Stop Set-up Time | | 600 | -- | 260 | -- | ns |
| t _{VD_ACK} | Data Out Hold Time | | 50 | -- | 50 | -- | ns |
| t _{VD_DAT} | Clock Low to Data Out Valid | | -- | 900 | -- | 450 | ns |

Table 9: I²C Bus Timing Characteristics, DI Mode, at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted

| Parameter | Description | Condition | Speed | | | | Unit |
|---|-------------|-----------|---------|-----|-------|-----|------|
| | | | 400 kHz | | 1 MHz | | |
| | | | Min | Max | Min | Max | |
| Note 1 Timing diagram can be found in the Figure 84 . Note 2 Please follow official I ² C spec UM10204. | | | | | | | |

Table 10: I²C Bus Timing Characteristics, DILV Mode, at T = -40°C to +85°C, V_{DD} = 2.3V to 5.5V Unless Otherwise Noted

| Parameter | Description | Condition | Speed | | Unit |
|---|--------------------------------------|-----------|---------|-----|------|
| | | | 400 kHz | | |
| | | | Min | Max | |
| F _{SCL} | Clock Frequency, SCL | | -- | 400 | kHz |
| t _{LOW} | Clock Pulse Width Low | | 1300 | -- | ns |
| t _{HIGH} | Clock Pulse Width High | | 600 | -- | ns |
| t _{BUF} | Bus Free Time between Stop and Start | | 1300 | -- | ns |
| t _{HD_STA} | Start Hold Time | | 600 | -- | ns |
| t _{SU_STA} | Start Set-up Time | | 600 | -- | ns |
| t _{HD_DAT} | Data Hold Time (Note 1) | | 264 | -- | ns |
| t _{SU_DAT} | Data Set-up Time (Note 1) | | 382 | -- | ns |
| t _R | Inputs Rise Time | | -- | 300 | ns |
| t _F | Inputs Fall Time | | -- | 300 | ns |
| t _{SU_STO} | Stop Set-up Time | | 600 | -- | ns |
| t _{VD_ACK} | Data Out Hold Time | | 50 | -- | ns |
| t _{VD_DAT} | Clock Low to Data Out Valid | | -- | 900 | ns |
| Note 1 Does not meet standard I ² C specifications: t _{HD_DAT} = 0 ns, t _{SU_DAT} = 100 ns. Note 2 Please follow official I ² C spec UM10204. Note 3 When SCL Input is in Low-Level Logic mode max frequency is 400 kHz. Note 4 Timing diagram can be found in the Figure 84 . | | | | | |

3.6 MACROCELLS CURRENT CONSUMPTION
Table 11: Typical Current Estimated for Each Macrocell at T = -40 °C to +85 °C

| Parameter | Description | Note | V _{DD} = 2.5 V | V _{DD} = 3.3 V | V _{DD} = 5.0 V | Unit |
|--|-------------|--|-------------------------|-------------------------|-------------------------|------|
| I _{DD} | Current | PDET+I ² C | 0.06 | 0.08 | 0.13 | μA |
| | | PDET+BG+I ² C | 0.38 | 0.41 | 0.49 | μA |
| | | Temperature Sensor Output | 15.06 | 15.14 | 15.48 | μA |
| | | OSC2 25 MHz, Pre-divider = 1 | 82.44 | 106.46 | 162.02 | μA |
| | | OSC2 25 MHz, Pre-divider = 4 | 45.97 | 57.00 | 83.21 | μA |
| | | OSC2 25 MHz, Pre-divider = 8 | 39.62 | 48.35 | 69.35 | μA |
| | | OSC0 2.048 kHz, Pre-divider = 1 | 0.33 | 0.36 | 0.44 | μA |
| | | OSC0 2.048 kHz, Pre-divider = 4 | 0.33 | 0.36 | 0.44 | μA |
| | | OSC0 2.048 kHz, Pre-divider = 8 | 0.33 | 0.36 | 0.44 | μA |
| | | OSC0 10 kHz, Pre-divider = 1 | 0.45 | 0.49 | 0.60 | μA |
| | | OSC0 10 kHz, Pre-divider = 4 | 0.44 | 0.48 | 0.57 | μA |
| | | OSC0 10 kHz, Pre-divider = 8 | 0.44 | 0.47 | 0.56 | μA |
| | | MS ACMP in regular mode (Vref Source - External V _{IN+} = 0 V, V _{IN-} = 32 mV), level sensitive | 14.44 | 14.83 | 15.95 | μA |
| | | MS ACMP in regular mode (Vref Source - Internal V _{IN+} = 0 V; V _{IN-} = 32 mV), level sensitive | 21.56 | 21.97 | 23.21 | μA |
| | | MS ACMP in regular mode (Vref Source - Internal V _{IN+} = 1 M Pull-up V _{IN-} = 32 mV), level sensitive | 35.40 | 36.11 | 38.18 | μA |
| MS ACMP in continuous sampling mode, four channels, V _{IN+} = 2.048 mV, V _{IN-} = 32 mV, 10 kHz oscillator clock (average consumption), level sensitive | 35.78 | 36.47 | 38.57 | μA | | |

3.7 TIMING CHARACTERISTICS
Table 12: Typical Delay Estimated for Each Macrocell at T = 25 °C

| Parameter | Description | Note | V _{DD} = 2.5 V | | V _{DD} = 3.3 V | | V _{DD} = 5 V | | Unit |
|-----------|-------------|---|-------------------------|---------|-------------------------|---------|-----------------------|---------|------|
| | | | Rising | Falling | Rising | Falling | Rising | Falling | |
| tpd | Delay | Digital Input to PP 1x | 31 | 32 | 22 | 24 | 17 | 18 | ns |
| tpd | Delay | Digital Input to PP 2x | 30 | 32 | 21 | 23 | 16 | 17 | ns |
| tpd | Delay | Digital Input with Schmitt Trigger to PP 1x | 31 | 32 | 22 | 24 | 17 | 18 | ns |
| tpd | Delay | Low Voltage Digital Input to PP 1x | 33 | 270 | 24 | 178 | 19 | 104 | ns |
| tpd | Delay | Digital input to NMOS 1x | -- | 31 | -- | 22 | -- | 17 | ns |
| tpd | Delay | Digital input to NMOS 2x | -- | 30 | -- | 22 | -- | 16 | ns |
| tpd | Delay | Output enable from Pin, OE Hi-Z to 1 | 28 | -- | 20 | -- | 15 | -- | ns |
| tpd | Delay | Output enable from Pin, OE Hi-Z to 0 | -- | 27 | -- | 20 | -- | 15 | ns |
| tpd | Delay | 1x3 State Hi-Z to 1 | 28 | -- | 20 | -- | 15 | -- | ns |
| tpd | Delay | 1x3 State Hi-Z to 0 | -- | 27 | -- | 20 | -- | 15 | ns |
| tpd | Delay | 2x3 State Hi-Z to 1 | 27 | -- | 19 | -- | 15 | -- | ns |

Table 12: Typical Delay Estimated for Each Macrocell at T = 25 °C (Continued)

| Parameter | Description | Note | V _{DD} = 2.5 V | | V _{DD} = 3.3 V | | V _{DD} = 5 V | | Unit |
|-----------|-------------|-----------------------------|-------------------------|---------|-------------------------|---------|-----------------------|---------|------|
| | | | Rising | Falling | Rising | Falling | Rising | Falling | |
| tpd | Delay | 2x3 State Hi-Z to 0 | -- | 26 | -- | 19 | -- | 14 | ns |
| tpd | Delay | LATCH Q | 15 | 16 | 12 | 11 | 8 | 8 | ns |
| tpd | Delay | LATCH nQ | 16 | 16 | 11 | 12 | 9 | 8 | ns |
| tpd | Delay | LATCH nRESET High Q | 23 | 24 | 16 | 18 | 12 | 12 | ns |
| tpd | Delay | LATCH nRESET High nQ | 23 | 25 | 17 | 18 | 12 | 12 | ns |
| tpd | Delay | LATCH nRESET Low Q | 23 | 24 | 16 | 17 | 12 | 12 | ns |
| tpd | Delay | LATCH nRESET Low nQ | 23 | 24 | 16 | 18 | 12 | 12 | ns |
| tpd | Delay | LATCH nSET High Q | 21 | 23 | 15 | 16 | 11 | 11 | ns |
| tpd | Delay | LATCH nSET High nQ | 22 | 22 | 15 | 17 | 11 | 11 | ns |
| tpd | Delay | LATCH nSET Low Q | 21 | 22 | 14 | 16 | 10 | 11 | ns |
| tpd | Delay | LATCH nSET Low nQ | 21 | 22 | 16 | 15 | 11 | 11 | ns |
| tpd | Delay | 2-bit LUT | 13 | 13 | 10 | 10 | 7 | 7 | ns |
| tpd | Delay | 3-bit LUT | 19 | 21 | 15 | 14 | 11 | 10 | ns |
| tpd | Delay | 4-bit LUT | 18 | 20 | 13 | 14 | 9 | 10 | ns |
| tpd | Delay | Shift Register Transition | 70 | 71 | 49 | 50 | 32 | 32 | ns |
| tpd | Delay | Shift Register Reset | 26 | 25 | 19 | 18 | 13 | 13 | ns |
| tpd | Delay | Edge detect | 18 | 18 | 13 | 13 | 9 | 9 | ns |
| tw | Width | Edge detect | 212 | 212 | 157 | 157 | 113 | 114 | ns |
| tpd | Delay | Edge detect Delayed | 230 | 232 | 169 | 170 | 122 | 122 | ns |
| tpd | Delay | DFF Q | 15 | 17 | 11 | 13 | 8 | 9 | ns |
| tpd | Delay | DFF nQ | 16 | 17 | 12 | 13 | 8 | 9 | ns |
| tpd | Delay | DFF nRESET High Q | -- | 23 | -- | 17 | -- | 12 | ns |
| tpd | Delay | DFF nRESET High nQ | 22 | -- | 16 | -- | 11 | -- | ns |
| tpd | Delay | DFF nRESET Low Q | -- | 23 | -- | 16 | -- | 12 | ns |
| tpd | Delay | DFF nRESET Low nQ | 22 | -- | 15 | -- | 11 | -- | ns |
| tpd | Delay | DFF nSET High Q | 22 | -- | 16 | -- | 11 | -- | ns |
| tpd | Delay | DFF nSET High nQ | -- | 23 | -- | 17 | -- | 12 | ns |
| tpd | Delay | DFF nSET Low Q | 22 | -- | 15 | -- | 11 | -- | ns |
| tpd | Delay | DFF nSET Low nQ | -- | 23 | -- | 17 | -- | 12 | ns |
| tpd | Delay | CNT/DLY | 81 | 79 | 59 | 70 | 43 | 70 | ns |
| tpd | Delay | PGen CLK | 18 | 16 | 14 | 12 | 9 | 9 | ns |
| tpd | Delay | PGen nRESET Z to 0 | -- | 19 | -- | 14 | -- | 10 | ns |
| tpd | Delay | PGen nRESET Z to 1 | 18 | -- | 13 | -- | 9 | -- | ns |
| tpd | Delay | Extended PGen CLK | 488 | 488 | 487 | 487 | 493 | 495 | ns |
| tpd | Delay | Extended PGen nRESET Z to 0 | -- | 67 | -- | 48 | -- | 35 | ns |
| tpd | Delay | Extended PGen nRESET Z to 1 | 68 | -- | 48 | -- | 33 | -- | ns |
| tpd | Delay | Filter Q, nQ | 122 | 125 | 93 | 95 | 68 | 69 | ns |

Table 13: Programmable Delay Expected Delays and Widths (Typical) at T = 25 °C

| Parameter | Description | Note | V _{DD} = 2.5 V | V _{DD} = 3.3 V | V _{DD} = 5.0 V | Unit |
|-----------|---------------------|---|-------------------------|-------------------------|-------------------------|------|
| tw | Pulse Width, 1 cell | mode: (any) edge detect, edge detect output | 216 | 160 | 115 | ns |
| tw | Pulse Width, 2 cell | mode: (any) edge detect, edge detect output | 427 | 316 | 228 | ns |
| tw | Pulse Width, 3 cell | mode: (any) edge detect, edge detect output | 638 | 471 | 341 | ns |
| tw | Pulse Width, 4 cell | mode: (any) edge detect, edge detect output | 850 | 627 | 453 | ns |
| time1 | Delay, 1 cell | mode: (any) edge detect, edge detect output | 18 | 13 | 9 | ns |
| time1 | Delay, 2 cell | mode: (any) edge detect, edge detect output | 18 | 13 | 9 | ns |
| time1 | Delay, 3 cell | mode: (any) edge detect, edge detect output | 18 | 13 | 9 | ns |
| time1 | Delay, 4 cell | mode: (any) edge detect, edge detect output | 18 | 13 | 9 | ns |
| time2 | Delay, 1 cell | mode: both edge delay, edge detect output | 234 | 172 | 124 | ns |
| time2 | Delay, 2 cell | mode: both edge delay, edge detect output | 446 | 328 | 237 | ns |
| time2 | Delay, 3 cell | mode: both edge delay, edge detect output | 656 | 483 | 350 | ns |
| time2 | Delay, 4 cell | mode: both edge delay, edge detect output | 866 | 639 | 461 | ns |

Table 14: Typical Filter Rejection Pulse Width at T = 25 °C

| Parameter | V _{DD} = 2.5 V | V _{DD} = 3.3 V | V _{DD} = 5.0 V | Unit |
|--|-------------------------|-------------------------|-------------------------|------|
| Filtered Pulse Width, t _{block} | < 63 | < 49 | < 37 | ns |

3.8 COUNTER/DELAY CHARACTERISTICS

Table 15: Typical Counter/Delay Offset at T = 25 °C

| Parameter | RC OSC Freq | RC OSC Power | V _{DD} = 2.5 V | V _{DD} = 3.3 V | V _{DD} = 5.0 V | Unit |
|--|---------------------------------|--------------|-------------------------|-------------------------|-------------------------|----------------|
| Power-On time | 25 MHz | auto | 0.055 | 0.04 | 0.025 | μs |
| Power-On time | 2.048 kHz | auto | 695 | 575 | 480 | μs |
| Power-On time | 10 kHz | auto | 695 | 575 | 480 | μs |
| Frequency Settling Time | 25 MHz | auto | 10 | 10 | 10 | Stabilized Clk |
| Frequency Settling Time | 2.048 kHz | auto | 1 | 1 | 1 | Stabilized Clk |
| Frequency Settling Time | 10 kHz | auto | 5 | 5 | 5 | Stabilized Clk |
| Variable (CLK period) | 25 MHz | forced | 0-40 | 0-40 | 0-40 | ns |
| Variable (CLK period) | 2.048 kHz | forced | 0-488 | 0-488 | 0-488 | μs |
| Variable (CLK period) | 10 kHz | forced | 0-100 | 0-100 | 0-100 | μs |
| Typical Propagation Delay (non-delayed edge) | 25 MHz/ 2.048 kHz/ 10 kHz | either | 35 | 25 | 18 | ns |

3.9 OSCILLATOR CHARACTERISTICS
Table 16: Oscillators Frequency Limits, $V_{DD} = 2.3\text{ V to }5.5\text{ V}$

| Parameter | Temperature Range | | | | | |
|----------------|--------------------|--------------------|----------|--------------------|--------------------|----------|
| | +25 °C | | | -40 °C to +85 °C | | |
| | Minimum Value, kHz | Maximum Value, kHz | Error, % | Minimum Value, kHz | Maximum Value, kHz | Error, % |
| 2.048 kHz OSC0 | 2.015 | 2.081 | +1.6 | 1.900 | 2.099 | +2.5 |
| | | | -1.6 | | | -7.2 |
| 10 kHz OSC0 | 9.84 | 10.16 | +1.6 | 9.46 | 10.16 | +1.6 |
| | | | -1.6 | | | -5.4 |
| 25 MHz OSC1 | 24600 | 25400 | +1.6 | 24000 | 25400 | +1.6 |
| | | | -1.6 | | | -4.0 |

3.9.1 OSC Power-On Delay
Table 17: Oscillators Power-On Delay at $T = -40\text{ °C to }+85\text{ °C}$, OSC Power Setting: "Auto Power-On"

| Power Supply Range (V_{DD}), V | OSC0 2.048 kHz | | OSC0 10 kHz | | OSC1 25 MHz | | OSC1 25 MHz Start with Delay | |
|------------------------------------|------------------------------|------------------------------|------------------------------|------------------------------|-------------------|-------------------|------------------------------|-------------------|
| | Typical Value, μs | Maximum Value, μs | Typical Value, μs | Maximum Value, μs | Typical Value, ns | Maximum Value, ns | Typical Value, ns | Maximum Value, ns |
| 2.30 | 725 | 1098 | 725 | 1101 | 60 | 77 | 150 | 163 |
| 3.30 | 577 | 815 | 577 | 816 | 37 | 51 | 142 | 159 |
| 4.00 | 528 | 714 | 528 | 716 | 31 | 44 | 141 | 160 |
| 5.00 | 483 | 623 | 483 | 624 | 26 | 38 | 140 | 161 |
| 5.50 | 459 | 581 | 459 | 582 | 24 | 41 | 140 | 161 |

3.10 MS ACMP CHARACTERISTICS
Table 18: MS ACMP Specifications at $T = -40\text{ °C to }+85\text{ °C}$, $V_{DD} = 2.3\text{ V to }5.5\text{ V}$ Unless Otherwise Noted

| Parameter | Description | Note | Condition | Min | Typ | Max | Unit |
|--------------|-----------------------------|--|-------------------------|------|------|----------|------|
| V_{ACMP} | MS ACMP Input Voltage Range | Positive Input | | 0 | -- | V_{DD} | V |
| | | Negative Input | | 0 | -- | V_{DD} | V |
| V_{offset} | MS ACMP Input Offset | MS ACMP $V_{hys} = 0\text{ mV}$, Gain = 1, $V_{ref} = 32\text{ mV to }2016\text{ mV}$ (regular mode) | | -6.7 | -0.6 | 5.2 | mV |
| | | MS ACMP $V_{hys} = 0\text{ mV}$, Gain = 1, $V_{ref} = 32\text{ mV to }2016\text{ mV}$ (sampling mode) | | -4.3 | 1.1 | 7.2 | mV |
| I_{LKG} | ACMP Input Leakage | $V_{IN} = V_{DD}$ | $V_{DD} = 2.3\text{ V}$ | -- | 1.5 | 6.0 | nA |
| | | | $V_{DD} = 3.3\text{ V}$ | -- | 1.5 | 6.0 | nA |
| | | | $V_{DD} = 5.5\text{ V}$ | -- | 1.5 | 6.0 | nA |

Table 18: MS ACMP Specifications at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted (Continued)

| Parameter | Description | Note | Condition | Min | Typ | Max | Unit |
|--------------------|------------------------------|---|-------------------------------------|--------|--------|--------|------|
| t _{start} | ACMP Startup Time | MS ACMP Power-On delay (regular mode) | | -- | -- | 70.8 | μs |
| | | MS ACMP Power-On delay (sampling mode), OSC0 = 10 kHz | Bandgap: Forced On, OSC0: Forced On | -- | -- | 0.56 | ms |
| | | MS ACMP Power-On delay (sampling mode), OSC0 = 10 kHz | Bandgap: Auto-On, OSC0: Auto-On | -- | -- | 2.66 | ms |
| | | MS ACMP Power-On delay (sampling mode), OSC0 = 10 kHz | Bandgap: Forced On, OSC0: Auto-On | -- | -- | 1.23 | ms |
| | | MS ACMP Power-On delay (sampling mode), OSC0 = 10 kHz | Bandgap: Auto-On, OSC0: Forced On | -- | -- | 2.59 | ms |
| V _{HYS} | Built-in Hysteresis (Note 1) | V _{HYS} = 32 mV (sampling mode) (Note 2) | T = 25 °C | 23.36 | 30.22 | 34.83 | mV |
| | | V _{HYS} = 64 mV (regular mode) | T = 25 °C | 55.62 | 61.57 | 65.58 | mV |
| | | V _{HYS} = 64 mV (sampling mode) | | 55.01 | 62.16 | 66.64 | mV |
| | | V _{HYS} = 192 mV (regular mode) | T = 25 °C | 182.69 | 189.56 | 193.88 | mV |
| | | V _{HYS} = 192 mV (sampling mode) | | 182.08 | 190.14 | 195.22 | mV |
| | | V _{HYS} = 32 mV (sampling mode) (Note 2) | | 21.08 | 30.22 | 37.44 | mV |
| | | V _{HYS} = 64 mV (regular mode) | | 52.29 | 61.57 | 67.63 | mV |
| | | V _{HYS} = 64 mV (sampling mode) | | 52.24 | 62.16 | 69.77 | mV |
| | | V _{HYS} = 192 mV (regular mode) | | 178.95 | 189.56 | 195.75 | mV |
| | | V _{HYS} = 192 mV (sampling mode) | | 179.54 | 190.14 | 198.71 | mV |
| R _{sin} | Series Input Resistance | Gain = 1x | | -- | 10 | -- | GΩ |
| | | Gain = 0.5x | | 1.6 | 1.9 | 2.4 | MΩ |
| | | Gain = 0.33x | | 1.6 | 1.9 | 2.4 | MΩ |
| | | Gain = 0.25x | | 1.6 | 1.9 | 2.4 | MΩ |

Table 18: MS ACMP Specifications at T = -40 °C to +85 °C, V_{DD} = 2.3 V to 5.5 V Unless Otherwise Noted (Continued)

| Parameter | Description | Note | Condition | Min | Typ | Max | Unit |
|---|----------------------------------|--|-------------|-------|-------|-------|------|
| PROP | Propagation Delay, Response Time | Gain = 1, Vref = 32 mV to 2016 mV, Overdrive = 10 mV, regular mode | Low to High | 0.35 | 1.05 | 4.01 | μs |
| | | | High to Low | 0.53 | 1.45 | 3.30 | μs |
| | | Gain = 1, T = 25 °C, Vref = 32 mV to 2016 mV, Overdrive = 10 mV, regular mode | Low to High | 0.56 | 1.05 | 2.49 | μs |
| | | | High to Low | 0.69 | 1.45 | 2.42 | μs |
| | | Gain = 0.25, T = 25 °C, Vref = 32 mV, Overdrive = 10 mV, regular mode | Low to High | 1.18 | 1.50 | 1.75 | μs |
| | | | High to Low | 2.23 | 2.49 | 2.84 | μs |
| | | Gain = 1, T = 25 °C, Vref = 32 mV to 2016 mV, Overdrive = 100 mV, regular mode | Low to High | 0.23 | 0.34 | 0.48 | μs |
| | | | High to Low | 0.27 | 0.39 | 0.65 | μs |
| Gain = 0.25, T = 25 °C, Vref = 32 mV, Overdrive = 100 mV, regular mode | Low to High | 0.46 | 0.56 | 0.65 | μs | | |
| | High to Low | 1.33 | 1.48 | 1.70 | μs | | |
| G | Gain error | G = 1 | | 1 | 1 | 1 | |
| | | G = 0.5 | | 0.498 | 0.500 | 0.503 | |
| | | G = 0.33 | | 0.332 | 0.334 | 0.337 | |
| | | G = 0.25 | | 0.249 | 0.251 | 0.253 | |
| Vref | Vref Accuracy, Vref = 2016 mV | | T = 25 °C | -0.43 | -0.10 | 0.21 | % |
| | | | | -0.82 | -0.10 | 0.24 | % |
| Note 1 $V_{IL} = V_{in} - V_{HYS}$, $V_{IH} = V_{in}$. Note 2 Available only in Sampling mode. | | | | | | | |

3.11 ANALOG TEMPERATURE SENSOR CHARACTERISTICS

 Temperature Sensor typical nonlinearity $\pm 0.57\%$ at $V_{DD} = 2.3\text{ V to }5.5\text{ V}$.

Table 19: Temperature Sensor Output vs Temperature at $V_{DD} = 2.3\text{ V to }5.5\text{ V}$

| T, °C | TS OUT, V | | | Error, % |
|--------|-----------|-------|-------|------------|
| | Min | Typ | Max | |
| -40 °C | 1.997 | 2.008 | 2.023 | ± 0.75 |
| -30 °C | 1.951 | 1.963 | 1.979 | ± 0.82 |
| -20 °C | 1.906 | 1.918 | 1.933 | ± 0.78 |
| -10 °C | 1.861 | 1.872 | 1.886 | ± 0.75 |
| 0 °C | 1.814 | 1.826 | 1.840 | ± 0.77 |
| 10 °C | 1.769 | 1.779 | 1.792 | ± 0.73 |
| 20 °C | 1.722 | 1.733 | 1.745 | ± 0.69 |
| 25 °C | 1.699 | 1.710 | 1.722 | ± 0.70 |
| 30 °C | 1.675 | 1.686 | 1.698 | ± 0.71 |
| 40 °C | 1.628 | 1.639 | 1.651 | ± 0.73 |
| 50 °C | 1.579 | 1.591 | 1.603 | ± 0.75 |
| 60 °C | 1.531 | 1.543 | 1.555 | ± 0.78 |
| 70 °C | 1.482 | 1.494 | 1.507 | ± 0.87 |
| 80 °C | 1.433 | 1.446 | 1.458 | ± 0.90 |
| 85 °C | 1.409 | 1.421 | 1.433 | ± 0.84 |
| 90 °C | 1.384 | 1.397 | 1.409 | ± 0.93 |
| 100 °C | 1.335 | 1.347 | 1.359 | ± 0.89 |
| 110 °C | 1.285 | 1.298 | 1.310 | ± 1.00 |
| 120 °C | 1.235 | 1.249 | 1.260 | ± 1.12 |
| 125 °C | 1.210 | 1.224 | 1.236 | ± 1.14 |
| 130 °C | 1.185 | 1.200 | 1.211 | ± 1.25 |

4 User Programmability

The SLG46811 is a user programmable device with one time programmable (OTP) memory elements that are able to configure the connection matrix and macrocells. A programming development kit allows the user the ability to create initial devices. Once the design is finalized, the programming code (.gpx file) is forwarded to Renesas Electronics Corporation to integrate into a production process.

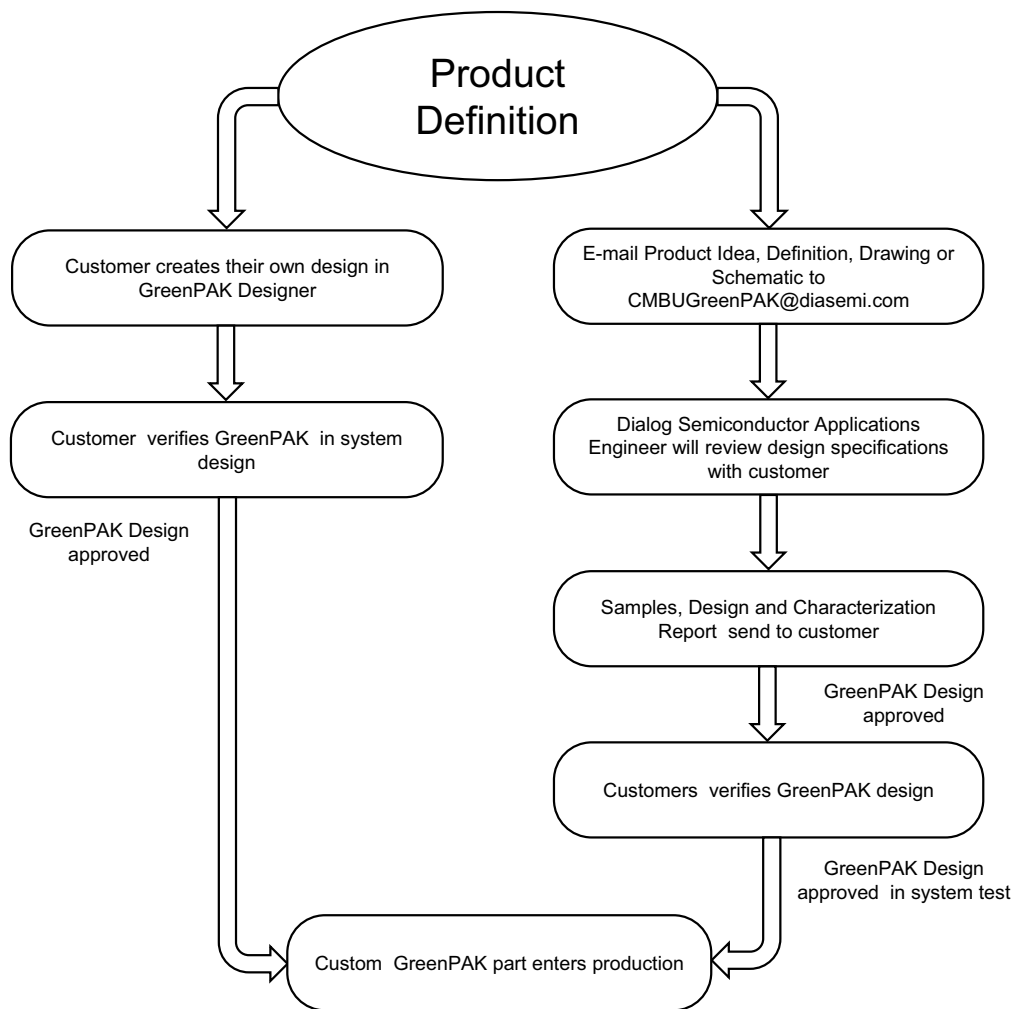


Figure 2: Steps to Create a Custom GreenPAK Device

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

5 IO Pins

The SLG46811 has a total of 9 GPIO and 1 GPI Pins which can function as either a user defined Input or Output.

5.1 GPIO PINS

Pins from GPIO0 to GPIO8 serve as General Purpose IO Pins. Input function of GPIO shared with I²C virtual inputs. See Section 6.1.

5.2 GPI PINS

GPI serves as a General Purpose Input Pin.

5.3 PULL-UP/DOWN RESISTORS

All IO Pins have the option for user selectable resistors connected to the input structure. The selectable values on these resistors are 10 kΩ, 100 kΩ, and 1 MΩ. The internal resistors can be configured as either Pull-up or Pull-downs.

5.4 FAST PULL-UP/DOWN DURING POWER-UP

During power-up, IO Pull-up/down resistance will switch to 2.6 kΩ initially and then it will switch to normal setting value. This function is enabled by register [594].

5.5 GPI STRUCTURE

5.5.1 GPI Structure (for GPI)

Input Mode [1:0]
 00: Digital In without Schmitt Trigger, wosmt_en = 1, OE=0
 01: Digital In with Schmitt Trigger, smt_en = 1, OE = 0
 10: Low Voltage Digital In mode, lv_en = 1, OE = 0
 11: Reserved

Note 1: OE cannot be selected by user
 Note 2: OE is Matrix output, Digital In is Matrix input

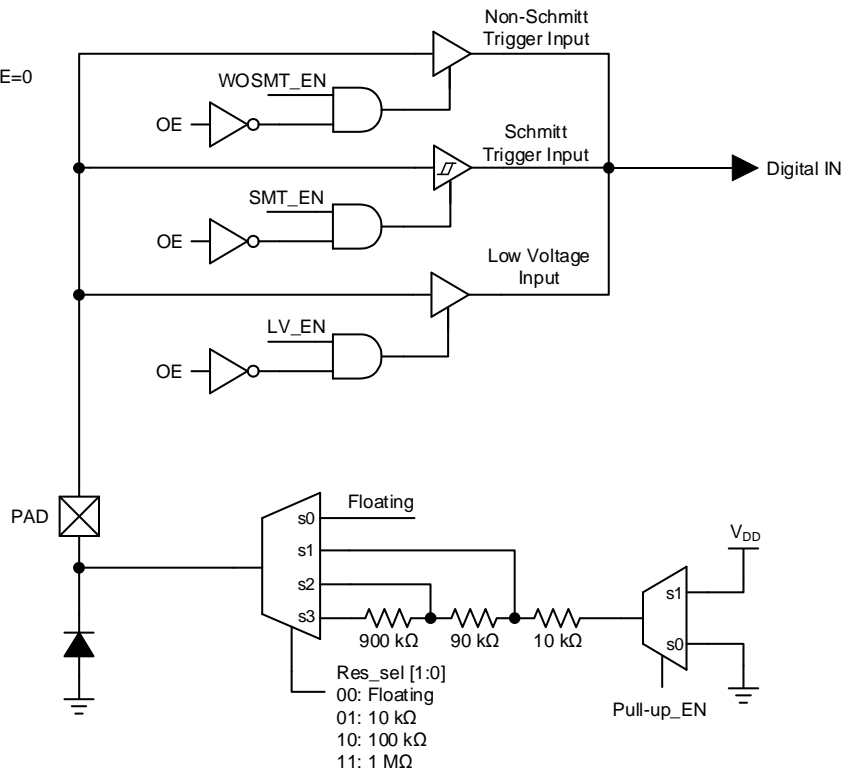


Figure 3: GPI Structure Diagram

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

5.6 GPIO WITH I²C MODE IO STRUCTURE

5.6.1 GPIO with I²C Mode Structure (for GPIO0 and GPIO1)

Input Mode [1:0]

- 00: Digital Input without Schmitt Trigger
- 01: Digital Input with Schmitt Trigger
- 10: Low Voltage Digital Input
- 11: Reserved

register [606]=1: Open-Drain NMOS for GPIO0
 register [613]=1: Open-Drain NMOS for GPIO1

- Note 1: OE cannot be selected by user and is controlled by register. Digital In is Matrix input.
- Note 2: GPIO0 and GPIO1 do not support Push-Pull and PMOS Open-Drain modes.
- Note 3: It is possible to apply an input voltage higher than V_{DD} to GPIO0 and GPIO1. However, this voltage should not exceed 5.5 V.
- Note 4: Can be varied over PVT, for reference only.

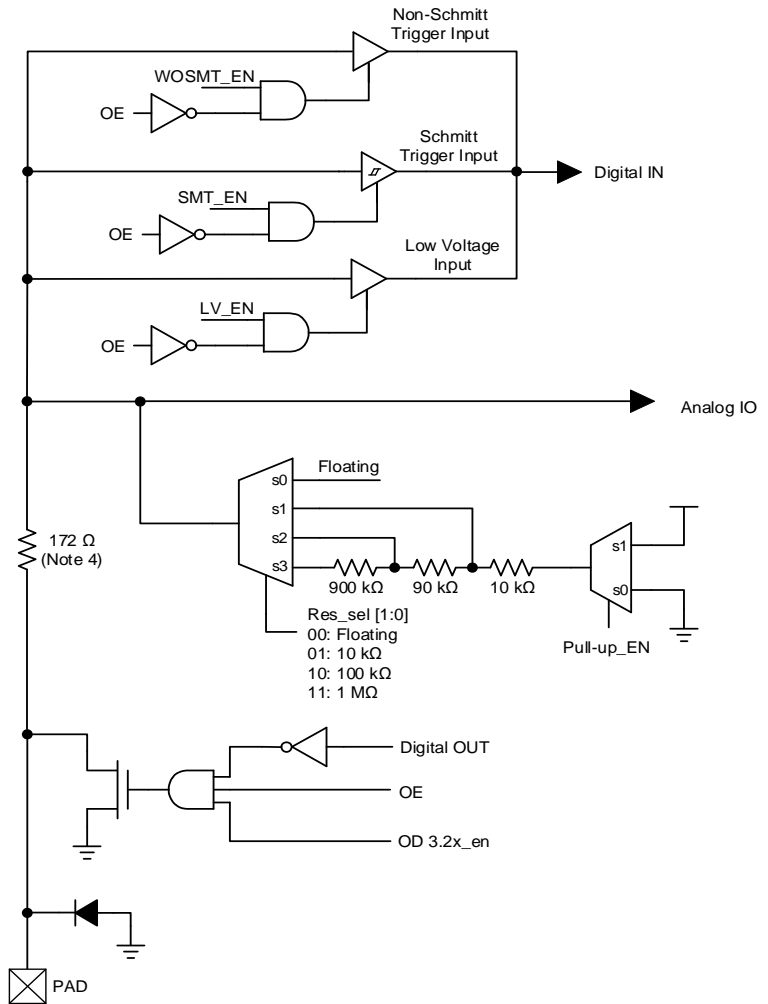


Figure 4: GPIO with I²C Mode IO Structure Diagram

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

5.7 MATRIX OE IO STRUCTURE

5.7.1 Matrix OE IO Structure (for GPIO2, GPIO3, GPIO7, GPIO8)

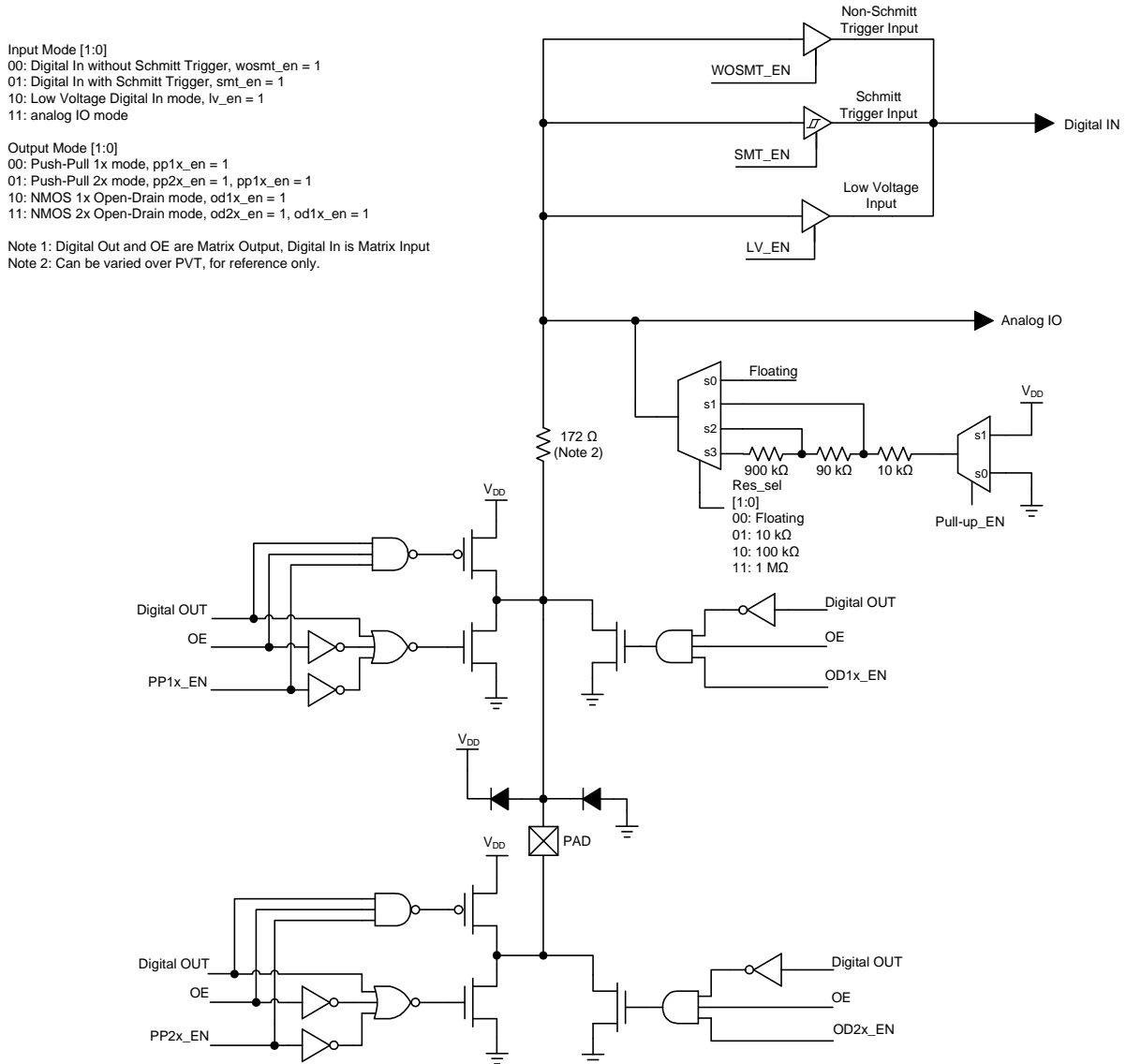


Figure 5: Matrix OE IO Structure Diagram

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

5.8 REGISTER OE IO STRUCTURE

5.8.1 Register OE IO Structure (for GPIO4, GPIO5, GPIO6)

Input Mode [1:0]
 00: Digital In without Schmitt Trigger, wosmt_en = 1
 01: Digital In with Schmitt Trigger, smt_en = 1
 10: Low Voltage Digital In mode, lv_en = 1
 11: Analog IO mode

Output Mode [1:0]
 00: Push-Pull 1x mode, pp1x_en = 1
 01: Push-Pull 2x mode, pp2x_en = 1, pp1x_en = 1
 10: NMOS 1x Open-Drain mode, od1x_en = 1
 11: NMOS 2x Open-Drain mode, od2x_en = 1, od1x_en = 1

Note 1: Digital Out is Matrix Output, Digital In is Matrix Input. OE is register bit
 Note 2: Can be varied over PVT, for reference only.

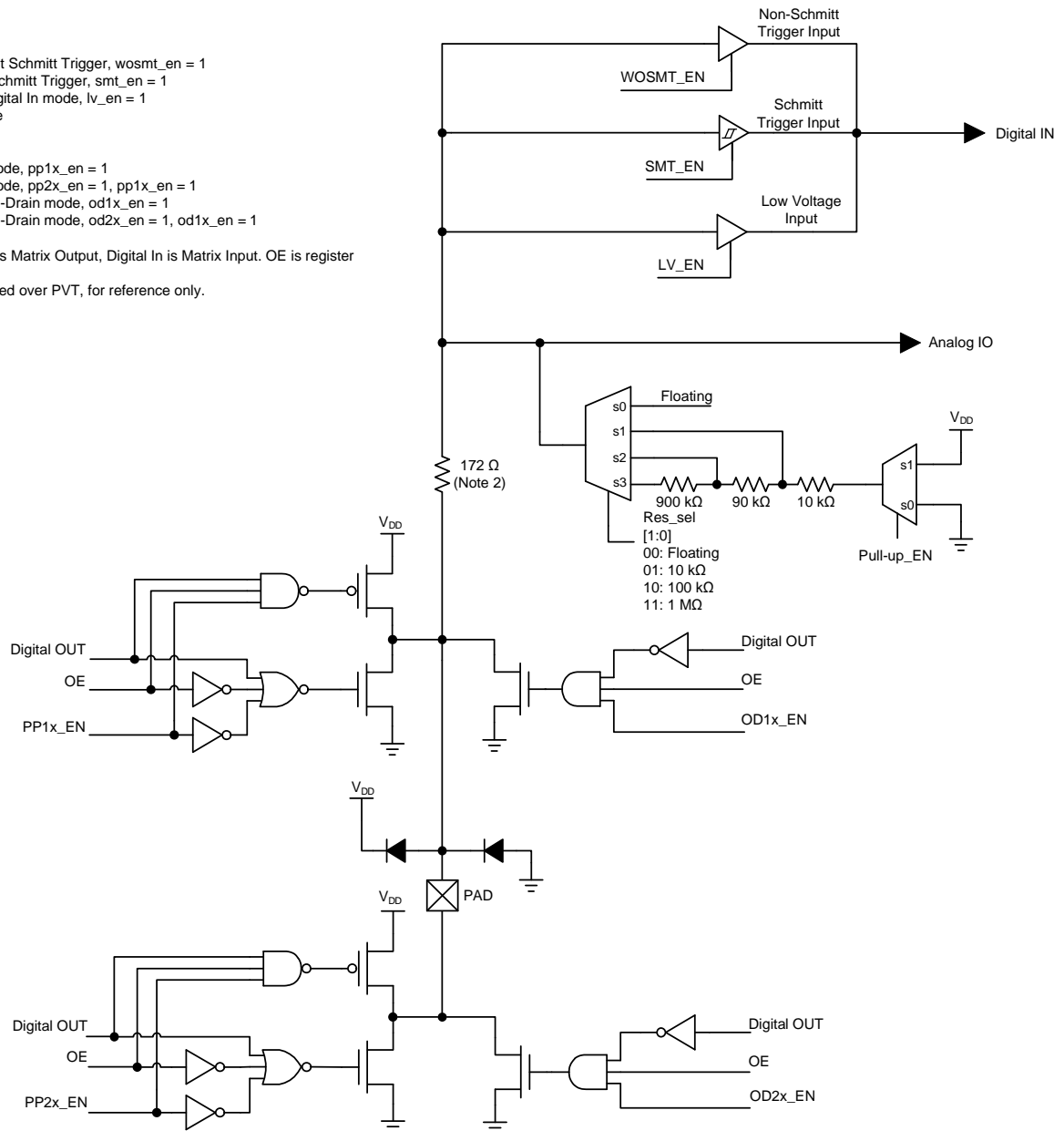


Figure 6: Register OE IO Structure Diagram

5.9 IO TYPICAL PERFORMANCE

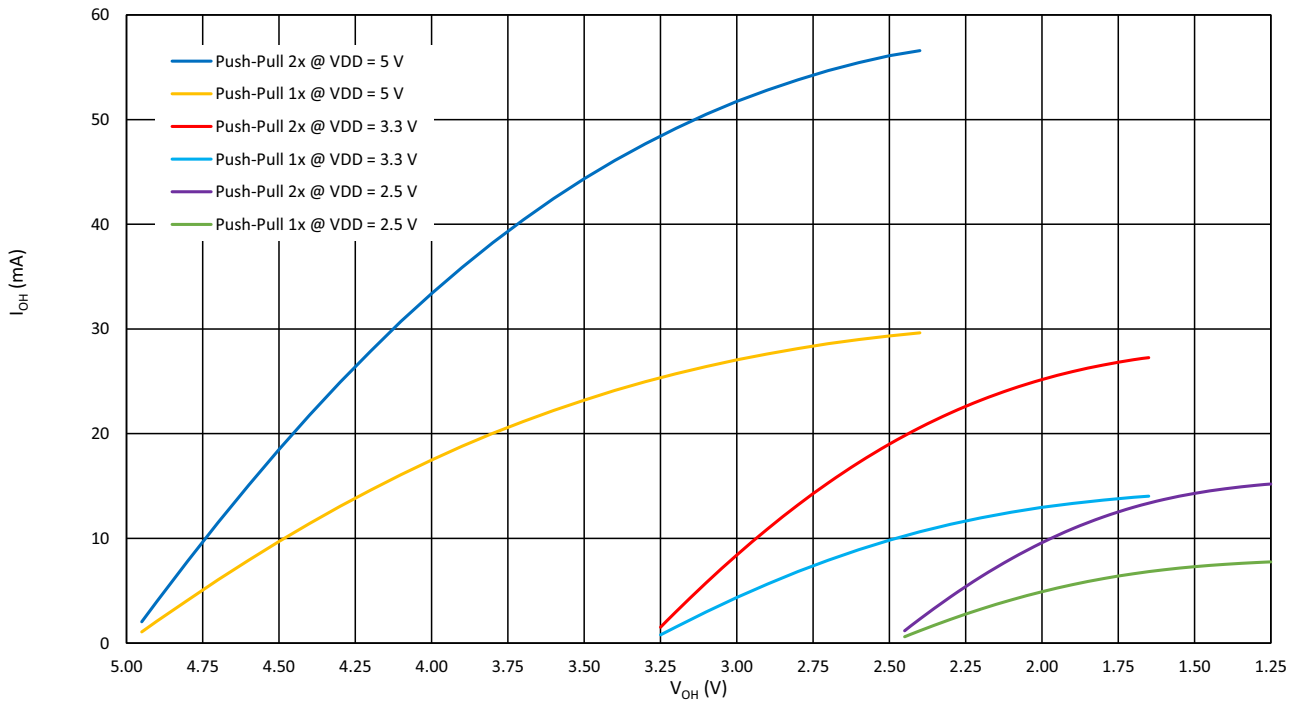


Figure 7: Typical High Level Output Current vs. High Level Output Voltage at T = 25 °C

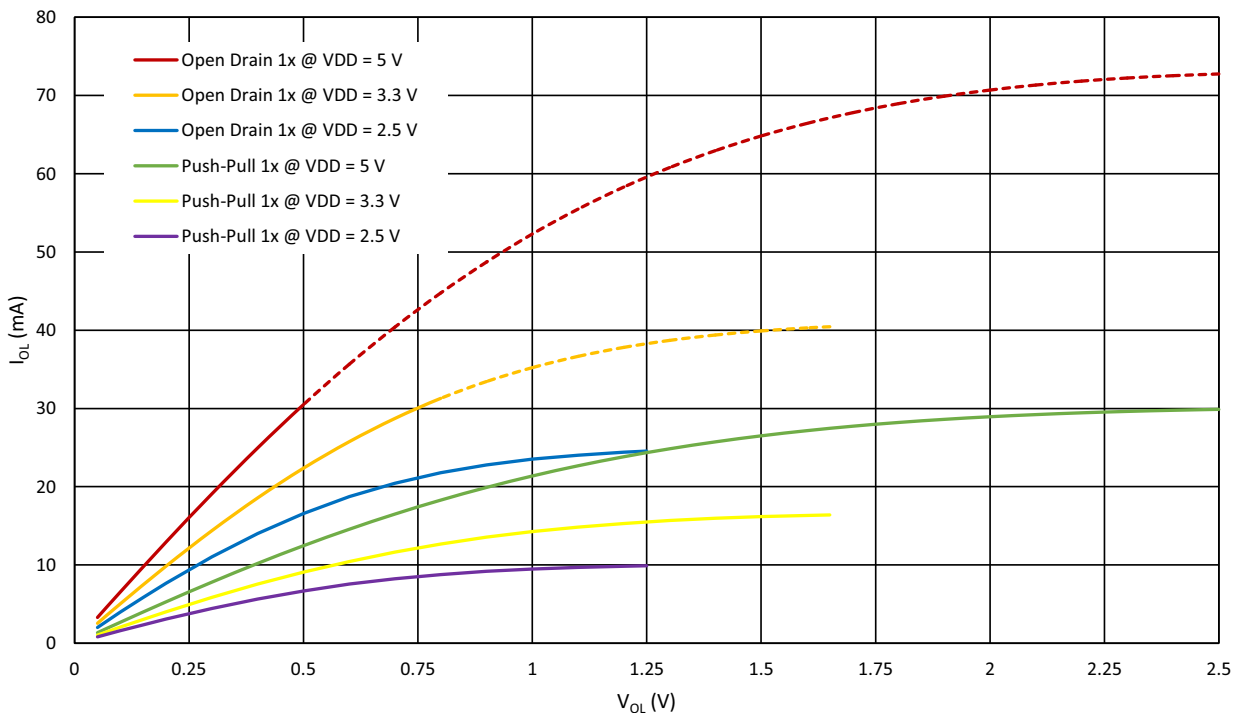


Figure 8: Typical Low Level Output Current vs. Low Level Output Voltage, 1x Drive at T = 25 °C, Full Range

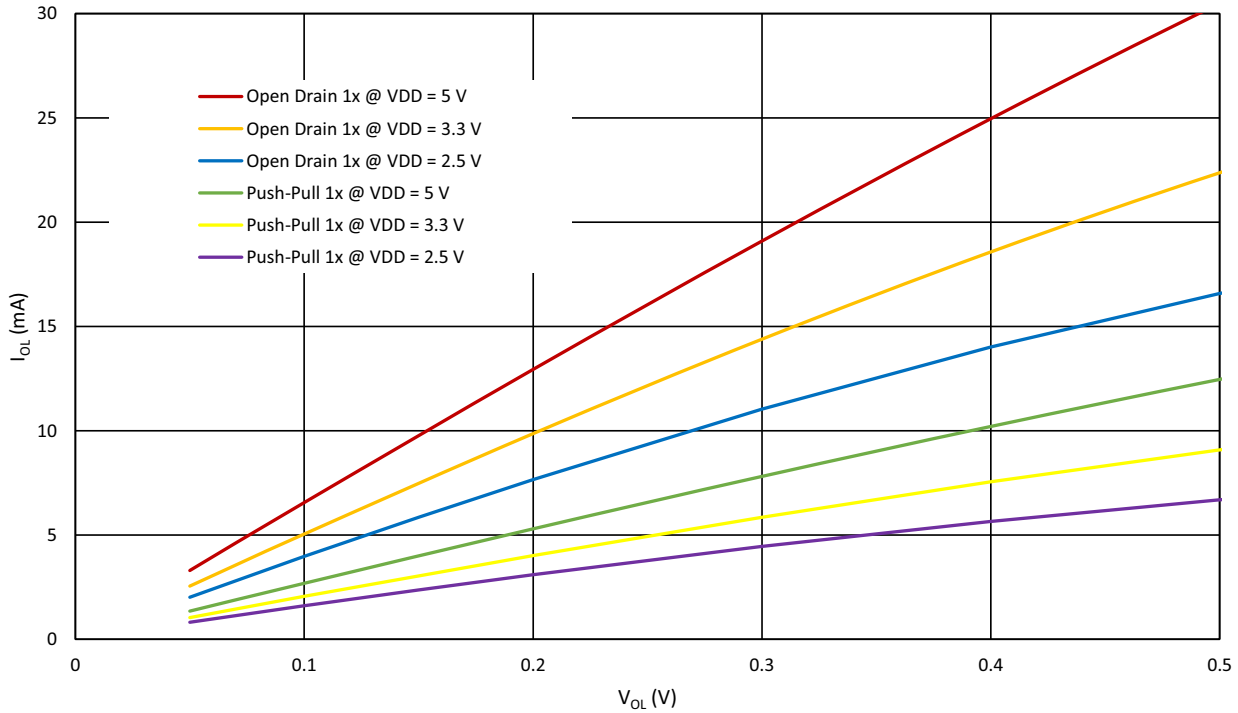


Figure 9: Typical Low Level Output Current vs. Low Level Output Voltage, 1x Drive at T = 25 °C

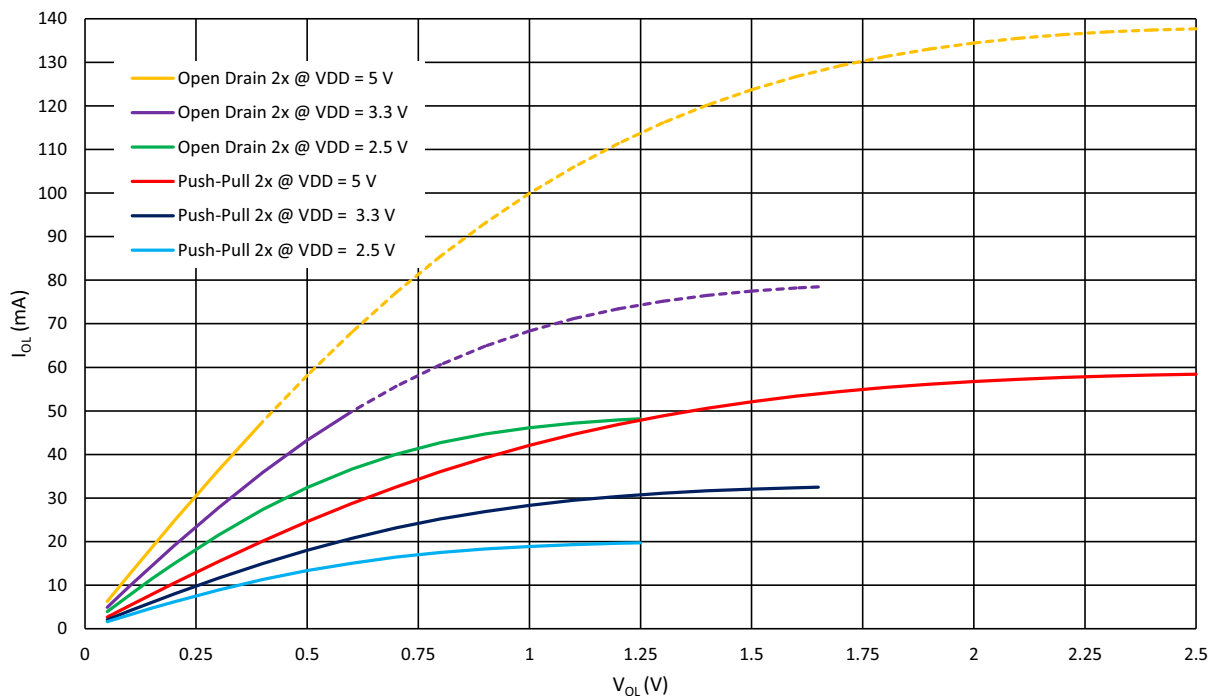


Figure 10: Typical Low Level Output Current vs. Low Level Output Voltage, 2x Drive at T = 25 °C, Full Range

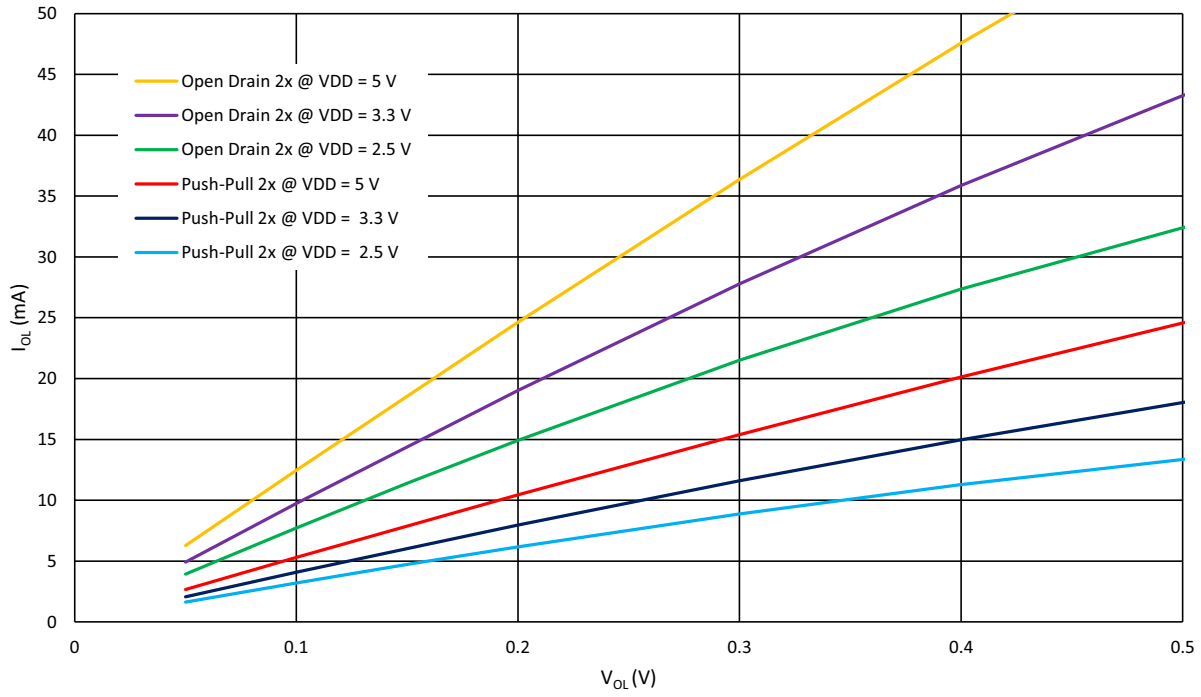


Figure 11: Typical Low Level Output Current vs. Low Level Output Voltage, 2x Drive at T = 25 °C

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

6 Connection Matrix

The Connection Matrix in the SLG46811 is used to create the internal routing for internal functional macrocells of the device once it is programmed. The registers are programmed from the one time programmable (OTP) NVM cell during Test Mode Operation. The output of each functional macrocell within the SLG46811 has a specific digital bit code assigned to it that is either set to active “High” or inactive “Low”, based on the design that is created. Once the 1200 register bits within the SLG46811 are programmed a fully custom circuit will be created.

The Connection Matrix has 53 inputs and 72 outputs. Each of the 53 inputs to the Connection Matrix is hard-wired to the digital output of a particular source macrocell, including IO pins, LUTs, analog comparators, other digital resources, such as V_{DD} and GND. The input to a digital macrocell uses a 6-bit register to select one of these 53 input lines.

For a complete list of the SLG46811’s register table, see Section 18.

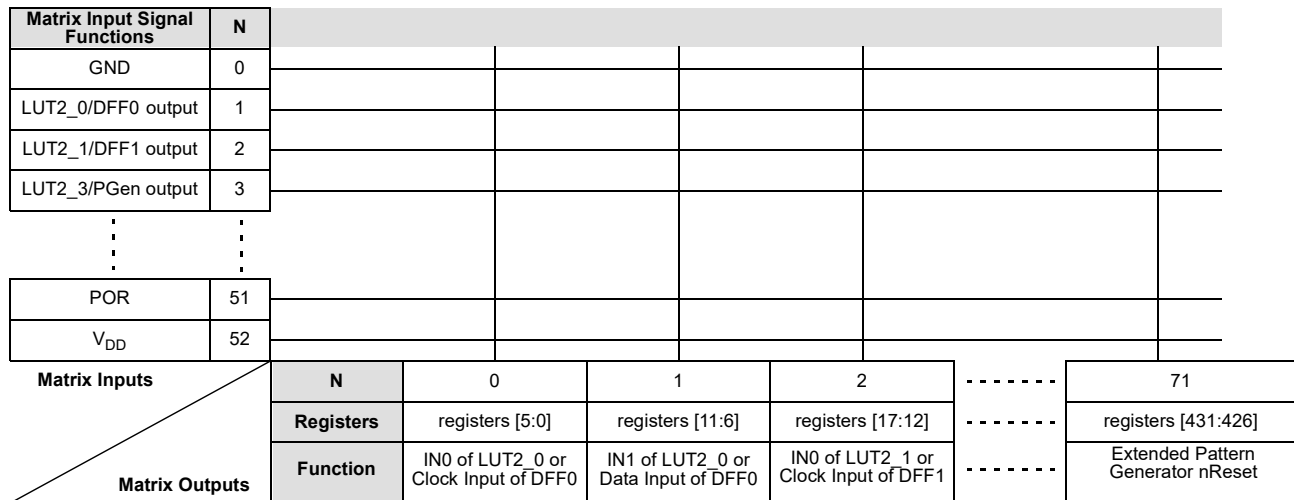


Figure 12: Connection Matrix

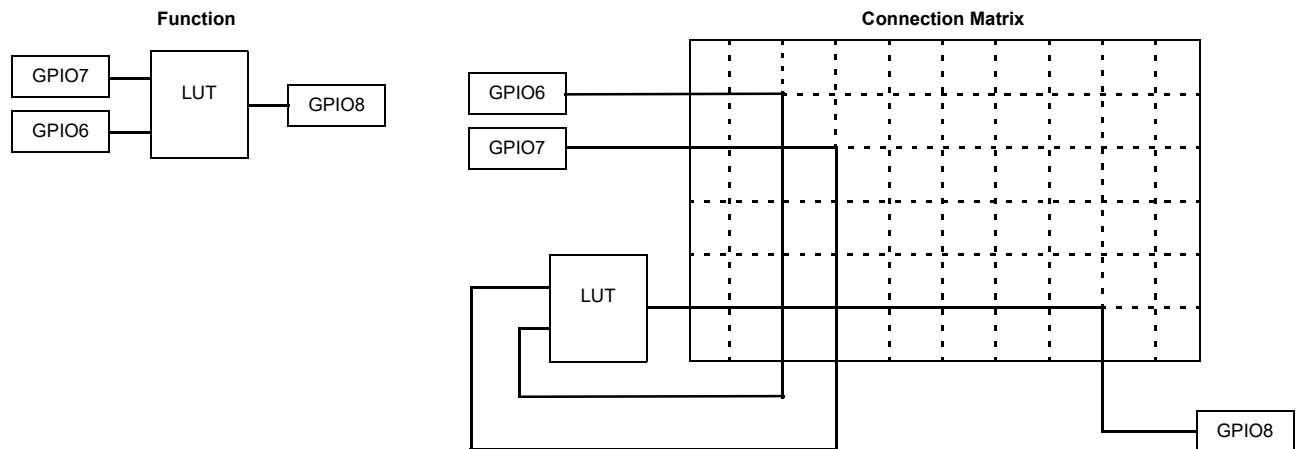


Figure 13: Connection Matrix Usage Example

6.1 MATRIX INPUT TABLE
Table 20: Matrix Input Table

| Matrix Input Number | Matrix Input Signal Function | Matrix Decode | | | | | |
|---------------------|---|---------------|---|---|---|---|---|
| | | 5 | 4 | 3 | 2 | 1 | 0 |
| 0 | GND | 0 | 0 | 0 | 0 | 0 | 0 |
| 1 | LUT2_0/DFF0 output | 0 | 0 | 0 | 0 | 0 | 1 |
| 2 | LUT2_1/DFF1 output | 0 | 0 | 0 | 0 | 1 | 0 |
| 3 | LUT2_3/PGen output | 0 | 0 | 0 | 0 | 1 | 1 |
| 4 | LUT3_0/DFF2 output | 0 | 0 | 0 | 1 | 0 | 0 |
| 5 | LUT3_1/DFF3 output | 0 | 0 | 0 | 1 | 0 | 1 |
| 6 | LUT3_2/DFF4 output | 0 | 0 | 0 | 1 | 1 | 0 |
| 7 | LUT3_3/DFF5 output | 0 | 0 | 0 | 1 | 1 | 1 |
| 8 | LUT3_4/DFF6 output/Shift_Reg0 output | 0 | 0 | 1 | 0 | 0 | 0 |
| 9 | LUT3_5/DFF7 output/Shift_Reg1 output | 0 | 0 | 1 | 0 | 0 | 1 |
| 10 | LUT3_6/DFF8 output/Shift_Reg2 output | 0 | 0 | 1 | 0 | 1 | 0 |
| 11 | LUT3_7/DFF9 output/Shift_Reg3 output | 0 | 0 | 1 | 0 | 1 | 1 |
| 12 | CNT0 output | 0 | 0 | 1 | 1 | 0 | 0 |
| 13 | MLT0_LUT3_8/DFF10_OUT | 0 | 0 | 1 | 1 | 0 | 1 |
| 14 | CNT1 output | 0 | 0 | 1 | 1 | 1 | 0 |
| 15 | MLT1_LUT3_9/DFF11_OUT | 0 | 0 | 1 | 1 | 1 | 1 |
| 16 | CNT2 output | 0 | 1 | 0 | 0 | 0 | 0 |
| 17 | MLT2_LUT3_10/DFF12_OUT | 0 | 1 | 0 | 0 | 0 | 1 |
| 18 | CNT3 output | 0 | 1 | 0 | 0 | 1 | 0 |
| 19 | MLT3_LUT3_11/DFF13_OUT | 0 | 1 | 0 | 0 | 1 | 1 |
| 20 | CNT4 output | 0 | 1 | 0 | 1 | 0 | 0 |
| 21 | MLT4_LUT3_12/DFF14_OUT | 0 | 1 | 0 | 1 | 0 | 1 |
| 22 | CNT5 output | 0 | 1 | 0 | 1 | 1 | 0 |
| 23 | MLT5_LUT3_13/DFF15_OUT | 0 | 1 | 0 | 1 | 1 | 1 |
| 24 | I ² C_virtual_0 Input, Extended Pattern Generator Output 0 | 0 | 1 | 1 | 0 | 0 | 0 |
| 25 | I ² C_virtual_1 Input, Extended Pattern Generator Output 1 | 0 | 1 | 1 | 0 | 0 | 1 |
| 26 | I ² C_virtual_2 Input, Extended Pattern Generator Output 2 | 0 | 1 | 1 | 0 | 1 | 0 |
| 27 | I ² C_virtual_3 Input, Extended Pattern Generator Output 3 | 0 | 1 | 1 | 0 | 1 | 1 |
| 28 | I ² C_virtual_4 Input, Extended Pattern Generator Output 4 | 0 | 1 | 1 | 1 | 0 | 0 |
| 29 | I ² C_virtual_5 Input, Extended Pattern Generator Output 5 | 0 | 1 | 1 | 1 | 0 | 1 |
| 30 | I ² C_virtual_6 Input, GPIO0 digital input, Extended Pattern Generator Output 6 or SCL | 0 | 1 | 1 | 1 | 1 | 0 |
| 31 | I ² C_virtual_7 Input, GPIO1 digital input, Extended Pattern Generator Output 7 or SDA | 0 | 1 | 1 | 1 | 1 | 1 |
| 32 | GPIO2 Digital Input or I ² C_virtual_8 Input | 1 | 0 | 0 | 0 | 0 | 0 |

Table 20: Matrix Input Table (Continued)

| Matrix Input Number | Matrix Input Signal Function | Matrix Decode | | | | | |
|---------------------|--|---------------|---|---|---|---|---|
| | | 5 | 4 | 3 | 2 | 1 | 0 |
| 33 | GPIO3 Digital Input or I ² C_virtual_9 Input | 1 | 0 | 0 | 0 | 0 | 1 |
| 34 | GPIO4 Digital Input or I ² C_virtual_10 Input | 1 | 0 | 0 | 0 | 1 | 0 |
| 35 | GPIO5 Digital Input or I ² C_virtual_11 Input | 1 | 0 | 0 | 0 | 1 | 1 |
| 36 | GPIO6 Digital Input or I ² C_virtual_12 Input | 1 | 0 | 0 | 1 | 0 | 0 |
| 37 | GPIO7 Digital Input or I ² C_virtual_13 Input | 1 | 0 | 0 | 1 | 0 | 1 |
| 38 | GPIO8 Digital Input or I ² C_virtual_14 Input | 1 | 0 | 0 | 1 | 1 | 0 |
| 39 | LUT4_0/DFF16 output | 1 | 0 | 0 | 1 | 1 | 1 |
| 40 | GPI Digital Input | 1 | 0 | 1 | 0 | 0 | 0 |
| 41 | Programmable Delay Edge Detect Output | 1 | 0 | 1 | 0 | 0 | 1 |
| 42 | Edge Detect Filter Output | 1 | 0 | 1 | 0 | 1 | 0 |
| 43 | Oscillator0 output 0 | 1 | 0 | 1 | 0 | 1 | 1 |
| 44 | Oscillator1 output | 1 | 0 | 1 | 1 | 0 | 0 |
| 45 | MS ACMP Output 0 | 1 | 0 | 1 | 1 | 0 | 1 |
| 46 | MS ACMP Output 1 | 1 | 0 | 1 | 1 | 1 | 0 |
| 47 | MS ACMP Output 2 | 1 | 0 | 1 | 1 | 1 | 1 |
| 48 | MS ACMP Output 3 | 1 | 1 | 0 | 0 | 0 | 0 |
| 49 | Oscillator0 output 1 | 1 | 1 | 0 | 0 | 0 | 1 |
| 50 | MS ASMP Data Ready Signal | 1 | 1 | 0 | 0 | 1 | 0 |
| 51 | POR | 1 | 1 | 0 | 0 | 1 | 1 |
| 52 | V _{DD} | 1 | 1 | 1 | 0 | 0 | 0 |

6.2 MATRIX OUTPUT TABLE
Table 21: Matrix Output Table

| Register Bit Address | Matrix Output Signal Function | Matrix Output Number |
|----------------------|---|----------------------|
| [5:0] | IN0 of LUT2_0 or Clock Input of DFF0 | 0 |
| [11:6] | IN1 of LUT2_0 or Data Input of DFF0 | 1 |
| [17:12] | IN0 of LUT2_1 or Clock Input of DFF1 | 2 |
| [23:18] | IN1 of LUT2_1 or Data Input of DFF1 | 3 |
| [29:24] | IN0 of LUT2_2 or Clock Input of PGen | 4 |
| [35:30] | IN1 of LUT2_2 or nRST of PGen | 5 |
| [41:36] | IN0 of LUT3_0 or CLK Input of DFF2 | 6 |
| [47:42] | IN1 of LUT3_0 or Data of DFF2 | 7 |
| [53:48] | IN2 of LUT3_0 or nRST (nSET) of DFF2 | 8 |
| [59:54] | IN0 of LUT3_1 or CLK Input of DFF3 | 9 |
| [65:60] | IN1 of LUT3_1 or Data of DFF3 | 10 |
| [71:66] | IN2 of LUT3_1 or nRST (nSET) of DFF3 | 11 |
| [77:72] | IN0 of LUT3_2 or CLK Input of DFF4 | 12 |
| [83:78] | IN1 of LUT3_2 or Data of DFF4 | 13 |
| [89:84] | IN2 of LUT3_2 or nRST (nSET) of DFF4 | 14 |
| [95:90] | IN0 of LUT3_3 or CLK Input of DFF5 | 15 |
| [101:96] | IN1 of LUT3_3 or Data of DFF5 | 16 |
| [107:102] | IN2 of LUT3_3 or nRST (nSET) of DFF5 | 17 |
| [113:108] | IN0 of LUT3_4 or CLK Input of DFF6 or Clock Input of Shift_Reg0 | 18 |
| [119:114] | IN1 of LUT3_4 or Data of DFF6 or Data Input of Shift_Reg0 | 19 |
| [125:120] | IN2 of LUT3_4 or nRST (nSET) of DFF6 or nRST (nSET) of Shift_Reg0 | 20 |
| [131:126] | IN0 of LUT3_5 or CLK Input of DFF7 or Clock Input of Shift_Reg1 | 21 |
| [137:132] | IN1 of LUT3_5 or Data of DFF7 or Data Input of Shift_Reg1 | 22 |
| [143:138] | IN2 of LUT3_5 or nRST (nSET) of DFF7 or nRST (nSET) of Shift_Reg1 | 23 |
| [149:144] | IN0 of LUT3_6 or CLK Input of DFF8 or Clock Input of Shift_Reg2 | 24 |
| [155:150] | IN1 of LUT3_6 or Data of DFF8 or Data Input of Shift_Reg2 | 25 |
| [161:156] | IN2 of LUT3_6 or nRST (nSET) of DFF8 or nRST (nSET) of Shift_Reg2 | 26 |
| [167:162] | IN0 of LUT3_7 or CLK Input of DFF9 or Clock Input of Shift_Reg3 | 27 |
| [173:168] | IN1 of LUT3_7 or Data of DFF9 or Data Input of Shift_Reg3 | 28 |
| [179:174] | IN2 of LUT3_7 or nRST (nSET) of DFF9 or nRST (nSET) of Shift_Reg3 | 29 |
| [185:180] | IN0 of LUT3_8 or CLK Input of DFF10 Delay0 Input (or Counter0 nRST Input) Up input of FSM | 30 |
| [191:186] | IN1 of LUT3_8 or nRST (nSET) of DFF10 Delay0 Input (or Counter0 nRST Input) or DLY/CNT/FSM External CLK input | 31 |
| [197:192] | IN2 of LUT3_8 or Data of DFF10 Delay0 Input (or Counter0 nRST Input) or FSM Reset/Set input | 32 |

Table 21: Matrix Output Table (Continued)

| Register Bit Address | Matrix Output Signal Function | Matrix Output Number |
|----------------------|--|----------------------|
| [203:198] | IN0 of LUT3_9 or CLK Input of DFF11 Delay1 Input (or Counter1 nRST Input) | 33 |
| [209:204] | IN1 of LUT3_9 or nRST (nSET) of DFF11 Delay1 Input (or Counter1 nRST Input) | 34 |
| [215:210] | IN2 of LUT3_9 or Data of DFF11 Delay1 Input (or Counter1 nRST Input) | 35 |
| [221:216] | IN0 of LUT3_10 or CLK Input of DFF12 Delay2 Input (or Counter1 nRST Input) | 36 |
| [227:222] | IN1 of LUT3_10 or nRST (nSET) of DFF12 Delay2 Input (or Counter1 nRST Input) | 37 |
| [233:228] | IN2 of LUT3_10 or Data of DFF12 Delay2 Input (or Counter2 nRST Input) | 38 |
| [239:234] | IN0 of LUT3_11 or CLK Input of DFF13 Delay3 Input (or Counter3 nRST Input) | 39 |
| [245:240] | IN1 of LUT3_11 or nRST (nSET) of DFF13 Delay3 Input (or Counter3 nRST Input) | 40 |
| [251:246] | IN2 of LUT3_11 or Data of DFF13 Delay3 Input (or Counter3 nRST Input) | 41 |
| [257:252] | IN0 of LUT3_12 or CLK Input of DFF14 Delay4 Input (or Counter4 nRST Input) | 42 |
| [263:258] | IN1 of LUT3_12 or nRST (nSET) of DFF14 Delay4 Input (or Counter4 nRST Input) | 43 |
| [269:264] | IN2 of LUT3_12 or Data of DFF14 Delay4 Input (or Counter4 nRST Input) | 44 |
| [275:270] | IN0 of LUT3_13 or CLK Input of DFF15 Delay5 Input (or Counter5 nRST Input) | 45 |
| [281:276] | IN1 of LUT3_13 or nRST (nSET) of DFF15 Delay5 Input (or Counter5 nRST Input) | 46 |
| [287:282] | IN2 of LUT3_13 or Data of DFF15 Delay5 Input (or Counter5 nRST Input) | 47 |
| [293:288] | IN0 of LUT4_0 or CLK Input of DFF16 | 48 |
| [299:294] | IN1 of LUT4_0 or Data of DFF16 | 49 |
| [305:300] | IN2 of LUT4_0 or nRST (nSET) of DFF16 | 50 |
| [311:306] | IN3 of LUT4_0 | 51 |
| [317:312] | Programmable Delay/Edge Detect Input | 52 |
| [323:318] | Filter/Edge Detect Input | 53 |
| [329:324] | GPIO0 Digital Output | 54 |
| [335:330] | GPIO1 Digital Output | 55 |
| [341:336] | GPIO2, Digital Output | 56 |
| [347:342] | GPIO2, Digital Output OE | 57 |
| [353:348] | GPIO3, Digital Output | 58 |
| [359:354] | GPIO3, Digital Output OE | 59 |
| [365:360] | GPIO4 Digital Output | 60 |
| [371:366] | GPIO5 Digital Output | 61 |
| [377:372] | GPIO6 Digital Output | 62 |
| [383:378] | GPIO7 Digital Output | 63 |
| [389:384] | GPIO7 Digital Output OE | 64 |
| [395:390] | GPIO8 Digital Output | 65 |
| [401:396] | GPIO8 Digital Output OE | 66 |
| [407:402] | MS ACMP Enable Input | 67 |
| [413:408] | Reset of MS ACMP DFFs | 68 |
| [419:414] | OSC Enable | 69 |

Table 21: Matrix Output Table (Continued)

| Register Bit Address | Matrix Output Signal Function | Matrix Output Number |
|----------------------|-----------------------------------|----------------------|
| [425:420] | Extended Pattern Generator Clock | 70 |
| [431:426] | Extended Pattern Generator nReset | 71 |

Note 1 For each Address, the two most significant bits are unused.

6.3 CONNECTION MATRIX VIRTUAL INPUTS

As mentioned previously, the Connection Matrix inputs come from the outputs of various digital macrocells on the device. Fifteen of the Connection Matrix inputs have the special characteristic that the state of these signal lines comes from a corresponding data bit written as a register value via I²C. This gives the user the ability to write data via the serial channel, and have this information translated to the inputs of other macrocells through Connection Matrix. The I²C address for reading and writing these register values is byte 0x39, 0x3A<6:0>.

An I²C write command to these register bits will set the signal values going into the Connection Matrix to the desired state. A read command to these register bits will read either the original data values coming from the NVM memory bits (that were loaded during the initial device startup), or the values from a previous write command (if that has happened).

Connection Matrix Virtual Inputs are shared with input function of GPIO and Pattern Generator output.

If the virtual input mode is selected, an I²C write command to these register bits will set the signal values going into the Connection Matrix to the desired state. A read command to these register bits will read either the original data values coming from the NVM memory bits (that were loaded during the initial device startup), or the values from a previous write command (if that has happened). The I²C disable/enable registers [1078:1072] and [1184] select whether the Connection Matrix input comes from the Pin input or from the I²C virtual input. All I²C virtual inputs with shared functions are listed below:

- Select Pattern Generator 0 or Virtual Input 0
- Select Pattern Generator 1 or Virtual Input 1
- Select Pattern Generator 2 or Virtual Input 2
- Select Pattern Generator 3 or Virtual Input 3
- Select Pattern Generator 4 or Virtual Input 4
- Select Pattern Generator 5 or Virtual Input 5
- Select Pattern Generator 6 or Virtual Input 6 or GPI (GPIO0)
- Select Pattern Generator 7 or Virtual Input 7 or GPI (GPIO1)
- Select Virtual Input 8 or GPI (GPIO2)
- Select Virtual Input 9 or GPI (GPIO3)
- Select Virtual Input 10 or GPI (GPIO4)
- Select Virtual Input 11 or GPI (GPIO5)
- Select Virtual Input 12 or GPI (GPIO6)
- Select Virtual Input 13 or GPI (GPIO7)
- Select Virtual Input 14 or GPI (GPIO8)

See [Table](#) for Connection Matrix Virtual Inputs.

Table 22: Connection Matrix Virtual Inputs

| Matrix Input Number | Matrix Input Signal Function | Register Bit Addresses (d) |
|---------------------|--|----------------------------|
| 24 | Extended Pattern Generator 0 or I ² C_virtual_0 Input | [456] |
| 25 | Extended Pattern Generator 1 or I ² C_virtual_1 Input | [457] |
| 26 | Extended Pattern Generator 2 or I ² C_virtual_2 Input | [458] |

Table 22: Connection Matrix Virtual Inputs (Continued)

| Matrix Input Number | Matrix Input Signal Function | Register Bit Addresses (d) |
|---------------------|---|----------------------------|
| 27 | Extended Pattern Generator 3 or I ² C_virtual_3 Input | [459] |
| 28 | Extended Pattern Generator 4 or I ² C_virtual_4 Input | [460] |
| 29 | Extended Pattern Generator 5 or I ² C_virtual_5 Input | [461] |
| 30 | Extended Pattern Generator 6 or I ² C_virtual_6 Input or GPI (GPIO0) | [462] |
| 31 | Extended Pattern Generator 7 or I ² C_virtual_7 Input or GPI (GPIO1) | [463] |
| 32 | GPI (GPIO2) or I ² C_virtual_8 Input | [464] |
| 33 | GPI (GPIO3) or I ² C_virtual_9 Input | [465] |
| 34 | GPI (GPIO4) or I ² C_virtual_10 Input | [466] |
| 35 | GPI (GPIO5) or I ² C_virtual_11 Input | [467] |
| 36 | GPI (GPIO6) or I ² C_virtual_12 Input | [468] |
| 37 | GPI (GPIO7) or I ² C_virtual_13 Input | [469] |
| 38 | GPI (GPIO8) or I ² C_virtual_14 Input | [470] |

6.4 CONNECTION MATRIX VIRTUAL OUTPUTS

The digital outputs of the various macrocells are routed to the Connection Matrix to enable interconnections to the inputs of other macrocells in the device. At the same time, it is possible to read the state of each of the macrocell outputs as a register value via I²C. This option, called Connection Matrix Virtual Outputs, allows the user to remotely read the values of each macrocell output. The I²C addresses for reading these register values are bytes 0x36 (053) to 0x3C (060) (except for registers [470:456]). Write commands to these same register values will be ignored (with the exception of the Virtual Input register bits at registers [470:456]).

7 Combination Function Macrocells

The SLG46811 has 12 combination function macrocells that can serve more than one logic or timing function. In each case, they can serve as a Look Up Table (LUT), or as another logic or timing function. See the list below for the functions that can be implemented in these macrocells.

- Two macrocells that can serve as either 2-bit LUT or as D Flip-Flop
- One macrocell that can serve as either 2-bit LUT or as Programmable Pattern Generator (PGen)
- Four macrocells that can serve as either 3-bit LUTs or as D Flip-Flops with Set/Reset Input
- Four macrocells that can serve as either 3-bit LUTs or as D Flip-Flops with Set/Reset Input or as Shift Register
- One macrocell that can serve as either 4-bit LUT or as D Flip-Flop with Set/Reset Input

Inputs/Outputs for the 12 combination function macrocells are configured from the connection matrix with specific logic functions being defined by the state of configuration bits.

When used as a LUT to implement combinatorial logic functions, the outputs of the LUTs can be configured to any user defined function, including the following standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR).

7.1 2-BIT LUT OR D FLIP-FLOP MACROCELLS

There is one macrocell that can serve as either 2-bit LUT or as D Flip-Flop. When used to implement LUT functions, the 2-bit LUT takes in two input signals from the connection matrix and produce a single output, which goes back into the connection matrix. When used to implement D Flip-Flop function, the two input signals from the connection matrix go to the data (D) and clock (CLK) inputs for the Flip-Flop, with the output going back to the connection matrix.

The operation of the D Flip-Flop and LATCH will follow the functional descriptions below:

DFF: CLK is rising edge triggered, then Q = D; otherwise Q will not change

LATCH: when CLK is Low, then Q = D; otherwise Q remains its previous value (input D has no effect on the output, when CLK is High).

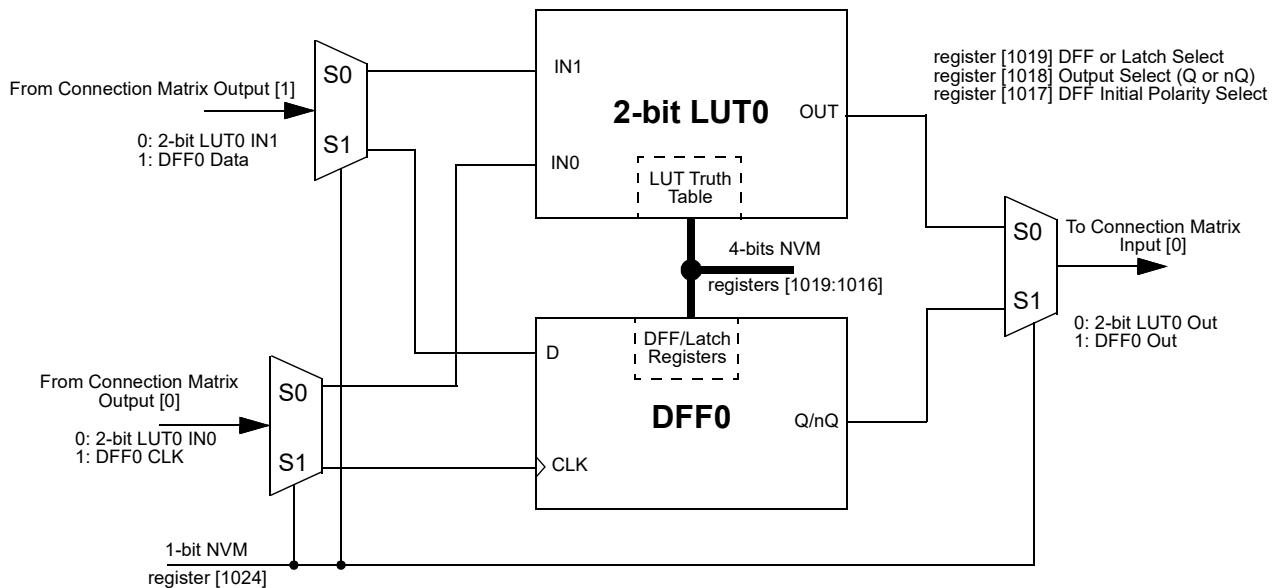


Figure 14: 2-bit LUT0 or DFF0

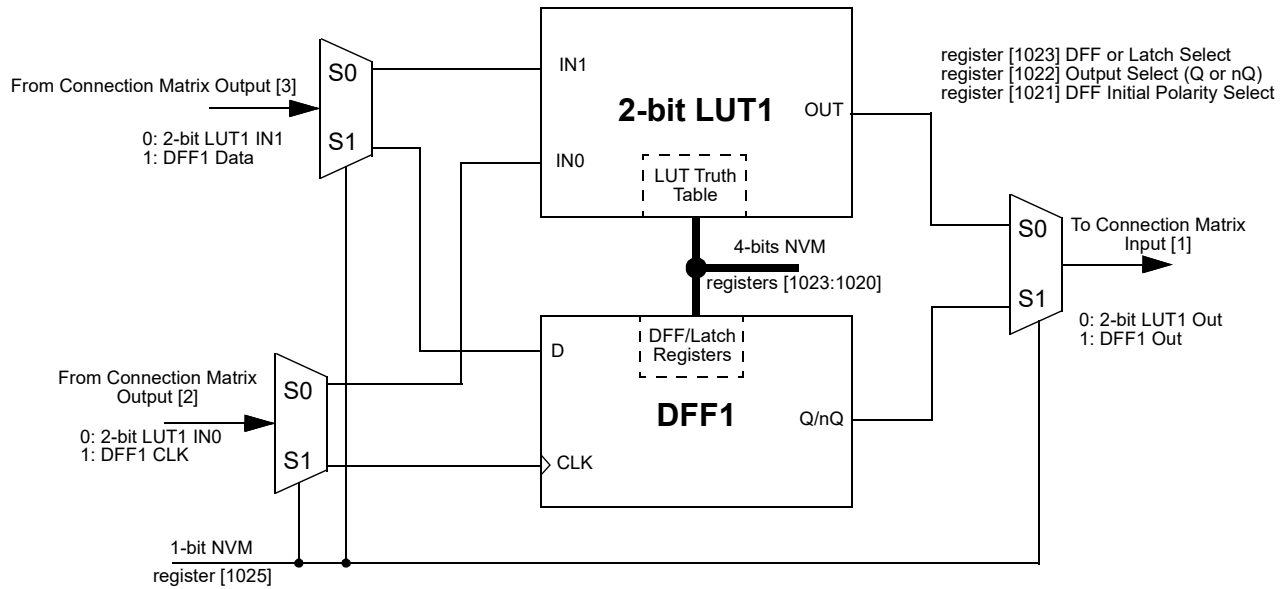


Figure 15: 2-bit LUT1 or DFF1

7.1.1 2-Bit LUT or D Flip-Flop Macrocell Used as 2-Bit LUT

This macrocell, when programmed for a LUT function, uses a 4-bit register to define their output function:

2-Bit LUT0 is defined by register [1019:1016]

2-Bit LUT1 is defined by register [1023:1020]

Table 23: 2-bit LUT2_0 to 2-bit LUT2_1 Truth Table

| IN1 | IN0 | OUT LUT0 | OUT LUT1 | |
|-----|-----|-----------------|-----------------|-----|
| 0 | 0 | Register [1016] | Register [1020] | LSB |
| 0 | 1 | Register [1017] | Register [1021] | |
| 1 | 0 | Register [1018] | Register [1022] | |
| 1 | 1 | Register [1019] | Register [1023] | MSB |

Table 24 shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the 2-bit LUT logic cells.

Table 24: 2-bit LUT Standard Digital Functions

| Function | MSB | | | LSB |
|----------|-----|---|---|-----|
| AND-2 | 1 | 0 | 0 | 0 |
| NAND-2 | 0 | 1 | 1 | 1 |
| OR-2 | 1 | 1 | 1 | 0 |
| NOR-2 | 0 | 0 | 0 | 1 |
| XOR-2 | 0 | 1 | 1 | 0 |
| XNOR-2 | 1 | 0 | 0 | 1 |

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

7.2 2-BIT LUT OR PROGRAMMABLE PATTERN GENERATOR

The SLG46811 has one combination function macrocell that can serve as a logic or timing function. This macrocell can serve as a Look Up Table (LUT), or Programmable Pattern Generator (PGen).

When used to implement LUT functions, the 2-bit LUT takes in two input signals from the connection matrix and produces a single output, which goes back into the connection matrix. When used as a LUT to implement combinatorial logic functions, the outputs of the LUT can be configured to any user defined function, including the following standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR). The user can also define the combinatorial relationship between inputs and outputs to be any selectable function.

It is possible to define the RST level for the PGen macrocell. There are both high level reset (RST) and a low level reset (nRST) options available which are selected by register [1027]. When operating as a Programmable Pattern Generator, the output of the macrocell will clock out a sequence of two to sixteen bits that are user selectable in their bit values, and user selectable in the number of bits (up to sixteen) that are output before the pattern repeats.

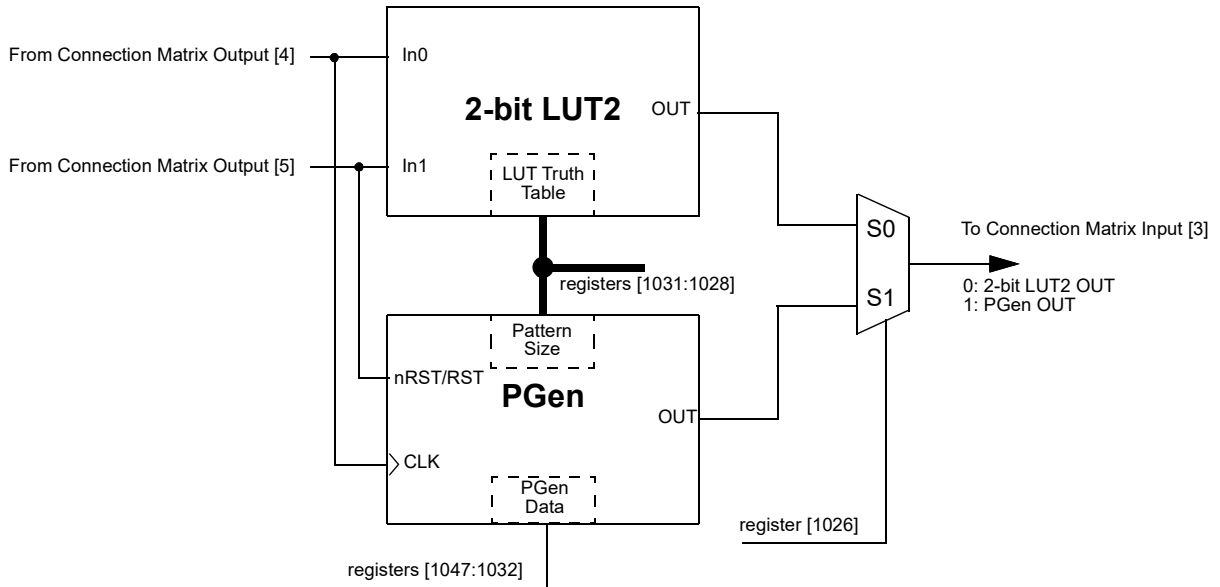
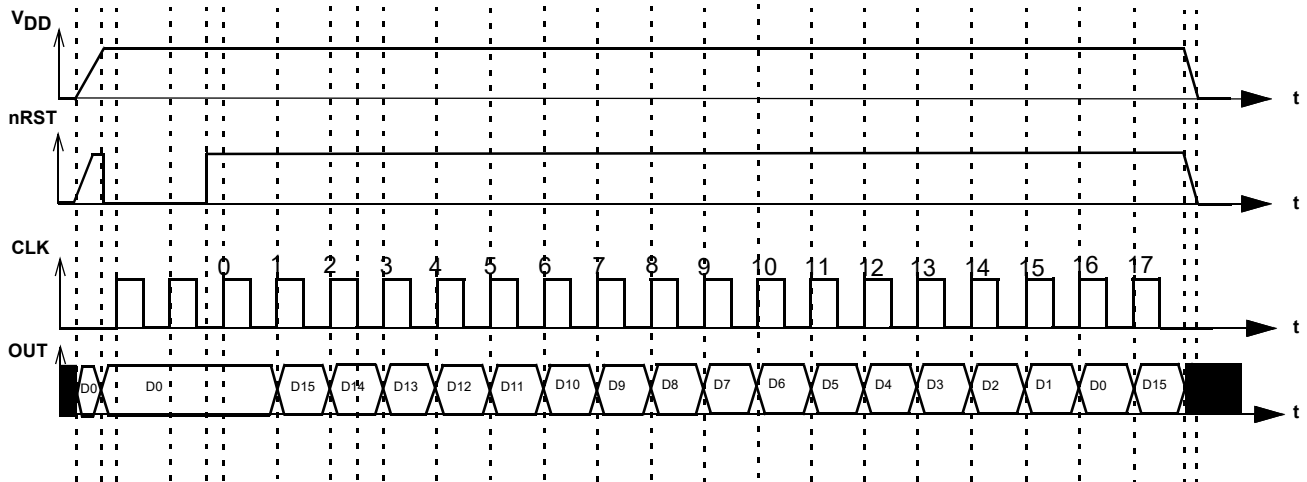


Figure 16: 2-bit LUT2 or PGen


Figure 17: PGen Timing Diagram
Table 25: 2-bit LUT2_2 Truth Table

| IN1 | IN0 | OUT | |
|-----|-----|-----------------|-----|
| 0 | 0 | register [1028] | LSB |
| 0 | 1 | register [1029] | |
| 1 | 0 | register [1030] | |
| 1 | 1 | register [1031] | MSB |

This macrocell, when programmed for a LUT function, uses a 4-bit register to define their output function:

2-Bit LUT2_2 is defined by registers [1031:1028]

Table 26 shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the 2-bit LUT logic cells.

Table 26: 2-bit LUT Standard Digital Functions

| Function | MSB | | | LSB |
|----------|-----|---|---|-----|
| AND-2 | 1 | 0 | 0 | 0 |
| NAND-2 | 0 | 1 | 1 | 1 |
| OR-2 | 1 | 1 | 1 | 0 |
| NOR-2 | 0 | 0 | 0 | 1 |
| XOR-2 | 0 | 1 | 1 | 0 |
| XNOR-2 | 1 | 0 | 0 | 1 |

7.3 3-BIT LUT OR D FLIP-FLOP WITH SET/RESET MACROCELLS OR SHIFT REGISTER MACROCELLS

There are four macrocells that can serve as 3-bit LUT or as DFF/LATCH or as Shift Register. It is also possible to define the active level (Q or nQ) for the macrocell's output by registers [958], [974], [990], [1006]. DFF/Shift Register or LUT are selected by registers [951:948]. When used to implement LUT functions, the 3-bit LUT takes in three input signals from the connection matrix and produce a single output, which goes back into the connection matrix.

When used to implement Shift Register, the three input signals from the connection matrix go to the data (D_IN), clock (CLK), and Set/Reset (nSET/nRST) inputs for the Shift Register, with the output going back to the connection matrix. It is possible to define the active level for the reset/set input of Shift Register macrocell which is selected by registers [955], [971], [987], [1003]. The input data (D_IN) writes into LSB. The Shift Register length (up to 8 bits/memory cells) is selected by registers [954:952], registers [970:968], registers [986:984], and registers [1002:1000]. Shift register length = 1 (corresponding registers = 0) means that DFF/LATCH function is selected. Please note that D and CLK inputs of the Shift Register should remain unchanged while the I²C master is reading data from the Shift Register. Otherwise, the I²C master can read the wrong data. Signals at D and CLK inputs of the Shift Register will be ignored while I²C master is writing a new data to the Shift Register macrocell. Also, note that the reset input of the Shift Register has higher priority to the Shift Register than the I²C write routine.

When used to implement D Flip-Flop/LATCH function, the three input signals from the connection matrix go to the data (D_IN), clock (CLK), and Set/Reset (nSET/nRST) inputs for the Flip-Flop/LATCH, with the output going back to the connection matrix. It is possible to define the active level for the reset/set input (nSET/nRST_sel which is selected by registers [956], [972], [988], [1004]) of DFF/LATCH macrocell. LATCH or DFF configuration is selected by registers [959], [975], [991], [1007].

The operation of the D Flip-Flop and LATCH will follow the functional descriptions below:

DFF: CLK is rising edge triggered, then Q = D; otherwise Q will not change.

LATCH: when CLK is Low, then Q = D; otherwise Q remains its previous value (input D has no effect on the output, when CLK is High).

Special care must be taken when writing new data to bytes 78h, 7Ah, 7Ch, 7Eh via I²C. If LUT/DFF/LATCH/Shift_Register macrocells configured as DFF or LATCH, writing new data to LSB of bytes 78h, 7Ah, 7Ch, 7Eh can change the current state of DFF (LATCH).

It's possible to read/write the Shift Register content via I²C (bytes 78h, 7Ah, 7Ch, 7Eh). Note that CLK signal of the Shift Register should be low when getting access to the Shift Register macrocell via I²C.

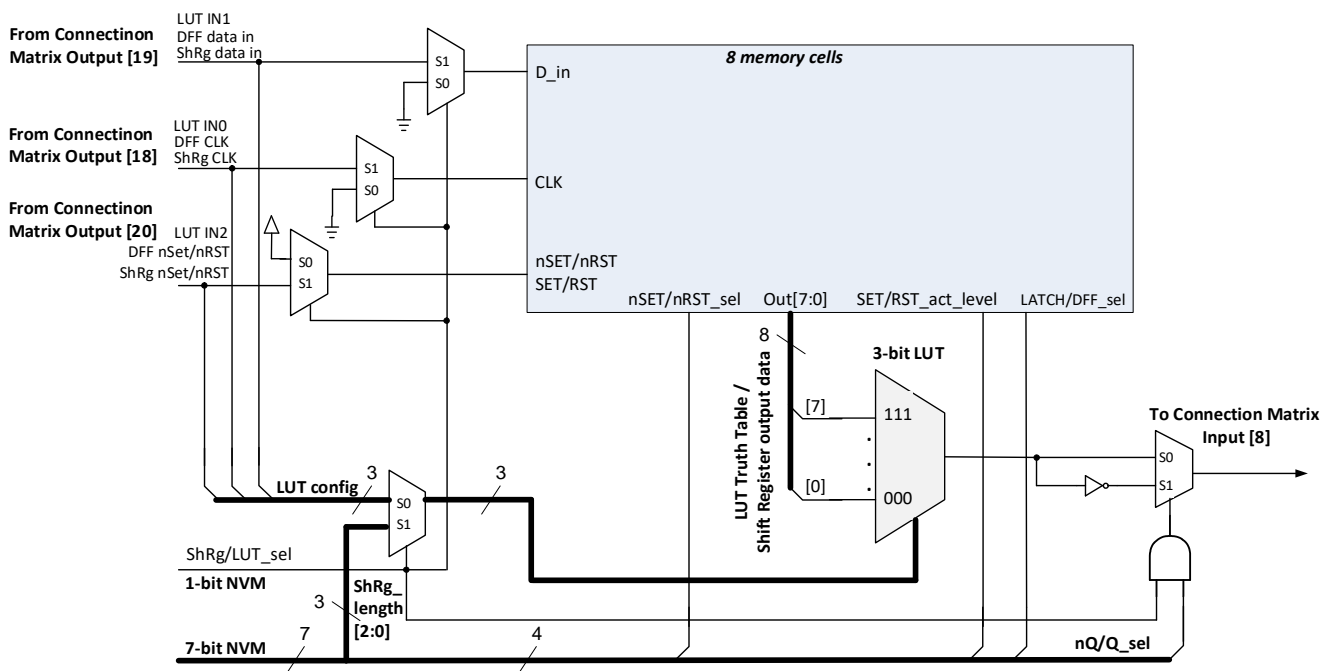


Figure 18: 3-bit LUT4 or DFF6 or Shift Register 0

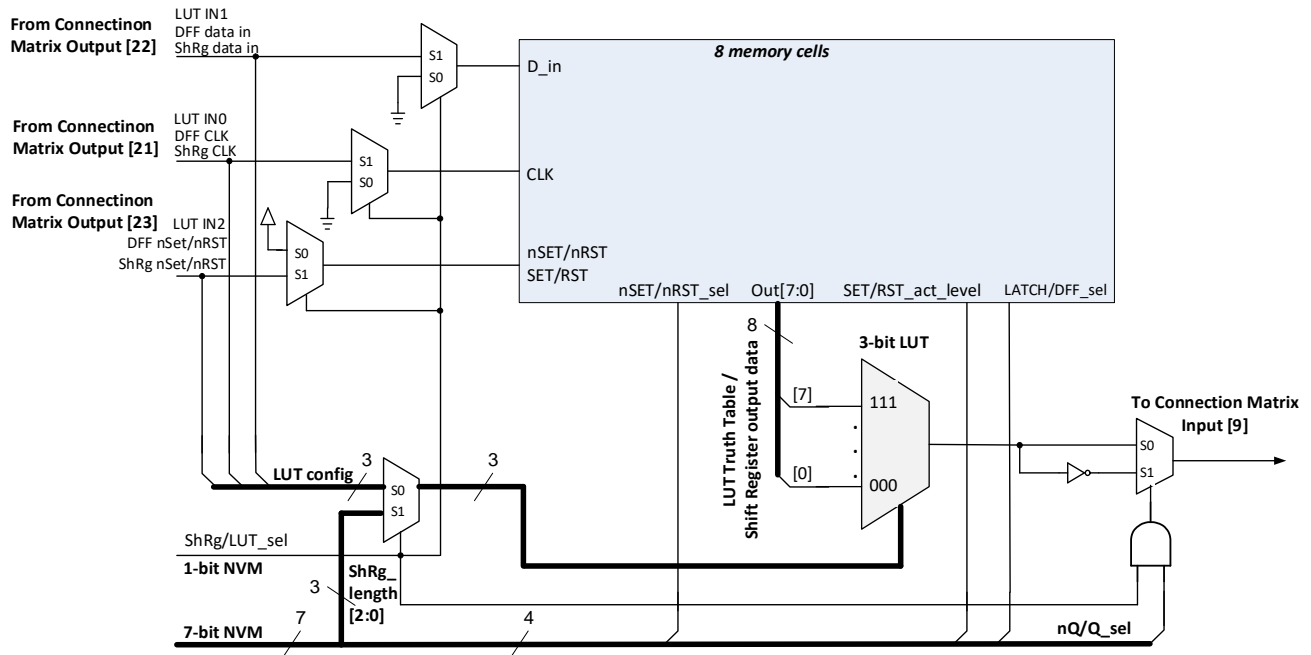


Figure 19: 3-bit LUT5 or DFF7 or Shift Register 1

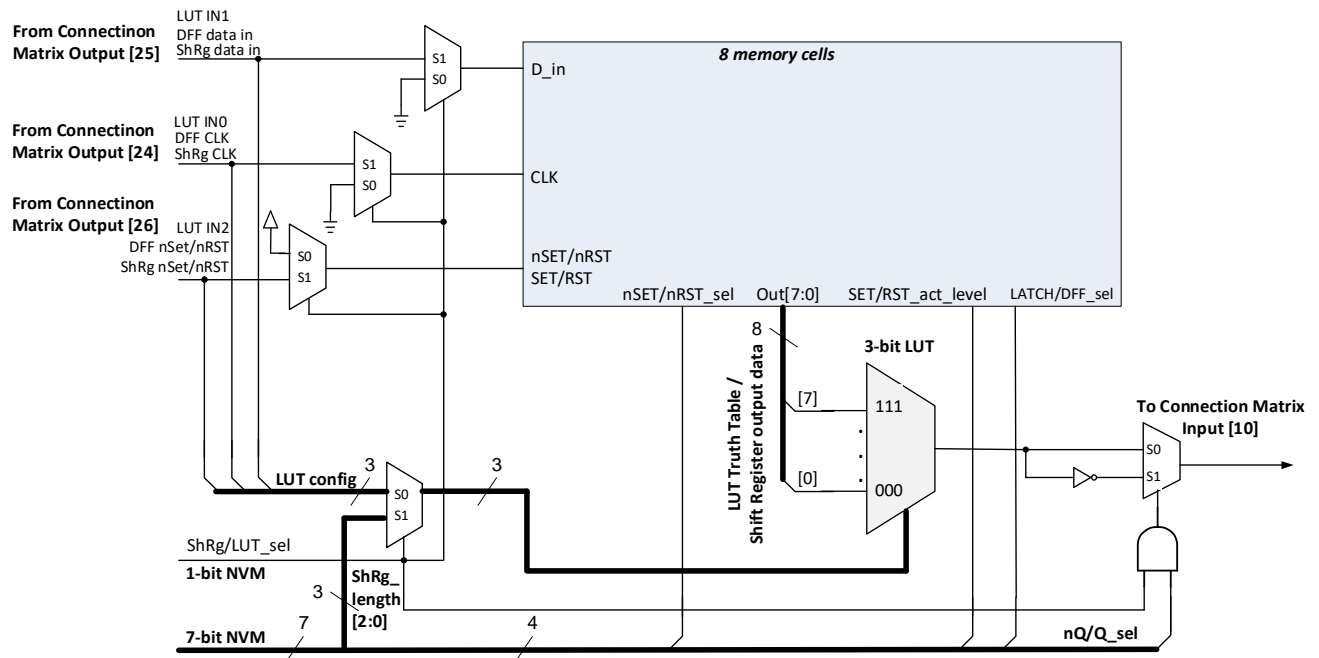


Figure 20: 3-bit LUT6 or DFF8 or Shift Register 2

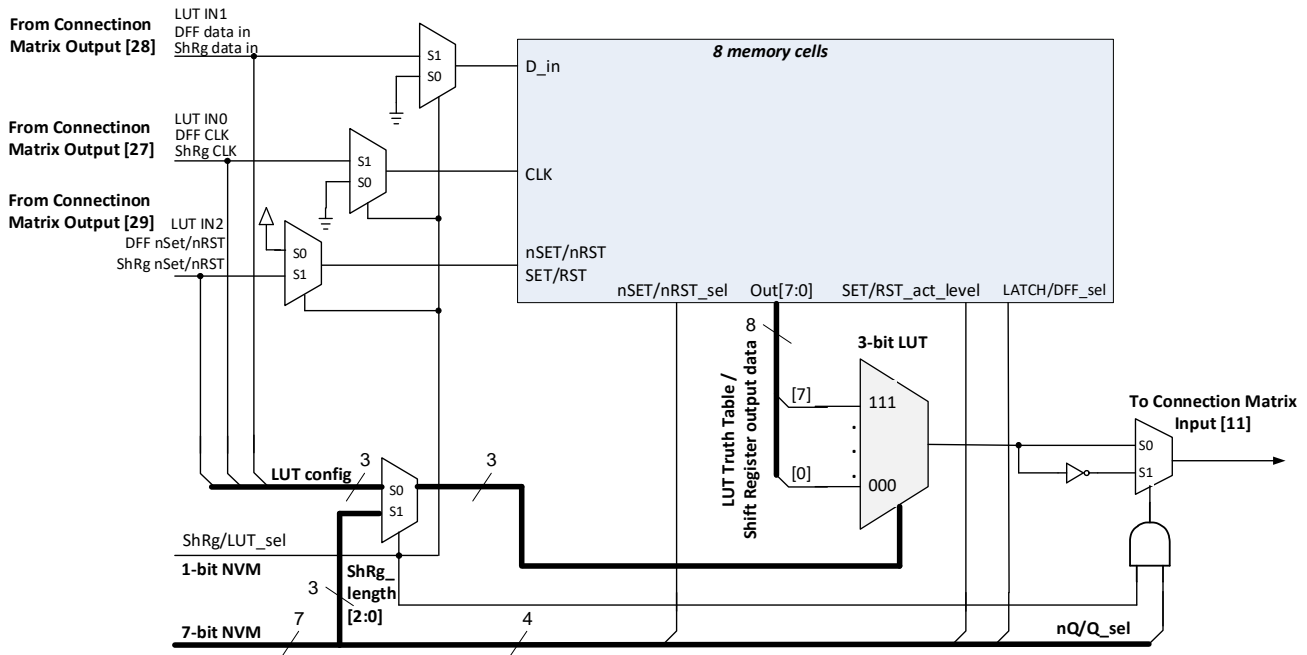
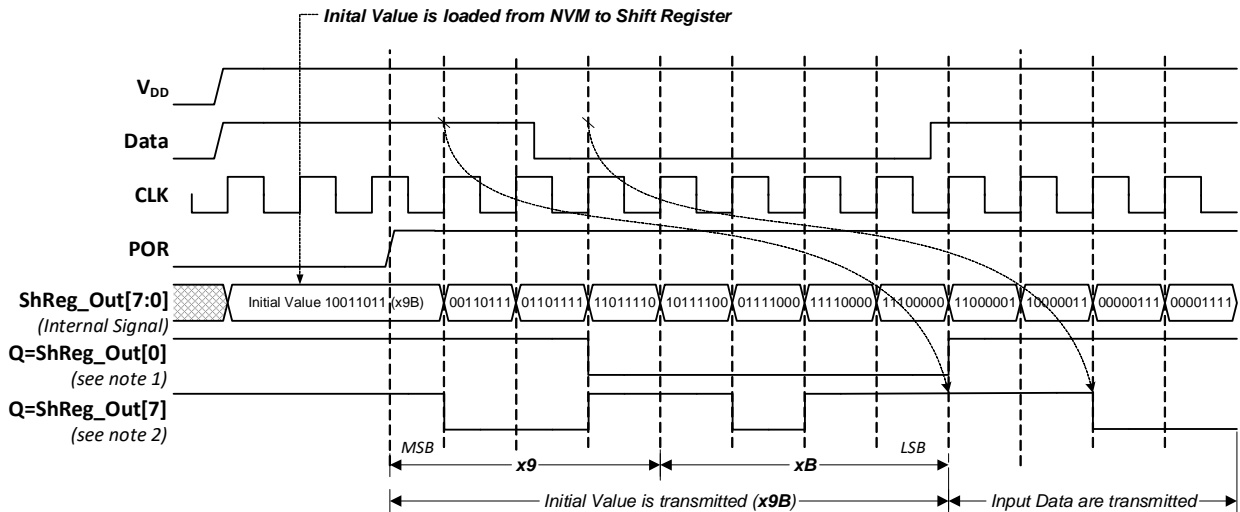


Figure 21: 3-bit LUT7 or DFF9 or Shift Register 3



Note1 :Macrocell is configured as DFF
 Note2 : Macrocell is configured as 8-bit Shift Register

Figure 22: DFF6 to DFF9 or Shift Register 0 to Shift Register 3 Operation

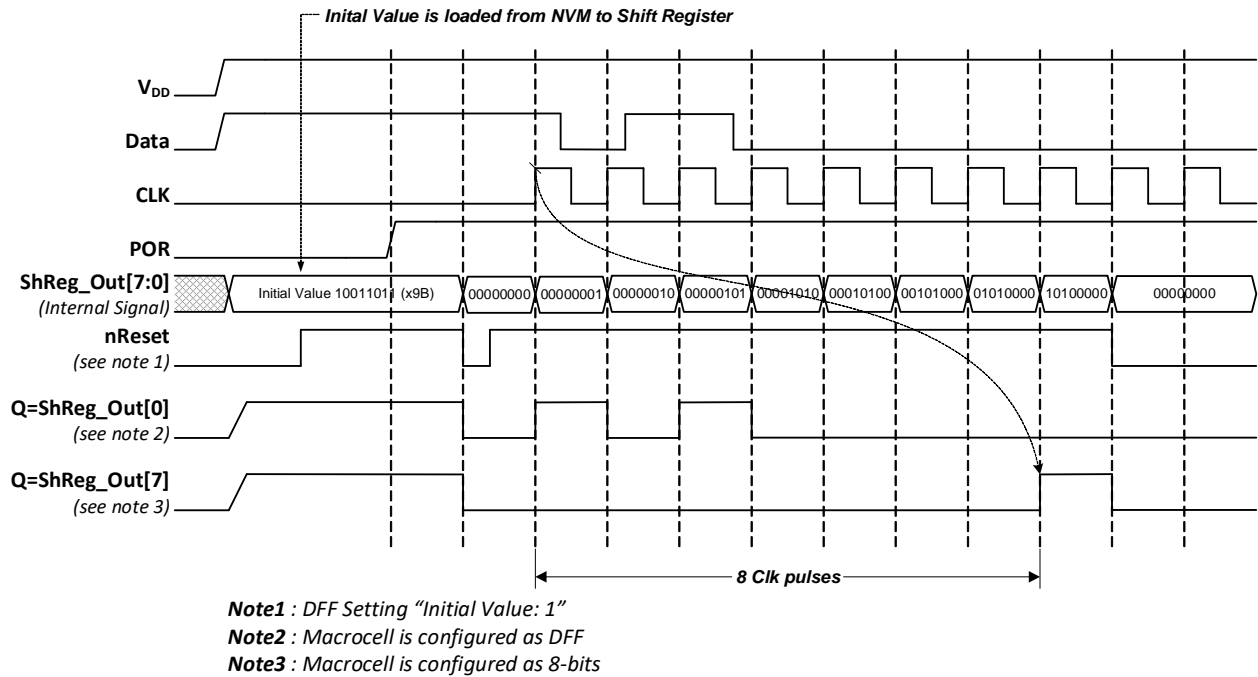


Figure 23: DFF6 to DFF9 or Shift Register 0 to Shift Register 3 Operation, nReset Option, DFF Initial Value: 1

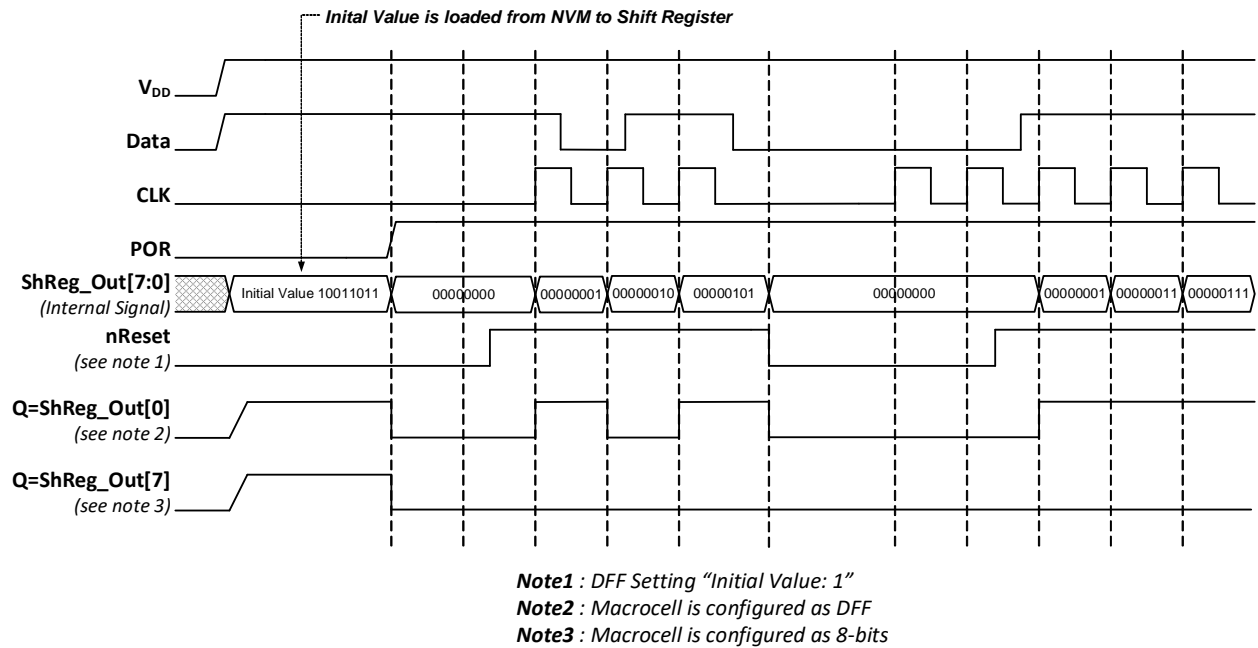


Figure 24: DFF6 to DFF9 or Shift Register 0 to Shift Register 3 Operation, nReset Option, DFF Initial Value: 1, Case 1

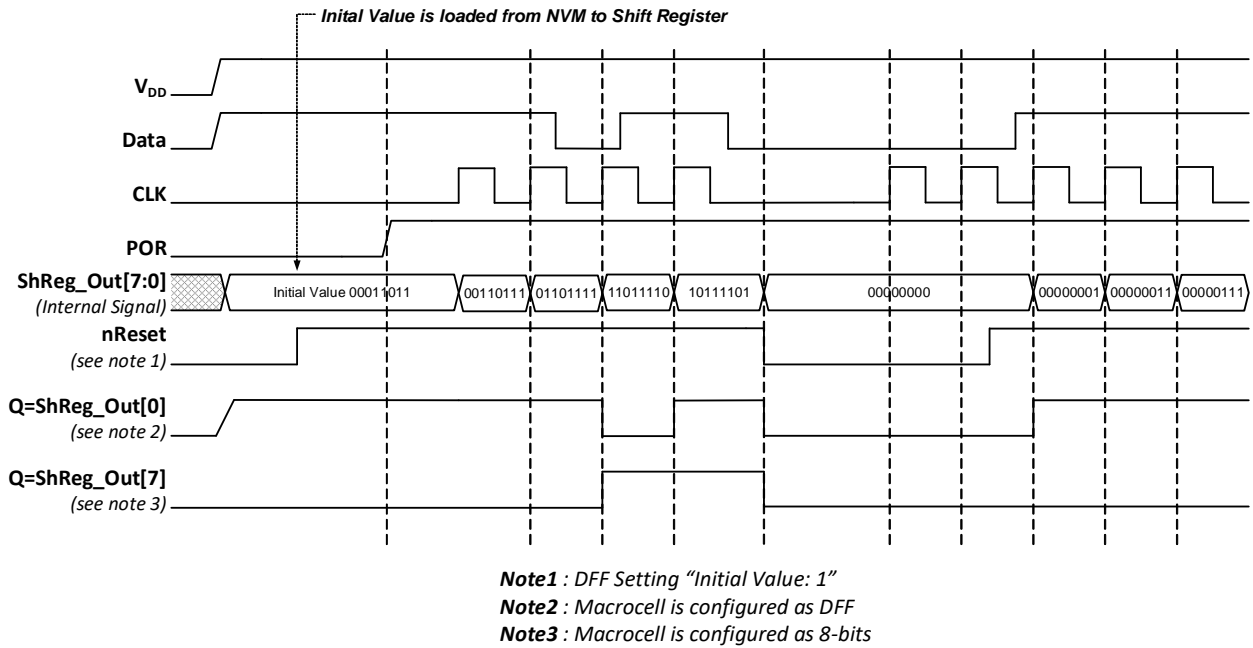


Figure 25: DFF6 to DFF9 or Shift Register 0 to Shift Register 3 Operation, nReset Option, DFF Initial Value: 1, Case 2

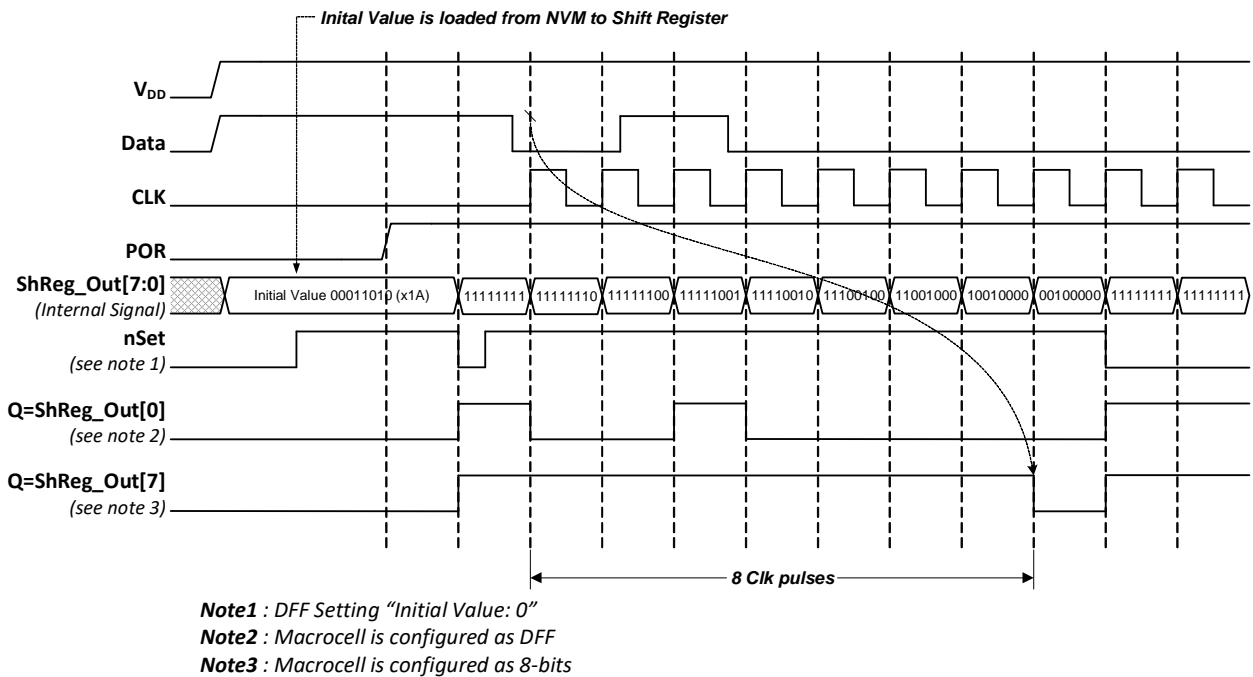


Figure 26: DFF6 to DFF9 or Shift Register 0 to Shift Register 3 Operation, nSet Option, DFF Initial Value: 0

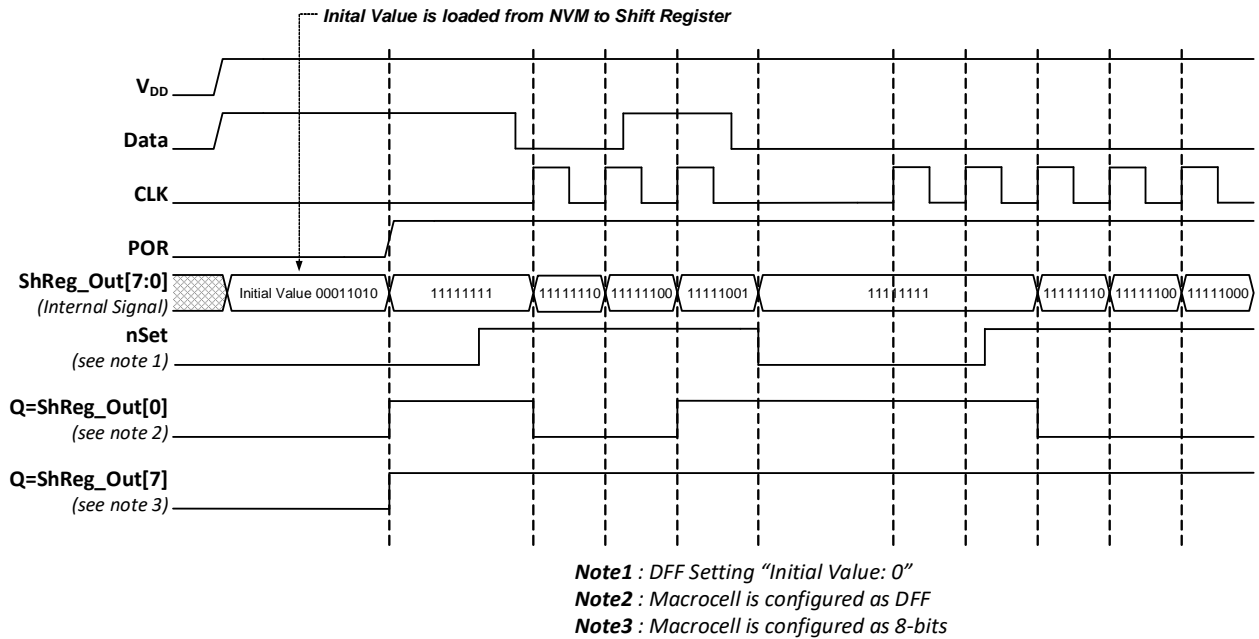


Figure 27: DFF6 to DFF9 or Shift Register 0 to Shift Register 3 Operation, nSet Option, DFF Initial Value: 0, Case 1

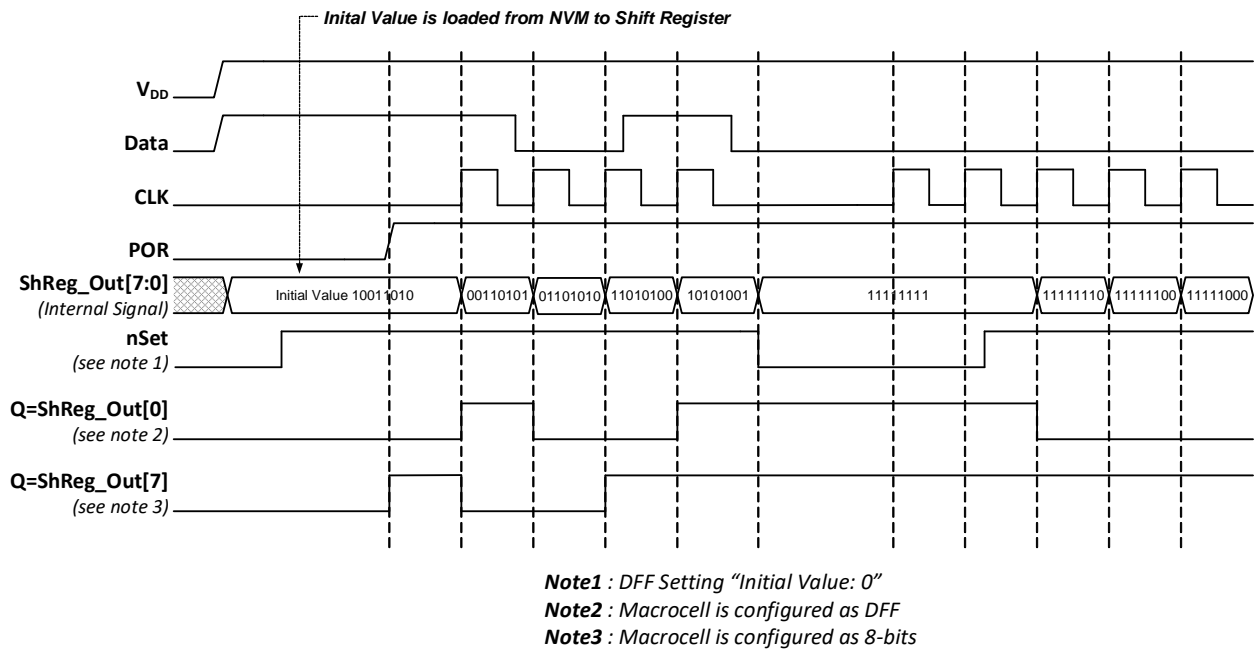


Figure 28: DFF6 to DFF9 or Shift Register 0 to Shift Register 3 Operation, nSet Option, DFF Initial Value: 0, Case 2

7.3.1 3-Bit LUT or D Flip-Flop Macrocells Used as 3-Bit LUTs

Each macrocell, when programmed for a LUT function, uses an 8-bit register to define their output function:

3-Bit LUT3_0 is defined by registers [895:888]

3-Bit LUT3_1 is defined by registers [903:896]

3-Bit LUT3_2 is defined by registers [911:904]

3-Bit LUT3_3 is defined by registers [919:912]

3-Bit LUT3_4 is defined by registers [967:960]

3-Bit LUT3_5 is defined by registers [983:976]

3-Bit LUT3_6 is defined by registers [999:992]

3-Bit LUT3_7 is defined by registers [1015:1008]

Table 27: 3-bit LUT3_0 to 3-bit LUT3_9 Truth Table

| IN2 | IN1 | IN0 | OUT LUT3_0 | OUT LUT3_1 | OUT LUT3_2 | OUT LUT3_3 | OUT LUT3_4 | OUT LUT3_5 | OUT LUT3_6 | OUT LUT3_7 | |
|-----|-----|-----|----------------|----------------|----------------|----------------|----------------|----------------|----------------|-----------------|-----|
| 0 | 0 | 0 | register [888] | register [896] | register [904] | register [912] | register [960] | register [976] | register [992] | register [1008] | LSB |
| 0 | 0 | 1 | register [889] | register [897] | register [905] | register [913] | register [961] | register [977] | register [993] | register [1009] | |
| 0 | 1 | 0 | register [890] | register [898] | register [906] | register [914] | register [962] | register [978] | register [994] | register [1010] | |
| 0 | 1 | 1 | register [891] | register [899] | register [907] | register [915] | register [963] | register [979] | register [995] | register [1011] | |
| 1 | 0 | 0 | register [892] | register [900] | register [908] | register [916] | register [964] | register [980] | register [996] | register [1012] | |
| 1 | 0 | 1 | register [893] | register [901] | register [909] | register [917] | register [965] | register [981] | register [997] | register [1013] | |
| 1 | 1 | 0 | register [894] | register [902] | register [910] | register [918] | register [966] | register [982] | register [998] | register [1014] | |
| 1 | 1 | 1 | register [895] | register [903] | register [911] | register [919] | register [967] | register [983] | register [999] | register [1015] | MSB |

Table 28 shows the register bits for the standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR) that can be created within each of the four 3-bit LUT logic cells.

Table 28: 3-bit LUT Standard Digital Functions

| Function | MSB | | | | | | | LSB |
|----------|-----|---|---|---|---|---|---|-----|
| AND-3 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| NAND-3 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| OR-3 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| NOR-3 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| XOR-3 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 |
| XNOR-3 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 |

7.4 3-BIT LUT OR D FLIP-FLOP WITH SET/RESET MACROCELLS

There are 4 macrocells that can serve as either 3-bit LUTs or as D Flip-Flops with Set/Reset inputs. When used to implement LUT functions, the 3-bit LUTs each take in three input signals from the connection matrix and produce a single output, which goes back into the connection matrix. When used to implement D Flip-Flop function, the three input signals from the connection matrix go to the data (D) and clock (CLK), and Reset/Set (nRST/nSET) inputs for the Flip-Flop, with the output going back to the connection matrix. It is possible to define the active level for the reset/set input of DFF/LATCH macrocell. There are both active high level Reset/Set (RST/SET) and active low level Reset/Set (nRST/nSET) options available which are selected by register [890].

DFF2 operation will flow the functional description below:

- If register [892] = 0, and the CLK is rising edge triggered, then Q = D, otherwise Q will not change.
- If register [892] = 1, then data from D is written into the DFF by the rising edge on CLK and output to Q by the falling edge on CLK.

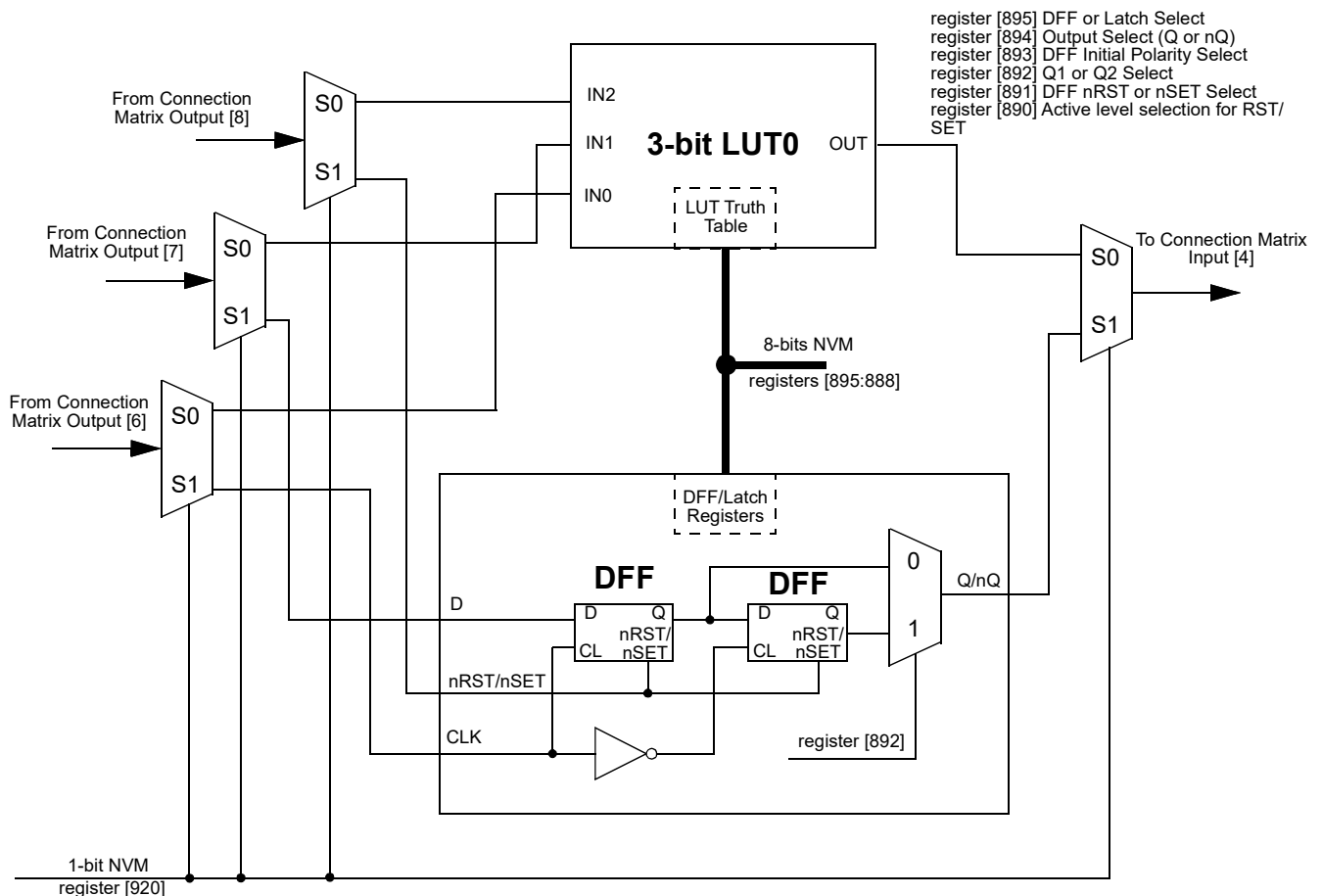


Figure 29: 3-bit LUT0 or DFF2

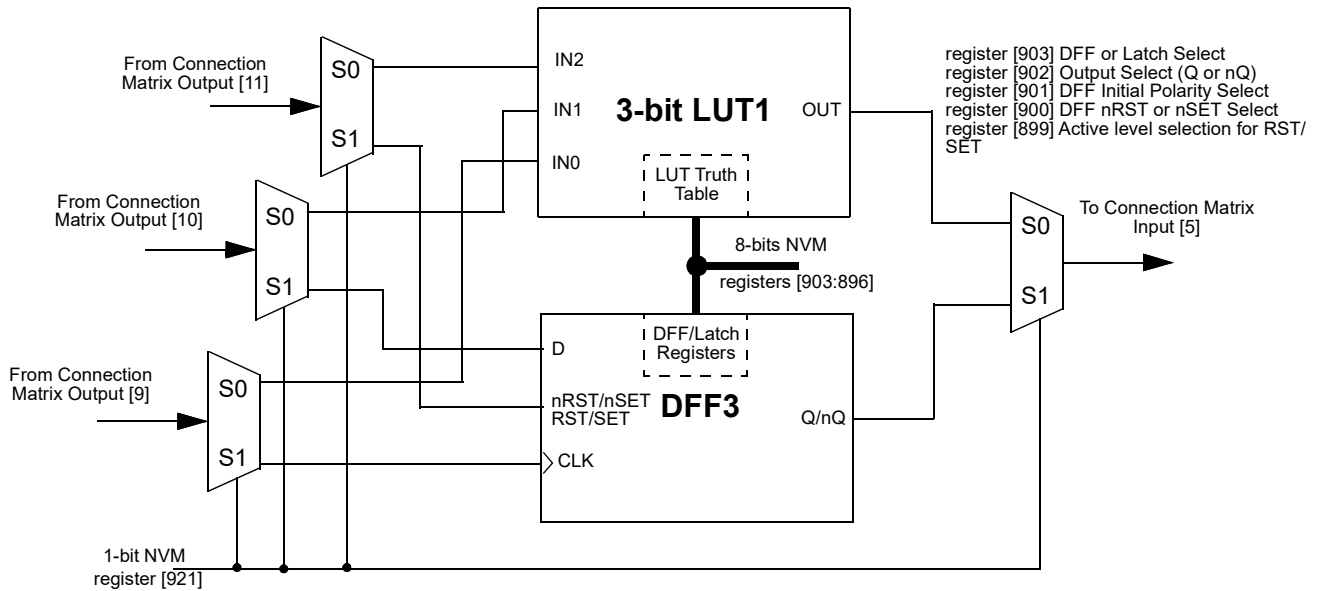


Figure 30: 3-bit LUT1 or DFF3

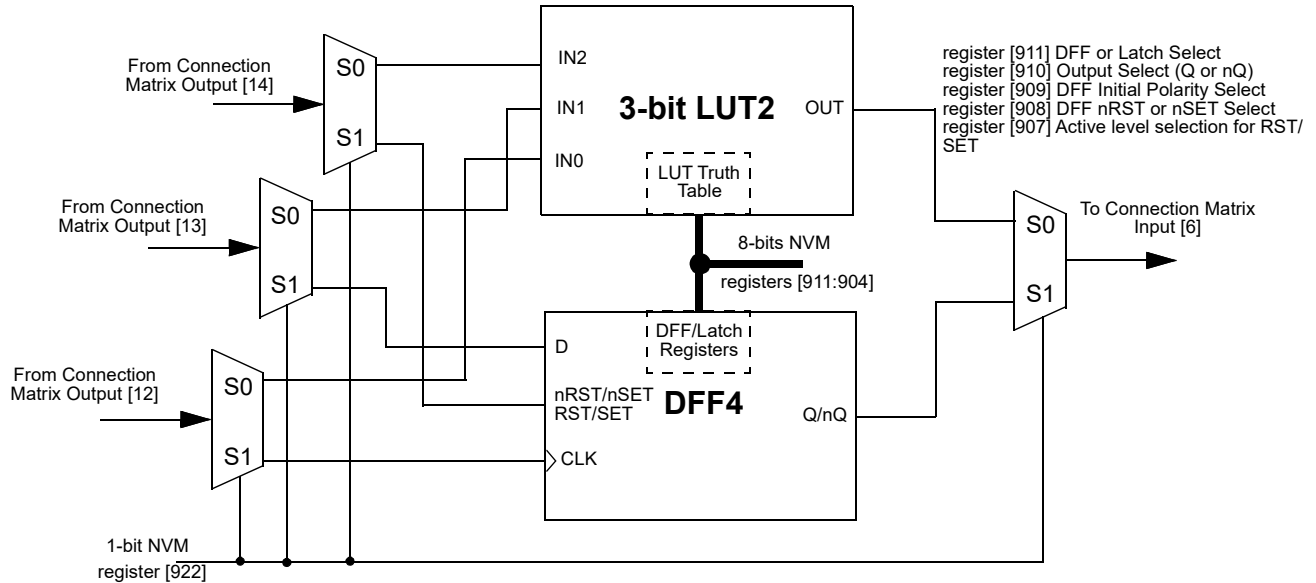


Figure 31: 3-bit LUT2 or DFF4

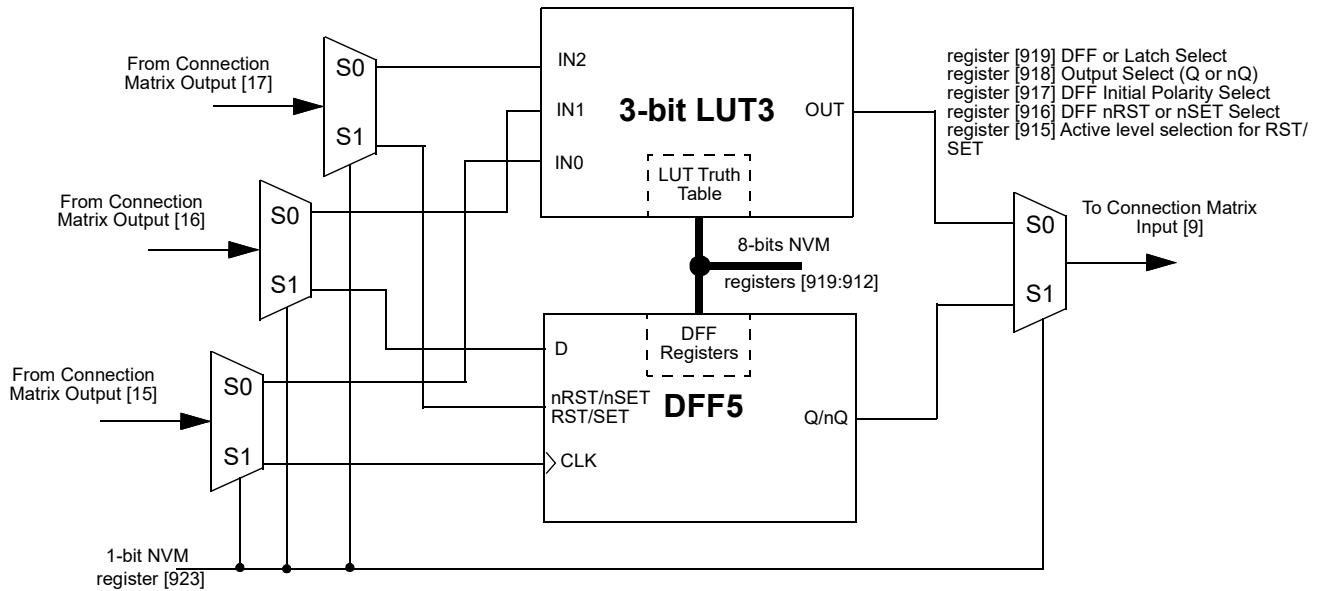


Figure 32: 3-bit LUT3 or DFF5

7.5 4-BIT LUT OR D FLIP-FLOP WITH SET/RESET MACROCELL

There is one macrocell that can serve as either a 4-bit LUT or as a D Flip-Flop with Set/Reset inputs. When used to implement LUT functions, the 4-bit LUT takes in four input signals from the connection matrix and produce a single output, which goes back into the connection matrix. When used to implement D Flip-Flop function, the input signals from the connection matrix go to the data (D) and clock (CLK), and Reset/Set (nRST/nSET) inputs for the Flip-Flop, with the output going back to the connection matrix

- If register [943] = 0, and the CLK is rising edge triggered, then Q = D, otherwise Q will not change.
- If register [943] = 1, then data from D is written into the DFF by the rising edge on CLK and output to Q by the falling edge on CLK.

It is possible to define the active level for the reset/set input of DFF/LATCH macrocell. There are both active high level reset/set (RST/SET) and active low level reset/set (nRST/nSET) options available which are selected by register [938].

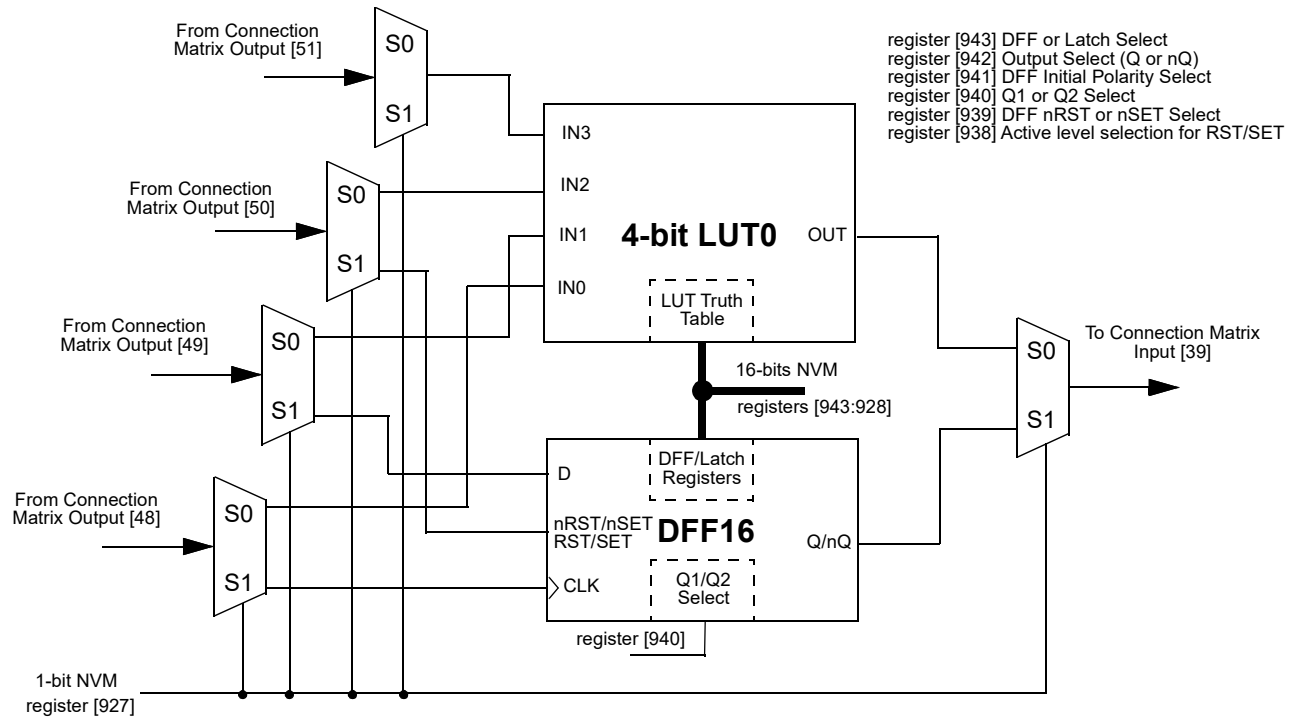


Figure 33: 4-bit LUT0 or DFF16

7.5.1 4-Bit LUT Macrocell Used as 4-Bit LUT

Table 29: 4-bit LUT0 Truth Table

| IN3 | IN2 | IN1 | IN0 | OUT | |
|-----|-----|-----|-----|----------------|-----|
| 0 | 0 | 0 | 0 | register [928] | LSB |
| 0 | 0 | 0 | 1 | register [929] | |
| 0 | 0 | 1 | 0 | register [930] | |
| 0 | 0 | 1 | 1 | register [931] | |
| 0 | 1 | 0 | 0 | register [932] | |
| 0 | 1 | 0 | 1 | register [933] | |
| 0 | 1 | 1 | 0 | register [934] | |
| 0 | 1 | 1 | 1 | register [935] | |
| 1 | 0 | 0 | 0 | register [936] | |
| 1 | 0 | 0 | 1 | register [937] | |
| 1 | 0 | 1 | 0 | register [938] | |
| 1 | 0 | 1 | 1 | register [939] | |
| 1 | 1 | 0 | 0 | register [940] | |
| 1 | 1 | 0 | 1 | register [941] | |
| 1 | 1 | 1 | 0 | register [942] | |
| 1 | 1 | 1 | 1 | register [943] | MSB |

This macrocell, when programmed for a LUT function, uses a 16-bit register to define their output function:

4-Bit LUT0 is defined by registers [943:928]

Table 30: 4-bit LUT Standard Digital Functions

| Function | MSB | | | | | | | | | | | | | | | LSB |
|----------|-----|---|---|---|---|---|---|---|---|---|---|---|---|---|---|-----|
| AND-4 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| NAND-4 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 |
| OR-4 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 0 |
| NOR-4 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 |
| XOR-4 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 |
| XNOR-4 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 1 |

8 Multi-Function Macrocells

The SLG46811 has 6 Multi-Function macrocells that can serve more than one logic or timing function. In each case, they can serve as a LUT, DFF with flexible settings, or as CNT/DLY with multiple modes such as One Shot, Frequency Detect, Edge Detect, and others. Also, the macrocell is capable to combine those functions: LUT/DFF connected to CNT/DLY or CNT/DLY connected to LUT/DFF, see Figure 34.

See the list below for the functions that can be implemented in these macrocells:

- Five macrocells that can serve as 3-bit LUTs/D Flip-Flops and as 8-Bit Counter/Delays
- One macrocell that can serve as a 3-bit LUT/D Flip-Flop and as 8-Bit Counter/Delay/FSM

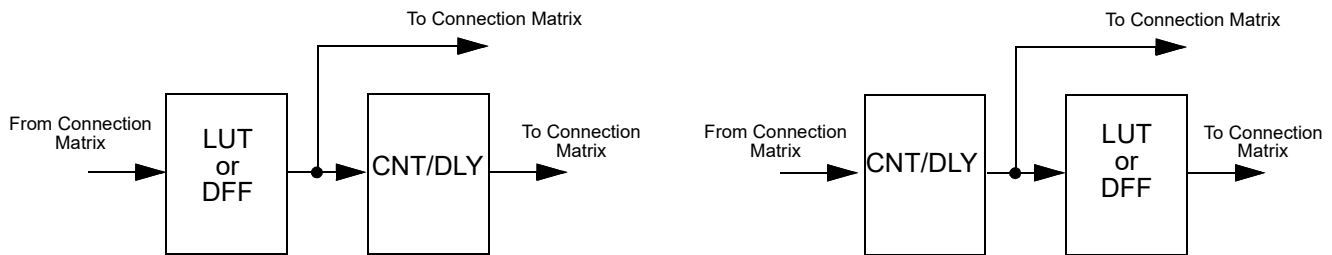


Figure 34: Possible Connections Inside Multi-Function Macrocell

Inputs/Outputs for the 6 Multi-Function function macrocells are configured from the connection matrix with specific logic functions being defined by the state of NVM bits.

When used as a LUT to implement combinatorial logic functions, the outputs of the LUTs can be configured to any user defined function, including the following standard digital logic devices (AND, NAND, OR, NOR, XOR, XNOR).

8.1 3-BIT LUT OR DFF/LATCH WITH 8-BIT COUNTER/DELAY MACROCELLS

There are five macrocells that can serve as 3-bit LUTs/D Flip-Flops and as 8-Bit Counter/Delays.

When used to implement LUT functions, the 3-bit LUTs each take in three input signals from the connection matrix and produce a single output, which goes back into the connection matrix or can be connected to CNT/DLY's input.

When used to implement D Flip-Flop function, the three input signals from the connection matrix go to the data (D), clock (CLK), and Set/Reset (nRST/nSET) inputs of the Flip-Flop, with the output going back to the connection matrix or to the CNT/DLY's input.

When used to implement Counter/Delays, each macrocell has a dedicated matrix input connection. For flexibility, each of these macrocells has a large selection of internal and external clock sources, as well as the option to chain from the output of the previous (N-1) CNT/DLY macrocell, to implement longer count/delay circuits. These macrocells can also operate in a One-Shot mode, which will generate an output pulse of user-defined width. They can also operate in a Frequency Detection or Edge Detection mode.

Counter/Delay macrocell has an initial value, which define its initial value after SLG46811 is powered up. It is possible to select initial Low or initial High, as well as initial value defined by a Delay In signal.

For example, in case initial LOW option is used, the rising edge delay will start operation.

For timing diagrams refer to sections 7.1 and 8.2.

Note: After two DFF – counters initialize with counter data = 0 after POR.
 Initial state = 1 – counters initialize with counter data = 0 after POR.
 Initial state = 0 And After two DFF is bypass – counters initialize with counter data after POR.

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CNT/DLY0/FSM macrocell has an optional Finite State Machine (FSM) function. There is one additional Up/Down matrix input in FSM mode.

8.1.1 3-Bit LUT or 8-Bit CNT/DLY Block Diagrams

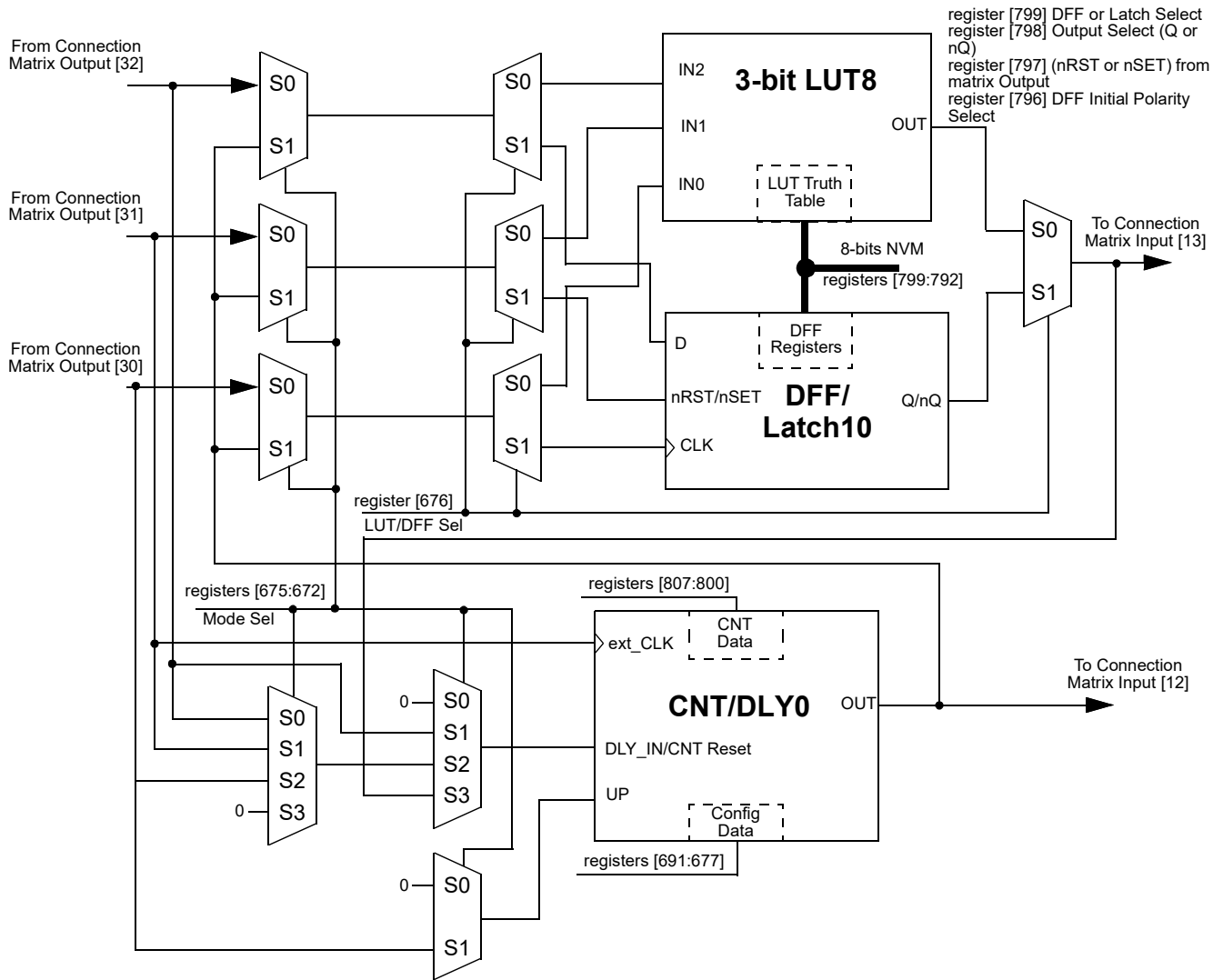


Figure 35: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT8/DFF10, CNT/DLY0/FSM)

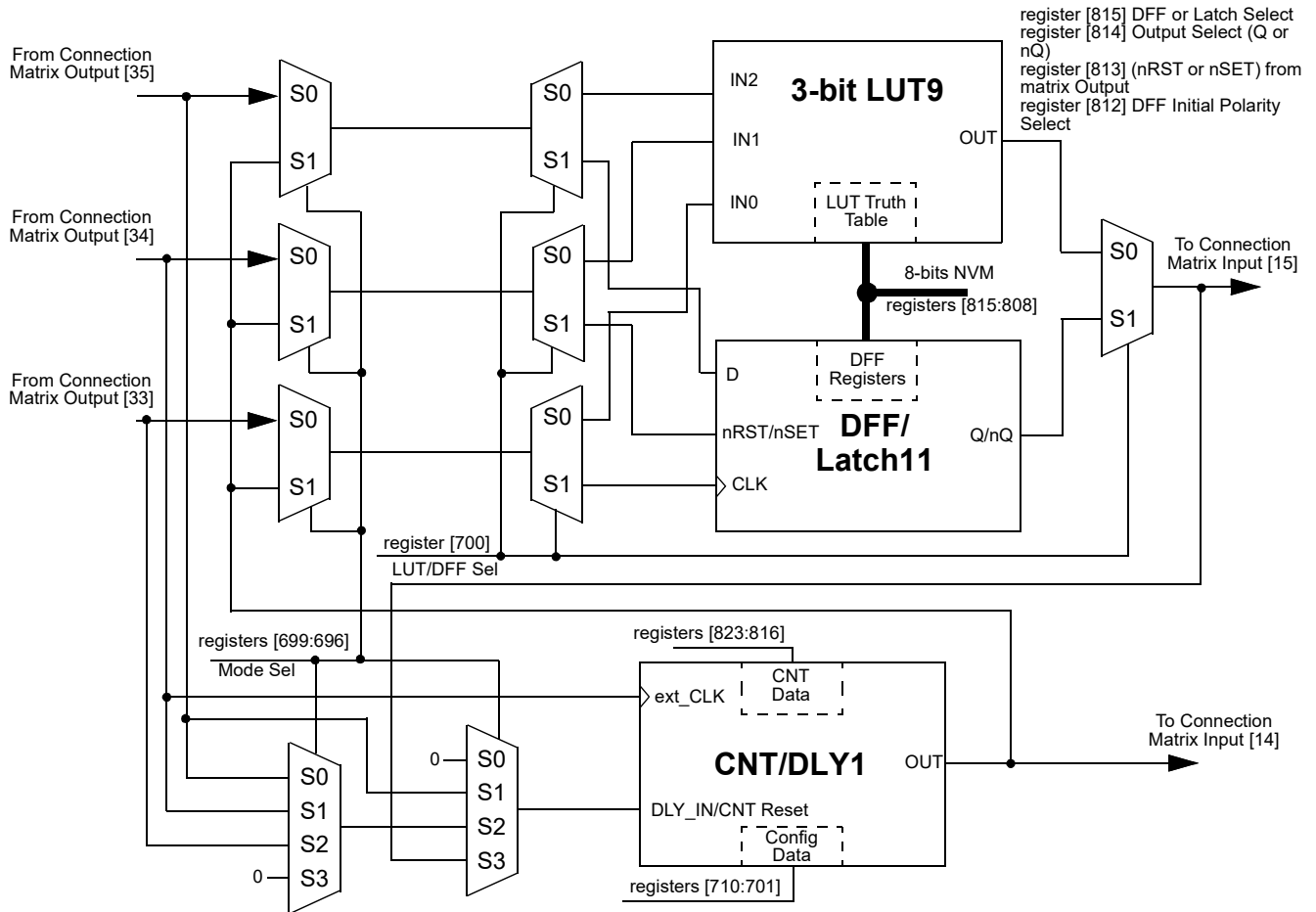


Figure 36: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT9/DFF11, CNT/DLY1)

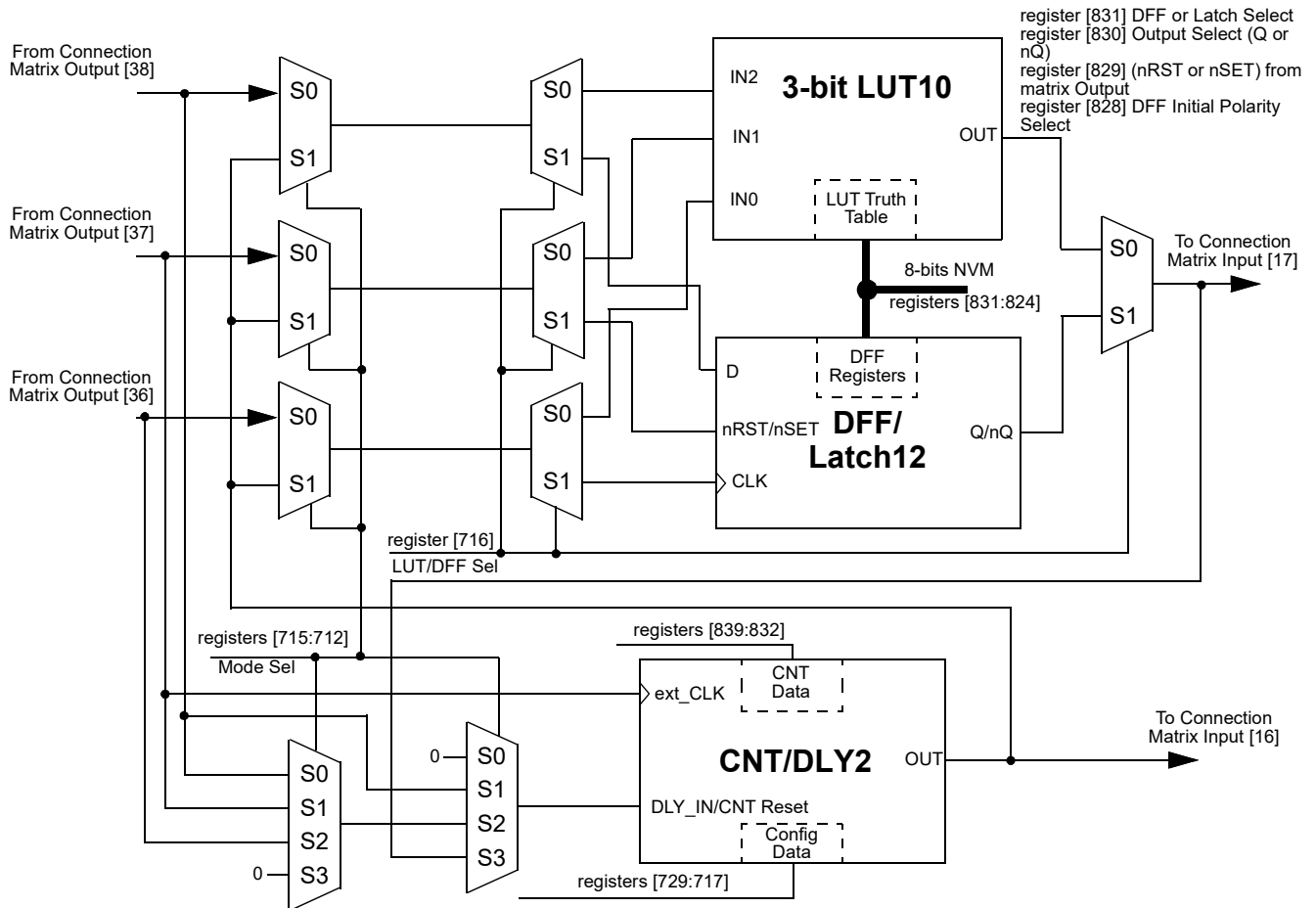


Figure 37: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT10/DFF12, CNT/DLY2)

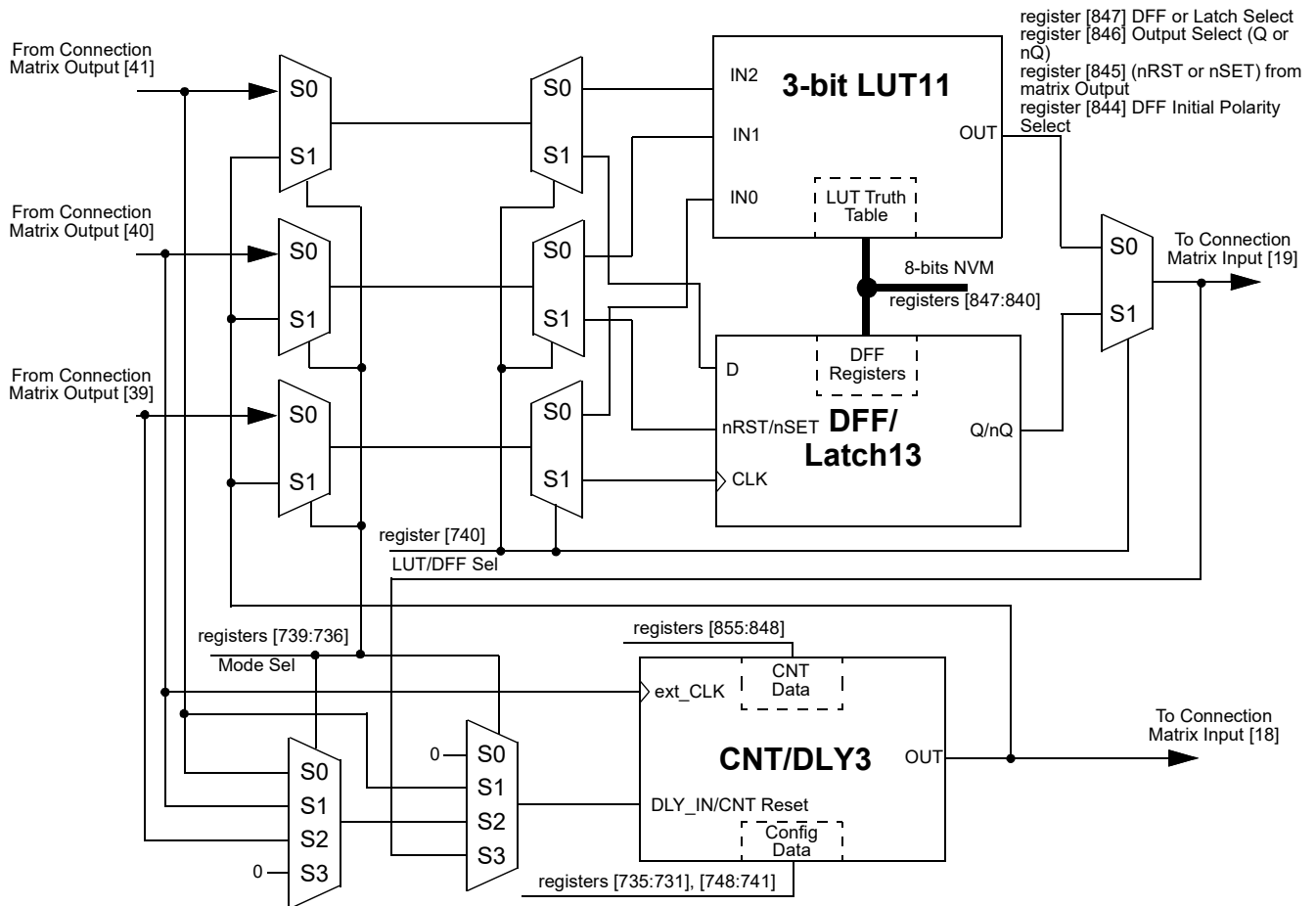


Figure 38: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT11/DFF13, CNT/DLY3)

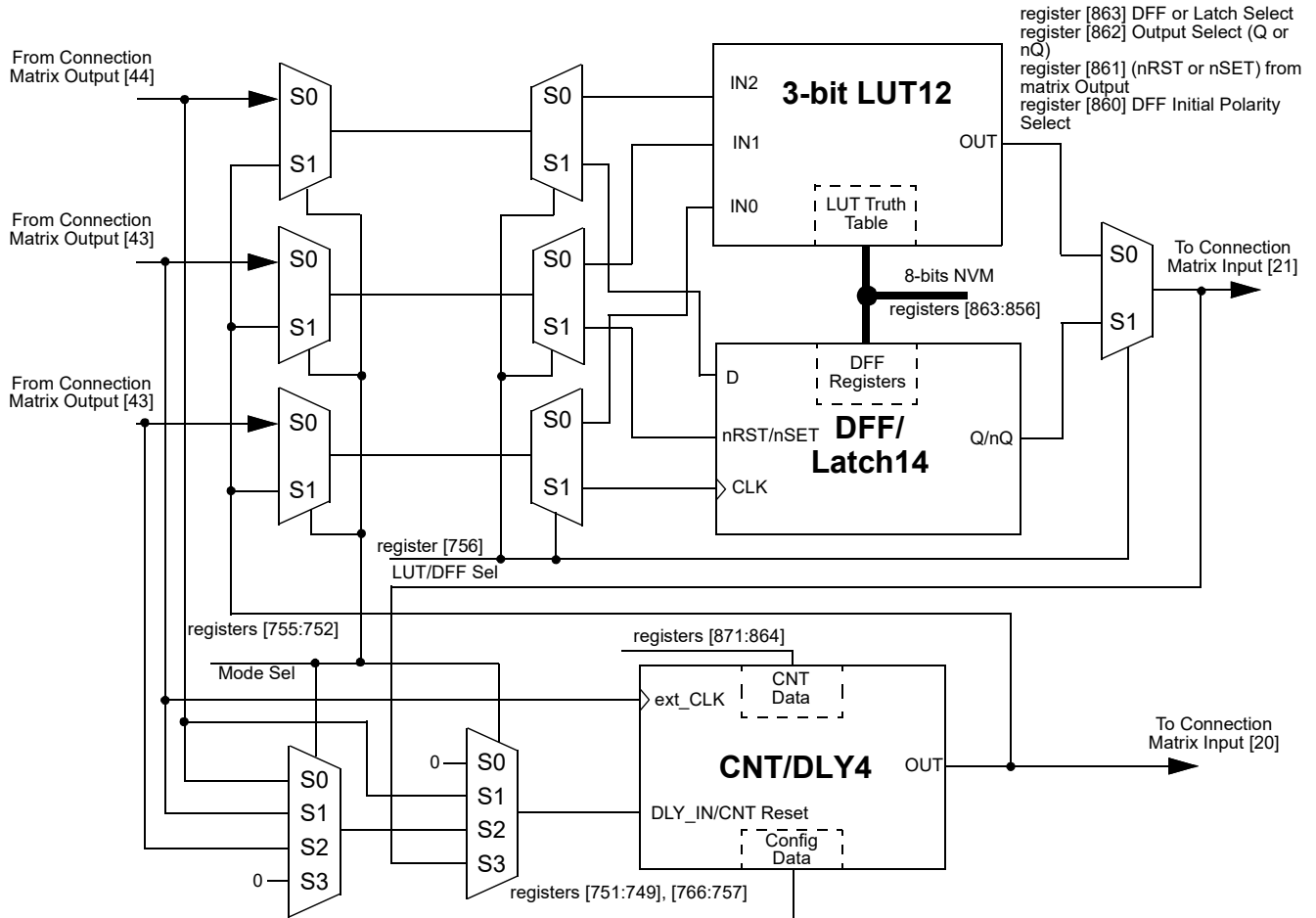


Figure 39: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT12/DFF14, CNT/DLY4)

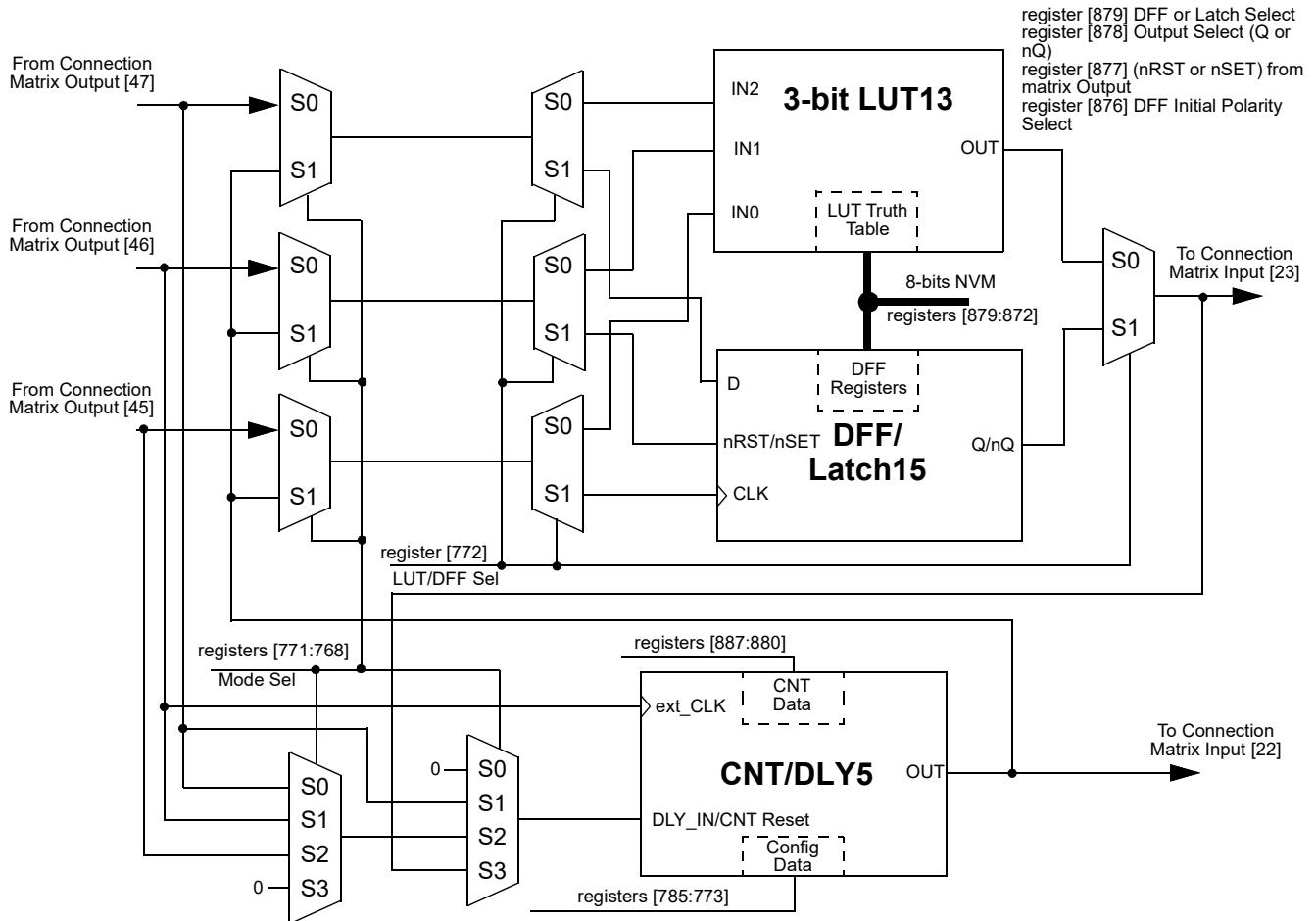


Figure 40: 8-bit Multi-Function Macrocells Block Diagram (3-bit LUT13/DFF15, CNT/DLY5)

As shown in Figure 35 - Figure 40 there is a possibility to use LUT/DFF and CNT/DLY simultaneously.

Note: It is not possible to use LUT and DFF at once, one of these macrocells must be selected.

- Case 1. LUT/DFF in front of CNT/DLY. Three input signals from the connection matrix go to previously selected LUT or DFF's inputs and produce a single output which goes to a CNT/DLY input. In its turn Counter/Delay's output goes back to the matrix.
- Case 2. CNT/DLY in front of LUT/DFF. Two input signals from the connection matrix go to CNT/DLY's inputs (IN and CLK). Its output signal can be connected to any input of previously selected LUT or DFF, after which the signal goes back to the matrix.
- Case 3. Single LUT/DFF or CNT/DLY. Also, it is possible to use a standalone LUT/DFF or CNT/DLY. In this case, all inputs and output of the macrocell are connected to the matrix.

8.1.2 3-Bit LUT or CNT/DLYs Used as 3-Bit LUTs
Table 31: 3-bit LUT8 Truth Table

| IN2 | IN1 | IN0 | OUT | |
|-----|-----|-----|----------------|-----|
| 0 | 0 | 0 | register [792] | LSB |
| 0 | 0 | 1 | register [793] | |
| 0 | 1 | 0 | register [794] | |
| 0 | 1 | 1 | register [795] | |
| 1 | 0 | 0 | register [796] | |
| 1 | 0 | 1 | register [797] | |
| 1 | 1 | 0 | register [798] | |
| 1 | 1 | 1 | register [799] | MSB |

Table 32: 3-bit LUT9 Truth Table

| IN2 | IN1 | IN0 | OUT | |
|-----|-----|-----|----------------|-----|
| 0 | 0 | 0 | register [808] | LSB |
| 0 | 0 | 1 | register [809] | |
| 0 | 1 | 0 | register [810] | |
| 0 | 1 | 1 | register [811] | |
| 1 | 0 | 0 | register [812] | |
| 1 | 0 | 1 | register [813] | |
| 1 | 1 | 0 | register [814] | |
| 1 | 1 | 1 | register [815] | MSB |

Table 33: 3-bit LUT10 Truth Table

| IN2 | IN1 | IN0 | OUT | |
|-----|-----|-----|----------------|-----|
| 0 | 0 | 0 | register [824] | LSB |
| 0 | 0 | 1 | register [825] | |
| 0 | 1 | 0 | register [826] | |
| 0 | 1 | 1 | register [827] | |
| 1 | 0 | 0 | register [828] | |
| 1 | 0 | 1 | register [829] | |
| 1 | 1 | 0 | register [830] | |
| 1 | 1 | 1 | register [831] | MSB |

Table 34: 3-bit LUT11 Truth Table

| IN2 | IN1 | IN0 | OUT | |
|-----|-----|-----|----------------|-----|
| 0 | 0 | 0 | register [840] | LSB |
| 0 | 0 | 1 | register [841] | |
| 0 | 1 | 0 | register [842] | |
| 0 | 1 | 1 | register [843] | |
| 1 | 0 | 0 | register [844] | |
| 1 | 0 | 1 | register [845] | |
| 1 | 1 | 0 | register [846] | |
| 1 | 1 | 1 | register [847] | MSB |

Table 35: 3-bit LUT12 Truth Table

| IN2 | IN1 | IN0 | OUT | |
|-----|-----|-----|----------------|-----|
| 0 | 0 | 0 | register [856] | LSB |
| 0 | 0 | 1 | register [857] | |
| 0 | 1 | 0 | register [858] | |
| 0 | 1 | 1 | register [859] | |
| 1 | 0 | 0 | register [860] | |
| 1 | 0 | 1 | register [861] | |
| 1 | 1 | 0 | register [862] | |
| 1 | 1 | 1 | register [863] | MSB |

Table 36: 3-bit LUT13 Truth Table

| IN2 | IN1 | IN0 | OUT | |
|-----|-----|-----|----------------|-----|
| 0 | 0 | 0 | register [872] | LSB |
| 0 | 0 | 1 | register [873] | |
| 0 | 1 | 0 | register [874] | |
| 0 | 1 | 1 | register [875] | |
| 1 | 0 | 0 | register [876] | |
| 1 | 0 | 1 | register [877] | |
| 1 | 1 | 0 | register [878] | |
| 1 | 1 | 1 | register [879] | MSB |

Each macrocell, when programmed for a LUT function, uses a 8-bit register to define their output function:

3-Bit LUT8 is defined by registers [799:792]

3-Bit LUT9 is defined by registers [815:808]

3-Bit LUT10 is defined by registers [831:824]

3-Bit LUT11 is defined by registers [847:840]

3-Bit LUT12 is defined by registers [863:856]

3-Bit LUT13 is defined by registers [879:872]

Optional Finite State Machine (FSM) function. There is additional matrix input Up to support FSM functionality.

This macrocell can also operate in a one-shot mode, which will generate an output pulse of user-defined width.

This macrocell can also operate in a frequency detection or edge detection mode.

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8.2 CNT/DLY TIMING DIAGRAMS

8.2.1 Delay Mode CNT/DLY0 to CNT/DLY5

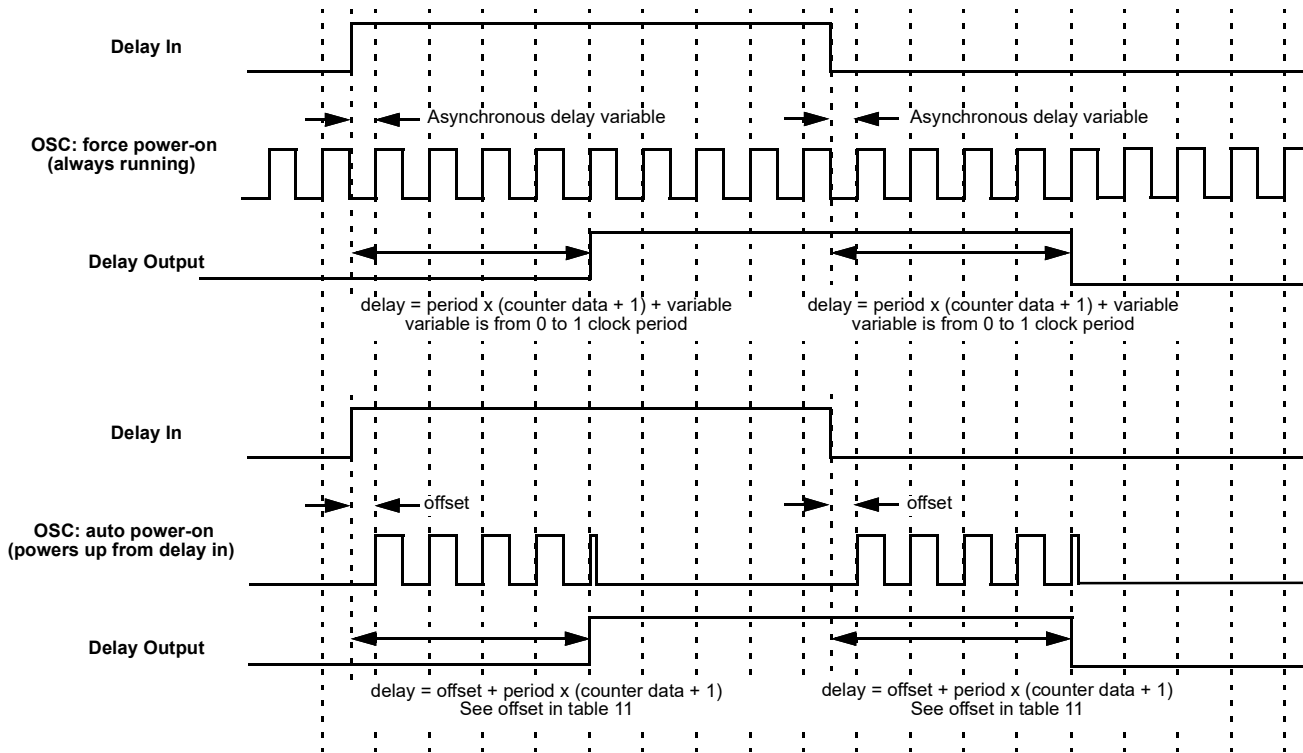


Figure 41: Delay Mode Timing Diagram, Edge Select: Both, Counter Data: 3

The macrocell shifts the respective edge to a set time and restarts by appropriate edge. It works as a filter, if the input signal is shorter than the delay time.

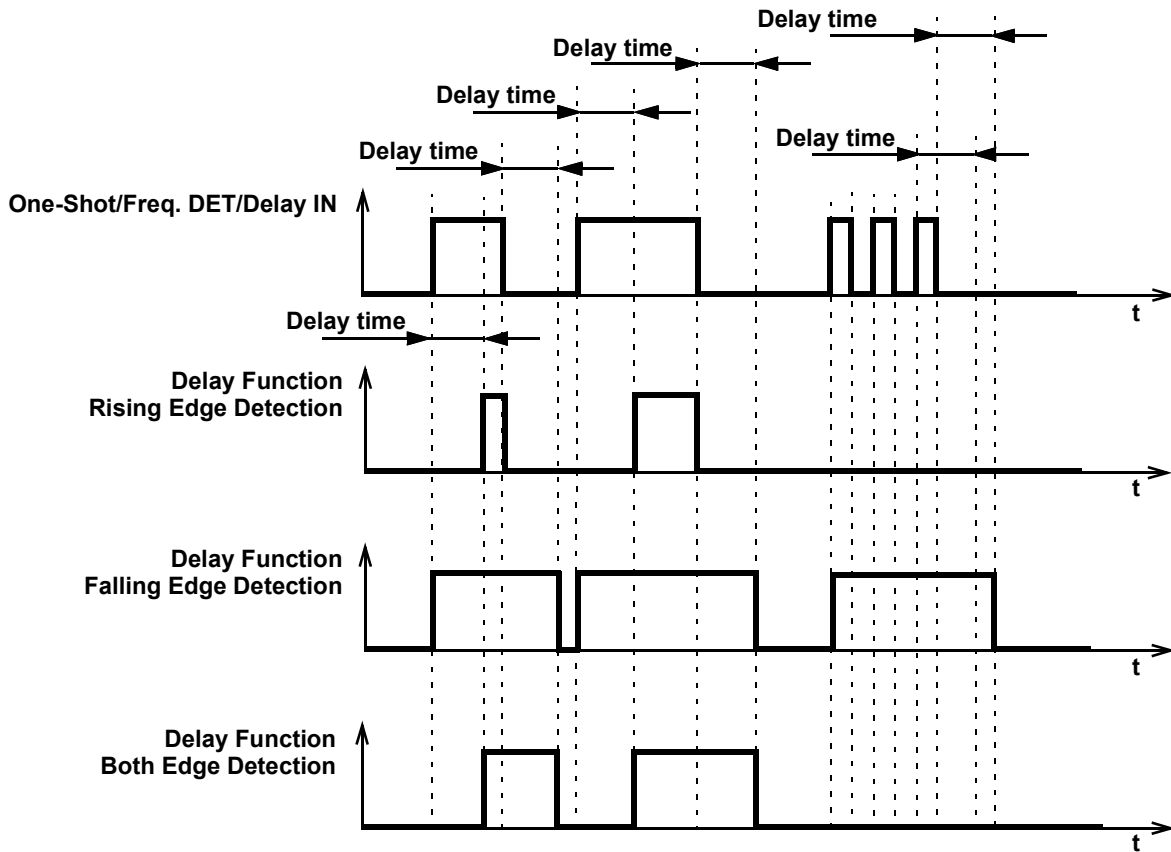


Figure 42: Delay Mode Timing Diagram for Different Edge Select Modes

8.2.2 Count Mode (Count Data: 3), Counter Reset (Rising Edge Detect) CNT/DLY0 to CNT/DLY5

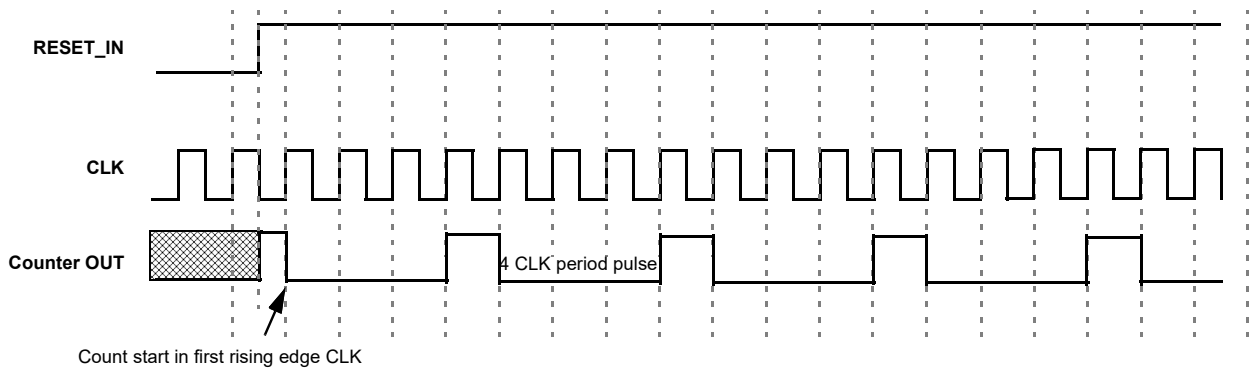


Figure 43: Counter Mode Timing Diagram without Two DFFs Synced Up

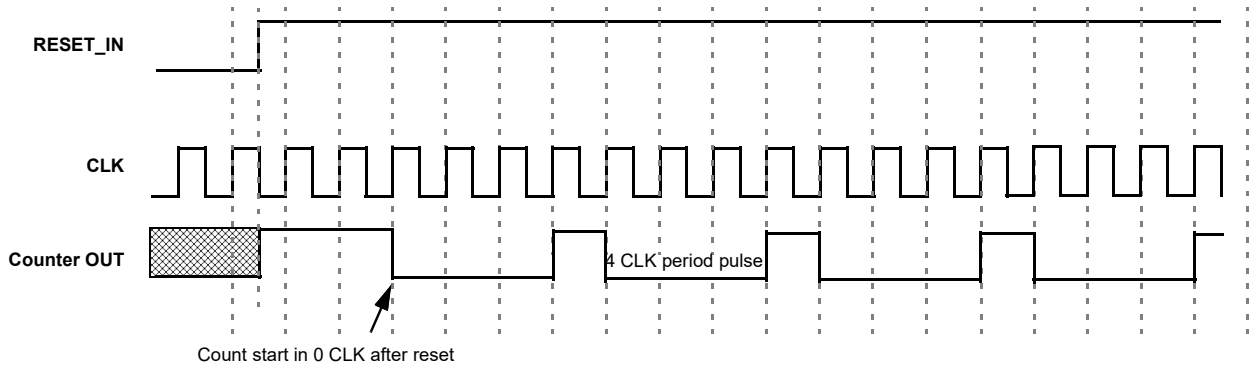


Figure 44: Counter Mode Timing Diagram with Two DFFs Synced Up

8.2.3 One-Shot Mode CNT/DLY0 to CNT/DLY5

This macrocell will generate a pulse whenever a selected edge is detected on its input. Register bits set the edge selection. The pulse width determines by counter data and clock selection properties. The output pulse polarity (non-inverted or inverted) is selected by register bit. Any incoming edges will be ignored during the pulse width generation. The following diagram shows one-shot function for non-inverted output.

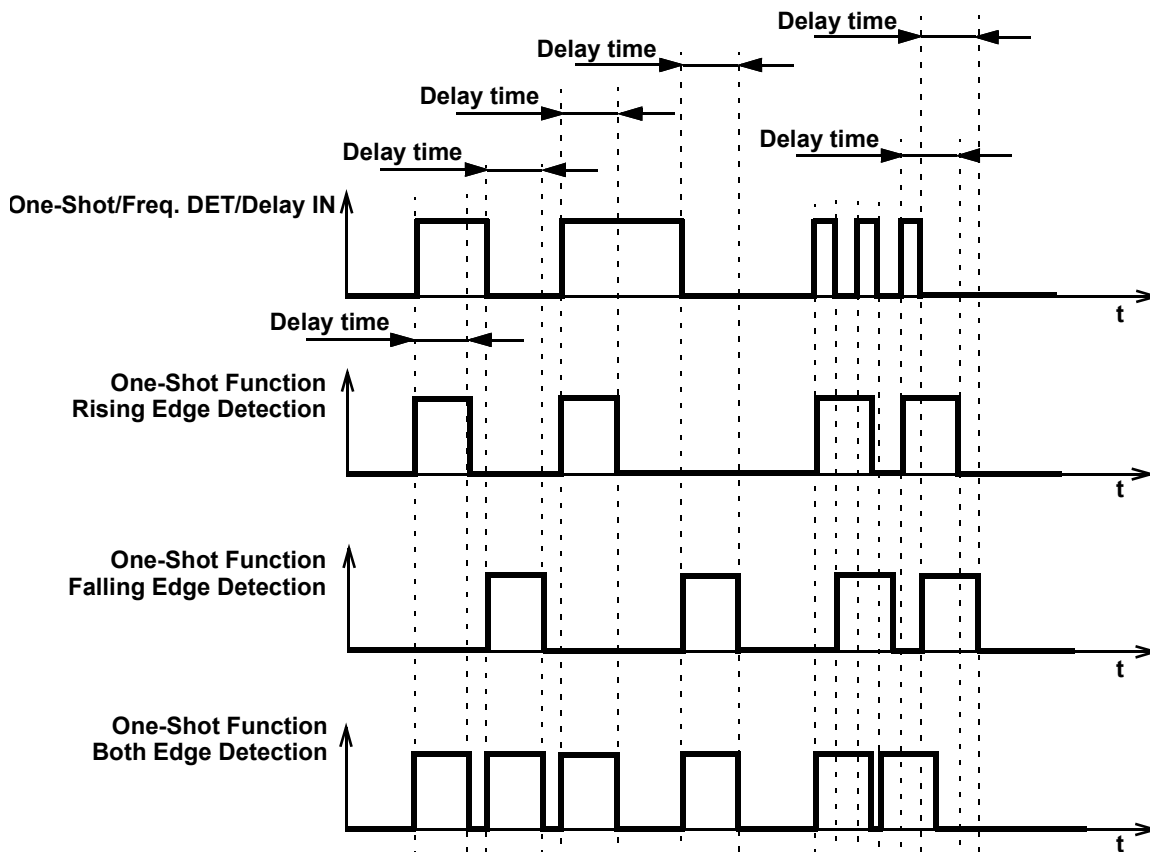


Figure 45: One-Shot Function Timing Diagram

This macrocell generates a high level pulse with a set width (defined by counter data) when detecting the respective edge. It does not restart while pulse is high.

8.2.4 Frequency Detection Mode CNT/DLY0 to CNT/DLY5

Rising Edge: The output goes high if the time between two successive edges is less than the delay. The output goes low if the second rising edge has not come after the last rising edge in specified time.

Falling Edge: The output goes high if the time between two falling edges is less than the set time. The output goes low if the second falling edge has not come after the last falling edge in specified time.

Both Edge: The output goes high if the time between the rising and falling edges is less than the set time, which is equivalent to the length of the pulse. The output goes low if after the last rising/falling edge and specified time, the second edge has not come.

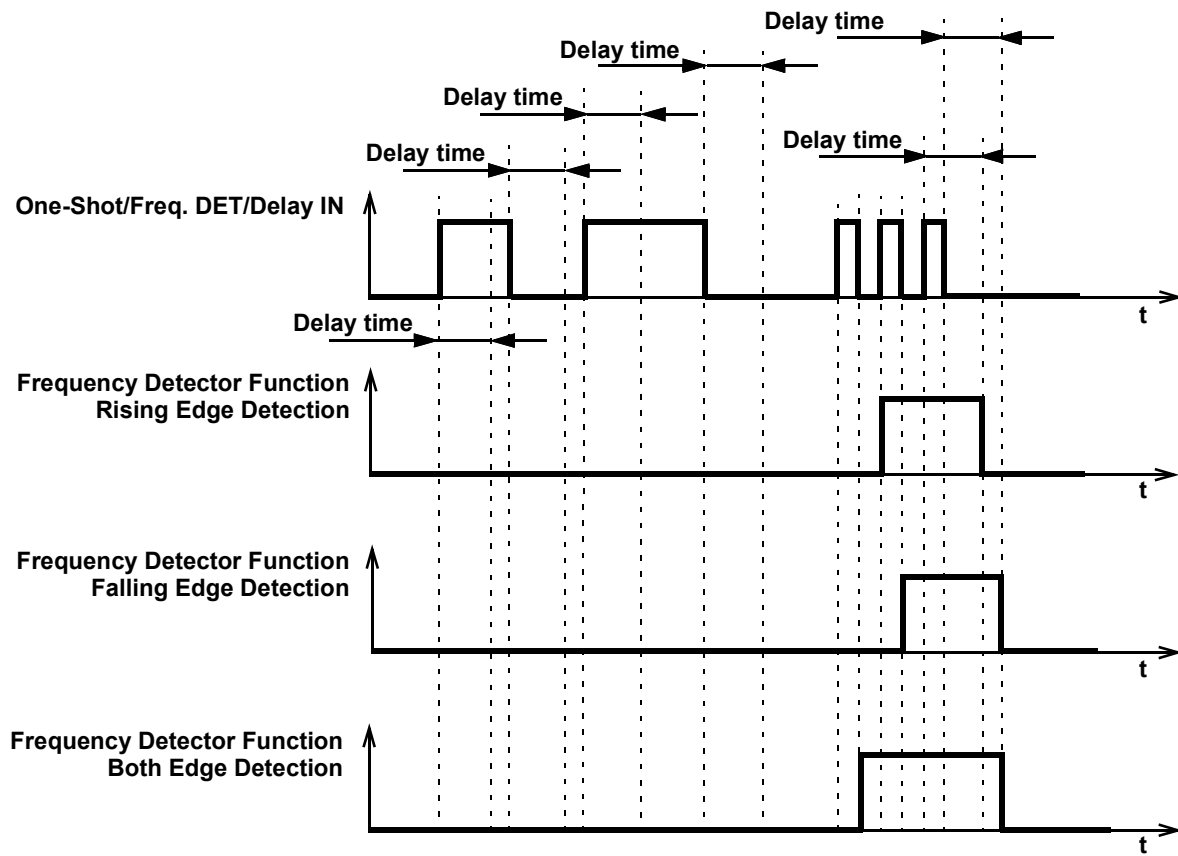


Figure 46: Frequency Detection Mode Timing Diagram

8.2.5 Edge Detection Mode CNT/DLY1 to CNT/DLY5

The macrocell generates high level short pulse when detecting the respective edge. See Figure 47.

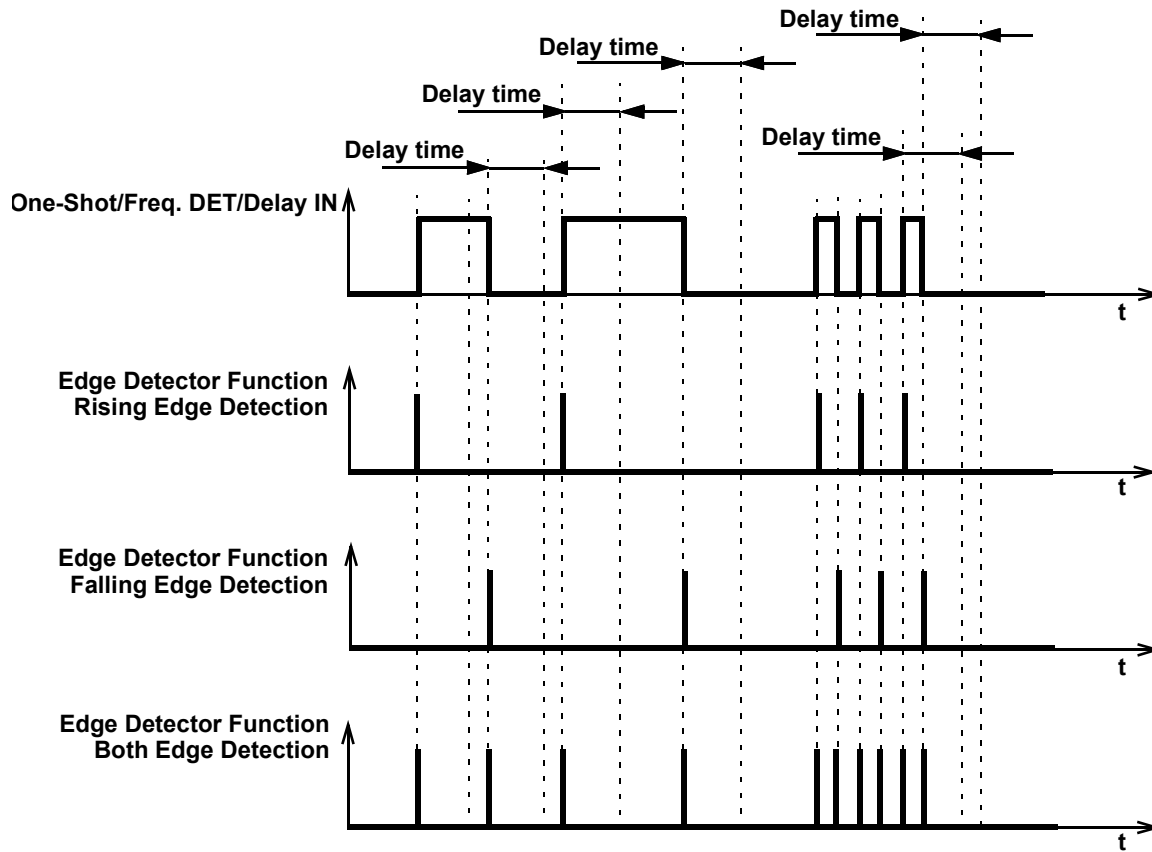


Figure 47: Edge Detection Mode Timing Diagram

8.2.6 Delayed Edge Detection Mode CNT/DLY0 to CNT/DLY5

In Delayed Edge Detection Mode, High level short pulses are generated on the macrocell output after the configured delay time, if the corresponding edge was detected on the input.

If the input signal is changed during the set delay time, the pulse will not be generated. See Figure 48.

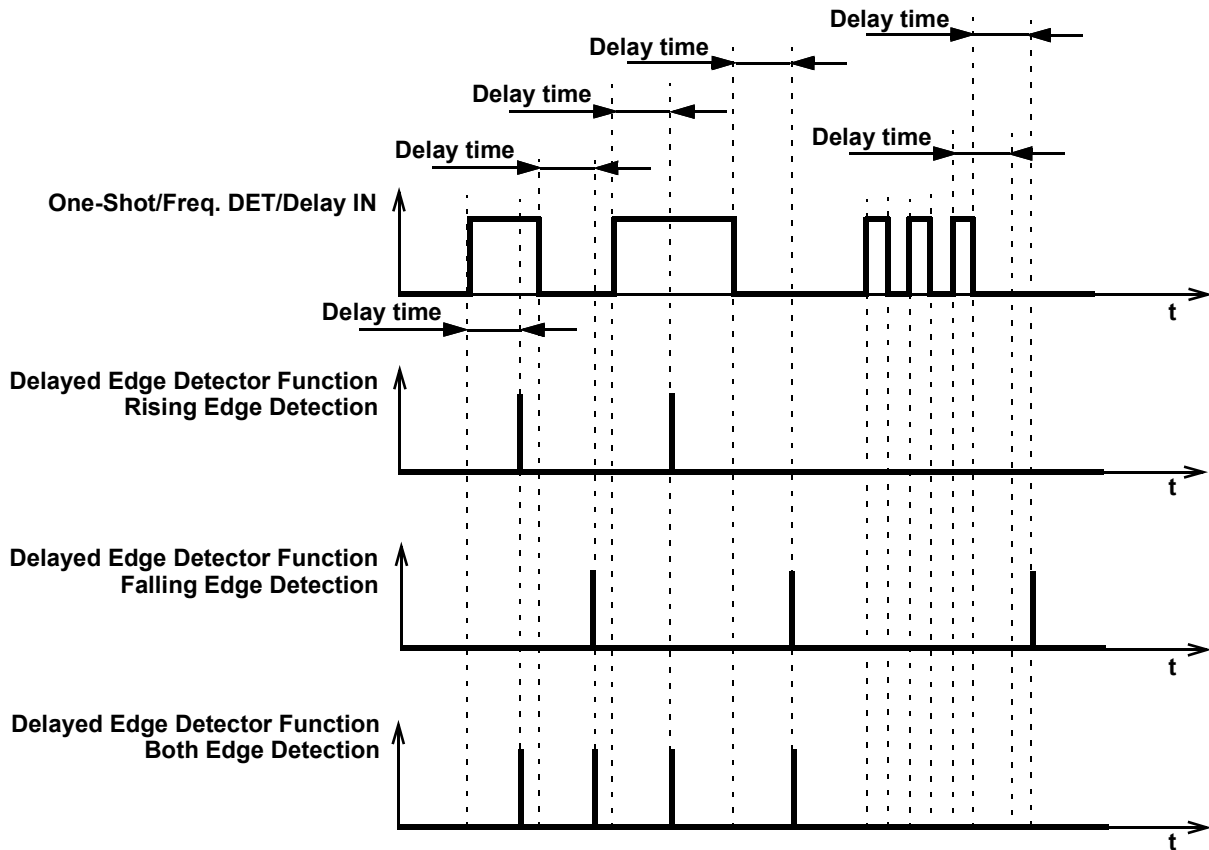


Figure 48: Delayed Edge Detection Mode Timing Diagram

8.2.7 Difference in Counter Value for Counter, Delay, One-Shot, and Frequency Detect Modes

There is a difference in counter value for Counter and Delay/One-Shot/Frequency Detect modes. The counter value is shifted for two rising edges of the clock signal in Delay/One-Shot/Frequency Detect modes compared to Counter mode. See Figure 49:

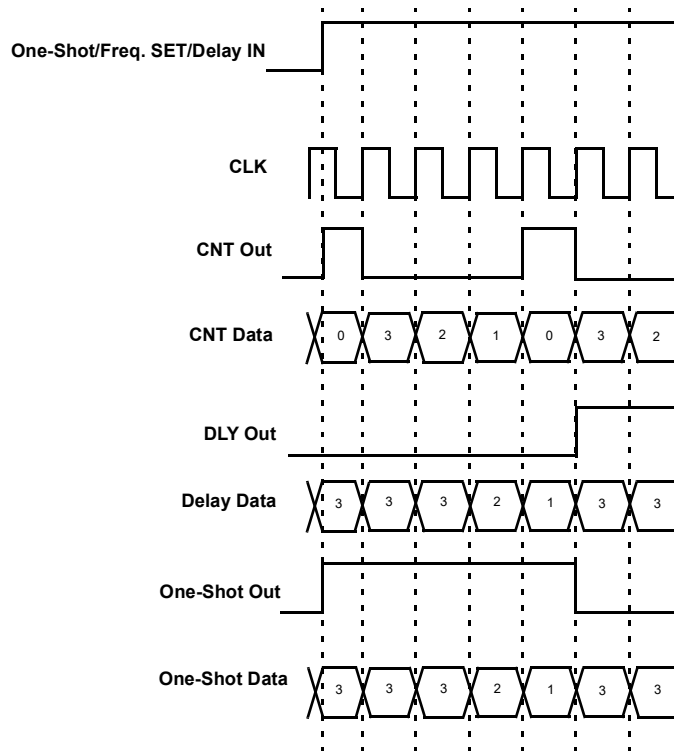


Figure 49: Counter Value, Counter Data = 3

8.3 FSM TIMING DIAGRAMS

The behavior of FSM macrocell with low level at Up input is the same as the behavior of other multifunction macrocells in corresponding modes (Counter, Delay, One Shot, Freq. Detector, Delayed Edge Detector).

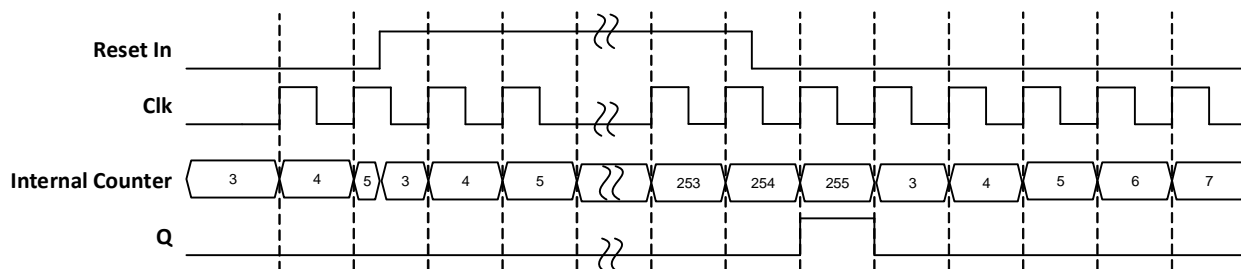


Figure 50: CNT/FSM Mode Timing Diagram (Set Rising Edge Mode, Oscillator Is Forced On, UP = 1) for CNT Data = 3

9 Multichannel Sampling Analog Comparator

The SLG46811 has one multichannel sampling ACMP that can make periodical samples of up to four input channels and latch the results at four outputs. The input sources for MS ACMP can be GPIO4, GPIO5, GPIO6, GPIO7, V_{DD} , Temperature sensor. User can select any number of channels to be sampled from one up to four, for example, Channel0, Channel2 and Channel3. Note that the channels are sampled in fixed order from 0 to 3rd. Each channel has separate configurable voltage reference and hysteresis. Vref range is from 32 mV to 2016 mV with 32 mV step in sampling mode and from 64 mV to 2016 mV with 32 mV step in regular mode. Hysteresis options are: no hysteresis, 32 mV (available only in sampling mode), 64 mV, 192 mV. Non-inverting input of MS ACMP has the input divider that can be configured for each channel separately. The options for the divider are: V_{in} , $V_{in} / 2$, $V_{in} / 3$, $V_{in} / 4$.

MS ACMP uses internal oscillator0 to switch between channels, change Vref and latch the results. Clock from the oscillator0 can be divided by 2, 4, or 8 inside the MS ACMP. If "Auto power on" setting of oscillator is selected, High voltage level (or rising edge, depending on setting) on Enable input starts the internal oscillator. Please use MS ACMP clock frequencies from [Table 37](#) when interfacing the sensor with high output impedance with SLG46811.

Table 37: Recommended MS ACMP Clock Frequencies

| Parameter | Range 1 | Range 2 | Range 3 | Range 4 | Range 5 | Unit |
|--------------------------|---------|---------|---------|---------|---------|------|
| Sensor Output Resistance | < 1 | 1 to 2 | 2 to 4 | 4 to 6 | > 6 | MΩ |
| MS ACMP Clock Frequency | ≤ 10 | ≤ 5 | ≤ 2.5 | ≤ 1.25 | ≤ 0.5 | kHz |

User can select the way the results appear at the outputs of MS ACMP. In asynchronous mode (register [499] = 0) results appear continuously after each channel is sampled. In synchronous mode (register [499] = 1) results at the output appear simultaneously after the last selected channel was sampled. The signal Sync data ready (matrix input [50]) generates a pulse of 100 ns approximate width when the sequence of selected channels was sampled.

Basic modes for MS ACMP are the next:

- Regular mode, register [497] = 0. In this mode MS ACMP operates as conventional ACMP. One selected channel is measured continuously when logic level at Enable input is High
- Sampling mode, register [497] = 1. Enable input is level sensitive, register [498] = 0. In this mode MS ACMP changes sampled channels and latches the result every pulse at Clk input while Enable input is High. When Enable becomes Low level MS ACMP finishes sampling the sequence and goes power down.
- Sampling mode, register [497] = 1. Enable input is edge sensitive, register [498] = 1. In this mode, when rising edge comes at Enable input, MS ACMP samples selected channels (up to four) every rising edge at Clk input and goes power down until the next pulse at Enable input.

9.1 MULTICHANNEL SAMPLING ACMP BLOCK DIAGRAM

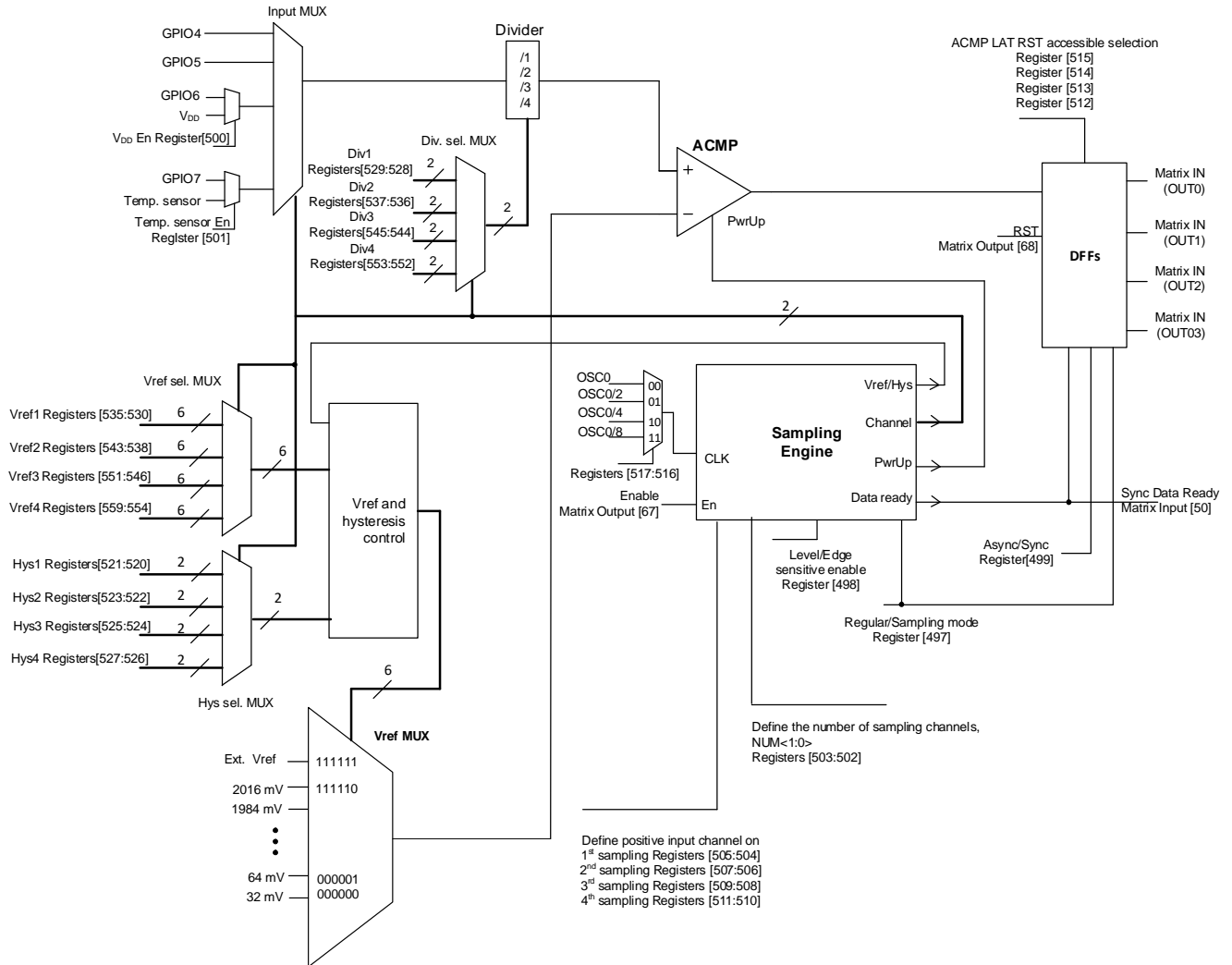


Figure 51: Multichannel Sampling ACMP Block Diagram

9.2 MS ACMP TIMING DIAGRAMS

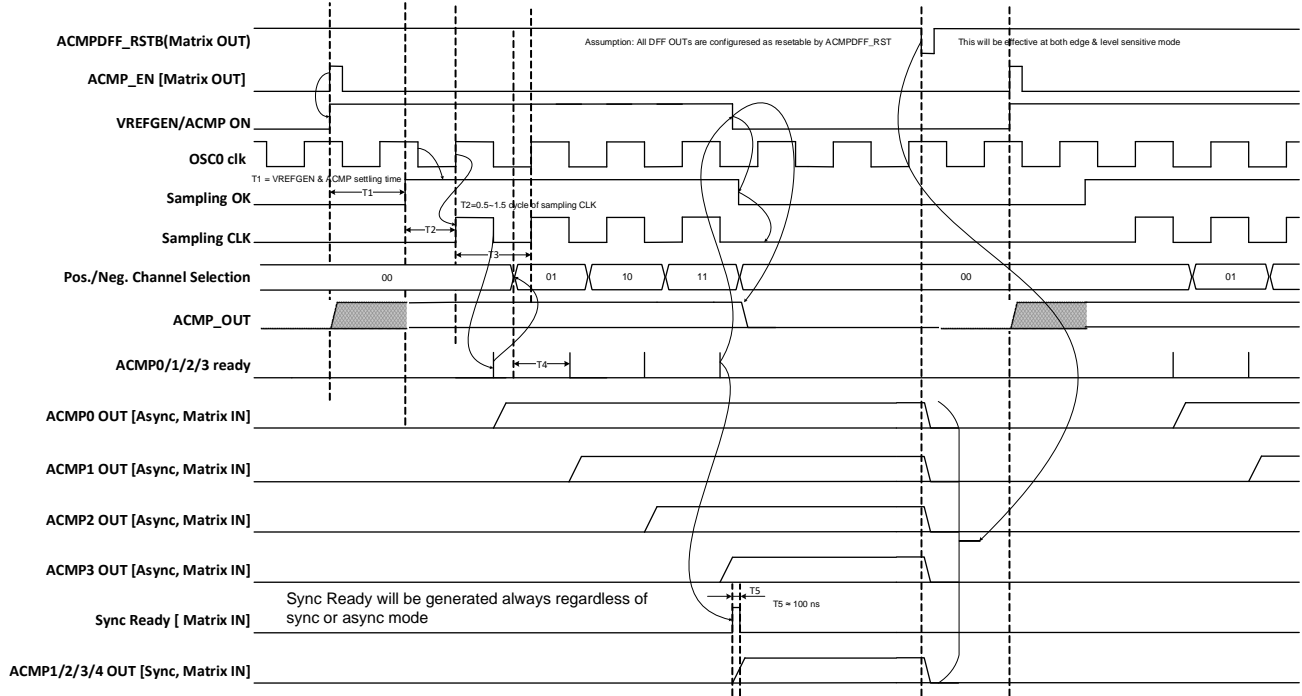


Figure 52: Timing Diagrams for MS ACMP. Edge Sensitive Mode. OSC0 and BG are Forced On

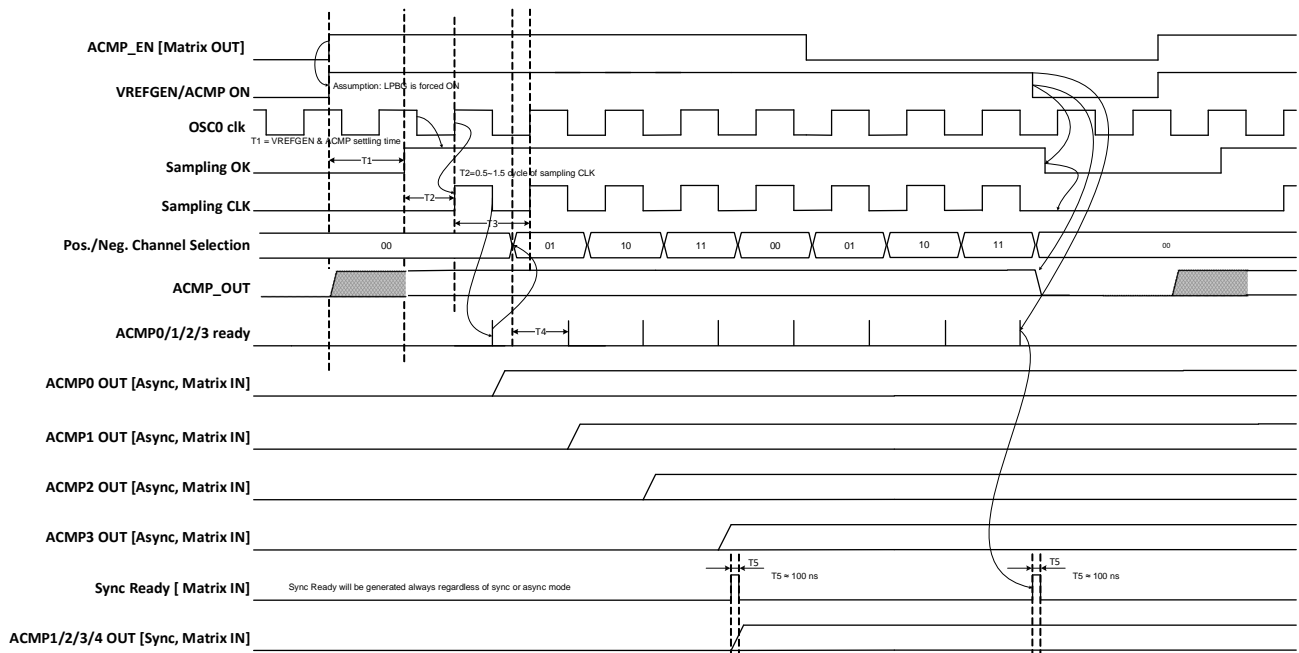


Figure 53: Timing Diagrams for MS ACMP. Level Sensitive Mode. OSC0 and BG are Forced On

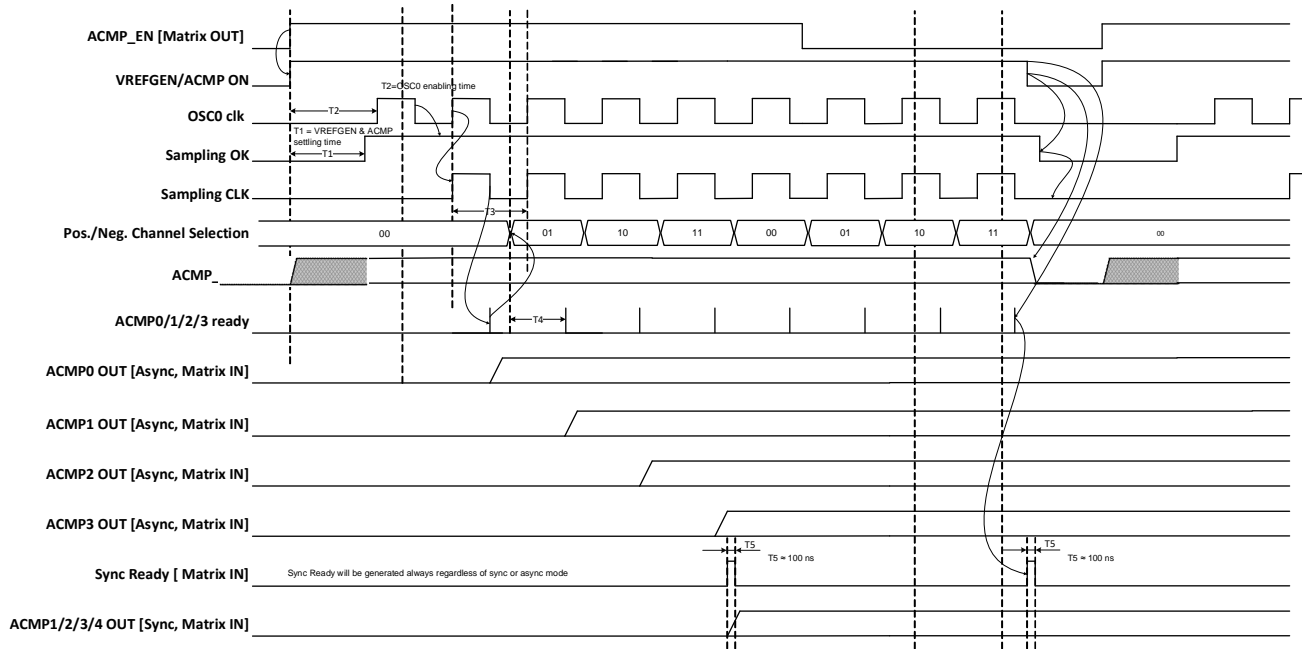


Figure 54: Timing Diagrams for MS ACMP. Level Sensitive Mode. OSC0 is in Auto Power On Mode. BG is Forced On

9.3 ACMP TYPICAL PERFORMANCE

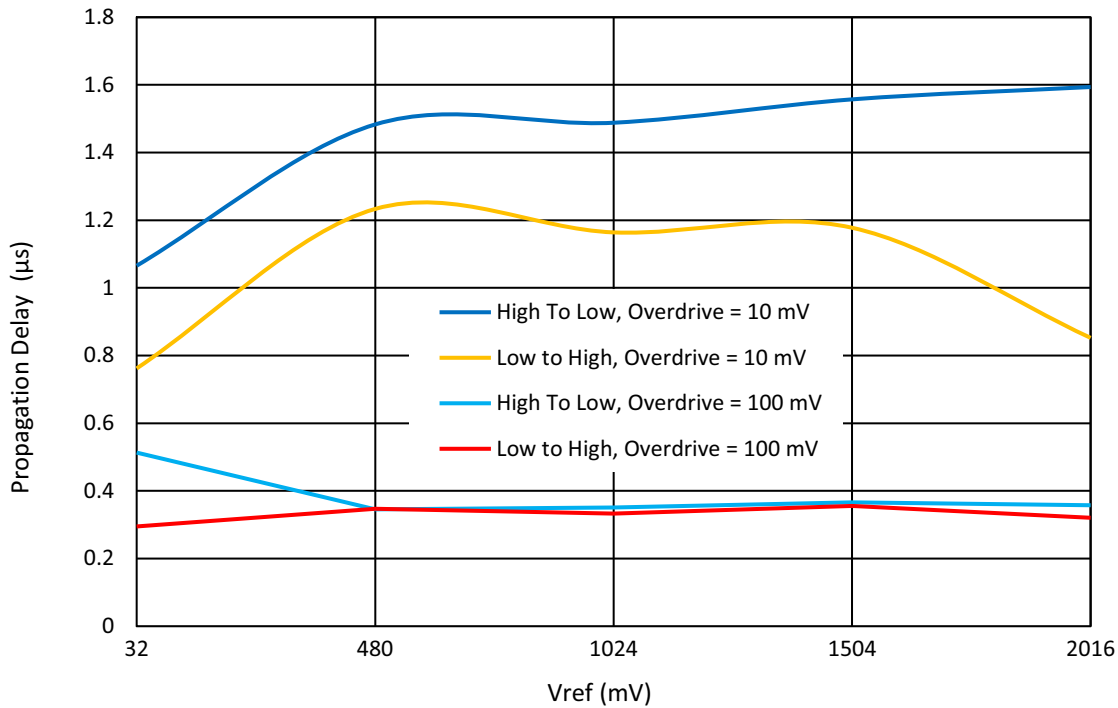


Figure 55: Typical Propagation Delay vs. Vref for MS ACMP at T = 25 °C, Gain = 1, Hysteresis = 0, Regular Mode

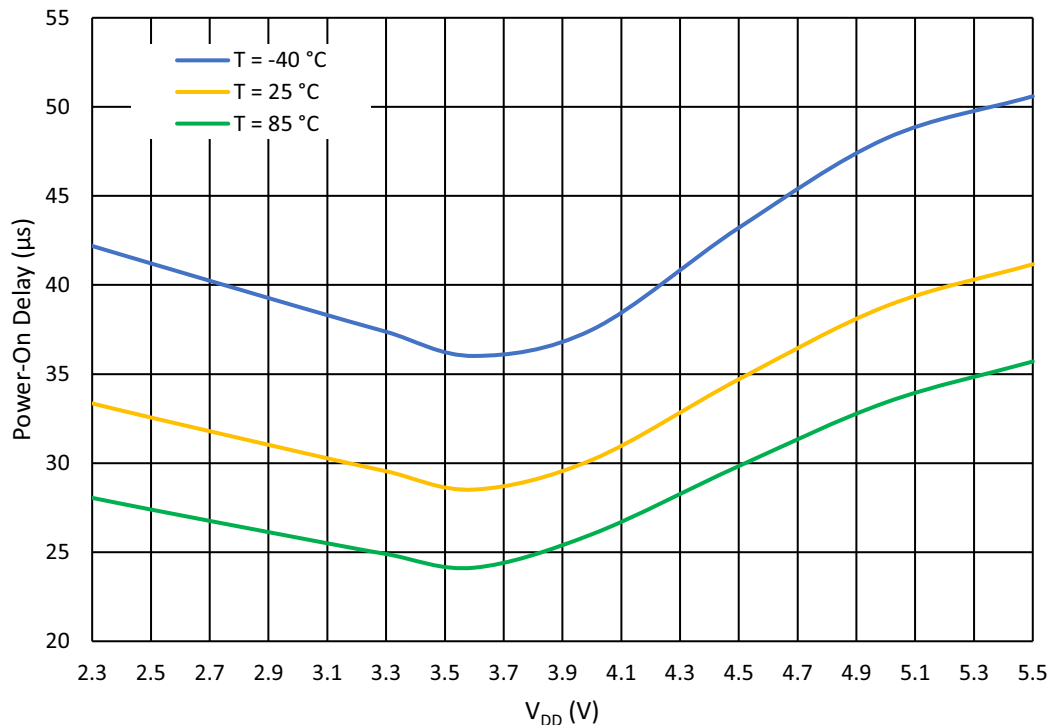


Figure 56: MS ACMP Power-On Delay vs. V_{DD}, Regular Mode

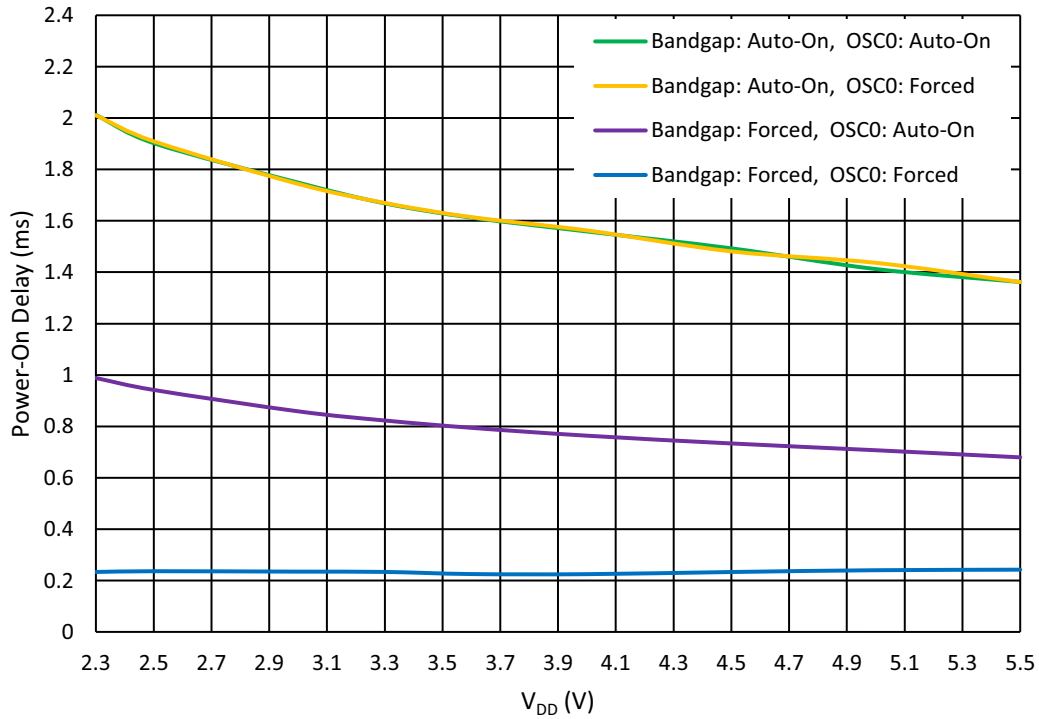


Figure 57: MS ACMP Power-On Delay vs. V_{DD}, Sampling Mode, T = -40 °C to 85 °C

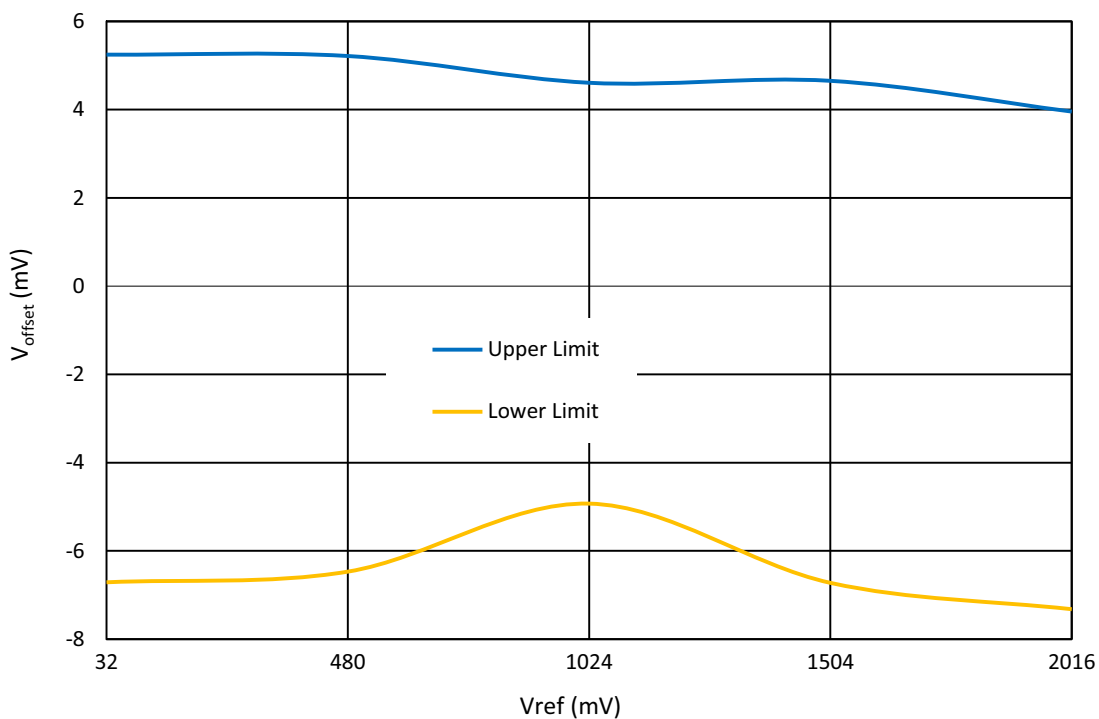


Figure 58: MS ACMP Input Offset Voltage vs. V_{ref} at T = -40 °C to 85 °C

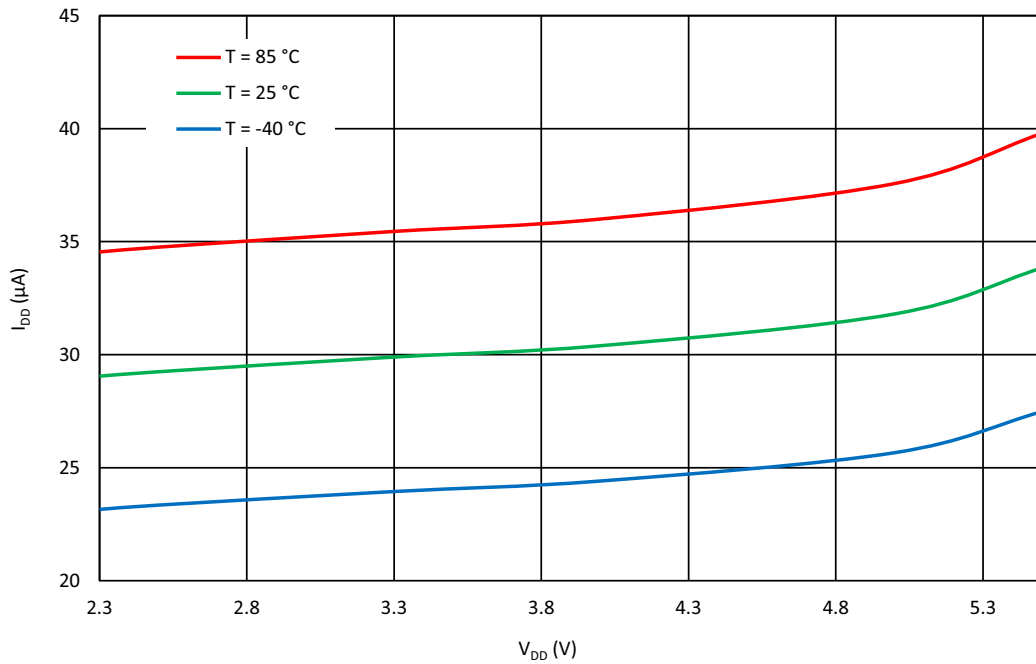


Figure 59: Current Consumption vs. V_{DD} for Regular Mode, External Vref, V_{IN+} = V_{DD}, V_{IN-} = GND

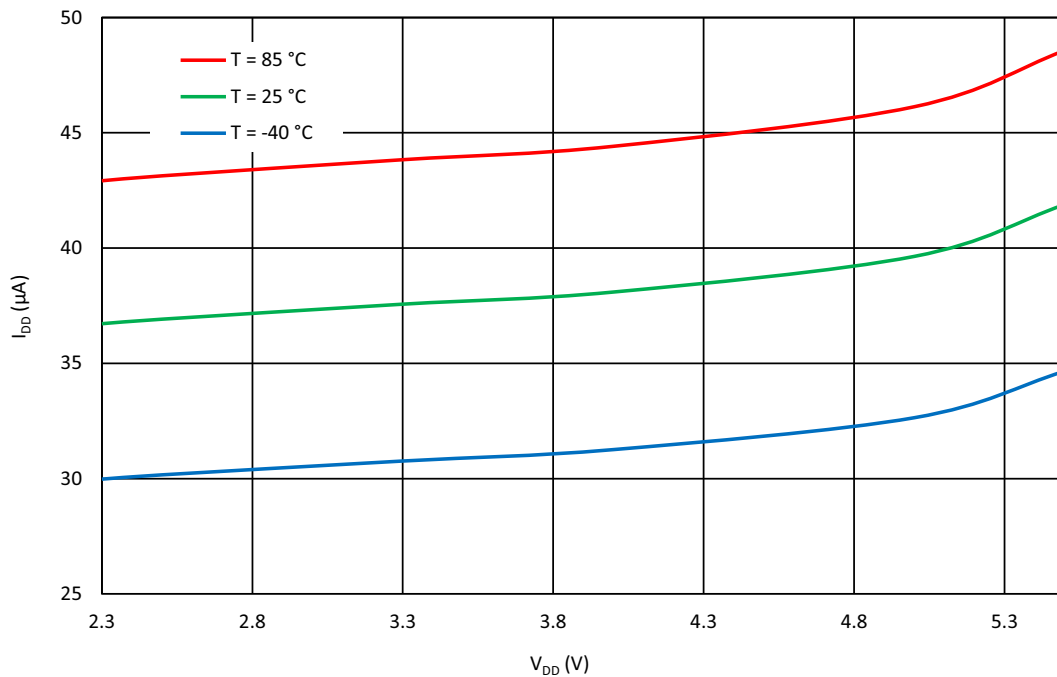


Figure 60: Current Consumption vs. V_{DD} for Sampling Mode, 4 Channels, V_{IN+} = 2048 mV, V_{IN-} = 32 mV, Clock = 10 kHz

10 Programmable Delay/Edge Detector

The SLG46811 has a programmable time delay logic cell that can generate a delay that is selectable from one of four timings (time2) configured in the GreenPAK Designer. The programmable time delay cell can generate one of four different delay patterns, rising edge detection, falling edge detection, both edge detection, and both edge delay. These four patterns can be further modified with the addition of delayed edge detection, which adds an extra unit of delay, as well as glitch rejection during the delay period. See Figure 62 for further information.

Note: The input signal must be longer than the delay, otherwise it will be filtered out.

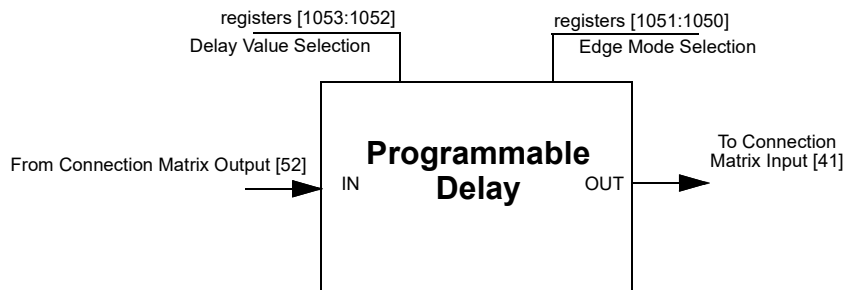


Figure 61: Programmable Delay

10.1 PROGRAMMABLE DELAY TIMING DIAGRAM - EDGE DETECTOR OUTPUT

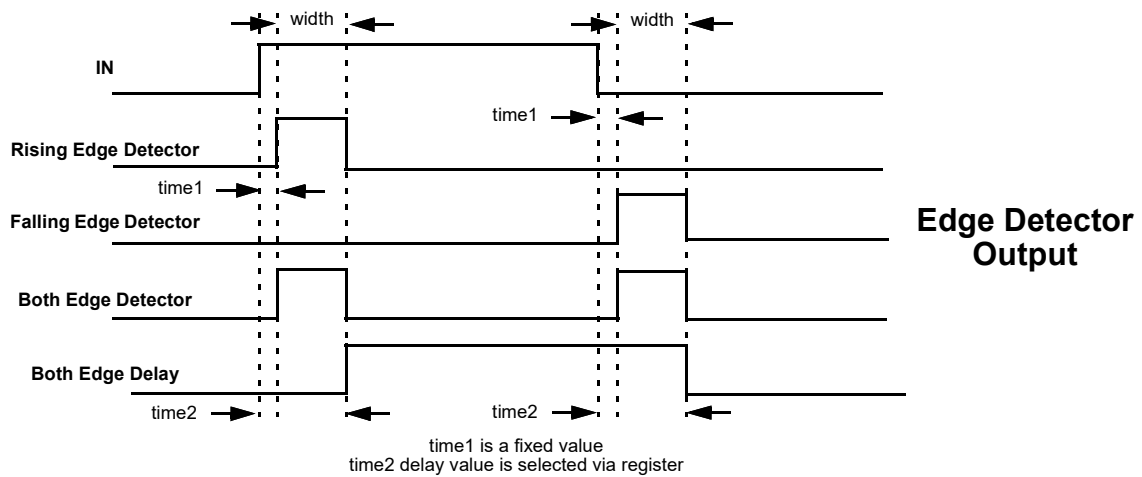


Figure 62: Edge Detector Output

Please refer to Table 12.

11 Additional Logic Function. Deglitch Filter

The SLG46811 has one Deglitch Filter macrocell with inverter function that is connected directly to the Connection Matrix inputs and outputs. The filter pass the input signal for pulse width > tpass (at typical temperature 25 °C. See Table 14).

In addition, this macrocell can be configured as an Edge Detector, with the following settings:

- Rising Edge Detector
- Falling Edge Detector
- Both Edge Detector
- Both Edge Delay

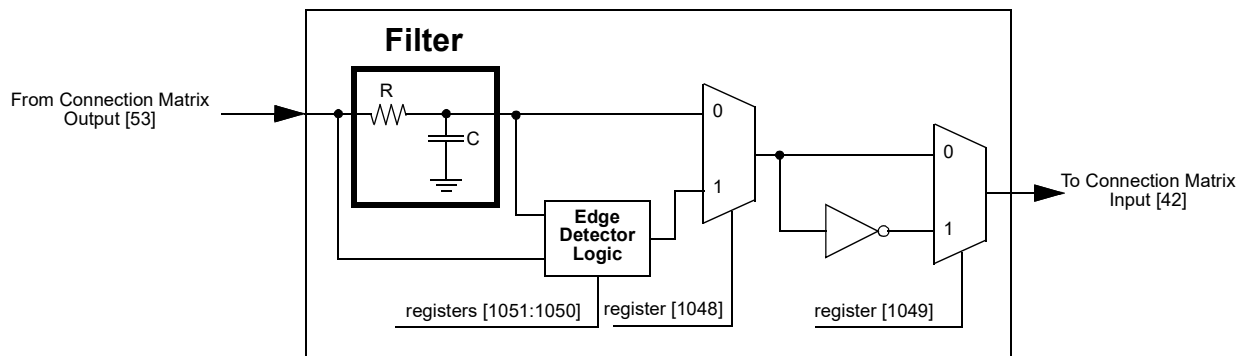


Figure 63: Deglitch Filter/Edge Detector Simplified Structure

12 Voltage Reference

12.1 VOLTAGE REFERENCE OVERVIEW

The SLG46811 has a Voltage Reference (Vref) macrocell to provide references to the Multichannel Sampling Analog Comparator. See [Table 38](#) for the available selections for Multichannel Sampling Analog Comparator.

12.2 VREF SELECTION TABLE

Table 38: Vref Selection Table

| SEL[5:0] | Vref | SEL[5:0] | Vref |
|----------|-------|----------|----------|
| 0 | 0.032 | 32 | 1.056 |
| 1 | 0.064 | 33 | 1.088 |
| 2 | 0.096 | 34 | 1.12 |
| 3 | 0.128 | 35 | 1.152 |
| 4 | 0.16 | 36 | 1.184 |
| 5 | 0.192 | 37 | 1.216 |
| 6 | 0.224 | 38 | 1.248 |
| 7 | 0.256 | 39 | 1.28 |
| 8 | 0.288 | 40 | 1.312 |
| 9 | 0.32 | 41 | 1.344 |
| 10 | 0.352 | 42 | 1.376 |
| 11 | 0.384 | 43 | 1.408 |
| 12 | 0.416 | 44 | 1.44 |
| 13 | 0.448 | 45 | 1.472 |
| 14 | 0.48 | 46 | 1.504 |
| 15 | 0.512 | 47 | 1.536 |
| 16 | 0.544 | 48 | 1.568 |
| 17 | 0.576 | 49 | 1.6 |
| 18 | 0.608 | 50 | 1.632 |
| 19 | 0.64 | 51 | 1.664 |
| 20 | 0.672 | 52 | 1.696 |
| 21 | 0.704 | 53 | 1.728 |
| 22 | 0.736 | 54 | 1.76 |
| 23 | 0.768 | 55 | 1.792 |
| 24 | 0.8 | 56 | 1.824 |
| 25 | 0.832 | 57 | 1.856 |
| 26 | 0.864 | 58 | 1.888 |
| 27 | 0.896 | 59 | 1.92 |
| 28 | 0.928 | 60 | 1.952 |
| 29 | 0.96 | 61 | 1.984 |
| 30 | 0.992 | 62 | 2.016 |
| 31 | 1.024 | 63 | External |

13 Clocking

13.1 OSC GENERAL DESCRIPTION

The SLG46811 has two internal oscillators to support a variety of applications:

- Oscillator0 (2.048 kHz or 10 kHz optional selection)
- Oscillator1 (25 MHz).

The Oscillator0 can operate in one of two modes (2.048 kHz or 10 kHz) selected by register [581]. There are two divider stages for each oscillator that gives the user flexibility for introducing clock signals to connection matrix, as well as various other macrocells. The pre-divider (first stage) for Oscillator0 is clock /1, /2, /4 or /8. The pre-divider (first stage) for Oscillator1 is clock /1, /2, /4, /8, /12, /24, /48. The second stage divider has an input of frequency from the pre-divider, and outputs one of eight different frequencies divided by /1, /2, /3, /4, /8, /12, /24 or /64 on Connection Matrix Input lines [43], [49]. Please see [Figure 64](#), [Figure 65](#) and [Figure 66](#) for more details on the SLG46811 clock scheme.

Oscillator1 (25 MHz) has an additional function of 100 ns delayed startup, which can be enabled/disabled by register [592]. This function is recommended to use when analog blocks are used along with the Oscillator.

The Matrix Power-down/Force On function allows switching off or force on the oscillators using an external pin (see [Table 39](#)). The Matrix Power-down/Force On (Connection Matrix Output [579]) signal has the highest priority.

Table 39: Oscillator Control Input Modes

| Registers [567:566] | Description |
|---------------------|---|
| b00 | OSC0 (2kHz/10kHz): Controlled by register [578] OSC1 (25MHz): Controlled by register [568] |
| b01 | OSC0 (2kHz/10kHz): Controlled by Matrix Output OSC1 (25MHz): Controlled by register [568] |
| b10 | OSC0 (2kHz/10kHz): Controlled by register [578] OSC1 (25MHz): Controlled by Matrix Output |
| b11 | OSC0 (2kHz/10kHz): Controlled by Matrix Output OSC1 (25MHz): Controlled by Matrix Output |

The OSC operates according to the [Table 40](#):

Table 40: Oscillator Operation Mode Configuration Settings

| POR | External Clock Selection | Signal From Connection Matrix | Register: Power-Down or Force On by Matrix Input | Register: Auto Power-On or Force On | OSC Enable Signal from CNT/DLY Macrocells | OSC Operation Mode |
|-----|--------------------------|-------------------------------|--|-------------------------------------|---|----------------------------------|
| 0 | X | X | X | X | X | OFF |
| 1 | 1 | X | X | X | X | Internal OSC is OFF, logic is ON |
| 1 | 0 | 1 | 0 | X | X | OFF |
| 1 | 0 | 1 | 1 | X | X | ON |
| 1 | 0 | 0 | X | 1 | X | ON |
| 1 | 0 | 0 | X | 0 | CNT/DLY requires OSC | ON |
| 1 | 0 | 0 | X | 0 | CNT/DLY does not require OSC | OFF |

Note 1 The OSC will run only when any macrocell that uses OSC is powered on.

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13.2 OSCILLATOR0 (2.048 KHZ/10 KHZ)

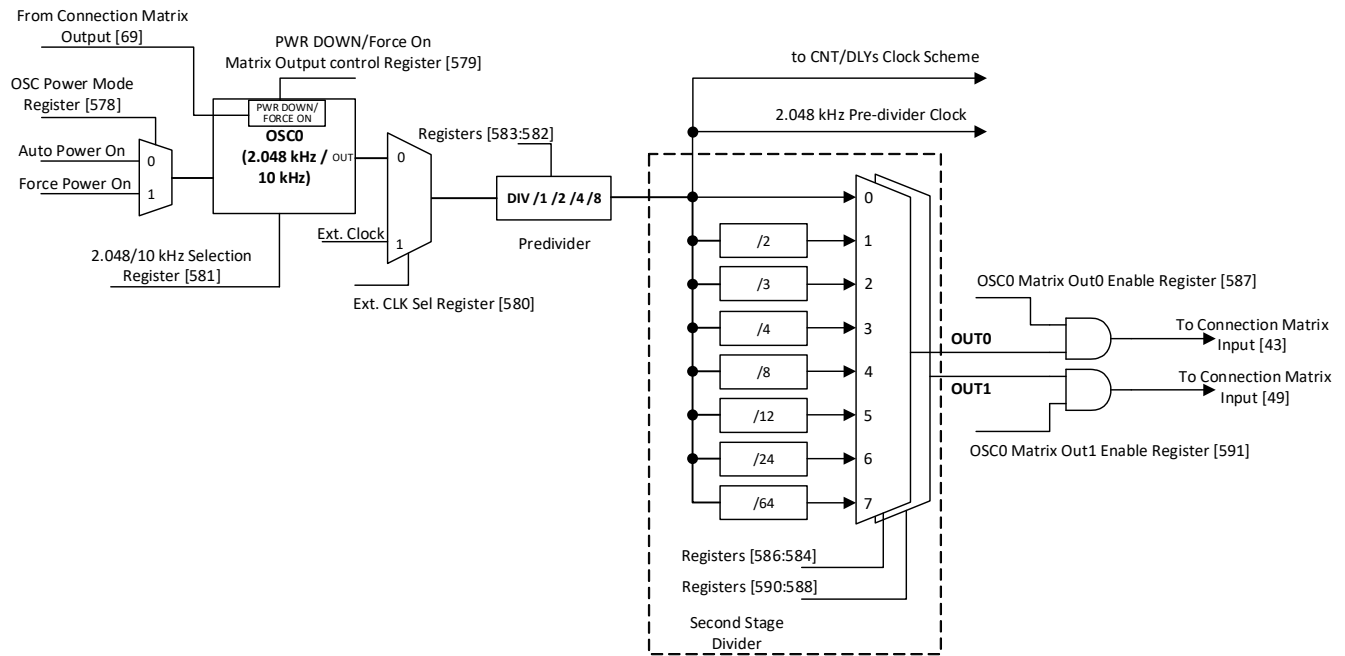


Figure 64: Oscillator0 Block Diagram

13.3 OSCILLATOR1 (25 MHZ)

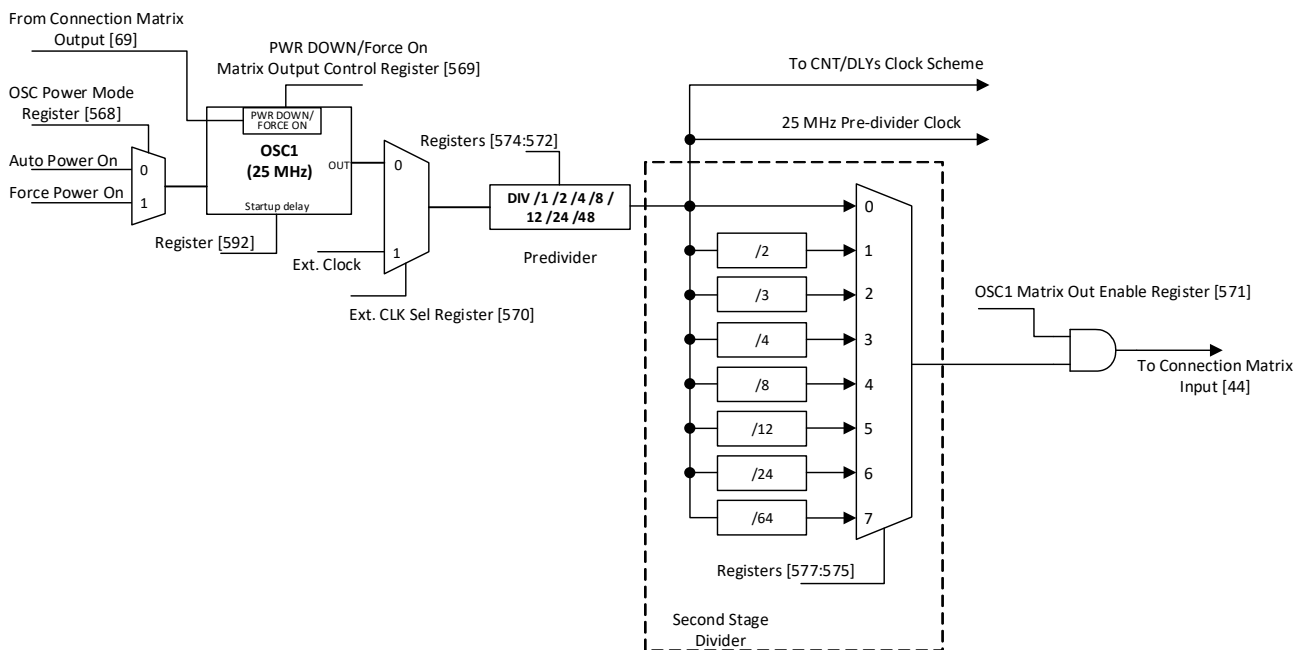


Figure 65: Oscillator1 Block Diagram

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13.4 CNT/DLY CLOCK SCHEME

Each CNT/DLY within Multi-Function macrocell has its own additional clock divider connected to oscillators pre-divider. Available dividers are:

- OSC0/1, OSC0/8, OSC0/12, OSC0/24, OSC0/64, OSC0/512, OSC0/4096
- OSC1/1, OSC1/4, OSC1/8, OSC1/64, OSC1/512

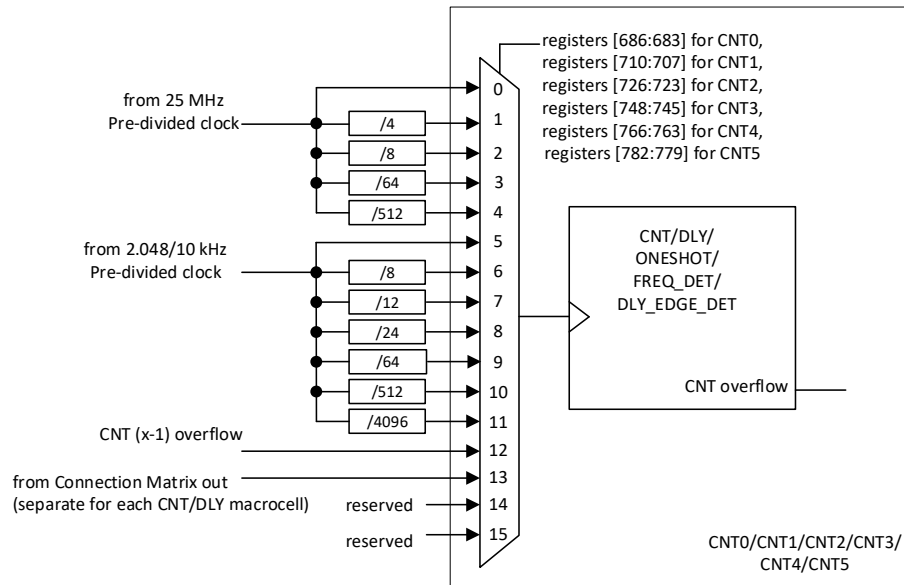


Figure 66: Clock Scheme

13.5 EXTERNAL CLOCKING

The SLG46811 supports several ways to use an external, higher accuracy clock as a reference source for internal operations.

13.5.1 GPI Source for Oscillator0 (2.048kHz/10 kHz)

When register [580] is set to 1, an external clocking signal on GPI will be routed in place of the internal oscillator derived 2.048 kHz clock source. See Figure 64. The low and high limits for external frequency that can be selected are 0 MHz and 10 MHz.

13.5.2 GPIO7 Source for Oscillator1 (25 MHz)

When register [570] is set to 1, an external clocking signal on GPIO7 will be routed in place of the internal oscillator derived 25 MHz clock source. See Figure 65. The external frequency range is 0 MHz to 20 MHz at $V_{DD} = 2.3$ V, 30 MHz at $V_{DD} = 3.3$ V, 50 MHz at $V_{DD} = 5.0$ V. When an external clock is selected for OSC1, the oscillator's output signal will be inverted with respect to the GPIO7 input signal.

13.6 OSCILLATORS POWER-ON DELAY

When OSC power mode is "Auto Power-On" "OSC enable" signal appears when any macrocell that uses OSC is powered on (see Figure 67). The values of Power-On Delay are in Table 17.

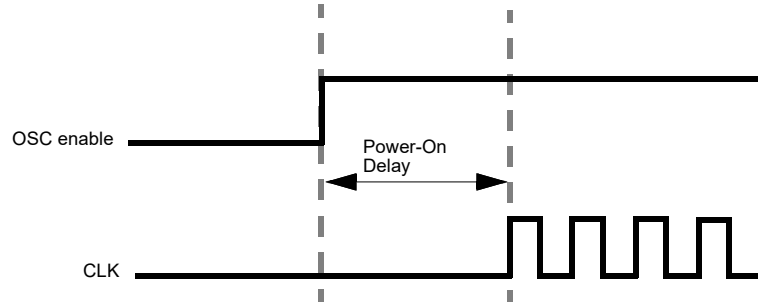


Figure 67: Oscillator Startup Diagram

Note 1 OSC power mode: “Auto Power-On”.

Note 2 “OSC enable” signal appears when any macrocell that uses OSC is powered on.

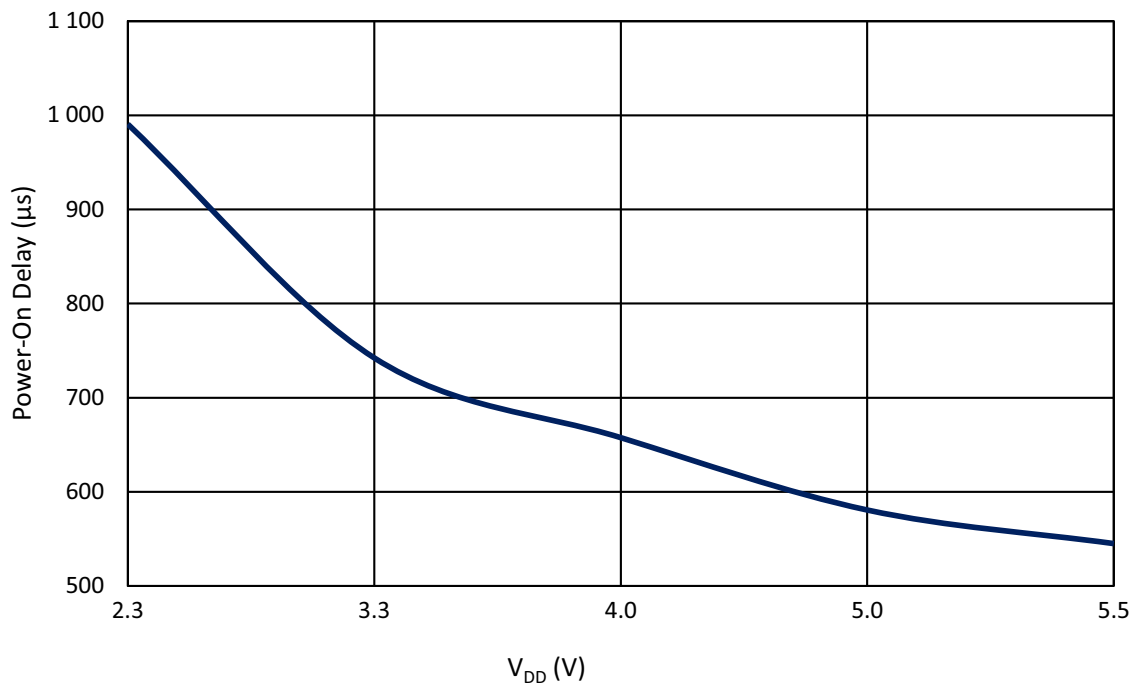


Figure 68: Oscillator0 Maximum Power-On Delay vs. V_{DD} at T = 25 °C, OSC0 = 2.048 kHz/10 kHz

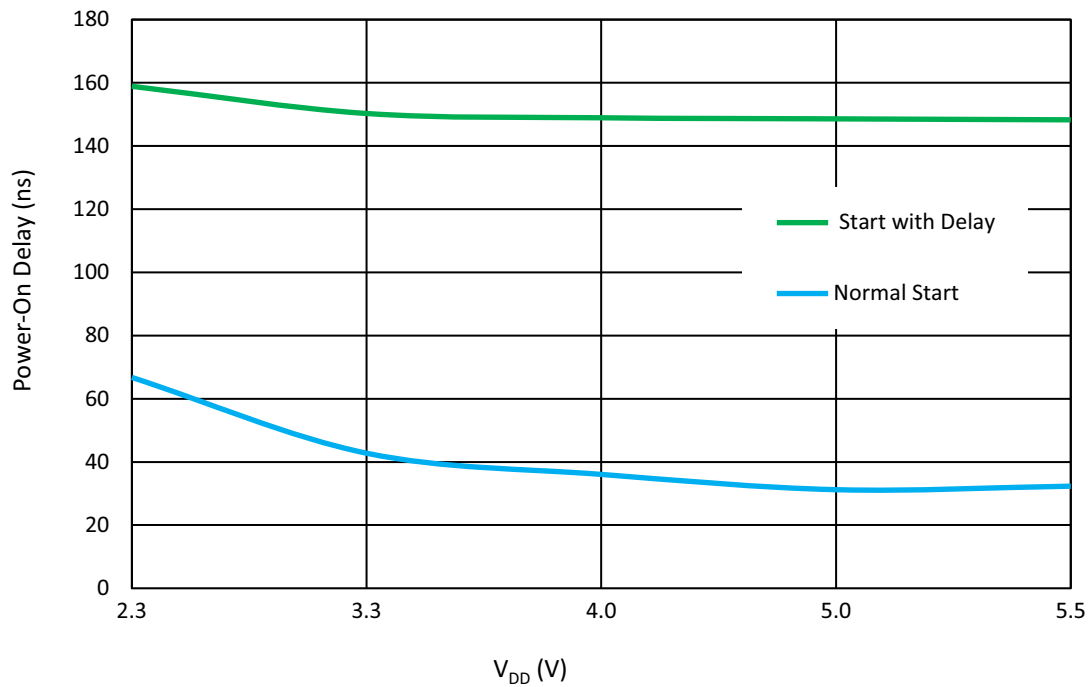


Figure 69: Oscillator1 Maximum Power-On Delay vs. V_{DD} at T = 25 °C, OSC1 = 25 MHz

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13.7 OSCILLATORS ACCURACY

Note: OSC power setting: Force Power-On; Clock to matrix input - enable; Bandgap: turn on by register - enable.

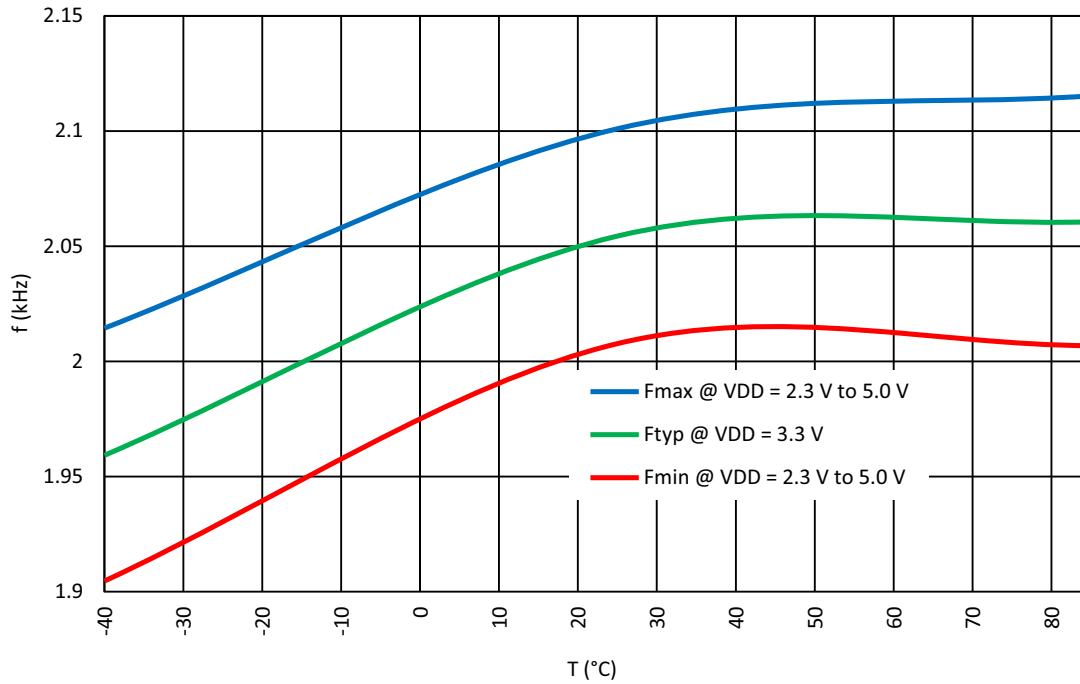


Figure 70: Oscillator0 Frequency vs. Temperature, OSC0 = 2.048 kHz

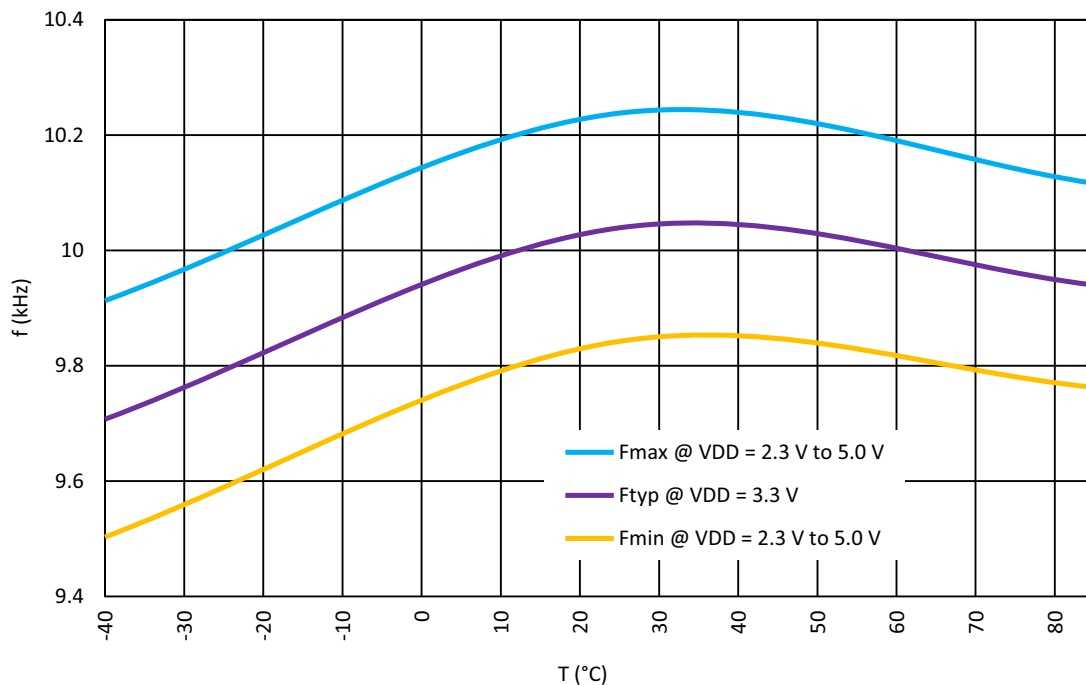


Figure 71: Oscillator0 Frequency vs. Temperature, OSC0 = 10 kHz

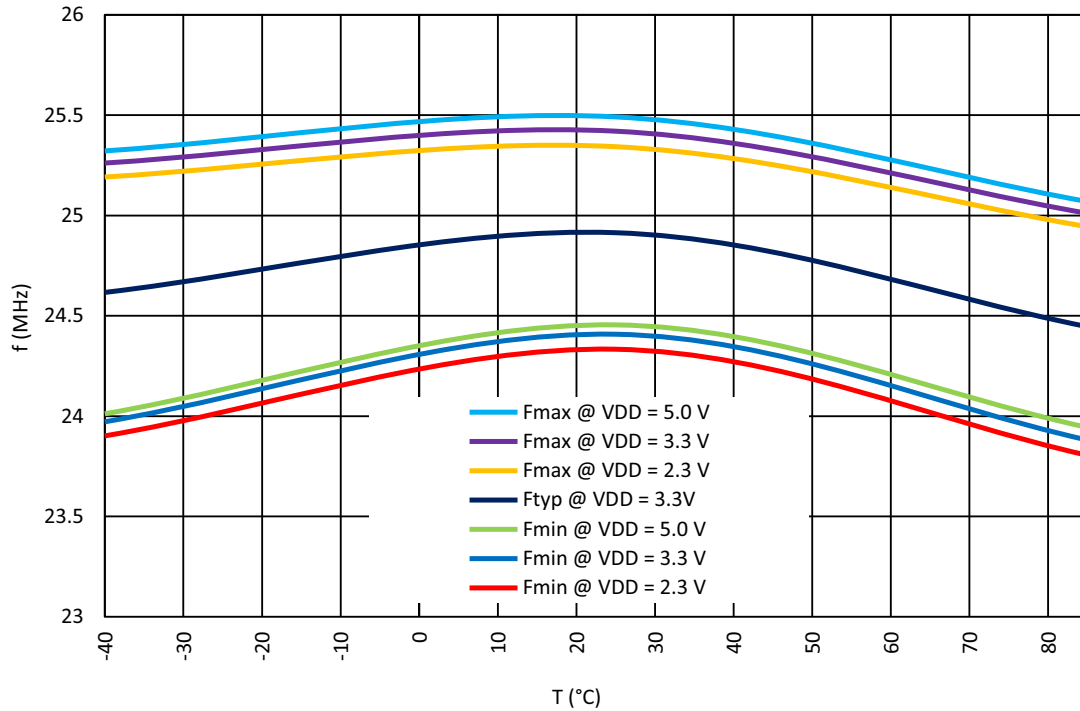


Figure 72: Oscillator1 Frequency vs. Temperature, OSC1 = 25 MHz

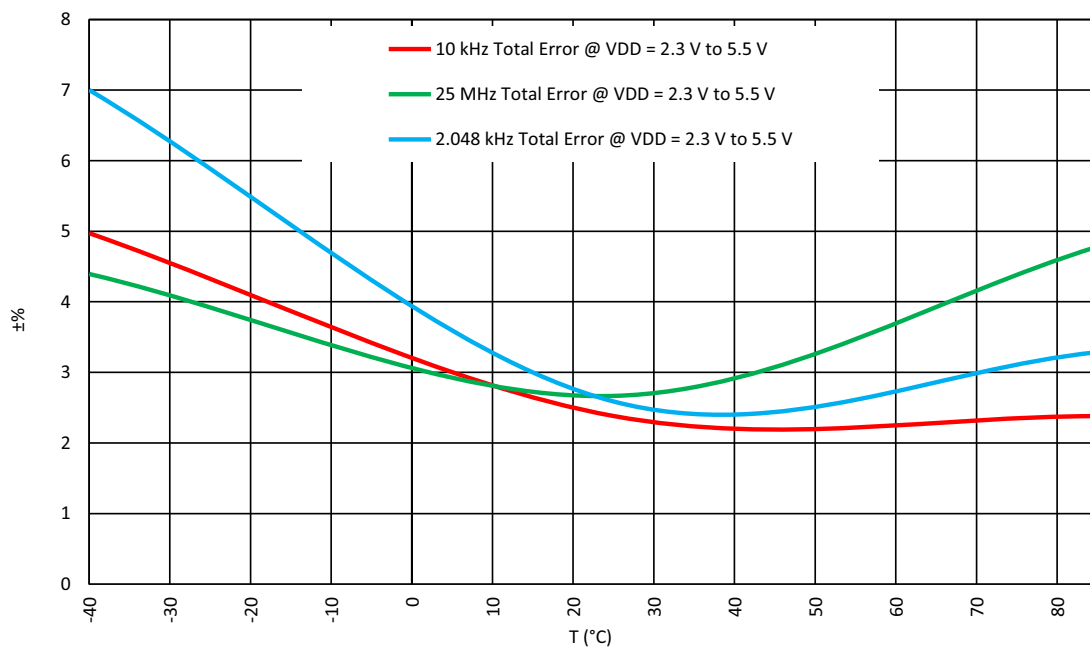


Figure 73: Oscillators Total Error vs. Temperature

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Note: For more information see Section 3.9.

13.8 OSCILLATORS SETTLING TIME

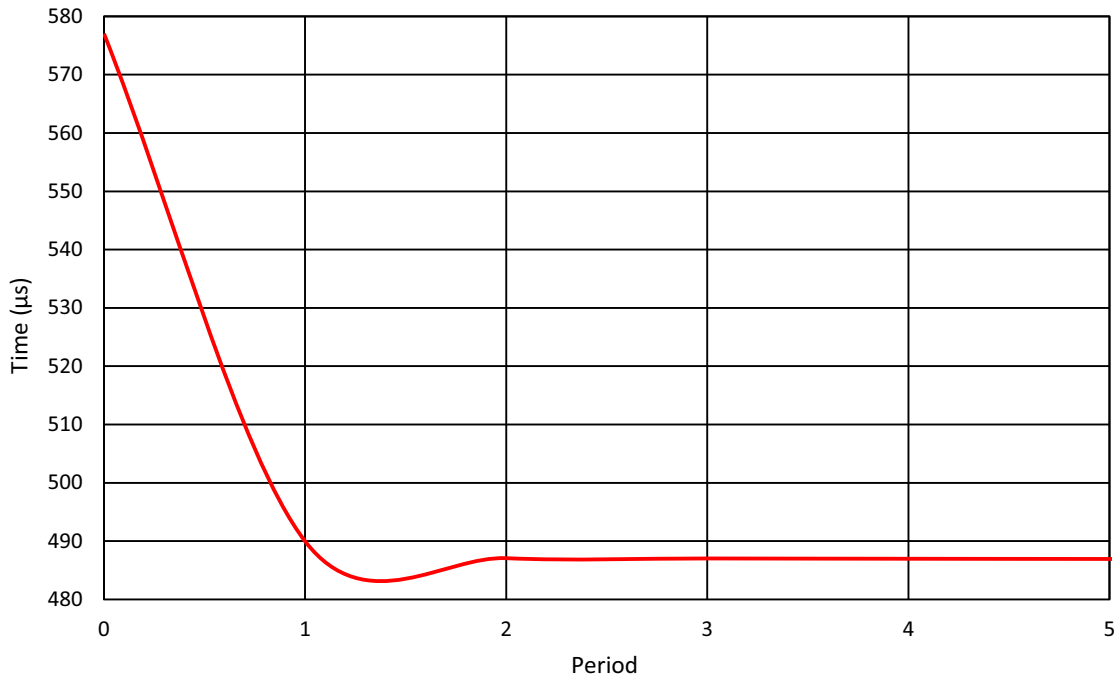


Figure 74: Oscillator0 Settling Time, $V_{DD} = 3.3\text{ V}$, $T = 25\text{ }^{\circ}\text{C}$, $\text{OSC0} = 2.048\text{ kHz}$

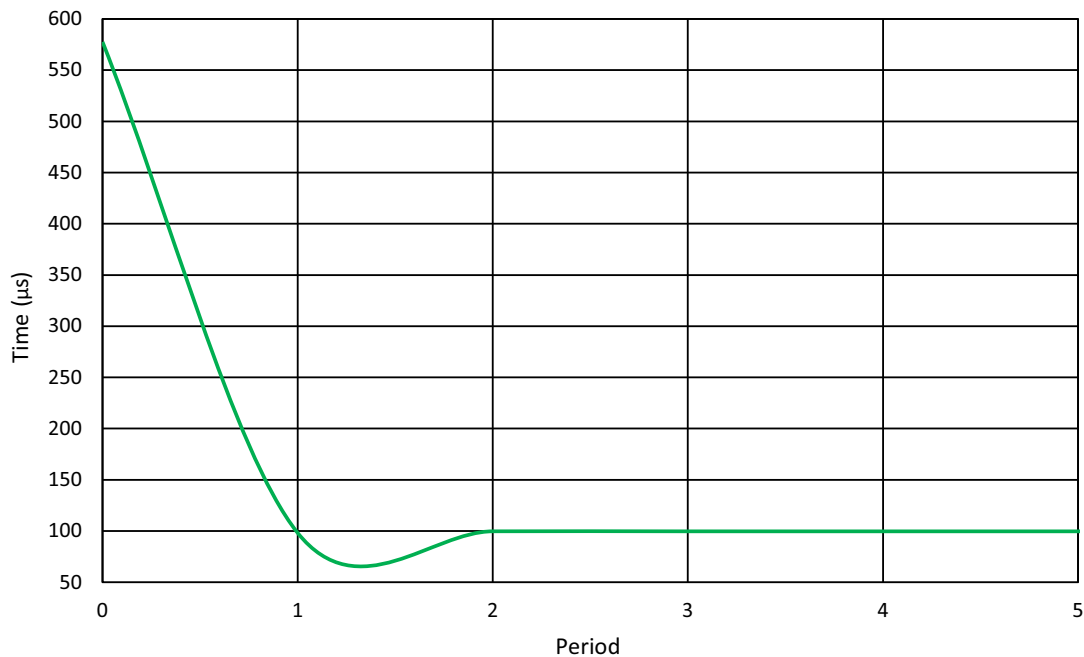


Figure 75: Oscillator0 Settling Time, $V_{DD} = 3.3\text{ V}$, $T = 25\text{ }^{\circ}\text{C}$, $\text{OSC0} = 10\text{ kHz}$

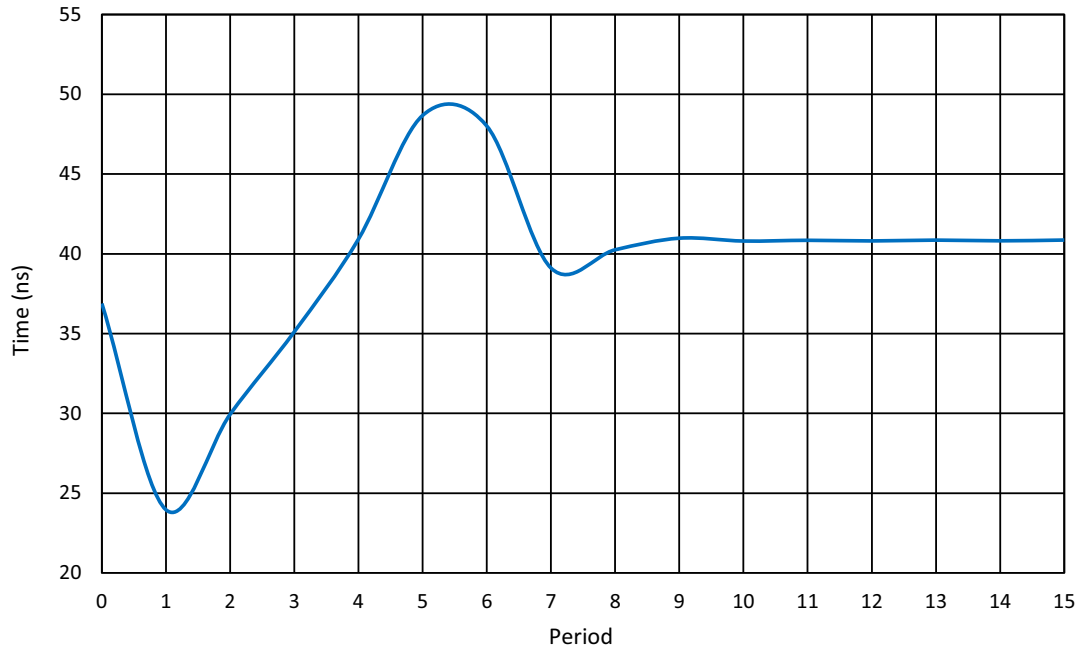


Figure 76: Oscillator1 Settling Time, $V_{DD} = 3.3\text{ V}$, $T = 25\text{ }^\circ\text{C}$, $\text{OSC1} = 25\text{ MHz}$ (Normal Start)

13.9 OSCILLATORS CURRENT CONSUMPTION

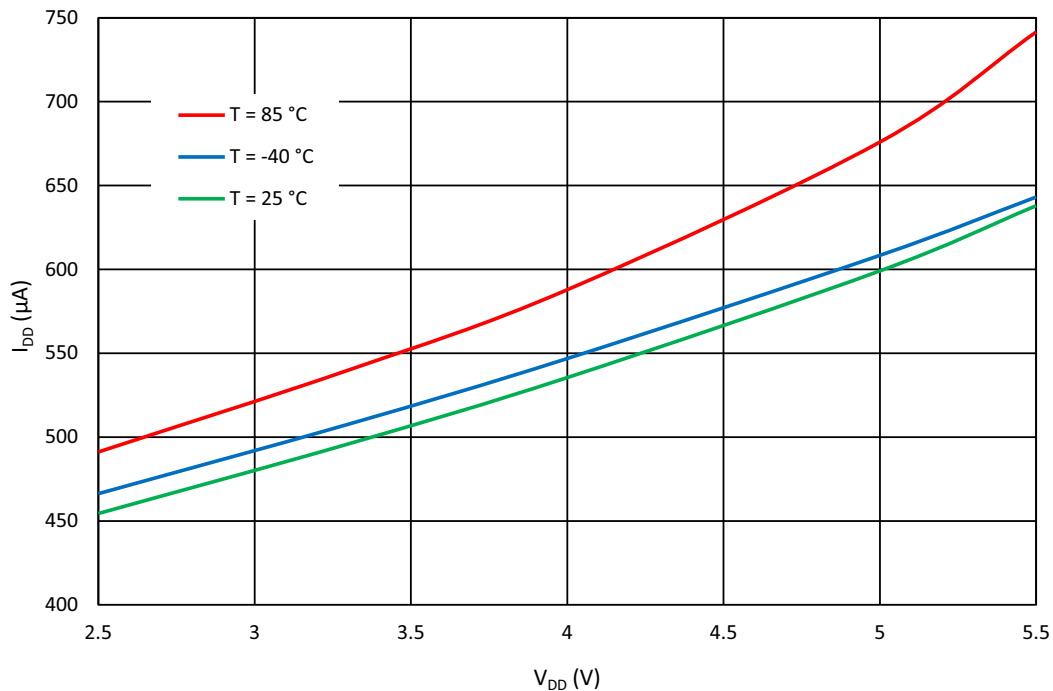


Figure 77: OSC0 Current Consumption vs. V_{DD} (All Pre-Dividers), $\text{OSC0} = 2.048\text{ kHz}$

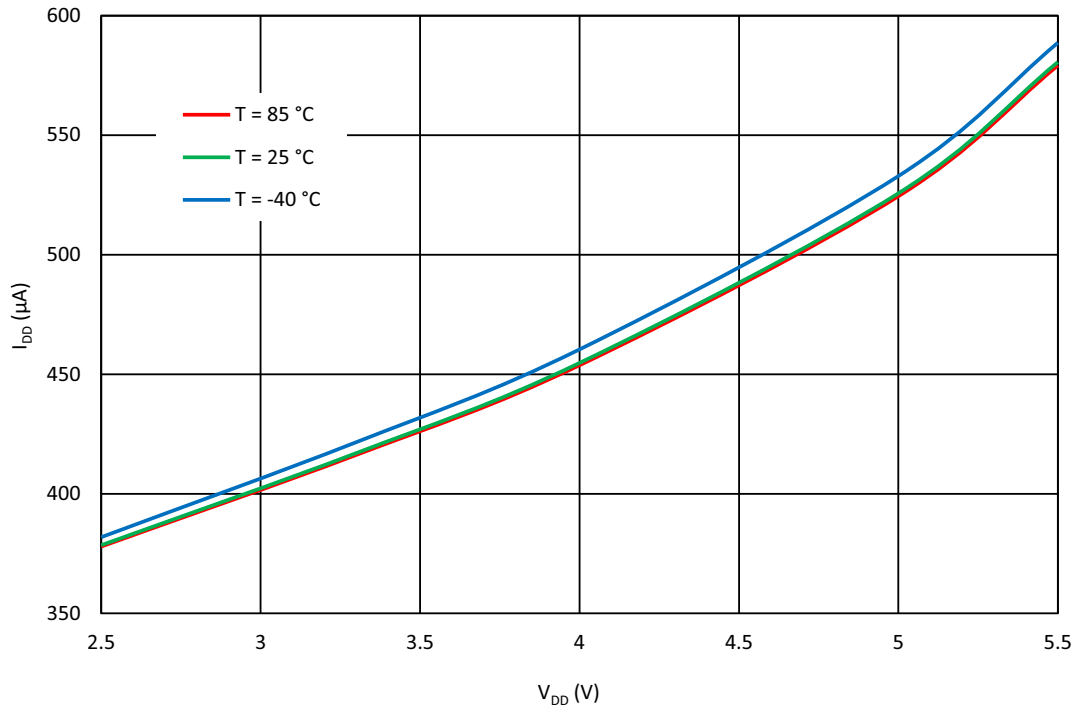


Figure 78: OSC0 Current Consumption vs. V_{DD} (All Pre-Dividers), OSC0 = 10 kHz

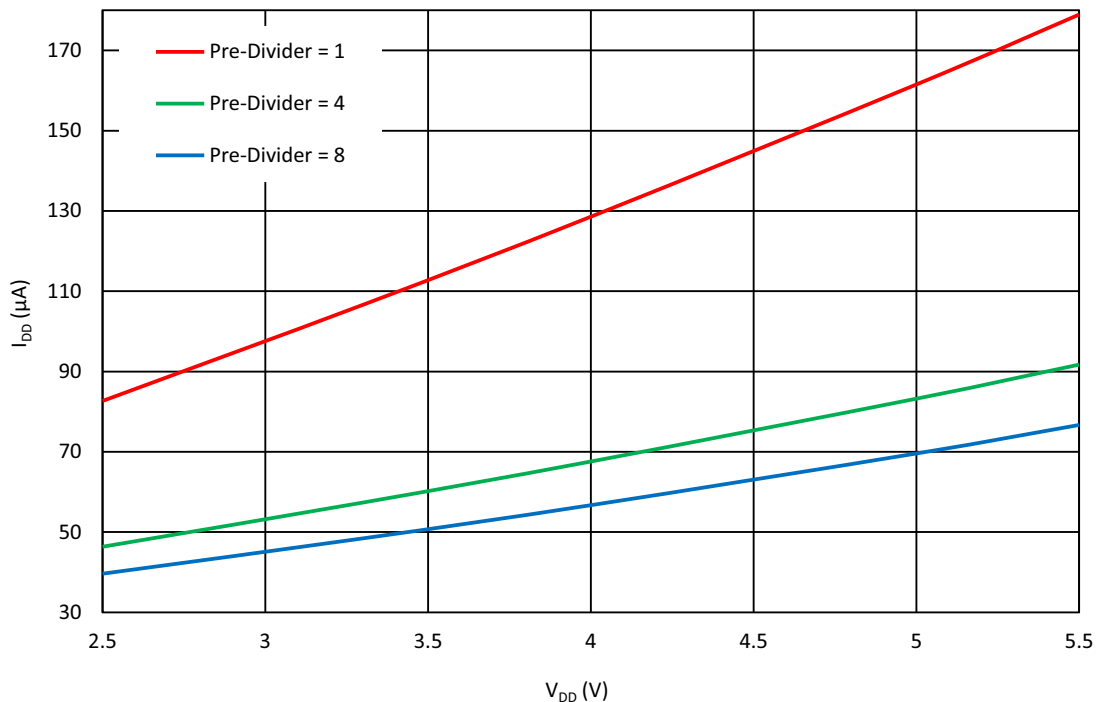


Figure 79: OSC1 Current Consumption vs. V_{DD}, T = -40 °C to 85 °C, OSC1 = 25 MHz

14 Power-On Reset

The SLG46811 has a Power-On Reset (POR) macrocell to ensure correct device initialization and operation of all macrocells in the device. The purpose of the POR circuit is to have consistent behavior and predictable results when the V_{DD} power is first ramping to the device, and also while the V_{DD} is falling during power-down. To accomplish this goal, the POR drives a defined sequence of internal events that trigger changes to the states of different macrocells inside the device, and finally to the state of the IOs.

14.1 GENERAL OPERATION

The SLG46811 is guaranteed to be powered down and non-operational when the V_{DD} voltage (voltage on PIN1) is less than Power-Off Threshold (see in [Table 6](#)), but not less than -0.6 V. Another essential condition for the chip to be powered down is that no voltage higher (Note) than the V_{DD} voltage is applied to any other PIN. For example, if V_{DD} voltage is 0.3 V, applying a voltage higher than 0.3 V to any other PIN is incorrect, and can lead to incorrect or unexpected device behavior.

Note: There is a 0.6 V margin due to forward drop voltage of the ESD protection diodes.

To start the POR sequence in the SLG46811, the voltage applied on the V_{DD} should be higher than the Power-On threshold (Note). The full operational V_{DD} range for the SLG46811 is 2.3 V to 5.5 V. This means that the V_{DD} voltage must ramp up to the operational voltage value, but the POR sequence will start earlier, as soon as the V_{DD} voltage rises to the Power-On threshold. After the POR sequence has started, the SLG46811 will have a typical period of time to go through all the steps in the sequence (noted in the datasheet for that device), and will be ready and completely operational after the POR sequence is complete.

Note: The Power-On threshold is defined in [Table 6](#).

To power down the chip the V_{DD} voltage should be lower than the operational and to guarantee that chip is powered down it should be less than Power-Off Threshold.

All PINs are in high impedance state when the chip is powered down and while the POR sequence is taking place. The last step in the POR sequence releases the IO structures from the high impedance state, at which time the device is operational. The pin configuration at this point in time is defined by the design programmed into the chip. Also, as it was mentioned before, the voltage on PINs can't be bigger than the V_{DD} , this rule also applies to the case when the chip is powered on.

14.2 POR SEQUENCE

The POR system generates a sequence of signals that enable certain macrocells. The sequence is shown in [Figure 80](#).

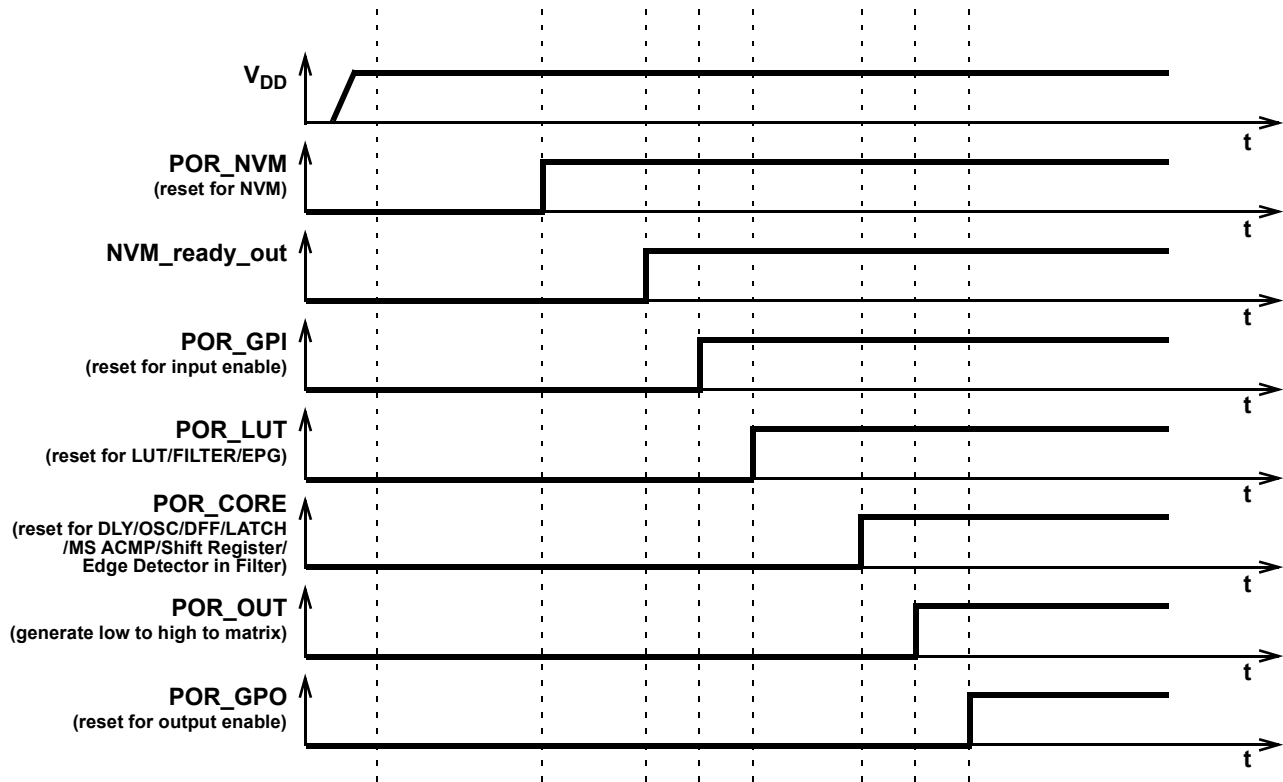


Figure 80: POR Sequence

As can be seen from [Figure 80](#) after the V_{DD} has start ramping up and crosses the Power-On threshold, first, the on-chip NVM memory is reset. Next, the chip reads the data from NVM, and transfers this information to a CMOS LATCH that serves to configure each macrocell, and the Connection Matrix which routes signals between macrocells. The third stage causes the reset of the input pins, and then to enable them. After that, the LUTs are reset and become active. After LUTs the Delay cells, OSCs, DFFs, and LATCHES are initialized. Only after all macrocells are initialized internal POR signal (POR macrocell output) goes from LOW to HIGH. The last portion of the device to be initialized are the output pins, which transition from high impedance to active at this point.

The typical time that takes to complete the POR sequence varies by device type in the GreenPAK family. It also depends on many environmental factors, such as: slew rate, V_{DD} value, temperature, and even will vary from chip to chip (process influence).

14.3 MACROCELLS OUTPUT STATES DURING POR SEQUENCE

To have a full picture of SLG46811 operation during powering and POR sequence, review the overview the macrocell output states during the POR sequence ([Figure 81](#) describes the output signals states).

First, before the NVM has been reset, all macrocells have their output set to logic LOW (except the output pins which are in high impedance state). On the next step, some of the macrocells start initialization: input pins output state becomes LOW; LUTs also output LOW. Only P_DLY macrocell configured as edge detector becomes active at this time. After that input pins are enabled.

Next, only LUTs are configured. Next, all other macrocells are initialized. After macrocells are initialized, internal POR matrix signal switches from LOW to HIGH. The last are output pins that become active and determined by the input signals.

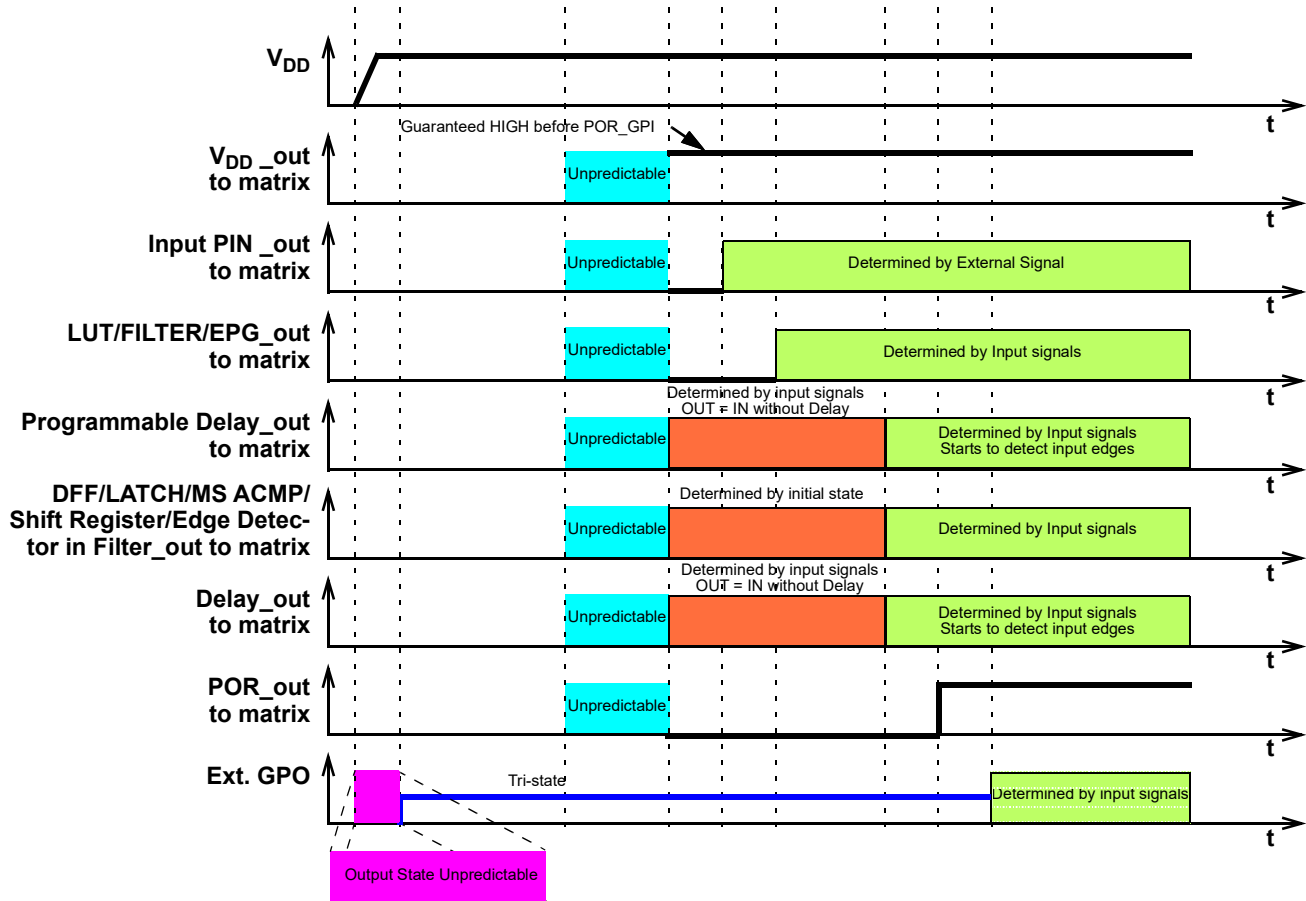


Figure 81: Internal Macrocell States During POR Sequence

14.3.1 Initialization

All internal macrocells by default have initial low level. Starting from indicated power-up time of 1.84 V (typical), macrocells in SLG46811 are powered on while forced to the reset state. All outputs are in Hi-Z and chip starts loading data from NVM. Then the reset signal is released for internal macrocells and they start to initialize according to the following sequence:

1. Input pins, ACMP, Pull-up/down.
2. LUTs.
3. DFFs, Delays/Counters.
4. POR output to matrix.
5. Output pin corresponds to the internal logic.

The POR signal going high indicates the mentioned power-up sequence is complete.

Note: The maximum voltage applied to any pin should not be higher than the V_{DD} level. There are ESD Diodes between pin → V_{DD} and pin → GND on each pin. So, if the input signal applied to pin is higher than V_{DD}, then current will sink through the diode to V_{DD}. Exceeding V_{DD} results in leakage current on the input pin, and V_{DD} will be pulled up, following the voltage on the input pin. There is no effect from input pin when input voltage is applied at the same time as V_{DD}.

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14.3.2 Power-Down

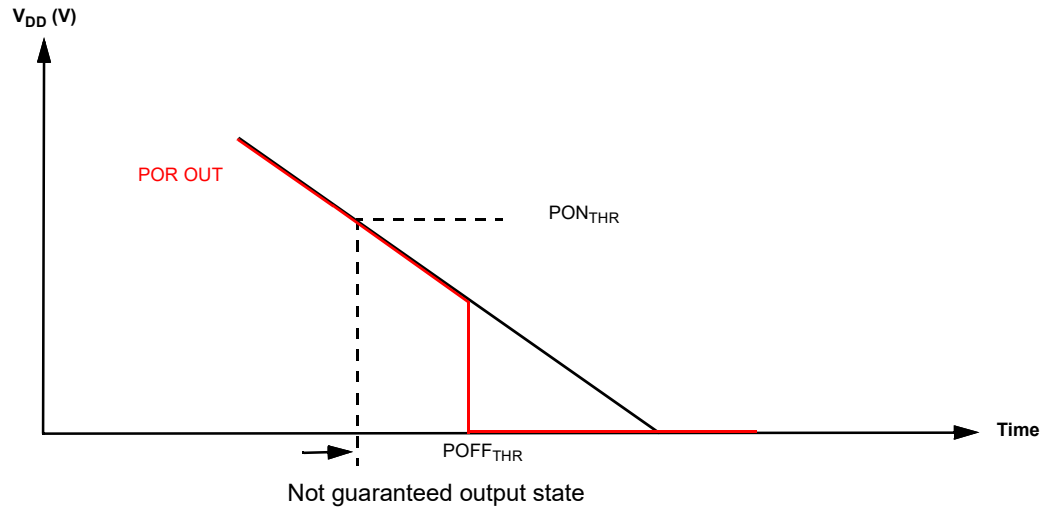


Figure 82: Power-Down

During Power-down, macrocells in SLG46811 are powered off after V_{DD} falling down below Power-Off Threshold. Please note that during a slow rampdown, outputs can possibly switch state during this time.

15 I²C Serial Communications Macrocell

15.1 I²C SERIAL COMMUNICATIONS MACROCELL OVERVIEW

In the standard use case for the GreenPAK devices, the configuration choices made by the user are stored as bit settings in the Non-Volatile Memory (NVM), and this information is transferred at startup time to volatile RAM registers that enable the configuration of the macrocells. Other RAM registers in the device are responsible for setting the connections in the Connection Matrix to route signals in the manner most appropriate for the user's application.

The I²C Serial Communications Macrocell in this device allows an I²C bus Master to read and write this information via a serial channel directly to the RAM registers, allowing the remote re-configuration of macrocells, and remote changes to signal chains within the device.

An I²C bus Master is also able read and write other register bits that are not associated with NVM memory. As an example, the input lines to the Connection Matrix can be read as digital register bits. These are the signal outputs of each of the macrocells in the device, giving an I²C bus Master the capability to remotely read the current value of any macrocell.

The user has the flexibility to control read access and write access via registers bits registers [1119:1117]. See Section 15.5 for more details on I²C read/write memory protection.

15.2 I²C SERIAL COMMUNICATIONS DEVICE ADDRESSING

Each command to the I²C Serial Communications macrocell begins with a Control Byte. The bits inside this Control Byte are shown in Figure 83. After the Start bit, the first four bits are a control code. Each bit in a control code can be sourced independently from the register or by value defined externally GPIO, GPIO2, GPIO4, and GPIO5. The LSB of the control code is defined by the value of GPIO, while the MSB is defined by the value of GPIO5. The address source (either register bit or PIN) for each bit in the control code is defined by registers [1179:1176]. This gives the user flexibility on the chip level addressing of this device and other devices on the same I²C bus. The Block Address is the next three bits (A10, A9, A8), which will define the most significant bits in the addressing of the data to be read or written by the command. The last bit in the Control Byte is the R/W bit, which selects whether a read command or write command is requested, with a "1" selecting for a Read command, and a "0" selecting for a Write command. This Control Byte will be followed by an Acknowledge bit (ACK), which is sent by this device to indicate successful communication of the Control Byte data.

In the I²C-bus specification and user manual, there are two groups of eight addresses (0000 xxx and 1111 xxx) that are reserved for the special functions, such as a system General Call address. If the user of this device chooses to set the Control Code to either "1111" or "0000" in a system with other slave device, please consult the I²C-bus specification and user manual to understand the addressing and implementation of these special functions, to insure reliable operation.

In the read and write command address structure, there are a total of 11 bits of addressing, each pointing to a unique byte of information, resulting in a total address space of 2K bytes. Of this 2K byte address space, the valid addresses accessible to the I²C Macrocell on the SLG46811 are in the range from 0 (0x00) to 255 (0xFF). The MSB address bits (A10, A9, and A8) will be "0" for all commands to the SLG46811.

With the exception of the Current Address Read command, all commands will have the Control Byte followed by the Word Address. Figure 83 shows this basic command structure.

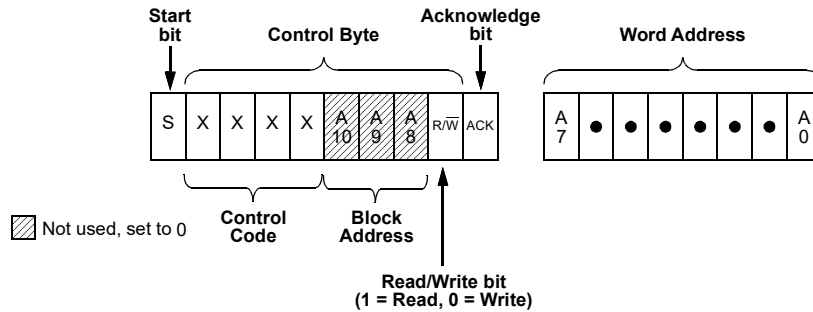


Figure 83: Basic Command Structure

15.3 I²C SERIAL GENERAL TIMING

General timing characteristics for the I²C Serial Communications macrocell are shown in Figure 84. Timing specifications can be found in the AC Characteristics section.

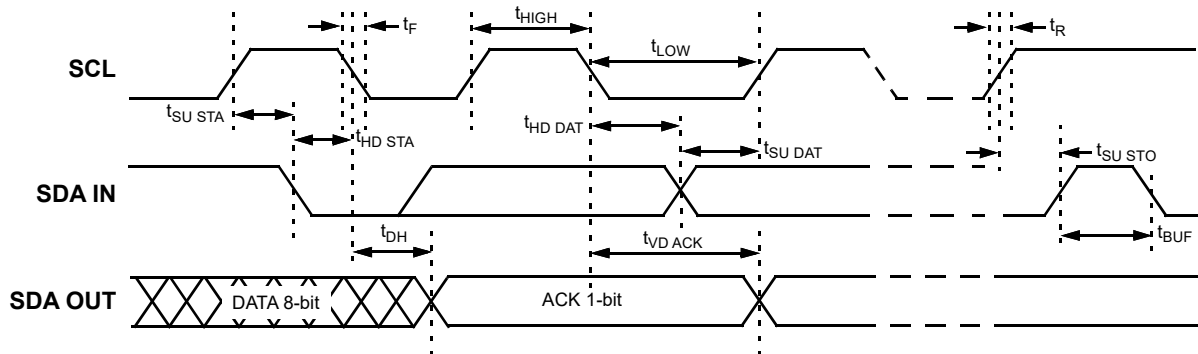


Figure 84: I²C General Timing Characteristics

15.4 I²C SERIAL COMMUNICATIONS COMMANDS

15.4.1 Byte Write Command

Following the Start condition from the Master, the Control Code [4 bits], the Block Address [3 bits], and the R/W bit (set to “0”), are placed onto the I²C bus by the Master. After the SLG46811 sends an Acknowledge bit (ACK), the next byte transmitted by the Master is the Word Address. The Block Address (A10, A9, A8), combined with the Word Address (A7 through A0), together set the internal address pointer in the SLG46811, where the data byte is to be written. After the SLG46811 sends another Acknowledge bit, the Master will transmit the data byte to be written into the addressed memory location. The SLG46811 again provides an Acknowledge bit and then the Master generates a Stop condition. The internal write cycle for the data will take place at the time that the SLG46811 generates the Acknowledge bit.

It is possible to latch all IOs during I²C write command, register [1113] = 1 - Enable. It means that IOs will remain their state until the write command is done.

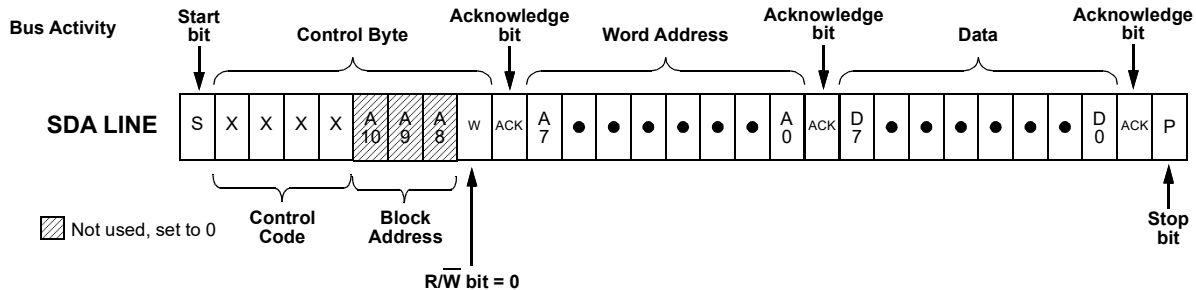


Figure 85: Byte Write Command, $\overline{R/W} = 0$

15.4.2 Sequential Write Command

The write Control Byte, Word Address and the first data byte are transmitted to the SLG46811 in the same way as in a Byte Write command. However, instead of generating a Stop condition, the Bus Master continues to transmit data bytes to the SLG46811. Each subsequent data byte will increment the internal address counter, and will be written into the next higher byte in the command addressing. As in the case of the Byte Write command, the internal write cycle will take place at the time that the SLG46811 generates the Acknowledge bit.

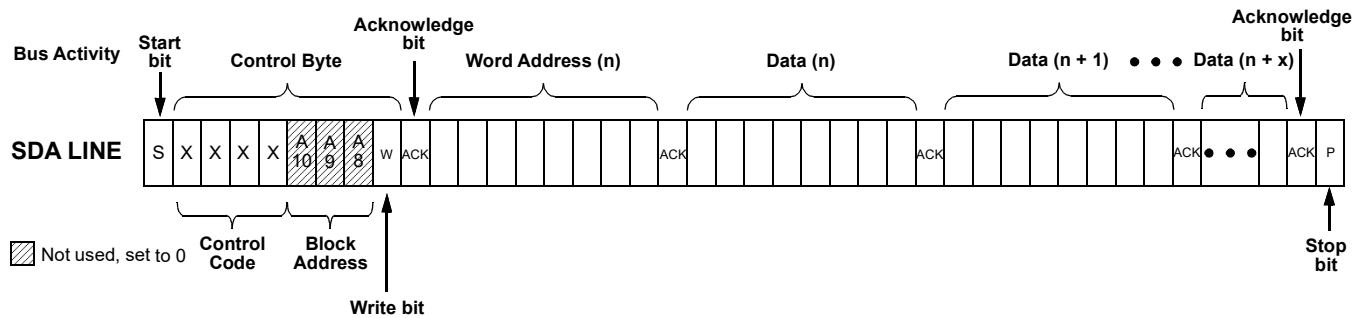


Figure 86: Sequential Write Command

15.4.3 Current Address Read Command

The Current Address Read Command reads from the current pointer address location. The address pointer is incremented at the first STOP bit following any write control byte. For example, if a Sequential Read command (which contains a write control byte) reads data up to address n, the address pointer would get incremented to n + 1 upon the STOP of that command. Subsequently, a Current Address Read that follows would start reading data at n + 1. The Current Address Read Command contains the Control Byte sent by the Master, with the $\overline{R/W}$ bit = "1". The SLG46811 will issue an Acknowledge bit, and then transmit eight data bits for the requested byte. The Master will not issue an Acknowledge bit, and follow immediately with a Stop condition.

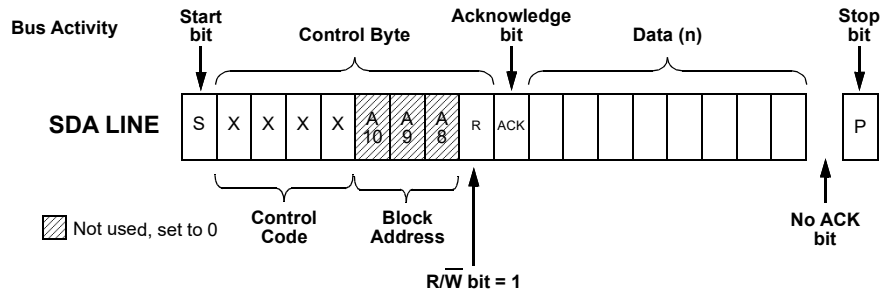


Figure 87: Current Address Read Command, $\overline{R/W} = 1$

15.4.4 Random Read Command

The Random Read command starts with a Control Byte (with R/W bit set to “0”, indicating a write command) and Word Address to set the internal byte address, followed by a Start bit, and then the Control Byte for the read (exactly the same as the Byte Write command). The Start bit in the middle of the command will halt the decoding of a Write command, but will set the internal address counter in preparation for the second half of the command. After the Start bit, the Bus Master issues a second control byte with the R/W bit set to “1”, after which the SLG46811 issues an Acknowledge bit, followed by the requested eight data bits.

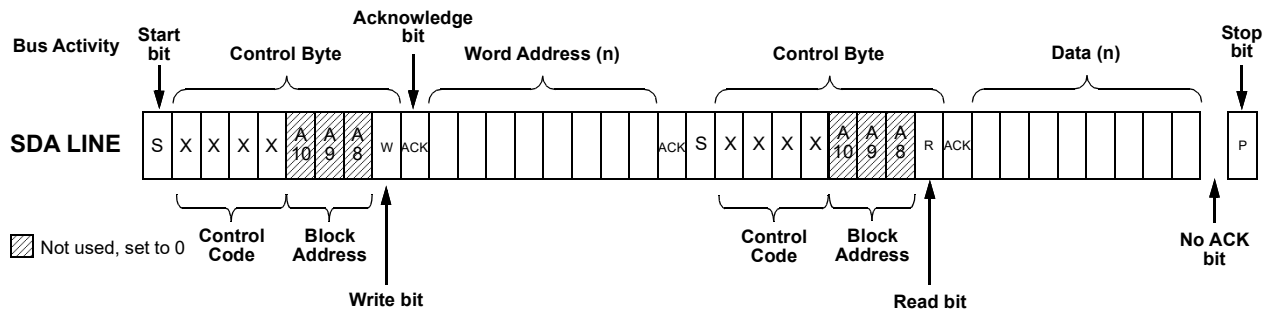


Figure 88: Random Read Command

SLG46811

GreenPAK Programmable Mixed-Signal Matrix

15.4.5 Sequential Read Command

The Sequential Read command is initiated in the same way as a Random Read command, except that once the SLG46811 transmits the first data byte, the Bus Master issues an Acknowledge bit as opposed to a Stop condition in a random read. The Bus Master can continue reading sequential bytes of data, and will terminate the command with a Stop condition.

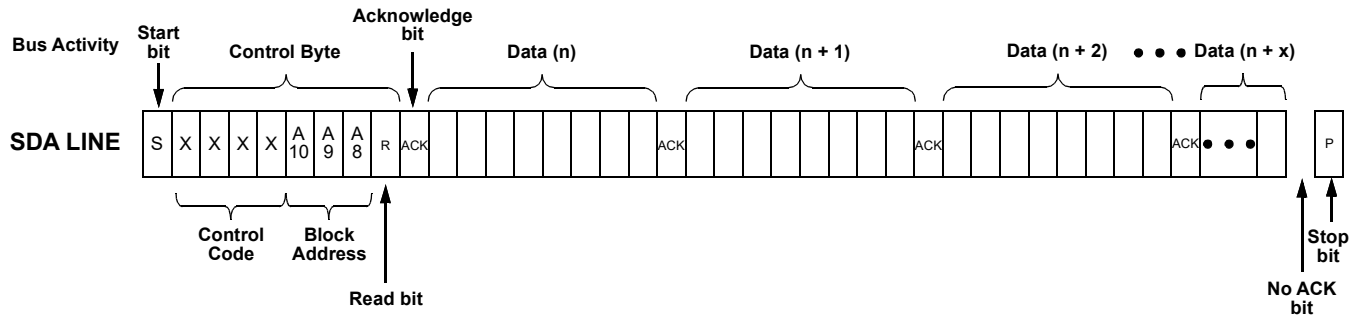


Figure 89: Sequential Read Command

15.4.6 I²C Serial Reset Command

If I²C serial communication is established with the device, it is possible to reset the device to initial power up conditions, including configuration of all macrocells, and all connections provided by the Connection Matrix. This is implemented by setting register [1112] I²C reset bit to “1”, which causes the device to re-enable the Power-On Reset (POR) sequence, including the reload of all register data from NVM. During the POR sequence, the outputs of the device will be in tri-state. After the reset has taken place, the contents of register [1112] will be set to “0” automatically. The Figure 90 illustrates the sequence of events for this reset function.

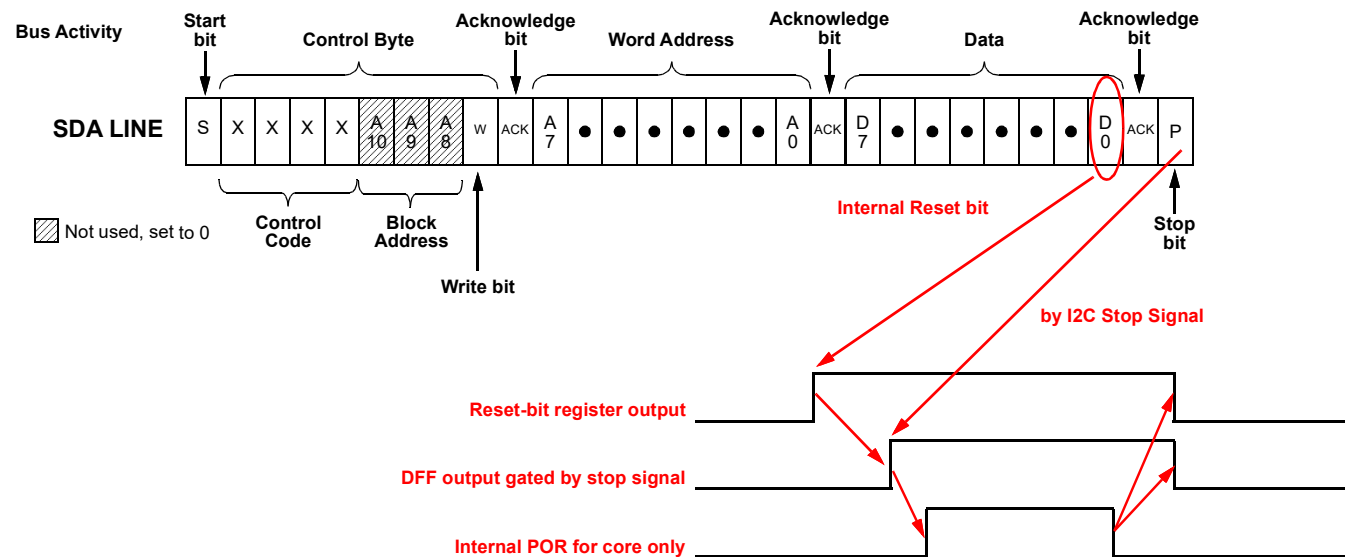


Figure 90: Reset Command Timing

15.5 I²C SERIAL COMMAND REGISTER MAP

There are seven read/write protect modes for the design sequence from being corrupted or copied. See [Table 40](#) for details.

Table 41: Read/Write Protection Options

| Configurations | Protection Modes Configuration | | | | | | | Register Address |
|---|--------------------------------|-------------------|-------------------|--------------------------|-----------|------------|------------------|-------------------------------|
| | Unlocked | Partly Lock Read1 | Partly Lock Read2 | Partly Lock Read2/ Write | Lock Read | Lock Write | Lock Read/ Write | |
| | (Mode 0) | (Mode 1) | (Mode 2) | (Mode 3) | (Mode 4) | (Mode 5) | (Mode 6) | |
| I ² C Byte Write Bit Masking (section 15.6.1) | R/W | R/W | R/W | R/W | W | R | - | 8C |
| I ² C Serial Reset Command (section 15.4.6) | R/W | R/W | R/W | R/W | R/W | R | R | 8B, b'0 |
| Outputs Latching During I ² C Write | R/W | R/W | R/W | R/W | R/W | R | R | 8B, b'1 |
| Connection Matrix Virtual Inputs (section 6.3) | R/W | R/W | R/W | R/W | W | R | - | 39; 3A, b'6~0 |
| Configuration Bits for All Macrocells (IO Pins, ACMPs, Combination Function Macrocells, etc.) | R/W | R/W | W | - | W | R | - | 3D~83, 85, 86 |
| Macrocells Inputs Configuration (Connection Matrix Outputs, section 6.2) | R/W | W | W | - | W | R | - | 0~35 |
| Protection Mode Enable | R | R | R | R | R | R | R | 8B, b'3 |
| Protection Mode Selection | R/W | R | R | R | R | R | R | 8B, b'7~5 |
| Macrocells Output Values (Connection Matrix Inputs, section 6.1) | R | R | R | R | - | R | - | 36~38; 3A, b'7; 3B; 3C, b'4~0 |
| I ² C Control Code (section 15.2) | R | R | R | R | R | R | R | 93, b'3~0 |
| Pin Slave Address Select | R | R | R | R | R | R | R | 93, b'7~4 |
| I ² C Disable/Enable | R | R | R | R | R | R | R | 94, b'0 |
| Programming disable | R | R | R | R | R | R | R | 94, b'1 |
| Code Compare Enable | R | R | R | R | R | R | R | 94, b'2 |

| | |
|-----|--|
| R/W | Allow Read and Write Data |
| W | Allow Write Data Only |
| R | Allow Read Data Only |
| - | The Data is protected for Read and Write |

It is possible to read some data from macrocells, such as connection matrix, Shift Registers State, and connection matrix virtual inputs. The I²C write will not have any impact on data in case data comes from macrocell output, except Connection Matrix Virtual Inputs. The silicon identification service bits allows identifying silicon family, its revision, and others.

See Section 18 for detailed information on all registers.

15.6 I²C ADDITIONAL OPTIONS

When Output latching during I²C write, register [1113] = 1 allows all PINs output value to be latched until I²C write is done. It will protect the output change due to configuration process during I²C write in case multiple register bytes are changed. Inputs and internal macrocells retain their status during I²C write.

If the user sets GPIO0 and GPIO1 function to a selection other than SDA and SCL, all access via I²C will be disabled.

Note: Any write commands that come to the device via I²C that are not blocked, based on the protection bits, will change the contents of the RAM register bits that mirror the NVM bits. These write commands will not change the NVM bits themselves, and a POR event will restore the register bits to original programmed contents of the NVM.

See Section 18 for detailed information on all registers.

15.6.1 I²C Byte Write Bit Masking

The I²C macrocell inside SLG46811 supports masking of individual bits within a byte that is written to the RAM memory space. This function is supported across the entire RAM memory space. To implement this function, the user performs a Byte Write Command (see Section 15.4.1 for details) on the I²C Byte Write Mask Register (address 0F6H) with the desired bit mask pattern. This sets a bit mask pattern for the target memory location that will take effect on the next Byte Write Command to this register byte. Any bit in the mask that is set to “1” in the I²C Byte Write Mask Register will mask the effect of changing that particular bit in the target register, during the next Byte Write Command. The contents of the I²C Byte Write Mask Register are reset (set to 00h) after valid Byte Write Command. If the next command received by the device is not a Byte Write Command, the effect of the bit masking function will be aborted, and the I²C Byte Write Mask Register will be reset with no effect. Figure 91 shows an example of this function.

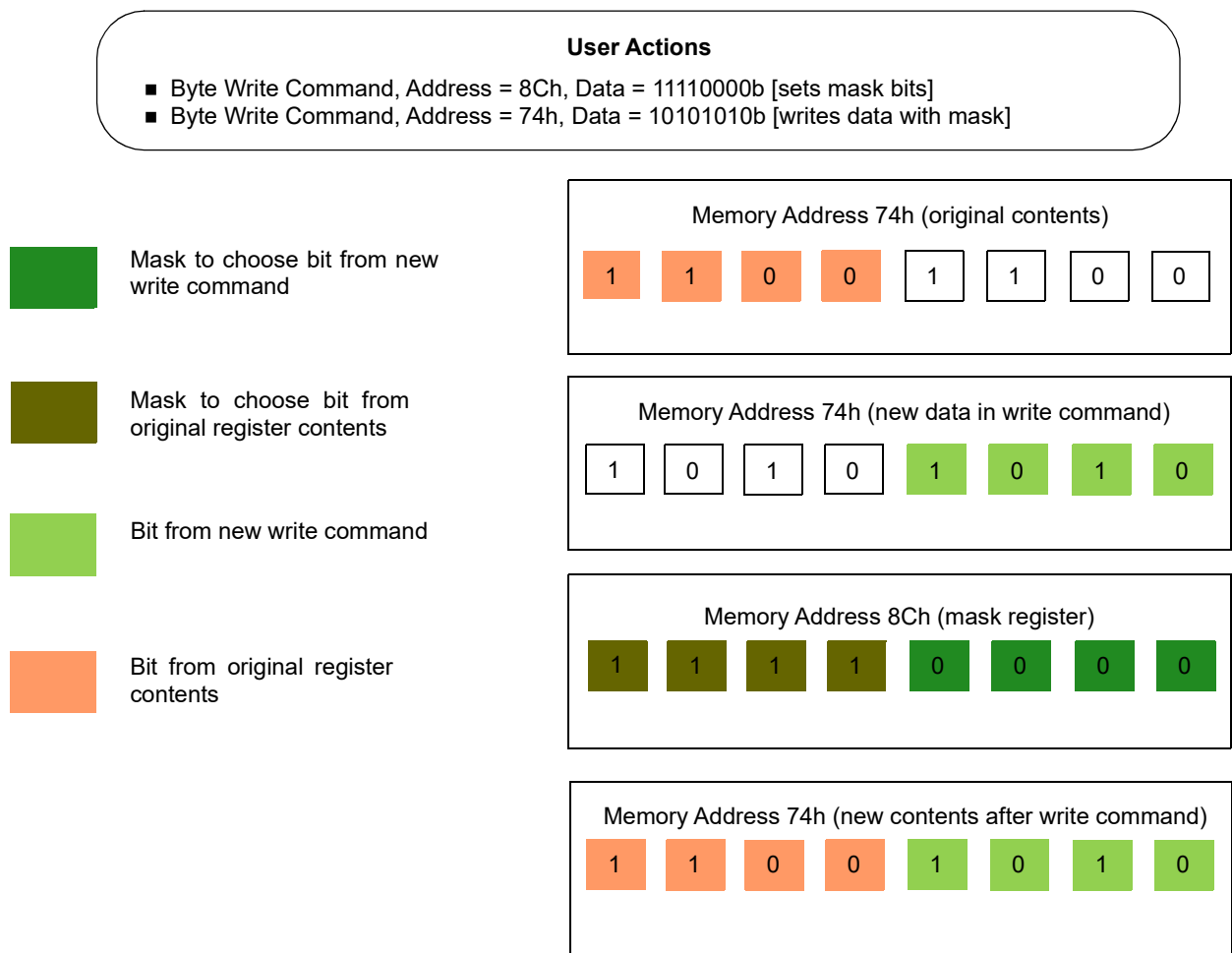


Figure 91: Example of I²C Byte Write Bit Masking

16 Extended Pattern Generator

SLG46811 has an ability to read the data from the part of NVM and to set this data to the matrix inputs. This is done with help of Extended Pattern Generator that shares its output with I²C virtual inputs. Figure 92 shows I²C General block diagram with shared outputs. Registers [1078:1064] define I²C block configuration as Virtual Inputs or Pattern Generator, or GPI.

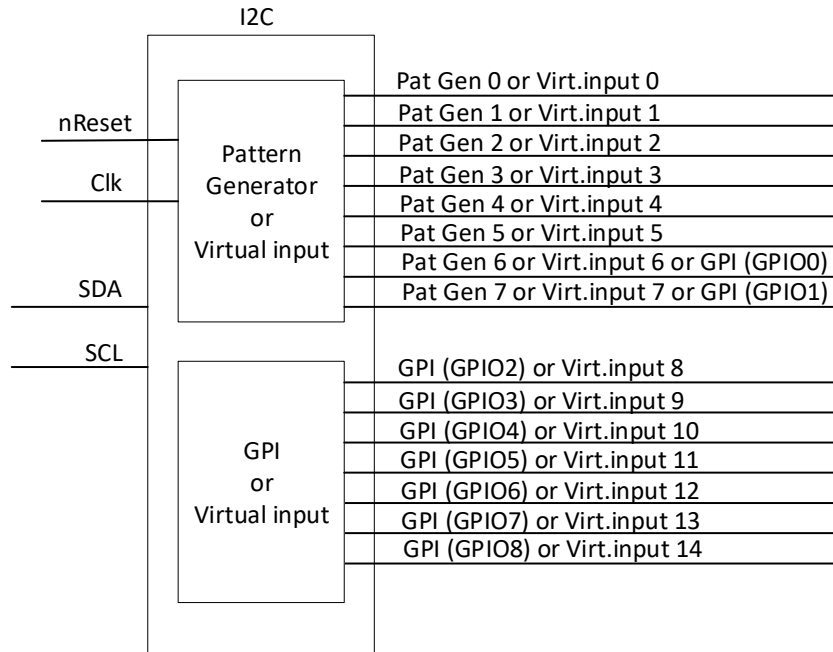


Figure 92: I²C General Block Diagram

Initial value of Extended Pattern Generator is defined by registers [495:488]. This value appears at the output of the macrocell after power up event and after applying low level at nReset input.

Every rising edge at Clk input generator loads byte from the NVM and this data appears at Pattern Generator outputs. The internal NVM pointer increases by 1. At the next rising edge new data from the next NVM byte will be loaded. The range of the data for the Extended Pattern Generator is 92 bytes from the NVM bit [1280] to the NVM bit [2015]. User can select the behavior of the Generator when the internal pointer reaches the last address of the NVM:

- If register [564] = 0, the internal counter will overflow.
- If register [564] = 1, the internal counter will stop when reaching the last byte of the NVM.

The maximum allowable speed of the EPG is 1 MHz.

The minimum duration of the clock pulse low and high level is 100 ns.

Low level at nReset input sets NVM pointer to the beginning and loads the initial value to the outputs. User can select any of Pattern Generator outputs to operate as Virtual Inputs.

17 Analog Temperature Sensor

The SLG46811 has an Analog Temperature sensor (TS) with an output voltage linearly-proportional to the Centigrade temperature. TS output can be selected as a source of MS ACMP channel. The TS is rated to operate over a -40°C to 85°C temperature range. The error in the whole temperature range does not exceed 5.96 %. For more detail refer to section 3.11.

The equation below calculates the typical analog voltage passed from the TS to the ACMPs' IN+ source input for $V_{DD} = 2.3\text{ V}$ to 5.5 V . It is important to note that there will be a chip to chip variation of about $\pm 2\text{ }^\circ\text{C}$.

$$V_T = -4.8 \times T + 1825.2$$

where:

V_{TS} (mV) - TS Output Voltage.

T ($^\circ\text{C}$) - Temperature

Temperature hysteresis can be setup by enabling the GreenPAK's internal ACMP hysteresis.

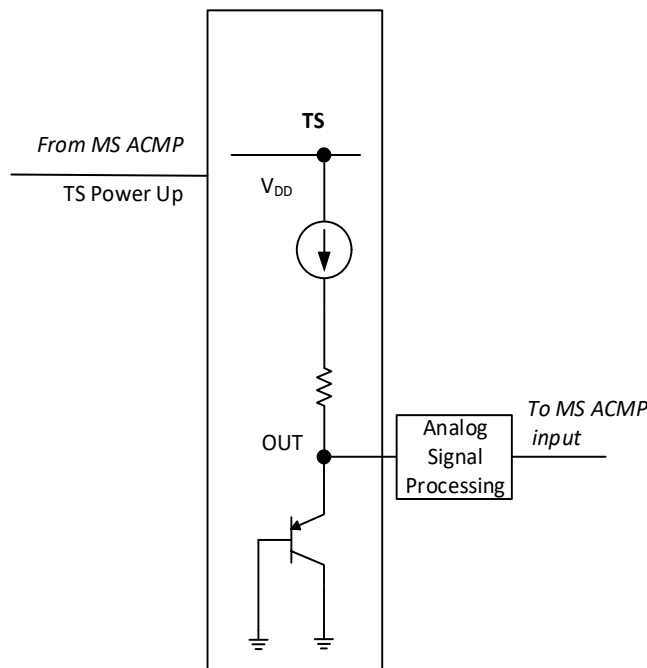


Figure 93: Analog Temperature Sensor Structure Diagram

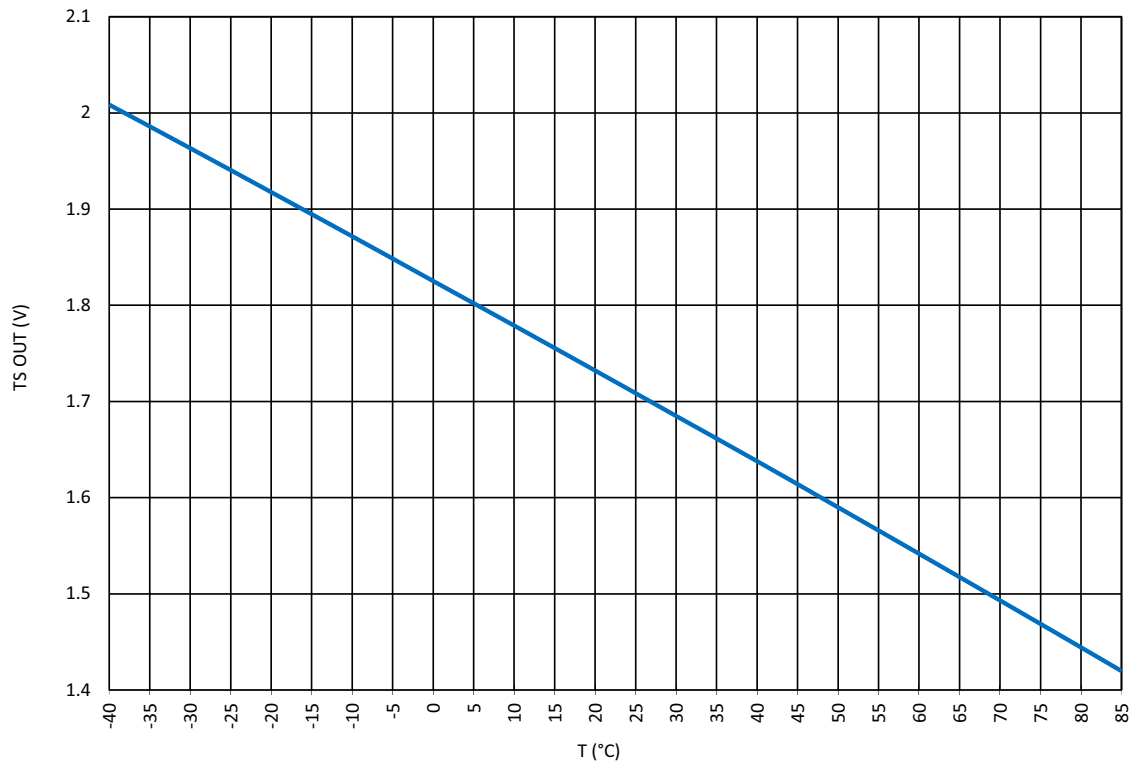


Figure 94: TS Output vs. Temperature, $V_{DD} = 2.3\text{ V to }5.5\text{ V}$

18 Register Definitions

18.1 REGISTER MAP

Table 42: Register Map

| Address | | Signal Function | Register Bit Definition |
|----------------------|--------------|-----------------|---|
| Byte | Register Bit | | |
| Matrix Output | | | |
| 0 | 0 | LUT2_0 & DFF0 | OUT0: IN0 of LUT2_0 or Clock Input of DFF0 |
| | 1 | | |
| | 2 | | |
| | 3 | | |
| | 4 | | |
| | 5 | | |
| | 6 | | |
| | 7 | | |
| 1 | 8 | LUT2_1 & DFF1 | OUT1: IN1 of LUT2_0 or Data Input of DFF0 |
| | 9 | | |
| | 10 | | |
| | 11 | | |
| | 12 | | |
| | 13 | | |
| 2 | 14 | LUT2_2 & PGen | OUT2: IN0 of LUT2_1 or Clock Input of DFF1 |
| | 15 | | |
| | 16 | | |
| | 17 | | |
| | 18 | | |
| | 19 | | |
| | 20 | | |
| | 21 | | |
| 3 | 22 | LUT2_2 & PGen | OUT3: IN1 of LUT2_1 or Data Input of DFF1 |
| | 23 | | |
| | 24 | | |
| | 25 | | |
| | 26 | | |
| | 27 | | |
| 4 | 28 | LUT2_2 & PGen | OUT4: IN0 of LUT2_2 or Clock Input of PGen |
| | 29 | | |
| | 30 | | |
| | 31 | | |
| 4 | 32 | LUT2_2 & PGen | OUT5: IN1 of LUT2_2 or RSTB of PGen |
| | 33 | | |
| | 34 | | |
| | 35 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition | |
|---------|--------------|-----------------|--|---|
| Byte | Register Bit | | | |
| 4 | 36 | LUT3_0 & DFF2 | OUT6: IN0 of LUT3_0 or CLK Input of DFF2 | |
| | 37 | | | |
| | 38 | | | |
| | 39 | | | |
| 5 | 40 | | LUT3_0 & DFF2 | OUT7: IN1 of LUT3_0 or Data of DFF2 |
| | 41 | | | |
| | 42 | | | |
| | 43 | | | |
| | 44 | | | |
| | 45 | | | |
| | 46 | | | |
| 6 | 47 | | LUT3_0 & DFF2 | OUT8: IN2 of LUT3_0 or RSTB (SETB) of DFF2 |
| | 48 | | | |
| | 49 | | | |
| | 50 | | | |
| | 51 | | | |
| | 52 | | | |
| | 53 | | | |
| 7 | 54 | LUT3_1 & DFF3 | OUT9: IN0 of LUT3_1 or CLK Input of DFF3 | |
| | 55 | | | |
| | 56 | | | |
| | 57 | | | |
| | 58 | | | |
| | 59 | | | |
| | 60 | | | |
| 8 | 61 | | LUT3_1 & DFF3 | OUT10: IN1 of LUT3_1 or Data of DFF3 |
| | 62 | | | |
| | 63 | | | |
| | 64 | | | |
| | 65 | | | |
| | 66 | | | |
| | 67 | | | |
| 8 | 68 | LUT3_1 & DFF3 | OUT11: IN2 of LUT3_1 or RSTB (SETB) of DFF3 | |
| | 69 | | | |
| | 70 | | | |
| | 71 | | | |
| | 71 | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition | | |
|---------|---------------------|--|--|---|--|
| Byte | Register Bit | | | | |
| 9 | 72 | LUT3_2 & DFF4 | OUT12: IN0 of LUT3_2 or CLK Input of DFF4 | | |
| | 73 | | | | |
| | 74 | | | | |
| | 75 | | | | |
| | 76 | | | | |
| | 77 | | | | |
| | 78 | | | | |
| 79 | | | | | |
| A | 80 | | LUT3_2 & DFF4 | OUT13: IN1 of LUT3_2 or Data of DFF4 | |
| | 81 | | | | |
| | 82 | | | | |
| | 83 | | | | |
| | 84 | | | | |
| | 85 | | | | |
| | 86 | | | | |
| B | 87 | LUT3_2 & DFF4 | OUT14: IN2 of LUT3_2 or RSTB (SETB) of DFF4 | | |
| | 88 | | | | |
| | 89 | | | | |
| | 90 | | | LUT3_3 & DFF5 | OUT15: IN0 of LUT3_3 or CLK Input of DFF5 |
| | 91 | | | | |
| | 92 | | | | |
| | 93 | | | | |
| 94 | | | | | |
| 95 | | | | | |
| 96 | LUT3_3 & DFF5 | OUT16: IN1 of LUT3_3 or Data of DFF5 | | | |
| 97 | | | | | |
| 98 | | | | | |
| 99 | | | | | |
| 100 | | | | | |
| 101 | | | | | |
| 102 | | | | | |
| C | 103 | LUT3_3 & DFF5 | OUT17: IN2 of LUT3_3 or RSTB (SETB) of DFF5 | | |
| | 104 | | | | |
| | 105 | | | | |
| | 106 | | | | |
| | 107 | | | | |
| | 108 | | | LUT3_4 & DFF6 & SR0 | OUT18: IN0 of LUT3_4 or CLK Input of DFF6 or CLK input of SR0 |
| | 109 | | | | |
| 110 | | | | | |
| 111 | | | | | |
| 112 | LUT3_4 & DFF6 & SR0 | OUT19: IN1 of LUT3_4 or Data Input of DFF6 or Data Input of SR0 | | | |
| 113 | | | | | |
| 114 | | | | | |
| 115 | | | | | |
| 116 | | | | | |
| 117 | | | | | |
| 118 | | | | | |
| 119 | | | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|---------------------|---|
| Byte | Register Bit | | |
| F | 120 | LUT3_4 & DFF6 & SR0 | OUT20: IN2 of LUT3_4 or RSTB (SETB) of DFF6 or RSTB(SETB) input of SR0 |
| | 121 | | |
| | 122 | | |
| | 123 | | |
| | 124 | | |
| | 125 | | |
| | 126 | | |
| 10 | 127 | LUT3_5 & DFF7 & SR1 | OUT21: IN0 of LUT3_5 or CLK Input of DFF7 or CLK input of SR1 |
| | 128 | | |
| | 129 | | |
| | 130 | | |
| | 131 | | |
| | 132 | | |
| | 133 | | |
| 11 | 134 | LUT3_5 & DFF7 & SR1 | OUT22: IN1 of LUT3_5 or Data of DFF7 or Data Input of SR1 |
| | 135 | | |
| | 136 | | |
| | 137 | | |
| | 138 | | |
| | 139 | | |
| | 140 | | |
| 12 | 141 | LUT3_6 & DFF8 & SR2 | OUT23: IN2 of LUT3_5 or RSTB (SETB) of DFF7 or RSTB(SETB) input of SR1 |
| | 142 | | |
| | 143 | | |
| | 144 | | |
| | 145 | | |
| | 146 | | |
| | 147 | | |
| 13 | 148 | LUT3_6 & DFF8 & SR2 | OUT24: IN0 of LUT3_6 or CLK Input of DFF8 or CLK input of SR2 |
| | 149 | | |
| | 150 | | |
| | 151 | | |
| | 152 | | |
| | 153 | | |
| | 154 | | |
| 14 | 155 | LUT3_6 & DFF8 & SR2 | OUT25: IN1 of LUT3_6 or Data of DFF8 or Data Input of SR2 |
| | 156 | | |
| | 157 | | |
| | 158 | | |
| | 159 | | |
| | 160 | | |
| | 161 | | |
| 14 | 162 | LUT3_7 & DFF9 & SR3 | OUT26: IN2 of LUT3_6 or RSTB (SETB) of DFF8 or RSTB(SETB) input of SR2 |
| | 163 | | |
| | 164 | | |
| | 165 | | |
| | 166 | | |
| | 167 | | |
| | 167 | | |
| 14 | 162 | LUT3_7 & DFF9 & SR3 | OUT27: IN0 of LUT3_7 or CLK Input of DFF9 or CLK input of SR3 |
| | 163 | | |
| | 164 | | |
| | 165 | | |
| | 166 | | |
| | 166 | | |
| | 167 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|---------------------|--|
| Byte | Register Bit | | |
| 15 | 168 | LUT3_7 & DFF9 & SR3 | OUT28: IN1 of LUT3_7 or Data of DFF9 or Data Input of SR3 |
| | 169 | | |
| | 170 | | |
| | 171 | | |
| | 172 | | |
| | 173 | | |
| | 174 | | |
| | 175 | | |
| 16 | 176 | Multi_function0 | OUT29: IN2 of LUT3_7 or RSTB (SETB) of DFF9 or RSTB(SETB) input of SR3 |
| | 177 | | |
| | 178 | | |
| | 179 | | |
| | 180 | | |
| | 181 | | |
| | 182 | | |
| 17 | 183 | Multi_function0 | OUT30: IN0 of LUT3_8 or CLK Input of DFF10 Delay0 Input (or Counter5 RSTB Input) |
| | 184 | | |
| | 185 | | |
| | 186 | | |
| | 187 | | |
| | 188 | | |
| | 189 | | |
| | 190 | | |
| 18 | 191 | Multi_function0 | OUT31: IN1 of LUT3_8 or RSTB (SETB) of DFF10 Delay0 Input (or Counter5 RSTB Input) |
| | 192 | | |
| | 193 | | |
| | 194 | | |
| | 195 | | |
| | 196 | | |
| | 197 | | |
| 19 | 198 | Multi_function1 | OUT32: IN2 of LUT3_8 or Data of DFF10 Delay0 Input (or Counter5 RSTB Input) |
| | 199 | | |
| | 200 | | |
| | 201 | | |
| | 202 | | |
| | 203 | | |
| | 204 | | |
| | 205 | | |
| 1A | 206 | Multi_function1 | OUT33: IN0 of LUT3_9 or CLK Input of DFF11 Delay1 Input (or Counter1 RSTB Input) |
| | 207 | | |
| | 208 | | |
| | 209 | | |
| | 210 | | |
| | 211 | | |
| | 212 | | |
| | 213 | | |
| 1A | 214 | Multi_function1 | OUT34: IN1 of LUT3_9 or RSTB (SETB) of DFF11 Delay1 Input (or Counter1 RSTB Input) |
| | 215 | | |
| | 216 | | |
| | 217 | | |
| 1A | 218 | Multi_function1 | OUT35: IN2 of LUT3_9 or Data of DFF11 Delay1 Input (or Counter1 RSTB Input) |
| | 219 | | |
| | 220 | | |
| | 221 | | |
| | 222 | | |
| | 223 | | |
| | 224 | | |
| | 225 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition | |
|---------|--------------|--|---|---|
| Byte | Register Bit | | | |
| 1B | 216 | Multi_function2 | OUT36: IN0 of LUT3_10 or CLK Input of DFF12 Delay2 Input (or Counter2 RSTB Input) | |
| | 217 | | | |
| | 218 | | | |
| | 219 | | | |
| | 220 | | | |
| | 221 | | | |
| | 222 | | | |
| 1C | 223 | | OUT37: IN1 of LUT3_10 or RSTB (SETB) of DFF12 Delay2 Input (or Counter2 RSTB Input) | |
| | 224 | | | |
| | 225 | | | |
| | 226 | | | |
| | 227 | | | |
| | 228 | | | |
| | 229 | | | |
| 1D | 230 | OUT38: IN2 of LUT3_10 or Data of DFF12 Delay2 Input (or Counter2 RSTB Input) | | |
| | 231 | | | |
| | 232 | | | |
| | 233 | | | |
| | 234 | | OUT39: IN0 of LUT3_11 or CLK Input of DFF13 Delay3 Input (or Counter3 RSTB Input) | |
| | 235 | | | |
| | 236 | | | |
| 237 | | | | |
| 238 | | | | |
| 239 | | | | |
| 1E | 240 | Multi_function3 | | OUT40: IN1 of LUT3_11 or RSTB (SETB) of DFF13 Delay3 Input (or Counter3 RSTB Input) |
| | 241 | | | |
| | 242 | | | |
| | 243 | | | |
| | 244 | | | |
| | 245 | | | |
| | 246 | | | |
| 1F | 247 | OUT41: IN2 of LUT3_11 or Data of DFF13 Delay3 Input (or Counter3 RSTB Input) | | |
| | 248 | | | |
| | 249 | | | |
| | 250 | | | |
| | 251 | | OUT42: IN0 of LUT3_12 or CLK Input of DFF14 Delay4 Input (or Counter5 RSTB Input) | |
| | 252 | | | |
| | 253 | | | |
| 254 | | | | |
| 255 | | | | |
| 20 | 256 | Multi_function4 | | OUT43: IN1 of LUT3_12 or RSTB (SETB) of DFF14 Delay4 Input (or Counter5 RSTB Input) |
| | 257 | | | |
| | 258 | | | |
| | 259 | | | |
| | 260 | | | |
| | 261 | | | |
| | 262 | | | |
| 263 | | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|--|---|
| Byte | Register Bit | | |
| 21 | 264 | Multi_function4 | OUT44: IN2 of LUT3_12 or Data of DFF14 Delay4 Input (or Counter5 RSTB Input) |
| | 265 | | |
| | 266 | | |
| | 267 | | |
| | 268 | | |
| | 269 | | |
| | 270 | | |
| 22 | 271 | Multi_function5 | OUT45: IN0 of LUT3_13 or CLK Input of DFF15 Delay5 Input (or Counter5 RSTB Input) |
| | 272 | | |
| | 273 | | |
| | 274 | | |
| | 275 | | |
| | 276 | | |
| | 277 | | |
| 23 | 278 | | OUT46: IN1 of LUT3_13 or RSTB (SETB) of DFF15 Delay5 Input (or Counter5 RSTB Input) |
| | 279 | | |
| | 280 | | |
| | 281 | | |
| | 282 | | |
| | 283 | | |
| | 284 | | |
| 24 | 285 | OUT47: IN2 of LUT3_13 or Data of DFF15 Delay5 Input (or Counter5 RSTB Input) | |
| | 286 | | |
| | 287 | | |
| | 288 | | |
| | 289 | | |
| | 290 | | |
| | 291 | | |
| 25 | 292 | LUT4_0_DFF16 | OUT48: IN0 of LUT4_0 or CLK Input of DFF16 |
| | 293 | | |
| | 294 | | |
| | 295 | | |
| | 296 | | |
| | 297 | | |
| | 298 | | |
| 26 | 299 | | OUT49: IN1 of LUT4_0 or Data of DFF16 |
| | 300 | | |
| | 301 | | |
| | 302 | | |
| | 303 | | |
| | 304 | | |
| | 305 | | |
| 26 | 306 | OUT50: IN2 of LUT4_0 or RSTB (SETB) of DFF16 | |
| | 307 | | |
| | 308 | | |
| | 309 | | |
| | 310 | | |
| | 311 | | |
| | 311 | | |
| 26 | 304 | OUT51: IN3 of LUT4_0 | |
| | 305 | | |
| | 306 | | |
| | 307 | | |
| | 308 | | |
| | 309 | | |
| | 310 | | |
| 26 | 311 | | |
| | 311 | | |
| | 311 | | |
| | 311 | | |
| | 311 | | |
| | 311 | | |
| | 311 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition | |
|---------|--------------|--------------------|--|----------------------|
| Byte | Register Bit | | | |
| 27 | 312 | Programmable Delay | OUT52: Programmable Delay/Edge Detect Input | |
| | 313 | | | |
| | 314 | | | |
| | 315 | | | |
| | 316 | | | |
| | 317 | | | |
| | 318 | | | |
| 28 | 319 | Filter/Edge Detect | OUT53: Filter/Edge Detect Input | |
| | 320 | | | |
| | 321 | | | |
| | 29 | 322 | GPIO0 | OUT54: GPIO0 DOUT |
| | | 323 | | |
| | | 324 | | |
| | | 325 | | |
| 326 | | | | |
| 2A | 327 | GPIO1 | OUT55: GPIO1 DOUT | |
| | 328 | | | |
| | 329 | | | |
| | 330 | | | |
| | 331 | | | |
| | 332 | | | |
| | 333 | | | |
| 2B | 334 | GPIO2 | OUT56: GPIO2 DOUT | |
| | 335 | | | |
| | 336 | | | |
| | 337 | | | |
| | 338 | | | |
| | 339 | | | |
| | 340 | | | |
| 2C | 341 | GPIO3 | OUT57: GPIO2 DOUT OE | |
| | 342 | | | |
| | 343 | | | |
| | 344 | | | |
| | 345 | | | |
| | 346 | | | |
| | 347 | | | |
| 2C | 348 | GPIO3 | OUT58: GPIO3 DOUT | |
| | 349 | | | |
| | 350 | | | |
| | 351 | | | |
| | 352 | | | |
| | 353 | | | |
| | 354 | | | |
| 2C | 355 | GPIO3 | OUT59: GPIO3 DOUT OE | |
| | 356 | | | |
| | 357 | | | |
| | 358 | | | |
| | 359 | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-----------------|-------------------------|
| Byte | Register Bit | | |
| 2D | 360 | GPIO4 | OUT60: GPIO4 DOUT |
| | 361 | | |
| | 362 | | |
| | 363 | | |
| | 364 | | |
| | 365 | | |
| | 366 | | |
| 2E | 367 | GPIO5 | OUT61: GPIO5 DOUT |
| | 368 | | |
| | 369 | | |
| | 370 | | |
| | 371 | | |
| | 372 | | |
| | 373 | | |
| 2F | 374 | GPIO6 | OUT62: GPIO6 DOUT |
| | 375 | | |
| | 376 | | |
| | 377 | | |
| | 378 | | |
| | 379 | | |
| | 380 | | |
| 30 | 381 | GPIO7 | OUT63: GPIO7 DOUT |
| | 382 | | |
| | 383 | | |
| | 384 | | |
| | 385 | | |
| | 386 | | |
| | 387 | | |
| 31 | 388 | GPIO8 | OUT64: GPIO7 DOUT OE |
| | 389 | | |
| | 390 | | |
| | 391 | | |
| | 392 | | |
| | 393 | | |
| | 394 | | |
| 32 | 395 | MS ACMP | OUT65: GPIO8 DOUT |
| | 396 | | |
| | 397 | | |
| | 398 | | |
| | 399 | | |
| | 400 | | |
| | 401 | | |
| 32 | 402 | MS ACMP | OUT66: GPIO8 DOUT OE |
| | 403 | | |
| | 404 | | |
| | 405 | | |
| | 406 | | |
| | 407 | | |
| | 407 | | |
| 32 | 402 | MS ACMP | OUT67: EN of MS ACMP |
| | 403 | | |
| | 404 | | |
| | 405 | | |
| | 406 | | |
| | 407 | | |
| | 407 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|---|---|
| Byte | Register Bit | | |
| 33 | 408 | MS ACMP | OUT68: RSTB of ACMP LATs |
| | 409 | | |
| | 410 | | |
| | 411 | | |
| | 412 | | |
| | 413 | | |
| | 414 | | |
| 34 | 415 | OSC0/1 | OUT69: Oscillator Enable/Disable Input |
| | 416 | | |
| | 417 | | |
| | 418 | | |
| | 419 | | |
| | 420 | | |
| | 421 | | |
| 35 | 422 | EPG (Embedded Input Pattern Generator) | OUT70: Clock of Pattern Generator |
| | 423 | | |
| | 424 | | |
| | 425 | | |
| | 426 | | |
| | 427 | | |
| | 428 | | |
| 36 | 429 | Matrix Input 0 | OUT71: RESETB of Pattern Generator |
| | 430 | | |
| | 431 | | |
| | 432 | | |
| | 433 | | |
| | 434 | | |
| | 435 | | |
| 37 | 436 | Matrix Input 1 | GND |
| | 437 | Matrix Input 2 | LUT2_0/DFF0 output |
| | 438 | Matrix Input 3 | LUT2_1/DFF1 output |
| | 439 | Matrix Input 4 | LUT2_2/PGen output |
| | 440 | Matrix Input 5 | LUT3_0/DFF2 output |
| | 441 | Matrix Input 6 | LUT3_1/DFF3 output |
| | 442 | Matrix Input 7 | LUT3_2/DFF4 output |
| 38 | 443 | Matrix Input 8 | LUT3_3/DFF5 output |
| | 444 | Matrix Input 9 | LUT3_4/DFF6/SR0 output |
| | 445 | Matrix Input 10 | LUT3_5/DFF7/SR1 output |
| | 446 | Matrix Input 11 | LUT3_6/DFF8/SR2 output |
| | 447 | Matrix Input 12 | LUT3_7/DFF9/SR3 output |
| | 448 | Matrix Input 13 | CNT0 output |
| | 449 | Matrix Input 14 | MLT0_LUT3_8/DFF10_OUT |
| 38 | 450 | Matrix Input 15 | CNT1 output |
| | 451 | Matrix Input 16 | MLT1_LUT3_9/DFF11_OUT |
| | 452 | Matrix Input 17 | CNT2 output |
| | 453 | Matrix Input 18 | MLT2_LUT3_10/DFF12_OUT |
| | 454 | Matrix Input 19 | CNT3 output |
| | 455 | Matrix Input 20 | MLT3_LUT3_11/DFF13_OUT |
| | 456 | Matrix Input 21 | CNT4 output |
| | 457 | Matrix Input 22 | MLT4_LUT3_12/DFF14_OUT |
| | 458 | Matrix Input 23 | CNT5 output |
| | 459 | Matrix Input 24 | MLT5_LUT3_13/DFF15_OUT |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-------------------------------------|-----------------------------------|
| Byte | Register Bit | | |
| 39 | 456 | Virtual_0 Input | I2C_virtual_0 Input data value |
| | 457 | Virtual_1 Input | I2C_virtual_1 Input data value |
| | 458 | Virtual_2 Input | I2C_virtual_2 Input data value |
| | 459 | Virtual_3 Input | I2C_virtual_3 Input data value |
| | 460 | Virtual_4 Input | I2C_virtual_4 Input data value |
| | 461 | Virtual_5 Input | I2C_virtual_5 Input data value |
| | 462 | Virtual_6 Input | I2C_virtual_6 Input data value |
| | 463 | Virtual_7 Input | I2C_virtual_7 Input data value |
| 3A | 464 | Virtual_8 Input | I2C_virtual_8 Input data value |
| | 465 | Virtual_9 Input | I2C_virtual_9 Input data value |
| | 466 | Virtual_10 Input | I2C_virtual_10 Input data value |
| | 467 | Virtual_11 Input | I2C_virtual_11 Input data value |
| | 468 | Virtual_12 Input | I2C_virtual_12 Input data value |
| | 469 | Virtual_13 Input | I2C_virtual_13 Input data value |
| | 470 | Virtual_14 Input | I2C_virtual_14 Input data value |
| 3B | 471 | Matrix Input 39 | LUT4_0/DFF16 output |
| | 472 | Matrix Input 40 | GPI Digital Input |
| | 473 | Matrix Input 41 | progdly_edgedet output |
| | 474 | Matrix Input 42 | edgedet_filter output |
| | 475 | Matrix Input 43 | OSC0 output 0 |
| | 476 | Matrix Input 44 | OSC1 output |
| | 477 | Matrix Input 45 | ACMP0 Output |
| | 478 | Matrix Input 46 | ACMP1 Output |
| 3C | 479 | Matrix Input 47 | ACMP2 Output |
| | 480 | Matrix Input 48 | ACMP3 Output |
| | 481 | Matrix Input 49 | OSC0 output 1 |
| | 482 | Matrix Input 50 | ACMP sync mode ready |
| | 483 | Matrix Input 51 | Reset_core_matrix |
| | 484 | Matrix Input 52 | V _{DD} |
| | 485 | Reserved | |
| 3D | 486 | Reserved | |
| | 487 | Reserved | |
| | 488 | EPG (Extended Pattern Generator) | Initial Value at POR & EPG RESETB |
| | 489 | | |
| | 490 | | |
| | 491 | | |
| | 492 | | |
| 493 | | | |
| 494 | | | |
| 495 | | | |

MS ACMP

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|---|--|
| Byte | Register Bit | | |
| 3E | 496 | Bandgap power down control | 0: always on, 1: power down if no function enable it (ACMP, Vref, TS) |
| | 497 | Sampling enable | 0: regular mode, 1: multi-channel sampling mode |
| | 498 | Edge enable | 0: level sensitive mode, 1: edge sensitive mode |
| | 499 | Sync enable | 0: ACMPs out async, 1: ACMPs out sync |
| | 500 | V _{DD} input enable (ACMP positive input selected as V _{DD}) | 0: disable, 1: enable |
| | 501 | Temp sensor enable (ACMP positive input selected as TS) | 0: disable, 1: enable |
| | 502 | Define the number of sampling channels, NUM[1:0] | 00: 1 channel, 01: 2 channels, 10: 3 channels, 11: 4 channels |
| 503 | | | |
| 3F | 504 | Define positive input channel on 1st sampling, CHS0[1:0] | 00: APIO0, 01: APIO1, 10: APIO2 (or V _{DD} decided by register [500]), 11: APIO3 (or TS decided by register [501]) |
| | 505 | | |
| | 506 | Define positive input channel on 2nd sampling, CHS1[1:0] | 00: APIO0, 01: APIO1, 10: APIO2 (or V _{DD} decided by register [500]), 11: APIO3 (or TS decided by register [501]) |
| | 507 | | |
| | 508 | Define positive input channel on 3rd sampling, CHS2[1:0] | 00: APIO0, 01: APIO1, 10: APIO2 (or V _{DD} decided by register [500]), 11: APIO3 (or TS decided by register [501]) |
| | 509 | | |
| | 510 | Define positive input channel on 4th sampling, CHS3[1:0] | 00: APIO0, 01: APIO1, 10: APIO2 (or V _{DD} decided by register [500]), 11: APIO3 (or TS decided by register [501]) |
| 511 | | | |
| 40 | 512 | ACMP LAT0 RST accessible selection | 0: not accessible, 1: accessible |
| | 513 | ACMP LAT1 RST accessible selection | 0: not accessible, 1: accessible |
| | 514 | ACMP LAT2 RST accessible selection | 0: not accessible, 1: accessible |
| | 515 | ACMP LAT3 RST accessible selection | 0: not accessible, 1: accessible |
| | 516 | Sampling CK selection | 00: div1, 01: div2, 10: div4, 11: div8 |
| | 517 | | |
| | 518 | Reserved | |
| 519 | Reserved | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|--------------------|--|
| Byte | Register Bit | | |
| 41 | 520 | ACMP0 hysteresis | 00: 0 mV, 01: 32 mV, 10: 64mV; 11: 192 mV |
| | 521 | | |
| | 522 | ACMP1 hysteresis | 00: 0 mV, 01: 32 mV, 10: 64 mV, 11: 192 mV |
| | 523 | | |
| | 524 | ACMP2 hysteresis | 00: 0 mV, 01: 32 mV, 10: 64 mV, 11: 192 mV |
| | 525 | | |
| | 526 | ACMP3 hysteresis | 00: 0mV, 01: 32 mV, 10: 64 mV, 11: 192 mV |
| 527 | | | |
| 42 | 528 | ACMP0 Gain Divider | ACMP Gain Divider Select: 00: 1x; 01: 0.5x; 10: 0.33x; 11: 0.25x |
| | 529 | | |
| | 530 | ACMP0 Vref | ACMP Vref Select: 000000: 32 mV ~ 111110: 2.016 V/step = 32 mV; 111111: External Vref |
| | 531 | | |
| | 532 | | |
| | 533 | | |
| | 534 | | |
| 535 | | | |
| 43 | 536 | ACMP1 Gain Divider | ACMP Gain Divider Select: 00: 1x; 01: 0.5x; 10: 0.33x; 11: 0.25x |
| | 537 | | |
| | 538 | ACMP1 Vref | ACMP Vref Select: 000000: 32 mV ~ 111110: 2.016 V/ step = 32 mV; 111112: External Vref |
| | 539 | | |
| | 540 | | |
| | 541 | | |
| | 542 | | |
| 543 | | | |
| 44 | 544 | ACMP2 Gain Divider | ACMP Gain Divider Select: 00: 1x; 01: 0.5x; 10: 0.33x; 11: 0.25x |
| | 545 | | |
| | 546 | ACMP2 Vref | ACMP Vref Select: 000000: 32 mV ~ 111110: 2.016 V/ step = 32 mV; 111111: External Vref |
| | 547 | | |
| | 548 | | |
| | 549 | | |
| | 550 | | |
| 551 | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------------|--------------|--|--|
| Byte | Register Bit | | |
| 45 | 552 | ACMP3 Gain Divider | ACMP Gain Divider Select: 00: 1x; 01: 0.5x; 10: 0.33x; 11: 0.25x |
| | 553 | | |
| | 554 | ACMP3 Vref | ACMP Vref Select: 000000: 32 mV ~ 111110: 2.016 V/ step = 32 mV; 111111: External Vref |
| | 555 | | |
| | 556 | | |
| | 557 | | |
| | 558 | | |
| 559 | | | |
| 46 | 560 | Reserved | Reserved |
| | 561 | Reserved | Reserved |
| | 562 | Reserved | Reserved |
| | 563 | Reserved | Reserved |
| | 564 | EPG | EPG CNT overflow/keep selection 0: overflow to A0, 1: keep at FB |
| | 565 | Reserved | Reserved |
| OSC0/1 | | | |
| 46 | 566 | Oscillator Enable/Disable Input Selection from Matrix Output | 00: OSC0 (2kHz/10kHz): Controlled by register OSC1 (25MHz): Controlled by register 01: OSC0 (2kHz/10kHz): Controlled by Matrix Output OSC1 (25MHz): Controlled by register 10: OSC0 (2kHz/10kHz): Controlled by register OSC1 (25MHz): Controlled by Matrix Output 11: OSC0 (2kHz/10kHz): Controlled by Matrix Output OSC1 (25MHz): Controlled by Matrix Output |
| | 567 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|--------------|------------------------|---|--|
| Byte | Register Bit | | |
| 47 | 568 | OSC1 turn on by register | 0: auto on by delay cells, 1: always on |
| | 569 | Matrix power down or on select | 0: matrix down, 1: matrix on |
| | 570 | External clock source enable | 0: internal OSC1, 1: external clock from GPIO7 |
| | 571 | Output enable to matrix in 44 | 0: disable, 1: enable |
| | 572 | Pre-divider ratio control | 000: /1, 001: /2, 010: /4, 011: /8, 100: /12, 101: /24, 110: /48, 111: N/A |
| | 573 | | |
| | 574 | | |
| 48 | 575 | Output mux control to matrix in 44 | 000: /1, 001:/2, 010:/3, 011: /4, 100: /8, 101: /12, 110: /24, 111: /64 |
| | 576 | | |
| | 577 | OSC0 turn on by register | 0: auto on by delay cells 1: always on |
| | 578 | Matrix power down or on select | 0: matrix down, 1: matrix on |
| | 579 | External clock source enable | 0: internal OSC0, 1: external clock from GPI |
| | 580 | OSC0 frequency selection | 0: 2.048 kHz, 1: 10 kHz |
| | 581 | Pre-divider ratio control | 00: div 1; 01: div 2; 10: div 4; 11: div 8 |
| 582 | | | |
| 49 | 583 | Output mux control to matrix in 43 | 000: /1, 001:/2, 010:/3, 011: /4, 100: /8, 101: /12, 110: /24, 111: /64 |
| | 584 | | |
| | 585 | | |
| | 586 | Output enable to matrix in 43 | 0: disable, 1: enable |
| | 587 | OSC0 2nd output mux control to matrix in 49 | 000: /1, 001:/2, 010:/3, 011: /4, 100: /8, 101: /12, 110: /24, 111: /64 |
| | 588 | | |
| | 589 | 2nd output enable to matrix in 49 | 0: disable, 1: enable |
| 590 | | | |
| 4A | 591 | OSC1 startup delay with 100 ns | 0: enable, 1: disable |
| | 592 | Reserved | Reserved |
| | 593 | IO fast Pull-up/down enable | 0: disable, 1: enable |
| GPI | | | |
| 4A | 594 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: Reserved |
| | 595 | | |
| | 596 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 597 | | |
| 598 | Pull-up/down selection | 0: Pull-down, 1: Pull-up | |
| GPIO0 | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|--------------|--------------|---|---|
| Byte | Register Bit | | |
| 4B | 600 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: reserved |
| | 601 | | |
| | 602 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 603 | | |
| | 604 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| | 605 | I ² C mode selection | 0: I2C fast mode +, 1: I2C standard/fast mode |
| | 606 | Open-drain output enable (3.2x drivability) | 0: disable, 1: enable (3.2x) |
| | 607 | Reserved | |
| GPIO1 | | | |
| 4C | 608 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: reserved |
| | 609 | | |
| | 610 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 611 | | |
| | 612 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| | 613 | Open-drain output enable (3.2x drivability) | 0: disable, 1: enable (3.2x) |
| | 614 | Reserved | |
| | 615 | Reserved | |
| GPIO2 | | | |
| 4D | 616 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: reserved |
| | 617 | | |
| | 618 | Output mode configuration | 00: Push-Pull 1x, 01: Push-Pull 2x, 10: 1x Open-Drain, 11: 2x Open-Drain |
| | 619 | | |
| | 620 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 621 | | |
| | 622 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| | 623 | Reserved | |
| GPIO3 | | | |
| 4E | 624 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: analog IO |
| | 625 | | |
| | 626 | Output mode configuration | 00: Push-Pull 1x, 01: Push-Pull 2x, 10: 1x Open-Drain, 11: 2x Open-Drain |
| | 627 | | |
| | 628 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 629 | | |
| | 630 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| | 631 | Reserved | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|--------------|----------------------------------|-----------------------------------|---|
| Byte | Register Bit | | |
| GPIO4 | | | |
| 4F | 632 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: analog IO |
| | 633 | | |
| | 634 | Output mode configuration | 00: Push-Pull 1x, 01: Push-Pull 2x, 10: 1x Open-Drain, 11: 2x Open-Drain |
| | 635 | | |
| | 636 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 637 | | |
| | 638 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| 639 | Input mode/output mode selection | 0: input, 1: output | |
| GPIO5 | | | |
| 50 | 640 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: analog IO |
| | 641 | | |
| | 642 | Output mode configuration | 00: Push-Pull 1x, 01: Push-Pull 2x, 10: 1x Open-Drain, 11: 2x Open-Drain |
| | 643 | | |
| | 644 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 645 | | |
| | 646 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| 647 | Input mode/output mode selection | 0: input, 1: output | |
| GPIO6 | | | |
| 51 | 648 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: analog IO |
| | 649 | | |
| | 650 | Output mode configuration | 00: Push-Pull 1x, 01: Push-Pull 2x, 10: 1x Open-Drain, 11: 2x Open-Drain |
| | 651 | | |
| | 652 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 653 | | |
| | 654 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| 655 | Input mode/output mode Selection | 0: input, 1: output | |
| GPIO7 | | | |
| 52 | 656 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: analog IO |
| | 657 | | |
| | 658 | Output mode configuration | 00: Push-Pull 1x, 01: Push-Pull 2x, 10: 1x Open-Drain, 11: 2x Open-Drain |
| | 659 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|--------------|--------------|-----------------------------------|--|
| Byte | Register Bit | | |
| 52 | 660 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 661 | | |
| | 662 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| | 663 | Analog input enable for ACMP3 IP | 0: disable, 1: enable |
| GPIO8 | | | |
| 53 | 664 | Input mode configuration | 00: digital without Schmitt Trigger, 01: digital with Schmitt Trigger, 10: low voltage digital in, 11: Reserved |
| | 665 | | |
| | 666 | Output mode configuration | 00: Push-Pull 1x, 01: Push-Pull 2x, 10: 1x Open-Drain, 11: 2x Open-Drain |
| | 667 | | |
| | 668 | Pull-up/down resistance selection | 00: floating, 01: 10K, 10: 100K, 11: 1M |
| | 669 | | |
| | 670 | Pull-up/down selection | 0: Pull-down, 1: Pull-up |
| | 671 | Reserved | |
| 54 | 676:672 | Single 3-bit LUT | 00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW) |
| | | Single DFF w RST and SET | 10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW) |
| | | Single CNT/DLY | 00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF) |
| | | CNT/DLY → LUT | 00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2) |
| | | CNT/DLY → DFF | 10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D) |
| | | CNT/DLY → LUT | 00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1) |
| | | CNT/DLY → DFF | 10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST) |
| | | CNT/DLY → LUT | 01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0) |
| | | CNT/DLY → DFF | 11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK) |
| | | LUT → CNT/DLY | 00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN) |
| | | DFF → CNT/DLY | 10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN) |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|---------------------------------------|---|
| Byte | Register Bit | | |
| 54 | 677 | CNT0 function and edge mode selection | 0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset cnt; 1101: falling edge reset cnt; 1110: rising edge reset cnt; 1111: high level reset cnt |
| | 678 | | |
| | 679 | | |
| 55 | 680 | | |
| | 681 | CNT0 initial value selection | 00: bypass the initial; 01: initial 0; 10: initial 1; 11: initial 1 |
| | 682 | | |
| | 683 | DLY/CNT0 Clock Source Select | Clock source sel [3:0] 0000: OSC1(25MHz); 0001: OSC1/4; 0010: OSC1/8; 0011: OSC1/64; 0100: OSC1/512; 0101: OSC0(2K/10KHz); 0110: OSC0/8; 0111: OSC0/12; 1000: OSC0/24; 1001: OSC0/64; 1010: OSC0/512; 1011: OSC0/4096 1100: CNT4_END; 1101: External; |
| | 684 | | |
| 685 | | | |
| | 686 | | |
| | 687 | CNT0 output pol selection | 0: Default Output, 1: Inverted Output |
| 56 | 688 | CNT0 CNT mode SYNC selection | 0: bypass; 1: after two DFF |
| | 689 | CNT0 DLY EDET FUNCTION Selection | 0: normal; 1: DLY function edge detection (registers [679:677] = 0000/0001/0010) |
| | 690 | CNT0 SET/RST Selection | 0: Reset to 0 (High CNT output at CNT reset), 1: Set to data (Low CNT output at CNT reset) |
| | 691 | FSM0 UP signal SYCN selection | 0: bypass; 1: after two DFF |
| | 692 | Reserved | |
| | 693 | CNT1 output pol selection | 0: Default Output, 1: Inverted Output |
| | 694 | CNT1 CNT mode SYNC selection | 0: bypass; 1: after two DFF |
| | 695 | CNT1 DLY EDET FUNCTION Selection | 0: normal; 1: DLY function edge detection (register [703:701] = 0000/0001/0010) |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------------------|--|
| Byte | Register Bit | | |
| 57 | 700:696 | Single 3-bit LUT | 00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW) |
| | | Single DFF w RST and SET | 10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW) |
| | | Single CNT/DLY | 00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF) |
| | | CNT/DLY → LUT | 00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2) |
| | | CNT/DLY → DFF | 10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D) |
| | | CNT/DLY → LUT | 00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1) |
| | | CNT/DLY → DFF | 10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST) |
| | | CNT/DLY → LUT | 01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0) |
| | | CNT/DLY → DFF | 11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK) |
| | | LUT → CNT/DLY | 00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN) |
| | | DFF → CNT/DLY | 10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN) |
| | | 701 | 704 |
| 702 | | | |
| 703 | | | |
| 58 | 705 | CNT1 initial value selection | 00: bypass the initial; 01: initial 0; 10: initial 1; 11: initial 1 |
| | 706 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------------------|--|
| Byte | Register Bit | | |
| 58 | 707 | DLY/CNT1 Clock Source Select | Clock source sel [3:0] |
| | 708 | | 0000: OSC1(25MHz); |
| | 709 | | 0001: OSC1/4; |
| | 710 | | 0010: OSC1/8; |
| | | | 0011: OSC1/64; |
| | | | 0100: OSC1/512; |
| | | | 0101: OSC0(2K/10KHz); |
| | | | 0110: OSC0/8; |
| | | | 0111: OSC0/12; |
| | | | 1000: OSC0/24; |
| | | | 1001: OSC0/64; |
| | | | 1010: OSC0/512; |
| | | | 1011: OSC0/4096 |
| | | | 1100: CNT4_END; |
| | | | 1101: External; |
| | 711 | Reserved | |
| 59 | 716:712 | Single 3-bit LUT | 00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW) |
| | | Single DFF w RST and SET | 10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW) |
| | | Single CNT/DLY | 00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF) |
| | | CNT/DLY → LUT | 00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2) |
| | | CNT/DLY → DFF | 10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D) |
| | | CNT/DLY → LUT | 00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1) |
| | | CNT/DLY → DFF | 10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST) |
| | | CNT/DLY → LUT | 01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0) |
| | | CNT/DLY → DFF | 11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK) |
| | | LUT → CNT/DLY | 00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN) |
| | | DFF → CNT/DLY | 10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN) |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|---------------------------|--|---|
| Byte | Register Bit | | |
| 59 | 717 | | 0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset cnt; 1101: falling edge reset cnt; 1110: rising edge reset cnt; 1111: high level reset cnt |
| | 718 | | |
| | 719 | | |
| 5A | 720 | CNT2 function and edge mode selection | |
| | 721 | CNT2 initial value selection | 00: bypass the initial; 01: initial 0; 10: initial 1; 11: initial 1 |
| | 722 | | |
| | 723 | DLY/CNT2 Clock Source Select | Clock source sel [3:0] 0000: OSC1(25MHz); 0001: OSC1/4; 0010: OSC1/8; 0011: OSC1/64; 0100: OSC1/512; 0101: OSC0(2K/10KHz); 0110: OSC0/8; 0111: OSC0/12; 1000: OSC0/24; 1001: OSC0/64; 1010: OSC0/512; 1011: OSC0/4096; 1100: CNT4_END; 1101:External; |
| | 724 | | |
| | 725 | | |
| | 726 | | |
| 727 | CNT2 output pol selection | 0: Default Output, 1: Inverted Output | |
| 5B | 728 | CNT2 CNT mode SYNC selection | 0: bypass; 1: after two DFF |
| | 729 | CNT2 DLY EDET FUNCTION Selection | 0: normal; 1: DLY function edge detection (register [719:717] = 0000/ 0001/0010) |
| | 730 | Reserved | |
| | 731 | CNT3 output pol selection | 0: Default Output, 1: Inverted Output |
| | 732 | CNT3 CNT mode SYNC selection | 0: bypass; 1: after two DFF |
| | 733 | CNT3 DLY EDET FUNCTION Selection | 0: normal; 1: DLY function edge detection (registers [743:742] = 0000/ 0001/0010) |
| | 734 | CNT3 initial value selection | 00: bypass the initial; 01: initial 0; 10: initial 1; 11: initial 1 |
| | 735 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|---------------------------------------|---|
| Byte | Register Bit | | |
| 5C | 740:736 | Single 3-bit LUT | 00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW) |
| | | Single DFF w RST and SET | 10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW) |
| | | Single CNT/DLY | 00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF) |
| | | CNT/DLY → LUT | 00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2) |
| | | CNT/DLY → DFF | 10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D) |
| | | CNT/DLY → LUT | 00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1) |
| | | CNT/DLY → DFF | 10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST) |
| | | CNT/DLY → LUT | 01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0) |
| | | CNT/DLY → DFF | 11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK) |
| | | LUT → CNT/DLY | 00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN) |
| | | DFF → CNT/DLY | 10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN) |
| | 741 | CNT3 function and edge mode selection | 0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset cnt; 1101: falling edge reset cnt; 1110: rising edge reset cnt; 1111: high level reset cnt |
| | 742 | | |
| 743 | | | |
| 5D | 744 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|------------------------|----------------------------------|--|
| Byte | Register Bit | | |
| 5D | 745 | DLY/CNT3 Clock Source Select | Clock source sel [3:0] |
| | 746 | | 0000: OSC1(25MHz); |
| | 747 | | 0001: OSC1/4; |
| | | | 0010: OSC1/8; |
| | | | 0011: OSC1/64; |
| | | | 0100: OSC1/512; |
| | 0101: OSC0 (2K/10KHz); | | |
| | 0110: OSC0/8; | | |
| | 0111: OSC0/12; | | |
| | 1000: OSC0/24; | | |
| | 1001: OSC0/64; | | |
| | 1010: OSC0/512; | | |
| | 1011: OSC0/4096 | | |
| | 1100: CNT4_END; | | |
| | 1101: External; | | |
| | 749 | CNT4 output pol selection | 0: Default Output, 1: Inverted Output |
| | 750 | CNT4 CNT mode SYNC selection | 0: bypass; 1: after two DFF |
| | 751 | CNT4 DLY EDET FUNCTION Selection | 0: normal; 1: DLY function edge detection (registers [759:757] = 0000/ 0001/0010) |
| 5E | 756:752 | Single 3-bit LUT | 00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW) |
| | | Single DFF w RST and SET | 10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW) |
| | | Single CNT/DLY | 00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF) |
| | | CNT/DLY → LUT | 00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2) |
| | | CNT/DLY → DFF | 10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D) |
| | | CNT/DLY → LUT | 00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1) |
| | | CNT/DLY → DFF | 10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST) |
| | | CNT/DLY → LUT | 01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0) |
| | | CNT/DLY → DFF | 11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK) |
| | | LUT → CNT/DLY | 00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN) |
| | | DFF → CNT/DLY | 10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN) |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|---------------------------------------|---|
| Byte | Register Bit | | |
| 5E | 757 | | 0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset cnt; 1101: falling edge reset cnt; 1110: rising edge reset cnt; 1111: high level reset cnt |
| | 758 | | |
| | 759 | | |
| 5F | 760 | CNT4 function and edge mode selection | |
| | 761 | CNT4 initial value selection | 00: bypass the initial; 01: initial 0; 10: initial 1; 11: initial 1 |
| | 762 | | |
| | 763 | DLY/CNT4 Clock Source Select | Clock source sel [3:0] 0000: OSC1(25MHz); 0001: OSC1/4; 0010: OSC1/8; 0011: OSC1/64; 0100: OSC1/512; 0101: OSC0(2K/10KHz); 0110: OSC0/8; 0111: OSC0/12; 1000: OSC0/24; 1001: OSC0/64; 1010: OSC0/512; 1011: OSC0/4096 1100: CNT4_END; 1101: External; |
| | 764 | | |
| | 765 | | |
| | 766 | | |
| 767 | Reserved | | |
| 60 | 772:768 | Single 3-bit LUT | 00000: Matrix A - In2; Matrix B - In1; Matrix C - In0 (DLY_IN - LOW) |
| | | Single DFF w RST and SET | 10000: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DLY_IN - LOW) |
| | | Single CNT/DLY | 00001: Matrix A - DLY_IN (CNT); Matrix B - EXT_CLK (CNT); Matrix C - NC (DLY_OUT connected to LUT/DFF) |
| | | CNT/DLY → LUT | 00010: Matrix A - DLY_IN; Matrix B - In1; Matrix C - In0 (DLY_OUT connected to In2) |
| | | CNT/DLY → DFF | 10010: Matrix A - DLY_IN; Matrix B - nSET/nRST; Matrix C - CLK (DLY_OUT connected to D) |
| | | CNT/DLY → LUT | 00110: Matrix A - In2; Matrix B - DLY_IN; Matrix C - In0 (DLY_OUT connected to In1) |
| | | CNT/DLY → DFF | 10110: Matrix A - D; Matrix B - DLY_IN; Matrix C - CLK (DLY_OUT connected to nSET/nRST) |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition | |
|---------|---------------------------|--|---|-----|
| Byte | Register Bit | | | |
| 60 | 772:768 | CNT/DLY → LUT | 01010: Matrix A - In2; Matrix B - In1; Matrix C - DLY_IN (DLY_OUT connected to In0) | |
| | | CNT/DLY → DFF | 11010: Matrix A - D; Matrix B - nSET/nRST; Matrix C - DLY_IN (DLY_OUT connected to CLK) | |
| | | LUT → CNT/DLY | 00011: Matrix A - In2; Matrix B - In1; Matrix C - In0 (LUT_OUT connected to DLY_IN) | |
| | | DFF → CNT/DLY | 10011: Matrix A - D; Matrix B - nSET/nRST; Matrix C - CLK (DFF_OUT connected to DLY_IN) | |
| | 773 | CNT5 function and edge mode selection | 0000: both edge Delay; 0001: falling edge delay; 0010: rising edge delay; 0011: both edge One Shot; 0100: falling edge One Shot; 0101: rising edge One Shot; 0110: both edge freq detect; 0111: falling edge freq detect; 1000: rising edge freq detect; 1001: both edge detect; 1010: falling edge detect; 1011: rising edge detect; 1100: both edge reset cnt; 1101: falling edge reset cnt; 1110: rising edge reset cnt; 1111: high level reset cnt | |
| 774 | | | | |
| 775 | | | | |
| 777 | | | | |
| 61 | 778 | CNT5 initial value selection | 00: bypass the initial; 01: initial 0; 10: initial 1; 11: initial 1 | |
| | 782 | DLY/CNT5 Clock Source Select | Clock source sel [3:0] 0000: OSC1(25MHz); 0001: OSC1/4; 0010: OSC1/8; 0011: OSC1/64; 0100: OSC1/512; 0101: OSC0 (2K/10KHz); 0110: OSC0/8; 0111: OSC0/12; 1000: OSC0/24; 1001: OSC0/64; 1010: OSC0/512; 1011: OSC0/4096 1100: CNT4_END; 1101: External; | |
| | | | | 779 |
| | | | | 780 |
| | | | | 781 |
| 783 | CNT5 output pol selection | 0: Default Output, 1: Inverted Output | | |
| 62 | 784 | CNT5 CNT mode SYNC selection | 0: bypass; 1: after two DFF | |
| | 785 | CNT5 DLY EDET FUNCTION Selection | 0: normal; 1: DLY function edge detection (registers [775:773] = 0000/0001/0010) | |
| | 786 | Reserved | Reserved | |
| | 787 | Reserved | Reserved | |
| | 788 | Reserved | Reserved | |
| | 789 | Reserved | Reserved | |
| | 790 | Reserved | Reserved | |
| | 791 | Reserved | Reserved | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------------------|---|
| Byte | Register Bit | | |
| 63 | 792 | Multi0_LUT3_8_DFF10 setting | [7]:LUT3_8 [7]/DFF10 or LATCH Select 0: DFF function, 1: LATCH function [6]:LUT3_8 [6]/DFF10 Output Select 0: Q output, 1: QB output [5]:LUT3_8 [5]/DFF10 0: RSTB from Matrix Output, 1: SETB from Matrix Output [4]:LUT3_8 [4]/DFF10 Initial Polarity Select 0: Low, 1: High [3:0]:LUT3_8 [3:0] |
| | 793 | | |
| | 794 | | |
| | 795 | | |
| | 796 | | |
| | 797 | | |
| | 798 | | |
| | 799 | | |
| 64 | 800 | REG_CNT0_D[7:0] | Data[7:0] |
| | 801 | | |
| | 802 | | |
| | 803 | | |
| | 804 | | |
| | 805 | | |
| | 806 | | |
| | 807 | | |
| 65 | 808 | Multi1_LUT3_9_DFF11 setting | [7]:LUT3_9 [7]/DFF11 or LATCH Select 0: DFF function, 1: LATCH function [6]:LUT3_9 [6]/DFF11 Output Select 0: Q output, 1: QB output [5]:LUT3_9 [5]/DFF11 0: RSTB from Matrix Output, 1: SETB from Matrix Output [4]:LUT3_9 [4]/DFF11 Initial Polarity Select 0: Low, 1: High [3:0]:LUT3_9 [3:0] |
| | 809 | | |
| | 810 | | |
| | 811 | | |
| | 812 | | |
| | 813 | | |
| | 814 | | |
| | 815 | | |
| 66 | 816 | REG_CNT1_D[7:0] | Data[7:0] |
| | 817 | | |
| | 818 | | |
| | 819 | | |
| | 820 | | |
| | 821 | | |
| | 822 | | |
| | 823 | | |
| 67 | 824 | Multi2_LUT3_10_DFF12 setting | [7]:LUT3_10 [7]/DFF12 or LATCH Select 0: DFF function, 1: LATCH function [6]:LUT3_10 [6]/DFF12 Output Select 0: Q output, 1: QB output [5]:LUT3_10 [5]/DFF12 0: RSTB from Matrix Output, 1: SETB from Matrix Output [4]:LUT3_10 [4]/DFF12 Initial Polarity Select 0: Low, 1: High [3:0]:LUT3_10 [3:0] |
| | 825 | | |
| | 826 | | |
| | 827 | | |
| | 828 | | |
| | 829 | | |
| | 830 | | |
| | 831 | | |
| 68 | 832 | REG_CNT2_D[7:0] | Data[7:0] |
| | 833 | | |
| | 834 | | |
| | 835 | | |
| | 836 | | |
| | 837 | | |
| | 838 | | |
| | 839 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------------------|---|
| Byte | Register Bit | | |
| 69 | 840 | Multi3_LUT3_11_DFF13 setting | [7]:LUT3_11 [7]/DFF13 or LATCH Select 0: DFF function, 1: LATCH function [6]:LUT3_11 [6]/DFF13 Output Select 0: Q output, 1: QB output [5]:LUT3_11 [5]/DFF13 0: RSTB from Matrix Output, 1: SETB from Matrix Output [4]:LUT3_11 [4]/DFF13 Initial Polarity Select 0: Low, 1: High [3:0]:LUT3_11 [3:0] |
| | 841 | | |
| | 842 | | |
| | 843 | | |
| | 844 | | |
| | 845 | | |
| | 846 | | |
| | 847 | | |
| 6A | 848 | REG_CNT3_D[7:0] | Data [7:0] |
| | 849 | | |
| | 850 | | |
| | 851 | | |
| | 852 | | |
| | 853 | | |
| | 854 | | |
| | 855 | | |
| 6B | 856 | Multi4_LUT3_12_DFF14 setting | [7]:LUT3_12 [7]/DFF14 or LATCH Select 0: DFF function, 1: LATCH function [6]:LUT3_12 [6]/DFF14 Output Select 0: Q output, 1: QB output [5]:LUT3_12 [5]/DFF14 0: RSTB from Matrix Output, 1: SETB from Matrix Output [4]:LUT3_12 [4]/DFF14 Initial Polarity Select 0: Low, 1: High [3:0]:LUT3_12 [3:0] |
| | 857 | | |
| | 858 | | |
| | 859 | | |
| | 860 | | |
| | 861 | | |
| | 862 | | |
| | 863 | | |
| 6C | 864 | REG_CNT4_D[7:0] | Data [7:0] |
| | 865 | | |
| | 866 | | |
| | 867 | | |
| | 868 | | |
| | 869 | | |
| | 870 | | |
| | 871 | | |
| 6D | 872 | Multi5_LUT3_13_DFF15 setting | [7]:LUT3_13 [7]/DFF15 or LATCH Select 0: DFF function, 1: LATCH function [6]:LUT3_13 [6]/DFF15 Output Select 0: Q output, 1: QB output [5]:LUT3_13 [5]/DFF15 0: RSTB from Matrix Output, 1: SETB from Matrix Output [4]:LUT3_13 [4]/DFF15 Initial Polarity Select 0: Low, 1: High [3:0]:LUT3_13 [3:0] |
| | 873 | | |
| | 874 | | |
| | 875 | | |
| | 876 | | |
| | 877 | | |
| | 878 | | |
| | 879 | | |
| 6E | 880 | REG_CNT5_D[7:0] | Data[7:0] |
| | 881 | | |
| | 882 | | |
| | 883 | | |
| | 884 | | |
| | 885 | | |
| | 886 | | |
| | 887 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------------|---|
| Byte | Register Bit | | |
| 6F | 888 | LUT3_0_DFF2 setting | [7]:LUT3_0 [7]/DFF2 or LATCH Select 0: DFF function, 1: LATCH function |
| | 889 | | [6]:LUT3_0 [6]/DFF2 Output Select 0: Q output, 1: QB output |
| | 890 | | [5]:LUT3_0 [5]/DFF2 Initial Polarity Select 0: Low, 1: High |
| | 891 | | [4]:LUT3_0 [4]/DFF2 stage selection 0: Q of first DFF; 1: Q of second DFF |
| | 892 | | [3]:LUT3_0 [3]/DFF2 0: RSTB from Matrix Output, 1: SETB from Matrix Output |
| | 893 | | [2]:LUT3_0 [2]/DFF2 Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set |
| | 894 | | [1:0]: LUT3_0 [1:0] |
| 70 | 896 | LUT3_1_DFF3 setting | [7]:LUT3_1 [7]/DFF3 or LATCH Select 0: DFF function, 1: LATCH function |
| | 897 | | [6]:LUT3_1 [6]/DFF3 Output Select 0: Q output, 1: QB output |
| | 898 | | [5]:LUT3_1 [5]/DFF3 Initial Polarity Select 0: Low, 1: High |
| | 899 | | [4]:LUT3_1 [4]/DFF3 0: RSTB from Matrix Output, 1: SETB from Matrix Output |
| | 900 | | [3]:LUT3_1 [3]/DFF3 Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set |
| | 901 | | [2:0]: LUT3_1 [2:0] |
| | 902 | | |
| 71 | 904 | LUT3_2_DFF4 setting | [7]:LUT3_2 [7]/DFF4 or LATCH Select 0: DFF function, 1: LATCH function |
| | 905 | | [6]:LUT3_2 [6]/DFF4 Output Select 0: Q output, 1: QB output |
| | 906 | | [5]:LUT3_2 [5]/DFF4 Initial Polarity Select 0: Low, 1: High |
| | 907 | | [4]:LUT3_2 [4]/DFF4 0: RSTB from Matrix Output, 1: SETB from Matrix Output |
| | 908 | | [3]:LUT3_2 [3]/DFF4 Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set |
| | 909 | | [2:0]: LUT3_2 [2:0] |
| | 910 | | |
| 72 | 912 | LUT3_3_DFF5 setting | [7]:LUT3_3 [7]/DFF5 or LATCH Select 0: DFF function, 1: LATCH function |
| | 913 | | [6]:LUT3_3 [6]/DFF5 Output Select 0: Q output, 1: QB output |
| | 914 | | [5]:LUT3_3 [5]/DFF5 Initial Polarity Select 0: Low, 1: High |
| | 915 | | [4]:LUT3_3 [4]/DFF5 0: RSTB from Matrix Output, 1: SETB from Matrix Output |
| | 916 | | [3]:LUT3_3 [3]/DFF5 Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set |
| | 917 | | [2:0]: LUT3_3 [2:0] |
| | 918 | | |
| 73 | 920 | LUT3_0 or DFF2 Select | 0: LUT3_0, 1: DFF2 |
| | 921 | LUT3_1 or DFF3 Select | 0: LUT3_1, 1: DFF3 |
| | 922 | LUT3_2 or DFF4 Select | 0: LUT3_2, 1: DFF4 |
| | 923 | LUT3_3 or DFF5 Select | 0: LUT3_3, 1: DFF5 |
| | 924 | Reserved | |
| | 925 | Reserved | |
| | 926 | Reserved | |
| | 927 | LUT4_0 or DFF16 Select | 0: LUT4_0, 1: DFF16 |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition | |
|---------|--------------|----------------------|---|--|
| Byte | Register Bit | | | |
| 74 | 928 | LUT4_0_DFF16 setting | [15]:LUT4_0 [15]/DFF16 or LATCH Select 0: DFF function, 1: LATCH function [14]:LUT4_0 [14]/DFF16 Output Select 0: Q output, 1: QB output [13]:LUT4_0 [13]/DFF16 Initial Polarity Select 0: Low, 1: High [12]:LUT4_0 [12]/DFF16 stage selection 0: Q of first DFF; 1 Q of second DFF [11]:LUT4_0 [11]/DFF16 0: RSTB from Matrix Output, 1: SETB from Matrix Output [10]:LUT4_0 [10]/DFF16 Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set [9:0]: LUT4_0 [9:0] | |
| | 929 | | | |
| | 930 | | | |
| | 931 | | | |
| | 932 | | | |
| | 933 | | | |
| | 934 | | | |
| | 935 | | | |
| 75 | 936 | | | |
| | 937 | | | |
| | 938 | | | |
| | 939 | | | |
| | 940 | | | |
| | 941 | | | |
| | 942 | | | |
| | 943 | | | |
| 76 | 944 | Reserved | | |
| | 945 | | | |
| | 946 | | | |
| | 947 | | | |
| | 948 | | | |
| | 949 | | | |
| | 950 | | | |
| | 951 | | | |
| 77 | 952 | DFF6/SR0 setting | [7]:DFF or LATCH Select 0: DFF function, 1: LATCH function [6]:DFF/LATCH/SR/Output polarity select 0: non-inverted output, 1: inverted output [5] Reserved [4]:DFF/LATCH/SR RSTB or SETB selection 0: RSTB from Matrix Output, 1: SETB from Matrix Output [3]:DFF/LATCH/SR Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set [2:0] SR Output Select 000: DFF/1st SR output, 001: 2nd SR output 010: 3rd SR output, 011: 4th SR output 100: 5th SR output, 101: 6th SR output 110: 7th SR output, 111: 8th SR output | |
| | 953 | | | |
| | 954 | | | |
| | 955 | | | |
| | 956 | | | |
| | 957 | | | |
| | 958 | | | |
| | 959 | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-------------------------|---|
| Byte | Register Bit | | |
| 78 | 960 | LUT3_4/DFF6/SR0 setting | [7:1]:LUT [7:1] or Shift Register initial value[7:1] [0]:LUT [0] or Shift Register initial value [0] (= DFF/LATCH Initial polarity select) 0: Low, 1: High |
| | 961 | | |
| | 962 | | |
| | 963 | | |
| | 964 | | |
| | 965 | | |
| | 966 | | |
| 79 | 967 | DFF7/SR1 setting | [7]:DFF or LATCH Select 0: DFF function, 1: LATCH function [6]:DFF/LATCH/SR/Output polarity select 0: non-inverted output, 1: inverted output [5] Reserved [4]:DFF/LATCH/SR RSTB or SETB selection 0: RSTB from Matrix Output, 1: SETB from Matrix Output [3]:DFF/LATCH/SR Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set [2:0] SR Output Select 000: DFF/1st SR output, 001: 2nd SR output 010: 3rd SR output, 011: 4th SR output 100: 5th SR output, 101: 6th SR output 110: 7th SR output, 111: 8th SR output |
| | 968 | | |
| | 969 | | |
| | 970 | | |
| | 971 | | |
| | 972 | | |
| | 973 | | |
| 7A | 974 | LUT3_5/DFF7/SR1 setting | [7:1]:LUT [7:1] or Shift Register initial value[7:1] [0]:LUT [0] or Shift Register initial value [0] (= DFF/LATCH Initial polarity select) 0: Low, 1: High |
| | 975 | | |
| | 976 | | |
| | 977 | | |
| | 978 | | |
| | 979 | | |
| | 980 | | |
| 981 | | | |
| 982 | | | |
| 983 | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-------------------------|---|
| Byte | Register Bit | | |
| 7B | 984 | DFF8/SR2 setting | [7]: DFF or LATCH Select 0: DFF function, 1: LATCH function [6]: DFF/LATCH/SR/Output polarity select 0: non-inverted output, 1: inverted output [5] Reserved [4]: DFF/LATCH/SR RSTB or SETB selection 0: RSTB from Matrix Output, 1: SETB from Matrix Output [3]: DFF/LATCH/SR Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set [2:0] SR Output Select 000: DFF/1st SR output, 001: 2nd SR output 010: 3rd SR output, 011: 4th SR output 100: 5th SR output, 101: 6th SR output 110: 7th SR output, 111: 8th SR output |
| | 985 | | |
| | 986 | | |
| | 987 | | |
| | 988 | | |
| | 989 | | |
| | 990 | | |
| | 991 | | |
| 7C | 992 | LUT3_6/DFF8/SR2 setting | [7:1]: LUT [7:1] or Shift Register initial value[7:1] [0]: LUT [0] or Shift Register initial value [0] (= DFF/LATCH Initial polarity select) 0: Low, 1: High |
| | 993 | | |
| | 994 | | |
| | 995 | | |
| | 996 | | |
| | 997 | | |
| | 998 | | |
| | 999 | | |
| 7D | 1000 | DFF9/SR3 setting | [7]: DFF or LATCH Select 0: DFF function, 1: LATCH function [6]: DFF/LATCH/SR/Output polarity select 0: non-inverted output, 1: inverted output [5] Reserved [4]: DFF/LATCH/SR RSTB or SETB selection 0: RSTB from Matrix Output, 1: SETB from Matrix Output [3]: DFF/LATCH/SR Active level selection for RST/SET 0: Active low level reset/set, 1: Active high level reset/set [2:0] SR Output Select 000: DFF/1st SR output, 001: 2nd SR output 010: 3rd SR output, 011: 4th SR output 100: 5th SR output, 101: 6th SR output 110: 7th SR output, 111: 8th SR output |
| | 1001 | | |
| | 1002 | | |
| | 1003 | | |
| | 1004 | | |
| | 1005 | | |
| | 1006 | | |
| | 1007 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition | | |
|---------|--------------|---|---|--|--|
| Byte | Register Bit | | | | |
| 7E | 1008 | LUT3_7/DFF9/SR3 setting | [7:1]:LUT [7:1] or Shift Register initial value[7:1] [0]:LUT [0] or Shift Register initial value [0] (= DFF/LATCH Initial polarity select) 0: Low, 1: High | | |
| | 1009 | | | | |
| | 1010 | | | | |
| | 1011 | | | | |
| | 1012 | | | | |
| | 1013 | | | | |
| | 1014 | | | | |
| 7F | 1015 | LUT2_0/DFF0 setting | [3]:LUT2_0 [3]/DFF0 or LATCH Select 0: DFF function, 1: LATCH function [2]:LUT2_0 [2]/DFF0 Output Select 0: Q output, 1: QB output [1]:LUT2_0 [1]/DFF0 Initial Polarity Select 0: Low, 1: High [0]:LUT2_0 [0] | | |
| | 1016 | | | | |
| | 1017 | | | | |
| | 1018 | | | | |
| | 1019 | | | | |
| | 1020 | | | | |
| | 1021 | | | | |
| 80 | 1022 | LUT2_1/DFF1 setting | [3]:LUT2_1 [3]/DFF1 or LATCH Select 0: DFF function, 1: LATCH function [2]:LUT2_1 [2]/DFF1 Output Select 0: Q output, 1: QB output [1]:LUT2_1 [1]/DFF1 Initial Polarity Select 0: Low, 1: High [0]:LUT2_1 [0] | | |
| | 1023 | | | | |
| | 1024 | LUT2_0 or DFF0 Select | 0: LUT2_0, 1: DFF0 | | |
| | 1025 | LUT2_1 or DFF1 Select | 0: LUT2_1, 1: DFF1 | | |
| | 1026 | LUT2_2 or PGen Select | 0: LUT2_3, 1: PGen | | |
| | 1027 | Active level selection for RST/SET for LUT2_2 or PGen | 0: Active low level reset/set, 1: Active high level reset/set | | |
| | 1028 | LUT2_2_VAL or PGEN_BIT_NUMBER | LUT2_2[3:0] or PGen BIT NUMBER[3:0] | | |
| 1029 | | | | | |
| 1030 | | | | | |
| 1031 | | | | | |
| 81 | 1032 | PGen data | PGen Data [15:0] | | |
| | 1033 | | | | |
| | 1034 | | | | |
| | 1035 | | | | |
| | 1036 | | | | |
| | 1037 | | | | |
| | 1038 | | | | |
| 1039 | | | | | |
| 82 | 1040 | | | | |
| | 1041 | | | | |
| | 1042 | | | | |
| | 1043 | | | | |
| | 1044 | | | | |
| | 1045 | | | | |
| | 1046 | | | | |
| 1047 | | | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|----------------------------|---|--|--|
| Byte | Register Bit | | |
| 83 | 1048 | Filter or Edge Detector Selection | 0, filter, 1, edge det |
| | 1049 | Output Polarity Select | 0: output non-invert, 1: output invert |
| | 1050 | Select the edge mode | 00: Rising Edges Det 01: Falling Edge Det 10: Both Edge Det 11: Both Edge DLY |
| | 1051 | | |
| | 1052 | Delay Value Select for Programmable Delay & Edge Detector | 00: 125 ns, 01: 250 ns, 10: 375 ns, 11: 500 ns |
| | 1053 | | |
| | 1054 | Select the Edge Mode of Programmable Delay & Edge Detector | 00: Rising Edge Detector, 01: Falling Edge Detector, 10: Both Edge Detector, 11: Both Edge Delay |
| 1055 | | | |
| 84 | 1056 | Reserved | Reserved |
| | 1057 | Reserved | Reserved |
| | 1058 | Reserved | Reserved |
| | 1059 | Reserved | Reserved |
| | 1060 | Reserved | Reserved |
| | 1061 | | |
| | 1062 | | |
| 1063 | | | |
| Matrix Virtual Data | | | |
| 85 | 1064 | Pat Gen 0/I ² C_virtual input [0] select | 0: matrix in 24 select Pat Gen 0 1: matrix in 24 select I ² C_virtual Input [0] |
| | 1065 | Pat Gen 1/I ² C_virtual input [1] digital input select | 0: matrix in 25 select Pat Gen 1 1: matrix in 25 select I ² C_virtual Input [1] |
| | 1066 | Pat Gen 2/I ² C_virtual input [2] digital input select | 0: matrix in 26 select Pat Gen 2 1: matrix in 26 select I ² C_virtual Input [2] |
| | 1067 | Pat Gen 3/I ² C_virtual input [3] digital input select | 0: matrix in 27 select Pat Gen 3 1: matrix in 27 select I ² C_virtual Input [3] |
| | 1068 | Pat Gen 4/I ² C_virtual input [4] digital input select | 0: matrix in 28 select Pat Gen 4 1: matrix in 28 select I ² C_virtual Input [4] |
| | 1069 | Pat Gen 5/I ² C_virtual input [5] digital input select | 0: matrix in 28 select Pat Gen 5 1: matrix in 29 select I ² C_virtual Input [5] |
| | 1070 | Pat Gen 6/I ² C_virtual input [6] digital input select | 0: matrix in 30 select Pat Gen 6 1: matrix in 30 select I ² C_virtual Input [6] or GPIO0 (at non-i2c mode) |
| 1071 | Pat Gen 7/I ² C_virtual input [7] digital input select | 0: matrix in 31 select Pat Gen 7 1: matrix in 31 select I ² C_virtual Input [7] or GPIO1 (at non-i2c mode) | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|--|--|
| Byte | Register Bit | | |
| 86 | 1072 | GPIO2/I ² C_virtual input [8] select | 0: matrix in 32 select GPIO2 digital input (GPIO2) 1: matrix in 32 select I ² C_virtual Input [8] |
| | 1073 | GPIO3/I ² C_virtual input [9] digital input select | 0: matrix in 33 select GPIO3 digital input (GPIO3) 1: matrix in 33 select I ² C_virtual Input [9] |
| | 1074 | GPIO4/I ² C_virtual input [10] digital input select | 0: matrix in 34 select GPIO4 digital input (GPIO4) 1: matrix in 34 select I ² C_virtual Input [10] |
| | 1075 | GPIO5/I ² C_virtual input [11] digital input select | 0: matrix in 35 select GPIO5 digital input (GPIO5) 1: matrix in 35 select I ² C_virtual Input [11] |
| | 1076 | GPIO6/I ² C_virtual input [12] digital input select | 0: matrix in 36 select GPIO6 digital input (GPIO6) 1: matrix in 36 select I ² C_virtual Input [12] |
| | 1077 | GPIO7/I ² C_virtual input [13] digital input select | 0: matrix in 37 select GPIO7 digital input (GPIO7) 1: matrix in 37 select I ² C_virtual Input [13] |
| | 1078 | GPIO8/I ² C_virtual input [14] digital input select | 0: matrix in 38 select GPIO8 digital input (GPIO8) 1: matrix in 38 select I ² C_virtual Input [14] |
| | | 1079 | Reserved |
| 87 | 1080 | Reserved | |
| | 1081 | Reserved | |
| | 1082 | Reserved | |
| | 1083 | Reserved | |
| | 1084 | Reserved | |
| | 1085 | Reserved | |
| | 1086 | Reserved | |
| | 1087 | Reserved | |
| 88 | 1088 | Reserved | |
| | 1089 | Reserved | |
| | 1090 | Reserved | |
| | 1091 | Reserved | |
| | 1092 | Reserved | |
| | 1093 | Reserved | |
| | 1094 | Reserved | |
| | 1095 | Reserved | |
| 89 | 1096 | Reserved | |
| | 1097 | Reserved | |
| | 1098 | Reserved | |
| | 1099 | Reserved | |
| | 1100 | Reserved | |
| | 1101 | Reserved | |
| | 1102 | Reserved | |
| | 1103 | Reserved | |
| 8A | 1104 | Reserved | |
| | 1105 | Reserved | |
| | 1106 | Reserved | |
| | 1107 | Reserved | |
| | 1108 | Reserved | |
| | 1109 | Reserved | |
| | 1110 | Reserved | |
| | 1111 | Reserved | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|--|--|
| Byte | Register Bit | | |
| 8B | 1112 | I2C reset bit with reloading NVM into Data register (soft reset) | 0: Keep existing condition, 1: Reset execution |
| | 1113 | IO Latching Enable During I2C Write Interface | 0: Disable, 1: Enable |
| | 1114 | Reserved | |
| | 1115 | Reserved | |
| | 1116 | Reserved | |
| | 1117 | Reserved | |
| | 1118 | Reserved | |
| 8C | 1119 | Reserved | |
| | 1120 | I ² C write mask bits | 1: mask, 0: overwrite |
| | 1121 | | |
| | 1122 | | |
| | 1123 | | |
| | 1124 | | |
| | 1125 | | |
| 1126 | | | |
| 8D | 1127 | | |
| | 1128 | Reserved | |
| | 1129 | Reserved | |
| | 1130 | Reserved | |
| | 1131 | Reserved | |
| | 1132 | Testmode EPG | 0: partial OTP read (A0 to FB) 1: all OTP read (00 to FF) |
| | 1133 | Reserved | |
| 8E | 1134 | Reserved | |
| | 1135 | Reserved | |
| | 1136 | Reserved | |
| | 1137 | Reserved | |
| | 1138 | Reserved | |
| | 1139 | Reserved | |
| | 1140 | Reserved | |
| 8F | 1141 | Reserved | |
| | 1142 | Reserved | |
| | 1143 | Reserved | |
| | 1144 | Reserved | |
| | 1145 | Reserved | |
| | 1146 | Reserved | |
| | 1147 | Reserved | |
| 8F | 1148 | Reserved | |
| | 1149 | Reserved | |
| | 1150 | Reserved | |
| | 1151 | Reserved | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|--|--|
| Byte | Register Bit | | |
| 90 | 1152 | Reserved | |
| | 1153 | Reserved | |
| | 1154 | Reserved | |
| | 1155 | Reserved | |
| | 1156 | Reserved | |
| | 1157 | Reserved | |
| | 1158 | Reserved | |
| 91 | 1159 | Reserved | |
| | 1160 | Reserved | |
| | 1161 | Reserved | |
| | 1162 | Reserved | |
| | 1163 | Reserved | |
| | 1164 | Reserved | |
| | 1165 | Reserved | |
| 92 | 1166 | Reserved | |
| | 1167 | Reserved | |
| | 1168 | Reserved | |
| | 1169 | Reserved | |
| | 1170 | Reserved | |
| | 1171 | Reserved | |
| | 1172 | Reserved | |
| 93 | 1173 | Reserved | |
| | 1174 | Reserved | |
| | 1175 | Reserved | |
| | 1176 | I ² C slave address | |
| | 1177 | | |
| | 1178 | | |
| | 1179 | | |
| | 1180 | Slave address selection bit0 | 0: from register [1176], 1: from GPI |
| | 1181 | Slave address selection bit1 | 0: from register [1177], 1: from GPIO3 |
| | 1182 | Slave address selection bit2 | 0: from register [1178], 1: from GPIO4 |
| | 1183 | Slave address selection bit3 | 0: from register [1179], 1: from GPIO7 |
| 94 | 1184 | I ² C operation disable bit | 0: I ² C operation enable; matrix in 26(27) select I ² C_virtual_0(1) Input 1: I ² C operation disable; matrix in 26(27) select GPIO3(4) digital input |
| | 1185 | Reserved | |
| | 1186 | Reserved | |
| | 1187 | Reserved | |
| | 1188 | Reserved | |
| | 1189 | Reserved | |
| | 1190 | Reserved | |
| | 1191 | Reserved | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-----------------|-------------------------|
| Byte | Register Bit | | |
| 95 | 1192 | Reserved | |
| | 1193 | Reserved | |
| | 1194 | Reserved | |
| | 1195 | Reserved | |
| | 1196 | Reserved | |
| | 1197 | Reserved | |
| | 1198 | Reserved | |
| | 1199 | Reserved | |
| 96 | 1200 | Reserved | |
| | 1201 | | |
| | 1202 | | |
| | 1203 | | |
| | 1204 | | |
| | 1205 | | |
| | 1206 | | |
| | 1207 | | |
| 97 | 1208 | Reserved | |
| | 1209 | | |
| | 1210 | | |
| | 1211 | | |
| | 1212 | | |
| | 1213 | | |
| | 1214 | | |
| | 1215 | | |
| 98 | 1216 | Reserved | |
| | 1217 | | |
| | 1218 | | |
| | 1219 | | |
| | 1220 | | |
| | 1221 | | |
| | 1222 | | |
| | 1223 | | |
| 99 | 1224 | Reserved | |
| | 1225 | Reserved | |
| | 1226 | Reserved | |
| | 1227 | Reserved | |
| | 1228 | Reserved | |
| | 1229 | Reserved | |
| | 1230 | Reserved | |
| | 1231 | Reserved | |
| | 9A | 1232 | |
| 1233 | | Reserved | |
| 1234 | | Reserved | |
| 1235 | | Reserved | |
| 1236 | | Reserved | |
| 1237 | | Reserved | |
| 1238 | | Reserved | |
| 1239 | | Reserved | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-----------------|-------------------------|
| Byte | Register Bit | | |
| 9B | 1240 | Reserved | |
| | 1241 | Reserved | |
| | 1242 | Reserved | |
| | 1243 | Reserved | |
| | 1244 | Reserved | |
| | 1245 | Reserved | |
| | 1246 | Reserved | |
| 9C | 1247 | Reserved | |
| | 1248 | Reserved | |
| | 1249 | Reserved | |
| | 1250 | Reserved | |
| | 1251 | Reserved | |
| | 1252 | Reserved | |
| | 1253 | Reserved | |
| 9D | 1254 | Reserved | |
| | 1255 | Reserved | |
| | 1256 | Reserved | |
| | 1257 | Reserved | |
| | 1258 | Reserved | |
| | 1259 | Reserved | |
| | 1260 | Reserved | |
| 9E | 1261 | Reserved | |
| | 1262 | Reserved | |
| | 1263 | Reserved | |
| | 1264 | Reserved | |
| | 1265 | Reserved | |
| | 1266 | Reserved | |
| | 1267 | Reserved | |
| 9F | 1268 | Reserved | |
| | 1269 | Reserved | |
| | 1270 | Reserved | |
| | 1271 | Reserved | |
| | 1272 | Reserved | |
| | 1273 | Reserved | |
| | 1274 | Reserved | |
| A0 | 1275 | Reserved | |
| | 1276 | Reserved | |
| | 1277 | Reserved | |
| | 1278 | Reserved | |
| | 1279 | Reserved | |
| | 1280 | EPG Data Byte 0 | |
| | 1281 | | |
| 1282 | | | |
| 1283 | | | |
| 1284 | | | |
| 1285 | | | |
| 1286 | | | |
| | 1287 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-----------------|-------------------------|
| Byte | Register Bit | | |
| A1 | 1288 | EPG Data Byte 1 | |
| | 1289 | | |
| | 1290 | | |
| | 1291 | | |
| | 1292 | | |
| | 1293 | | |
| | 1294 | | |
| A2 | 1295 | EPG Data Byte 2 | |
| | 1296 | | |
| | 1297 | | |
| | 1298 | | |
| | 1299 | | |
| | 1300 | | |
| | 1301 | | |
| A3 | 1302 | EPG Data Byte 3 | |
| | 1303 | | |
| | 1304 | | |
| | 1305 | | |
| | 1306 | | |
| | 1307 | | |
| | 1308 | | |
| A4 | 1309 | EPG Data Byte 4 | |
| | 1310 | | |
| | 1311 | | |
| | 1312 | | |
| | 1313 | | |
| | 1314 | | |
| | 1315 | | |
| A5 | 1316 | EPG Data Byte 5 | |
| | 1317 | | |
| | 1318 | | |
| | 1319 | | |
| | 1320 | | |
| | 1321 | | |
| | 1322 | | |
| A6 | 1323 | EPG Data Byte 6 | |
| | 1324 | | |
| | 1325 | | |
| | 1326 | | |
| | 1327 | | |
| | 1328 | | |
| | 1329 | | |
| | 1330 | EPG Data Byte 6 | |
| | 1331 | | |
| | 1332 | | |
| | 1333 | | |
| | 1334 | | |
| | 1335 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| A7 | 1336 | EPG Data Byte 7 | |
| | 1337 | | |
| | 1338 | | |
| | 1339 | | |
| | 1340 | | |
| | 1341 | | |
| | 1342 | | |
| A8 | 1343 | EPG Data Byte 8 | |
| | 1344 | | |
| | 1345 | | |
| | 1346 | | |
| | 1347 | | |
| | 1348 | | |
| | 1349 | | |
| A9 | 1350 | EPG Data Byte 9 | |
| | 1351 | | |
| | 1352 | | |
| | 1353 | | |
| | 1354 | | |
| | 1355 | | |
| | 1356 | | |
| AA | 1357 | EPG Data Byte 10 | |
| | 1358 | | |
| | 1359 | | |
| | 1360 | | |
| | 1361 | | |
| | 1362 | | |
| | 1363 | | |
| AB | 1364 | EPG Data Byte 11 | |
| | 1365 | | |
| | 1366 | | |
| | 1367 | | |
| | 1368 | | |
| | 1369 | | |
| | 1370 | | |
| AC | 1371 | EPG Data Byte 12 | |
| | 1372 | | |
| | 1373 | | |
| | 1374 | | |
| | 1375 | | |
| | 1376 | | |
| | 1377 | | |
| | 1378 | EPG Data Byte 12 | |
| | 1379 | | |
| | 1380 | | |
| | 1381 | | |
| | 1382 | | |
| | 1383 | | |
| | | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| AD | 1384 | EPG Data Byte 13 | |
| | 1385 | | |
| | 1386 | | |
| | 1387 | | |
| | 1388 | | |
| | 1389 | | |
| | 1390 | | |
| AE | 1391 | EPG Data Byte 14 | |
| | 1392 | | |
| | 1393 | | |
| | 1394 | | |
| | 1395 | | |
| | 1396 | | |
| | 1397 | | |
| AF | 1398 | EPG Data Byte 15 | |
| | 1399 | | |
| | 1400 | | |
| | 1401 | | |
| | 1402 | | |
| | 1403 | | |
| | 1404 | | |
| B0 | 1405 | EPG Data Byte 16 | |
| | 1406 | | |
| | 1407 | | |
| | 1408 | | |
| | 1409 | | |
| | 1410 | | |
| | 1411 | | |
| B1 | 1412 | EPG Data Byte 17 | |
| | 1413 | | |
| | 1414 | | |
| | 1415 | | |
| | 1416 | | |
| | 1417 | | |
| | 1418 | | |
| B2 | 1419 | EPG Data Byte 18 | |
| | 1420 | | |
| | 1421 | | |
| | 1422 | | |
| | 1423 | | |
| | 1424 | | |
| | 1425 | | |
| | 1426 | EPG Data Byte 18 | |
| | 1427 | | |
| | 1428 | | |
| | 1429 | | |
| | 1430 | | |
| | 1431 | | |
| | 1431 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| B3 | 1432 | EPG Data Byte 19 | |
| | 1433 | | |
| | 1434 | | |
| | 1435 | | |
| | 1436 | | |
| | 1437 | | |
| | 1438 | | |
| | 1439 | | |
| B4 | 1440 | EPG Data Byte 20 | |
| | 1441 | | |
| | 1442 | | |
| | 1443 | | |
| | 1444 | | |
| | 1445 | | |
| | 1446 | | |
| | 1447 | | |
| B5 | 1448 | EPG Data Byte 21 | |
| | 1449 | | |
| | 1450 | | |
| | 1451 | | |
| | 1452 | | |
| | 1453 | | |
| | 1454 | | |
| | 1455 | | |
| B6 | 1456 | EPG Data Byte 22 | |
| | 1457 | | |
| | 1458 | | |
| | 1459 | | |
| | 1460 | | |
| | 1461 | | |
| | 1462 | | |
| | 1463 | | |
| B7 | 1464 | EPG Data Byte 23 | |
| | 1465 | | |
| | 1466 | | |
| | 1467 | | |
| | 1468 | | |
| | 1469 | | |
| | 1470 | | |
| | 1471 | | |
| B8 | 1472 | EPG Data Byte 24 | |
| | 1473 | | |
| | 1474 | | |
| | 1475 | | |
| | 1476 | | |
| | 1477 | | |
| | 1478 | | |
| | 1479 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| B9 | 1480 | EPG Data Byte 25 | |
| | 1481 | | |
| | 1482 | | |
| | 1483 | | |
| | 1484 | | |
| | 1485 | | |
| | 1486 | | |
| | 1487 | | |
| BA | 1488 | EPG Data Byte 26 | |
| | 1489 | | |
| | 1490 | | |
| | 1491 | | |
| | 1492 | | |
| | 1493 | | |
| | 1494 | | |
| | 1495 | | |
| BB | 1496 | EPG Data Byte 27 | |
| | 1497 | | |
| | 1498 | | |
| | 1499 | | |
| | 1500 | | |
| | 1501 | | |
| | 1502 | | |
| | 1503 | | |
| BC | 1504 | EPG Data Byte 28 | |
| | 1505 | | |
| | 1506 | | |
| | 1507 | | |
| | 1508 | | |
| | 1509 | | |
| | 1510 | | |
| | 1511 | | |
| BD | 1512 | EPG Data Byte 29 | |
| | 1513 | | |
| | 1514 | | |
| | 1515 | | |
| | 1516 | | |
| | 1517 | | |
| | 1518 | | |
| | 1519 | | |
| BE | 1520 | EPG Data Byte 30 | |
| | 1521 | | |
| | 1522 | | |
| | 1523 | | |
| | 1524 | | |
| | 1525 | | |
| | 1526 | | |
| | 1527 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| BF | 1528 | EPG Data Byte 31 | |
| | 1529 | | |
| | 1530 | | |
| | 1531 | | |
| | 1532 | | |
| | 1533 | | |
| | 1534 | | |
| | 1535 | | |
| C0 | 1536 | EPG Data Byte 32 | |
| | 1537 | | |
| | 1538 | | |
| | 1539 | | |
| | 1540 | | |
| | 1541 | | |
| | 1542 | | |
| | 1543 | | |
| C1 | 1544 | EPG Data Byte 33 | |
| | 1545 | | |
| | 1546 | | |
| | 1547 | | |
| | 1548 | | |
| | 1549 | | |
| | 1550 | | |
| | 1551 | | |
| C2 | 1552 | EPG Data Byte 34 | |
| | 1553 | | |
| | 1554 | | |
| | 1555 | | |
| | 1556 | | |
| | 1557 | | |
| | 1558 | | |
| | 1559 | | |
| C3 | 1560 | EPG Data Byte 35 | |
| | 1561 | | |
| | 1562 | | |
| | 1563 | | |
| | 1564 | | |
| | 1565 | | |
| | 1566 | | |
| | 1567 | | |
| C4 | 1568 | EPG Data Byte 36 | |
| | 1569 | | |
| | 1570 | | |
| | 1571 | | |
| | 1572 | | |
| | 1573 | | |
| | 1574 | | |
| | 1575 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| C5 | 1576 | EPG Data Byte 37 | |
| | 1577 | | |
| | 1578 | | |
| | 1579 | | |
| | 1580 | | |
| | 1581 | | |
| | 1582 | | |
| C6 | 1583 | EPG Data Byte 38 | |
| | 1584 | | |
| | 1585 | | |
| | 1586 | | |
| | 1587 | | |
| | 1588 | | |
| | 1589 | | |
| C7 | 1590 | EPG Data Byte 39 | |
| | 1591 | | |
| | 1592 | | |
| | 1593 | | |
| | 1594 | | |
| | 1595 | | |
| | 1596 | | |
| C8 | 1597 | EPG Data Byte 40 | |
| | 1598 | | |
| | 1599 | | |
| | 1600 | | |
| | 1601 | | |
| | 1602 | | |
| | 1603 | | |
| C9 | 1604 | EPG Data Byte 41 | |
| | 1605 | | |
| | 1606 | | |
| | 1607 | | |
| | 1608 | | |
| | 1609 | | |
| | 1610 | | |
| CA | 1611 | EPG Data Byte 42 | |
| | 1612 | | |
| | 1613 | | |
| | 1614 | | |
| | 1615 | | |
| | 1616 | | |
| | 1617 | | |
| | 1618 | | |
| | 1619 | | |
| | 1620 | | |
| | 1621 | | |
| | 1622 | | |
| | 1623 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| CB | 1624 | EPG Data Byte 43 | |
| | 1625 | | |
| | 1626 | | |
| | 1627 | | |
| | 1628 | | |
| | 1629 | | |
| | 1630 | | |
| | 1631 | | |
| CC | 1632 | EPG Data Byte 44 | |
| | 1633 | | |
| | 1634 | | |
| | 1635 | | |
| | 1636 | | |
| | 1637 | | |
| | 1638 | | |
| | 1639 | | |
| CD | 1640 | EPG Data Byte 45 | |
| | 1641 | | |
| | 1642 | | |
| | 1643 | | |
| | 1644 | | |
| | 1645 | | |
| | 1646 | | |
| | 1647 | | |
| CE | 1648 | EPG Data Byte 46 | |
| | 1649 | | |
| | 1650 | | |
| | 1651 | | |
| | 1652 | | |
| | 1653 | | |
| | 1654 | | |
| | 1655 | | |
| CF | 1656 | EPG Data Byte 47 | |
| | 1657 | | |
| | 1658 | | |
| | 1659 | | |
| | 1660 | | |
| | 1661 | | |
| | 1662 | | |
| | 1663 | | |
| D0 | 1664 | EPG Data Byte 48 | |
| | 1665 | | |
| | 1666 | | |
| | 1667 | | |
| | 1668 | | |
| | 1669 | | |
| | 1670 | | |
| | 1671 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| D1 | 1672 | EPG Data Byte 49 | |
| | 1673 | | |
| | 1674 | | |
| | 1675 | | |
| | 1676 | | |
| | 1677 | | |
| | 1678 | | |
| | 1679 | | |
| D2 | 1680 | EPG Data Byte 50 | |
| | 1681 | | |
| | 1682 | | |
| | 1683 | | |
| | 1684 | | |
| | 1685 | | |
| | 1686 | | |
| | 1687 | | |
| D3 | 1688 | EPG Data Byte 51 | |
| | 1689 | | |
| | 1690 | | |
| | 1691 | | |
| | 1692 | | |
| | 1693 | | |
| | 1694 | | |
| | 1695 | | |
| D4 | 1696 | EPG Data Byte 52 | |
| | 1697 | | |
| | 1698 | | |
| | 1699 | | |
| | 1700 | | |
| | 1701 | | |
| | 1702 | | |
| | 1703 | | |
| D5 | 1704 | EPG Data Byte 53 | |
| | 1705 | | |
| | 1706 | | |
| | 1707 | | |
| | 1708 | | |
| | 1709 | | |
| | 1710 | | |
| | 1711 | | |
| D6 | 1712 | EPG Data Byte 54 | |
| | 1713 | | |
| | 1714 | | |
| | 1715 | | |
| | 1716 | | |
| | 1717 | | |
| | 1718 | | |
| | 1719 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| D7 | 1720 | EPG Data Byte 55 | |
| | 1721 | | |
| | 1722 | | |
| | 1723 | | |
| | 1724 | | |
| | 1725 | | |
| | 1726 | | |
| | 1727 | | |
| D8 | 1728 | EPG Data Byte 56 | |
| | 1729 | | |
| | 1730 | | |
| | 1731 | | |
| | 1732 | | |
| | 1733 | | |
| | 1734 | | |
| | 1735 | | |
| D9 | 1736 | EPG Data Byte 57 | |
| | 1737 | | |
| | 1738 | | |
| | 1739 | | |
| | 1740 | | |
| | 1741 | | |
| | 1742 | | |
| | 1743 | | |
| DA | 1744 | EPG Data Byte 58 | |
| | 1745 | | |
| | 1746 | | |
| | 1747 | | |
| | 1748 | | |
| | 1749 | | |
| | 1750 | | |
| | 1751 | | |
| DB | 1752 | EPG Data Byte 59 | |
| | 1753 | | |
| | 1754 | | |
| | 1755 | | |
| | 1756 | | |
| | 1757 | | |
| | 1758 | | |
| | 1759 | | |
| DC | 1760 | EPG Data Byte 60 | |
| | 1761 | | |
| | 1762 | | |
| | 1763 | | |
| | 1764 | | |
| | 1765 | | |
| | 1766 | | |
| | 1767 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| DD | 1768 | EPG Data Byte 61 | |
| | 1769 | | |
| | 1770 | | |
| | 1771 | | |
| | 1772 | | |
| | 1773 | | |
| | 1774 | | |
| | 1775 | | |
| DE | 1776 | EPG Data Byte 62 | |
| | 1777 | | |
| | 1778 | | |
| | 1779 | | |
| | 1780 | | |
| | 1781 | | |
| | 1782 | | |
| | 1783 | | |
| DF | 1784 | EPG Data Byte 63 | |
| | 1785 | | |
| | 1786 | | |
| | 1787 | | |
| | 1788 | | |
| | 1789 | | |
| | 1790 | | |
| | 1791 | | |
| E0 | 1792 | EPG Data Byte 64 | |
| | 1793 | | |
| | 1794 | | |
| | 1795 | | |
| | 1796 | | |
| | 1797 | | |
| | 1798 | | |
| | 1799 | | |
| E1 | 1800 | EPG Data Byte 65 | |
| | 1801 | | |
| | 1802 | | |
| | 1803 | | |
| | 1804 | | |
| | 1805 | | |
| | 1806 | | |
| | 1807 | | |
| E2 | 1808 | EPG Data Byte 66 | |
| | 1809 | | |
| | 1810 | | |
| | 1811 | | |
| | 1812 | | |
| | 1813 | | |
| | 1814 | | |
| | 1815 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| E3 | 1816 | EPG Data Byte 67 | |
| | 1817 | | |
| | 1818 | | |
| | 1819 | | |
| | 1820 | | |
| | 1821 | | |
| | 1822 | | |
| E4 | 1823 | EPG Data Byte 68 | |
| | 1824 | | |
| | 1825 | | |
| | 1826 | | |
| | 1827 | | |
| | 1828 | | |
| | 1829 | | |
| E5 | 1830 | EPG Data Byte 69 | |
| | 1831 | | |
| | 1832 | | |
| | 1833 | | |
| | 1834 | | |
| | 1835 | | |
| | 1836 | | |
| E6 | 1837 | EPG Data Byte 70 | |
| | 1838 | | |
| | 1839 | | |
| | 1840 | | |
| | 1841 | | |
| | 1842 | | |
| | 1843 | | |
| E7 | 1844 | EPG Data Byte 71 | |
| | 1845 | | |
| | 1846 | | |
| | 1847 | | |
| | 1848 | | |
| | 1849 | | |
| | 1850 | | |
| E8 | 1851 | EPG Data Byte 72 | |
| | 1852 | | |
| | 1853 | | |
| | 1854 | | |
| | 1855 | | |
| | 1856 | | |
| | 1857 | | |
| | 1858 | EPG Data Byte 72 | |
| | 1859 | | |
| | 1860 | | |
| | 1861 | | |
| | 1862 | | |
| | 1863 | | |
| | 1863 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| E9 | 1864 | EPG Data Byte 73 | |
| | 1865 | | |
| | 1866 | | |
| | 1867 | | |
| | 1868 | | |
| | 1869 | | |
| | 1870 | | |
| | 1871 | | |
| EA | 1872 | EPG Data Byte 74 | |
| | 1873 | | |
| | 1874 | | |
| | 1875 | | |
| | 1876 | | |
| | 1877 | | |
| | 1878 | | |
| | 1879 | | |
| EB | 1880 | EPG Data Byte 75 | |
| | 1881 | | |
| | 1882 | | |
| | 1883 | | |
| | 1884 | | |
| | 1885 | | |
| | 1886 | | |
| | 1887 | | |
| EC | 1888 | EPG Data Byte 76 | |
| | 1889 | | |
| | 1890 | | |
| | 1891 | | |
| | 1892 | | |
| | 1893 | | |
| | 1894 | | |
| | 1895 | | |
| ED | 1896 | EPG Data Byte 77 | |
| | 1897 | | |
| | 1898 | | |
| | 1899 | | |
| | 1900 | | |
| | 1901 | | |
| | 1902 | | |
| | 1903 | | |
| EE | 1904 | EPG Data Byte 78 | |
| | 1905 | | |
| | 1906 | | |
| | 1907 | | |
| | 1908 | | |
| | 1909 | | |
| | 1910 | | |
| | 1911 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| EF | 1912 | EPG Data Byte 79 | |
| | 1913 | | |
| | 1914 | | |
| | 1915 | | |
| | 1916 | | |
| | 1917 | | |
| | 1918 | | |
| | 1919 | | |
| F0 | 1920 | EPG Data Byte 80 | |
| | 1921 | | |
| | 1922 | | |
| | 1923 | | |
| | 1924 | | |
| | 1925 | | |
| | 1926 | | |
| | 1927 | | |
| F1 | 1928 | EPG Data Byte 81 | |
| | 1929 | | |
| | 1930 | | |
| | 1931 | | |
| | 1932 | | |
| | 1933 | | |
| | 1934 | | |
| | 1935 | | |
| F2 | 1936 | EPG Data Byte 82 | |
| | 1937 | | |
| | 1938 | | |
| | 1939 | | |
| | 1940 | | |
| | 1941 | | |
| | 1942 | | |
| | 1943 | | |
| F3 | 1944 | EPG Data Byte 83 | |
| | 1945 | | |
| | 1946 | | |
| | 1947 | | |
| | 1948 | | |
| | 1949 | | |
| | 1950 | | |
| | 1951 | | |
| F4 | 1952 | EPG Data Byte 84 | |
| | 1953 | | |
| | 1954 | | |
| | 1955 | | |
| | 1956 | | |
| | 1957 | | |
| | 1958 | | |
| | 1959 | | |

Table 42: Register Map (Continued)

| Address | | Signal Function | Register Bit Definition |
|---------|--------------|------------------|-------------------------|
| Byte | Register Bit | | |
| F5 | 1960 | EPG Data Byte 85 | |
| | 1961 | | |
| | 1962 | | |
| | 1963 | | |
| | 1964 | | |
| | 1965 | | |
| | 1966 | | |
| F6 | 1967 | EPG Data Byte 86 | |
| | 1968 | | |
| | 1969 | | |
| | 1970 | | |
| | 1971 | | |
| | 1972 | | |
| | 1973 | | |
| F7 | 1974 | EPG Data Byte 87 | |
| | 1975 | | |
| | 1976 | | |
| | 1977 | | |
| | 1978 | | |
| | 1979 | | |
| | 1980 | | |
| F8 | 1981 | EPG Data Byte 88 | |
| | 1982 | | |
| | 1983 | | |
| | 1984 | | |
| | 1985 | | |
| | 1986 | | |
| | 1987 | | |
| F9 | 1988 | EPG Data Byte 89 | |
| | 1989 | | |
| | 1990 | | |
| | 1991 | | |
| | 1992 | | |
| | 1993 | | |
| | 1994 | | |
| FA | 1995 | EPG Data Byte 90 | |
| | 1996 | | |
| | 1997 | | |
| | 1998 | | |
| | 1999 | | |
| | 2000 | | |
| | 2001 | | |
| 2002 | | | |
| 2003 | | | |
| 2004 | | | |
| 2005 | | | |
| 2006 | | | |
| 2007 | | | |

Table 42: Register Map (Continued)

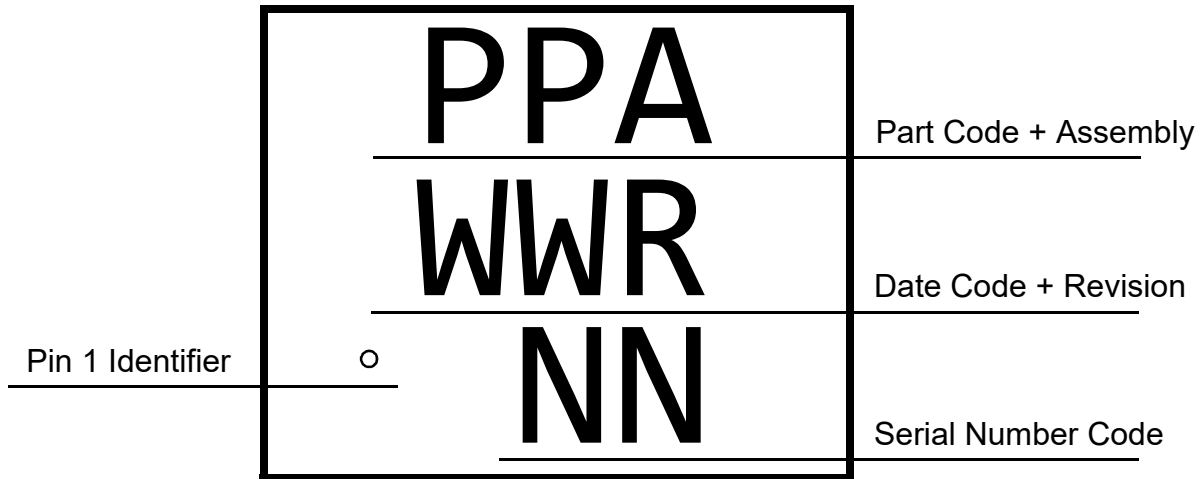
| Address | | Signal Function | Register Bit Definition |
|---------|--------------|-------------------|-------------------------|
| Byte | Register Bit | | |
| FB | 2008 | EPG Data Byte 91 | |
| | 2009 | | |
| | 2010 | | |
| | 2011 | | |
| | 2012 | | |
| | 2013 | | |
| | 2014 | | |
| | 2015 | | |
| FC | 2016 | Reserved | |
| | 2017 | Reserved | |
| | 2018 | Reserved | |
| | 2019 | Reserved | |
| | 2020 | Reserved | |
| | 2021 | Reserved | |
| | 2022 | Reserved | |
| | 2023 | Reserved | |
| FD | 2024 | NVM CRC Remainder | |
| | 2025 | | |
| | 2026 | | |
| | 2027 | | |
| | 2028 | | |
| | 2029 | | |
| | 2030 | | |
| | 2031 | | |
| FE | 2032 | NVM CRC Remainder | |
| | 2033 | | |
| | 2034 | | |
| | 2035 | | |
| | 2036 | | |
| | 2037 | | |
| | 2038 | | |
| | 2039 | | |
| FF | 2040 | NVM CRC Remainder | |
| | 2041 | | |
| | 2042 | | |
| | 2043 | | |
| | 2044 | | |
| | 2045 | | |
| | 2046 | | |
| | 2047 | | |

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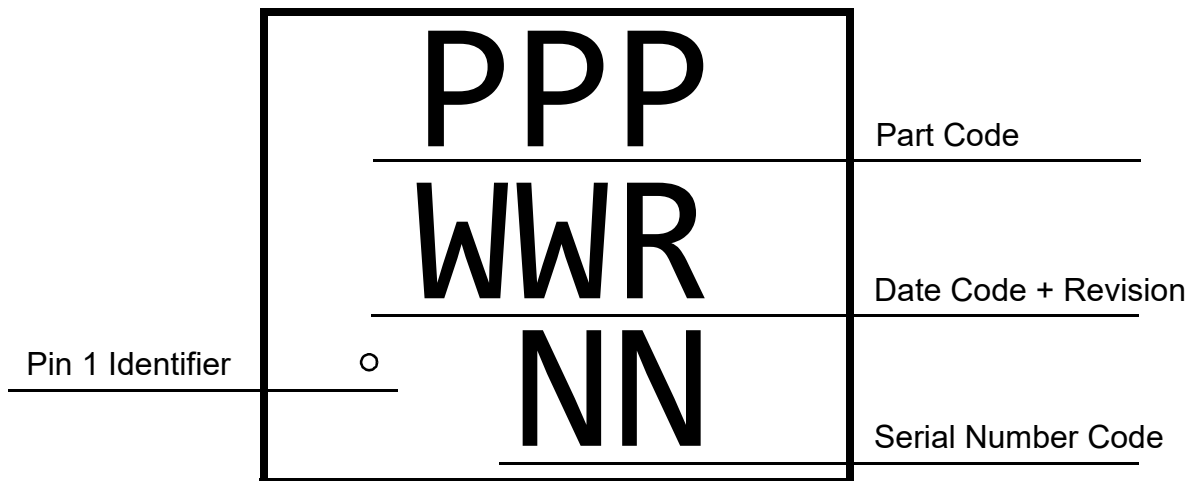
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19 Package Top Marking Definitions

19.1 STQFN 12L 1.6 MM X 1.6 MM 0.4P FC, BEFORE FEBRUARY 1, 2021



19.2 STQFN 12L 1.6 MM X 1.6 MM 0.4P FC, AFTER FEBRUARY 1, 2021



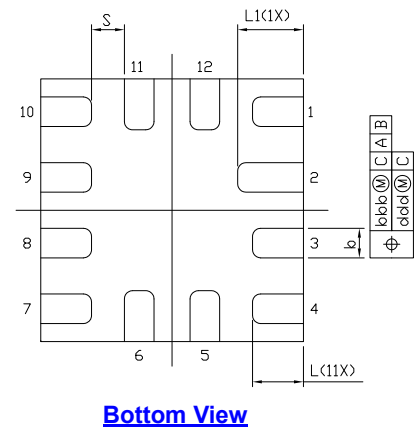
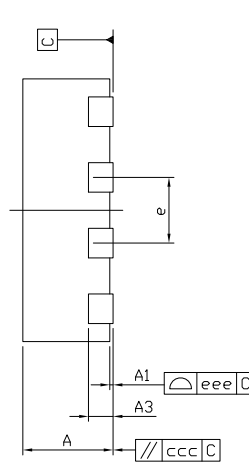
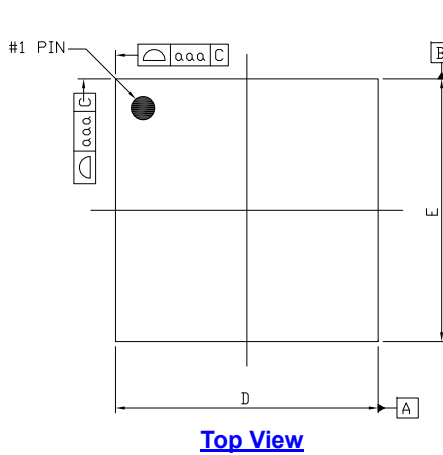
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20 Package Information

20.1 PACKAGE OUTLINES FOR STQFN 12L 1.6 MM X 1.6 MM X 0.55 MM 0.4P FC PACKAGE

JEDEC MO-220IC Net Weight: 0.0035 g



Controlling dimensions: mm

| Symbol | MILLIMETER | | | INCH | | |
|--------|------------|------|------|-----------|-------|-------|
| | Min | Nom. | Max | Min | Nom. | Max |
| A | 0.50 | 0.55 | 0.60 | 0.020 | 0.022 | 0.024 |
| A1 | 0.00 | 0.02 | 0.05 | 0.000 | 0.001 | 0.002 |
| A3 | 0.10 | 0.15 | 0.20 | 0.004 | 0.006 | 0.008 |
| D | 1.55 | 1.60 | 1.65 | 0.061 | 0.063 | 0.065 |
| E | 1.55 | 1.60 | 1.65 | 0.061 | 0.063 | 0.065 |
| e | 0.40 BSC | | | 0.016 BSC | | |
| L | 0.26 | 0.31 | 0.36 | 0.010 | 0.012 | 0.014 |
| L1 | 0.35 | 0.40 | 0.45 | 0.014 | 0.016 | 0.018 |
| b | 0.13 | 0.18 | 0.23 | 0.005 | 0.007 | 0.009 |
| S | 0.200 REF | | | 0.008 REF | | |
| aaa | 0.07 | | | 0.003 | | |
| bbb | 0.07 | | | 0.003 | | |
| ccc | 0.10 | | | 0.004 | | |
| ddd | 0.05 | | | 0.002 | | |
| eee | 0.08 | | | 0.003 | | |

"A1" max lead coplanarity 0.05 mm
Standard tolerance: ±0.05

Notes:

1. All dimensions are in millimeters.
2. Dimension "b" applies to metalized terminal and is measured between 0.15 mm and 0.30 mm from the terminal tip. If the terminal has the optional radius on the other end of the terminal, the dimension "b" should not be measured in that radius area.
3. Bilateral coplanarity zone applies to the exposed heat sink as well as the terminals.

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20.2 MOISTURE SENSITIVITY LEVEL

The Moisture Sensitivity Level (MSL) is an indicator for the maximum allowable time period (floor lifetime) in which a moisture sensitive plastic device, once removed from the dry bag, can be exposed to an environment with a specified maximum temperature and a maximum relative humidity before the solder reflow process. The MSL classification is defined in [Table 43](#).

For detailed information on MSL levels refer to the IPC/JEDEC standard J-STD-020, which can be downloaded from: <http://www.jedec.org>.

The <PACKAGE_NAME> package is qualified for MSL <n>.

Table 43: MSL Classification

| MSL Level | Floor Lifetime | Conditions |
|-----------|----------------|-----------------|
| MSL 4 | 72 hours | 30 °C / 60 % RH |
| MSL 3 | 168 hours | 30 °C / 60 % RH |
| MSL 2A | 4 weeks | 30 °C / 60 % RH |
| MSL 2 | 1 year | 30 °C / 60 % RH |
| MSL 1 | Unlimited | 30 °C / 85 % RH |

20.3 SOLDERING INFORMATION

Refer to the IPC/JEDEC standard J-STD-020 for relevant soldering information. This document can be downloaded from <http://www.jedec.org>.

21 Ordering Information

| Part Number | Type |
|-------------|---|
| SLG46811V | 12-pin STQFN |
| SLG46811VTR | 12-pin STQFN - Tape and Reel (3k units) |

Note 1 Use SLG46811V to order. Shipments are automatically in Tape and Reel.

Note 2 “TR” suffix is no longer used. It is a legacy naming convention shown here only for informational purposes.

21.1 TAPE AND REEL SPECIFICATIONS

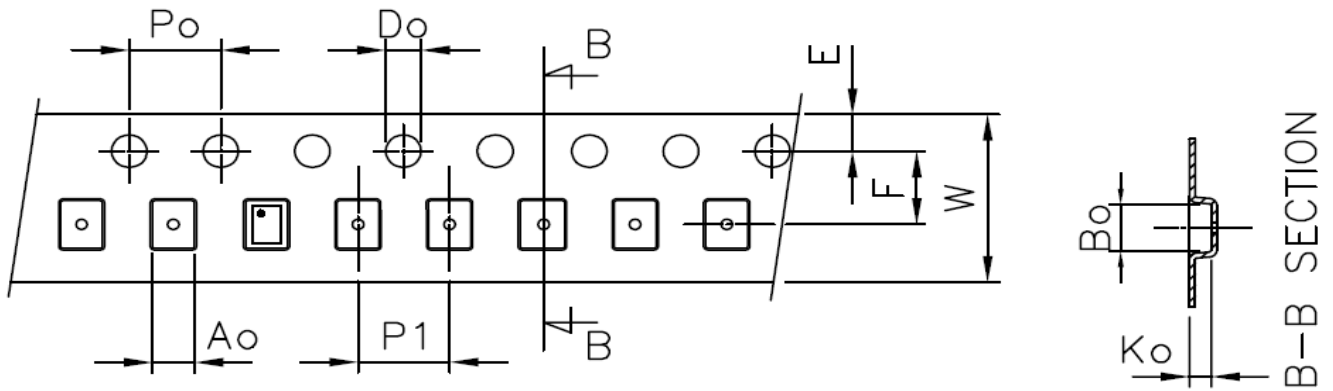
| Package Type | # of Pins | Nominal Package Size (mm) | Max Units | | Reel & Hub Size (mm) | Leader (min) | | Trailer (min) | | Tape Width (mm) | Part Pitch (mm) |
|--|-----------|---------------------------|-----------|---------|----------------------|--------------|-------------|---------------|-------------|-----------------|-----------------|
| | | | per Reel | per Box | | Pockets | Length (mm) | Pockets | Length (mm) | | |
| STQFN 12L 1.6 mm x 1.6mm x 0.55 mm 0.4P FC Green | 12 | 1.6x1.6x0.55 | 3000 | 3000 | 178/60 | 100 | 400 | 100 | 400 | 8 | 4 |

21.2 CARRIER TAPE DRAWING AND DIMENSIONS

| Package Type | PocketBTM Length (mm) | PocketBTM Width (mm) | Pocket Depth (mm) | Index Hole Pitch (mm) | Pocket Pitch (mm) | Index Hole Diameter (mm) | Index Hole to Tape Edge (mm) | Index Hole to Pocket Center (mm) | Tape Width (mm) |
|--|-----------------------|----------------------|-------------------|-----------------------|-------------------|--------------------------|------------------------------|----------------------------------|-----------------|
| | A0 | B0 | K0 | P0 | P1 | D0 | E | F | W |
| STQFN 12L 1.6 mm x 1.6mm x 0.55 mm 0.4P FC Green | 1.9 | 2.3 | 0.76 | 4 | 4 | 1.5 | 1.75 | 3.5 | 8 |

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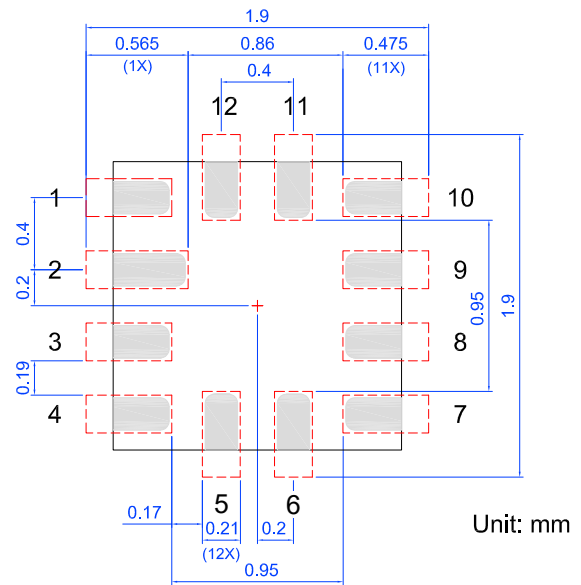
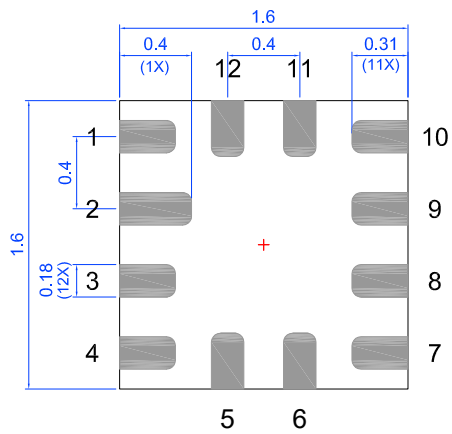
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22 Layout Guidelines

22.1 STQFN 12L 1.6 MM X 1.6 MM X 0.55 MM 0.4P FC PACKAGE

Expose Pad 
(Package face down)

Recommended Landing Pattern 
(Package face down)



Unit: mm

Glossary
A

| | |
|------|-------------------|
| ACK | Acknowledge bit |
| ACMP | Analog Comparator |

B

| | |
|----|---------|
| BG | Bandgap |
|----|---------|

C

| | |
|-----|--------------------------|
| CLK | Clock |
| CMO | Connection matrix output |

D

| | |
|-----|-------------|
| DFF | D Flip-Flop |
| DLY | Delay |

E

| | |
|-----|----------------------------|
| EPG | Extended Pattern Generator |
| ESD | Electrostatic discharge |
| EV | End Value |

F

| | |
|-----|----------------------|
| FSM | Finite State Machine |
|-----|----------------------|

G

| | |
|------|------------------------------|
| GPI | General Purpose Input |
| GPIO | General Purpose Input/Output |
| GPO | General Purpose Output |

I

| | |
|----|--------------|
| IN | Input |
| IO | Input/Output |

L

| | |
|-----|-----------------------|
| LPF | Low Pass Filter |
| LSB | Least Significant Bit |
| LUT | Look Up Table |
| LV | Low Voltage |

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M

| | |
|---------|---|
| MS ACMP | Multichannel Sampling Analog Comparator |
| MSB | Most Significant Bit |
| MUX | Multiplexer |

N

| | |
|------|---|
| NPR | Non-Volatile Memory Read/Write/Erase Protection |
| nRST | Reset |
| NVM | Non-Volatile Memory |

O

| | |
|-----|-----------------------|
| OD | Open-Drain |
| OE | Output Enable |
| OSC | Oscillator |
| OTP | One Time Programmable |
| OUT | Output |

P

| | |
|-------|--------------------|
| PD | Power-down |
| PGen | Pattern Generator |
| POR | Power-On Reset |
| PP | Push-Pull |
| PWR | Power |
| P DLY | Programmable Delay |

R

| | |
|-----|------------|
| R/W | Read/Write |
|-----|------------|

S

| | |
|-----|------------------------------------|
| SCL | I ² C Clock Input |
| SDA | I ² C Data Input/Output |
| SLA | Slave Address |
| SMT | With Schmitt Trigger |
| SV | nSET Value |

T

| | |
|----|--------------------|
| TS | Temperature Sensor |
|----|--------------------|

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V

Vref Voltage Reference

W

WOSMT Without Schmitt Trigger

Revision History

| Revision | Date | Description |
|----------|-------------|---|
| 3.4 | 27-Feb-2023 | Added notes to Ordering Information Fixed typos |
| 3.3 | 8-Dec-2022 | Fixed typos Updated section 3-Bit LUT or DFF with Set/Reset Macrocells Or Shift Register Macrocells |
| 3.2 | 7-Mar-2022 | Renesas re-branding Updated Pull-up or Pull-down Resistance Parameter in EC table |
| 3.1 | 29-Dec-2021 | Corrected Layout Guidelines Added IC Net Weight in Package Information section Added information about SCL and SDA Pins' Schmitt Trigger Updated section GPIO7 Source for Oscillator1 (25 MHz) |
| 3.0 | 14-Apr-2021 | Final version |

Status Definitions

| Revision | Datasheet Status | Product Status | Definition |
|----------|------------------|----------------|--|
| 1.<n> | Target | Development | This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| 2.<n> | Preliminary | Qualification | This datasheet contains the specifications and preliminary characterization data for products in pre-production. Specifications may be changed at any time without notice in order to improve the design. |
| 3.<n> | Final | Production | This datasheet contains the final specifications for products in volume production. The specifications may be changed at any time in order to improve the design, manufacturing and supply. Major specification changes are communicated via Customer Product Notifications. Datasheet changes are communicated via www.renesas.com . |
| 4.<n> | Obsolete | Archived | This datasheet contains the specifications for discontinued products. The information is provided for reference only. |

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